FS740 GPS Time and Frequency System

User Manual

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	← Sine output frequency :	TIMEBASE	SPS CONFIG	CONFIG
	$10\ 000\ 000\ 000\ 000\ \nabla$		URCE	MEASUR
	MHz kHz Hz mHz uHz V		KOUT PULSE OUT	TIME / FRE
	ESC 7 8 9 0 MHz			Front R TRIG
1	+/- 4 5 6 . kHz	DC to 30 MHz ARB, IRI 50 O Source 50 C	G-8 or Sine PWM or IRIG-8 Source 50 Ω Source	1 MΩ / 22.pl Input
10		Soll Source		6



Certification

Stanford Research Systems certifies that this product met its published specifications at the time of shipment.

Warranty

This Stanford Research Systems product is warranted against defects in materials and workmanship for a period of one (1) year from the date of shipment.

Service

For warranty service or repair, this product must be returned to a Stanford Research Systems authorized service facility. Contact Stanford Research Systems or an authorized representative before returning this product for repair.

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Revisions

Rev	Date	Changes
1.00	1/25/17	First release
1.01	4/10/17	Updated several specifications. Removed circuit description and assembly information.
1.02	5/25/17	Added circuit description, parts list, and antenna installation directions.
1.03	6/23/17	Added trigger level specification. Updated GPS lock description.
1.04	8/21/17	Added troubleshooting section. Revised table of optimum time constants for lock to GPS.
1.05	1/15/19	Updated to better describe new GNSS support in later versions of the FS740.
1.06	6/22/20	Added documentation for commands controlling remote and local access behavior.

Safety and Preparation for Use

Line Voltage

The instruments operate from a 90 to 132 V_{AC} or 175 to 264 V_{AC} power source having a line frequency between 47 and 63 Hz. Power consumption is less than 80 VA total. This instrument is intended to be powered at all times. Therefore, there is no power switch. Power is applied to the instrument as soon as the line cord is plugged in.

Power Entry Module

A power entry module, labeled AC POWER on the back panel of the instrument, provides connection to the power source and to a protective ground.

Power Cord

The unit is shipped with a detachable, three-wire power cord for connection to the power source and protective ground.

The exposed metal parts of the box are connected to the power ground to protect against electrical shock. Always use an outlet which has a properly connected protective ground. Consult with an electrician if necessary.

Grounding

BNC shields are connected to the chassis ground and the AC power source ground via the power cord. Do not apply any voltage to the shield.

Line Fuse

The line fuse is internal to the instrument and may not be serviced by the user.

Operate Only with Covers in Place

To avoid personal injury, do not remove the product covers or panels. Do not operate the product without all covers and panels in place.

Serviceable Parts

There are no user serviceable parts. Refer service to a qualified technician.

Symbols You May Find on SRS Products

Symbol	Description
\sim	Alternating Current
	Caution – risk of electrical shock
\rightarrow	Frame or Chassis terminal
	Caution – refer to accompanying document
	Earth (ground) terminal
	Battery
\sim	Fuse
	Power On
	Power Off
Ċ	Power Standby

Specifications

Standard TCXO Timebase

Oscillator type Temperature stability Aging (undisciplined to GNSS) Phase noise (SSB) Stability Oven controlled, 3rd OT, AT-cut crystal <2×10⁻⁶ (20 to 30°C) <5 ppm/year <-105 dBc/Hz at 10 Hz offset (typical) See graphs next page

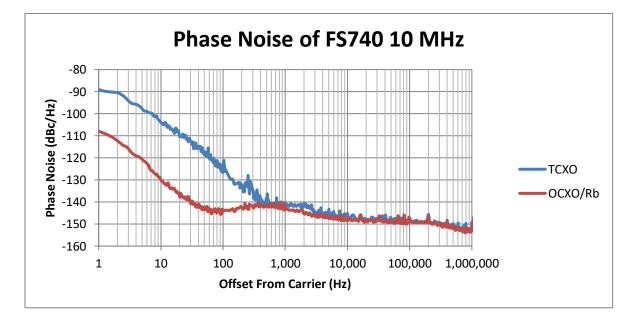
OCXO Timebase

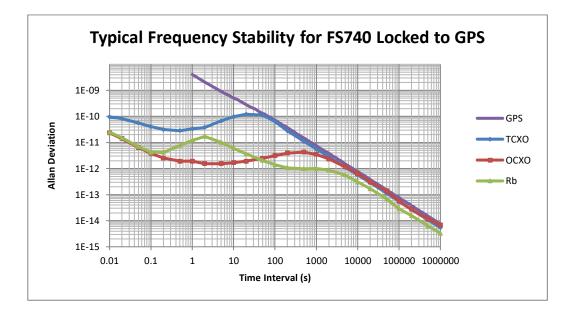
Oscillator type Temperature stability Aging (undisciplined to GNSS) Phase noise (SSB) Stability

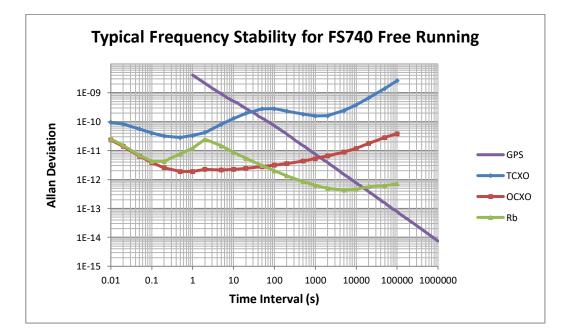
Rubidium Timebase

Oscillator type Physics package Temperature stability Aging (undisciplined to GNSS) Phase noise (SSB) Stability Oven controlled, 3rd OT, SC-cut crystal <1×10⁻⁹ (20 to 30°C) <0.2 ppm/year <-130 dBc/Hz at 10 Hz offset (typical) See graphs next page

Oven controlled, 3^{rd} OT, SC-cut crystal Rubidium vapor frequency discriminator $<1\times10^{-10}$ (20 to 30° C) <0.0005 ppm/year <-130 dBc/Hz at 10 Hz offset (typical) See graphs next page







GNSS Receiver

Model	Ublox NEO-M8T
Power on to satellite acquistion	<1 minute (typical)
Time to acquire almanac	~15 minutes when continuously tracking satellites
Optimized for static applications	Over determined clock mode enables receiver to use all
	satellites for timing.
Accuracy of UTC	< 100 ns
Timing wander	< 20 ns rms (clear view of the sky)
Antenna delay correction range	\pm 32.767 μ s

Sine Output (50 Ω load)

Direct DDS generation	
Frequency range	1 mHz to 30.1 MHz
Frequency resolution	1 μHz
Frequency error	$< 10 \text{ pHz} + \text{timebase error} \times f_C$
Phase settability	1 mDeg
Phase accuracy to internal reference	<2 ns
Amplitude	10 mV_{PP} to 1.414 V_{PP}
Amplitude resolution	<1 %
Amplitude accuracy	±5 %
Harmonics	<-40 dBc
Spurious	<-70 dBc
Output coupling	DC, 50 $\Omega \pm 2$ % at 10MHz
User load	50 Ω
Reverse protection	$\pm 5 V_{DC}$

Aux Output (50 Ω load)

Output options:	Sine, Triangle, Square, 100MHz, or AM IRIG-B
Frequency range	
Sine	1 mHz to 10 MHz
Triangle or square	1 mHz to 1 MHz
100 MHz sine	100 MHz
AM IRIG-B	1 kHz
Frequency resolution	1 μHz
Frequency error	$<10 \text{ pHz} + \text{timebase error} \times f_{\text{C}}$
Phase settability	1 mDeg (cannot adjust phase of 100MHz sine output)
Phase accuracy to internal reference	<2 ns
Amplitude (sine, triangle, square)	10 mV_{PP} to 1.414 V _{PP}
Amplitude (100 MHz)	2.75 dBm ±0.5 dBm
Amplitude resolution	<1 %
Amplitude accuracy	±5 %
Harmonics	<-40 dBc
Spurious	<-70 dBc
Output coupling	DC, 50 $\Omega \pm 2$ %
User load	50 Ω
Reverse protection	$\pm 5 V_{DC}$

Pulse Output

Output options:	Period/width, Freq/duty, Pulse IRIG-B
Period	40 ns to 1000 s
Width	5 ns to (Period -5 ns)
Period/width resolution	1 ps
Frequency range	1 mHz to 25 MHz
Frequency resolution	1 μHz
Frequency error	$< 10 \text{ pHz} + \text{timebase error} \times f_{C}$
Phase settability	5 ps
Phase accuracy to internal reference	<2 ns
Jitter	<50 ps (rms)
Level	+5 V CMOS logic
Transition time	<2 ns
Source impedance	50 Ω

10 MHz Output (50 Ω load)

Amplitude	13 dBm
Amplitude accuracy	±1.5 dBm
Harmonics	<-50 dBc
Spurious	<-90 dBc (100 kHz BW)
Phase settability	Phase can not be adjusted.
Output coupling	DC, 50 Ω ±2 %
User load	50 Ω
Reverse protection	$\pm 5 V_{DC}$

Time and Frequency Input

Time tag resolution:	1 ps
Time tag jitter (rms)	<50 ps
Frequency resolution	1 μHz
Maximum frequency	>120 MHz
Measurement stability	<10 ps/gate + timebase stability (synchronous)
	<100 ps/gate + timebase stability (otherwise)
Trigger level	±3 V

Computer Interfaces (standard)

Ethernet (LAN)	10/100 Base-T. TCP/IP & DHCP default.
RS-232	4.8k-115.2k baud, RTS/CTS flow

Option A: 10 MHz Distribution

Number of outputs	5
Specifications	Same as motherboard 10MHz output

Option B: Sine/Aux Distribution

Number of outputs	5
Specifications	Same as motherboard Sine or Aux output
Option C: Pulse Distribution	

Number of outputs	5
Specifications	Same as motherboard Pulse output

General

Line power EMI Compliance Dimensions Weight Warranty <90 W, 90 to 264 V_{AC} , 47 to 63 Hz with PFC FCC Part 15 (Class B), CISPR-22 (Class B) $8.5^{\circ} \times 3.5^{\circ} \times 13^{\circ}$ (W × H × D) <10 lbs One year on parts and labor

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Quick Start Instructions

Installing the FS740

To setup and install the FS740 follow these steps:

- 1. Install the GNSS antenna in a location that has a clear view of the sky, such as the roof of a building. See below for details.
- 2. Connect the cable from the antenna to the rear panel input of the FS740 labeled "GPS ANT"



3. Power on the FS740 by plugging in the AC power cord.

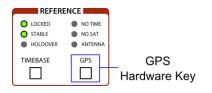
If you don't care about the absolute accuracy of the FS740's phase relative to UTC then setup is complete (otherwise, see below). The FS740 will automatically search for GNSS satellites and lock its internal timebase to them. Once locked, the FS740 may take up to 1 hour or more to fully stabilize. When the FS740 is fully stabilized the front panel locked and stable LEDs should be on.



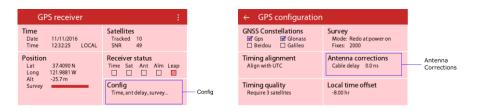
Correcting UTC for the Antenna Delay

The user can improve the absolute calibration of the FS740's estimate of UTC by computing and entering an antenna delay, the amount of time it takes for signals to travel from the antenna to the FS740. To do this, follow these additional steps:

- 4. Measure the length of cable in feet that was used to connect the antenna to the FS740.
- 5. With the FS740 powered on, press the hardware key labeled GPS to activate the top-level GNSS display.



6. Navigate to GPS > Config > Antenna corrections



7. To calculate the cable delay for the antenna, multiply 1.54 ns/ft by the length of the cable in feet as measured in step 4, and enter the result as a NEGATIVE number in ns using the virtual numeric key pad.

Installing the Antenna

Selecting a Location for the Antenna

The signals broadcast by the GNSS satellites are extremely weak and difficult to detect. Generally speaking, you will get best results if the antenna has a clear unobstructed view of the sky. This is commonly on the roof of the building within which the FS740 is located. If this is not possible, the user can try locating the antenna at a window. Doing so, however, may degrade the quality and reliability of the GNSS signals as fewer satellites will typically be visible and with less SNR. This can degrade the long-term stability of the FS740 by a factor of three.

Antennas Offered by SRS

SRS offers two antenna solutions, an indoor antenna and an outdoor antenna. The indoor antenna supports GPS only, and includes the antenna and 23 feet of RG58 cable to connect the antenna directly to the FS740. The outdoor solution includes a GNSS antenna that works with all the major satellite constellations, 75 feet of low loss cable, and a complete solution for protecting the equipment from lightning strikes. The outdoor kit is described in detail below.

Active Antenna Required

The antennas provided by SRS are active antennas. An active antenna is required with the FS740 to ensure sufficient signal is available at the receiver input. The FS740 supplies 5 VDC to the antenna cable to power the active antenna. Active antennas typically have more gain and improved signal detection capability over passive antennas. They also help to overcome the signal loss introduced by long antenna cables and, therefore, are necessary.

Antenna Warning LED

The orange LED on the front panel labeled ANTENNA warns if the FS740 detects that the antenna input is either an open or short circuit. It typically goes off when the antenna is properly connected to the FS740.



The state of the LED, however, is based solely on the DC current draw on the antenna cable, not on measured signal levels. If the current draw is less than 5 mA, the FS740 will

warn of an open circuit. If the current draw is greater than 75 mA, the FS740 will warn of a short circuit. The total current draw for the antenna is limited to 300 mA. Please note that the performance of the FS740 is not impacted at all if the power draw of your antenna falls outside this range, The FS740's GNSS receiver will continuously search for GNSS satellites regardless of the current draw on the antenna. The warning LED is merely meant to be a helpful diagnostic to consider when troubleshooting a lack of signal for the most common installations.

Antenna Delay Correction

The FS740's estimate of UTC is based on when the receiver detects the signal, not when the signal arrives at the antenna. If a long cable is needed to connect the antenna to the FS740, this delay can be significant. The typical delay for most BNC cables is 1.5417 ns per foot. Thus, for a 30 ft cable, the delay would be $1.54 \times 30 = 46$ ns. If uncorrected, the FS740's estimate of UTC would be 46 ns later than a properly calibrated unit.

The user can correct for this delay by entering a negative correction: -46 ns. To do this navigate to GNSS > Config > Antenna corrections and enter a correction of -46 ns. The correction will be stored in nonvolatile memory and need not be re-entered when the unit is power cycled. When entered correctly, the display will look like that shown in Figure 1.

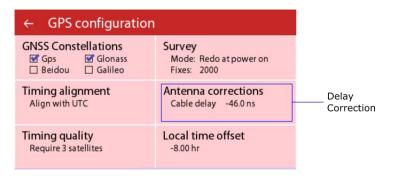


Figure 1: Antenna delay correction

GNSS-Outdoor Antenna Kit (Model O740ANT2)

The GNSS-Outdoor Antenna Kit consists of components for the construction of a robust GPS/GLONASS antenna system. The kit includes a Trimble Bullet III GNSS omnidirectional antenna with LNA and TNC connector on a short aluminum mast. The mast has a cable access slot, silicone weather plug, and a grounding lug for lightning protection. The cap at the bottom of the mast is tapped for ¹/₄"-20 and bolted to a magnetic mount which has a 90 lbs. (40 kg) pull rating.

The magnetic mount may be removed to allow for mounting to a shelf, bracket or cabinet. The included die cast aluminum bracket allows mounting to a wall or pole. A lightning surge arrestor and 100' (30 m) of 10 AWG copper wire is provided for lightning protection. Two lengths (25' and 50') of low loss, 0.400" diameter, 50 Ω TNC extension cables (male-female, *not* RP), and a TNC to BNC adapter to connect to the SRS GNSS receiver are included.

The +32 dBi gain antenna will provide a +20 dBi signal to the receiver, allowing for up to 12 dB of cable loss. The 0.400" cables allow cable lengths up to 200" (60 m). Inline GNSS amplifiers are available from third party vendors if the antenna is more than 200" from the receiver.

Outdoor Antenna Kit Contents

The contents of the outdoor antenna kit are detailed in Table 1. The main components are pictured in Figure 2.

Quantity in Kit	Description
	Antenna
1	Assembled antenna mast with magnetic base
1	TNC (M) to BNC (M) adapter to connect to FS740 ***
1	3/16" Allan key to remove magnetic mount ***
	Alternate mounting arm
1	Die cast aluminum mounting bracket
4	SS Wood screws (#10 x 1.5") for mounting bracket ***
4	#10 Flat washer for mounting bracket ***
	Cables
1	LMR400, TNC (M-F), 25' (1.4 dB loss)
1	LMR400, TNC (M-F), 50' (4.2 dB loss)
1	100', #10 AWG, solid, green insulation
1	Silicone tape wrap for water proofing
20	Black cable ties, UV protected, 7.5", 50 lb. ***
	Lightening arrestor
1	10 kA lightning surge suppressor, TNC (M-F) with copper ground lug ***
2	Self-tapping #8x1/2" SS metal screws to mount arrestor ***
1	Original lug and screw for lightning arrestor ground ***

*** Hardware item is located in polybag.



Figure 2: Outdoor antenna kit

Design Considerations

There are many considerations for the design of an outdoor GNSS antenna, including:

- 1. An unobstructed view of the sky. If obstructions are unavoidable, a clear view of the southern sky is preferred. Also, avoid antenna placement with multipath opportunities (reflections from other structures).
- 2. Use of cable types and lengths with less than 12 dB of loss at 1.6 GHz between the antenna and the timing receiver. (The cables included with the kit have a total loss of 5.6 dB.)
- 3. Sufficient height so that the antenna will not be buried by more than 1 foot of snow.

- 4. Strategies to avoid lightning strikes. Avoid being the highest metal object (which, unfortunately, conflicts with a clear sky view and avoiding multipath).
- 5. A strategy to handle a lightning strike. This is a complicated and important topic which must be addressed to insure the safety of personnel and reduce equipment damage. The antenna mast and inline lightning surge arrestor, included with the antenna kit, must be attached to a grounded structure, or connected to earth ground via a grounding rod.
- 6. Compliance with local building and electrical codes.
- 7. Compliance with building lease term and easements.

When designing the outdoor GNSS antenna system, site specific designs and the use of other materials will be required. If additional cables are needed they should have a TNC male on one end and a TNC female connector on the other, so that they may be used as extension cables without coax barrels. These are *not* RP cables (which reverse the pin and socket of conventional connectors). The cables sold by SRS are not plenum rated. For additional TNC cables we suggest part number 28-463-050 (a 50' cable with a typical loss of 4.2 dB) available from http://www.showmecables.com/

Mounting the Antenna

The required connections for installing the antenna are highlighted in Figure 3. The simplest semi-permanent installation uses the magnetic antenna mount placed on top of a HVAC unit on the roof. If HVAC placement is not available, the magnetic mount can be attached to a 10 lbs. weight (barbell weights work well for this purpose) and placed on the roof.

Alternatively, the magnetic mount can be removed allowing the antenna to mount to a wall or pole using the included mounting arm. The antenna may also be mounted to any horizontal surface or brace which has a $\frac{1}{4}$ " diameter hole. A $\frac{3}{16}$ " hex wrench is included in the kit to remove the magnetic mount from the antenna mast. The hardware, including fiber washers to break galvanic contact, should be reused.

To connect the antenna to the coax cable, first remove the antenna from the mast. Observing the gender of both ends of the cable, thread the male end of the cable through the oval slot in the antenna mast. Remove the plastic protector from the antenna connector. Screw the cable on to the antenna connector finger tight. Push the cable down into the mast and screw the antenna onto the mast. (The TNC connector is free to rotate, and the direction of rotation will not cause the TNC to loosen.)

Lightning Protection

There are two important components for lightning protection: A ground wire attached directly to the aluminum antenna mast, and a lightning arrestor/surge absorber located where the coax cable enters the building. The arrestor has a TNC male connector on one end and a TNC female on the other and a lug for earth ground in the center. Both the antenna mast ground and the lightning arrestor must be separately connected to earth ground with #10 AWG copper wire (included with kit). All outdoor TNC connectors, including those attached to the lightning arrestor, should be protected from weather and sunlight exposure with the included silicone tape wrap.

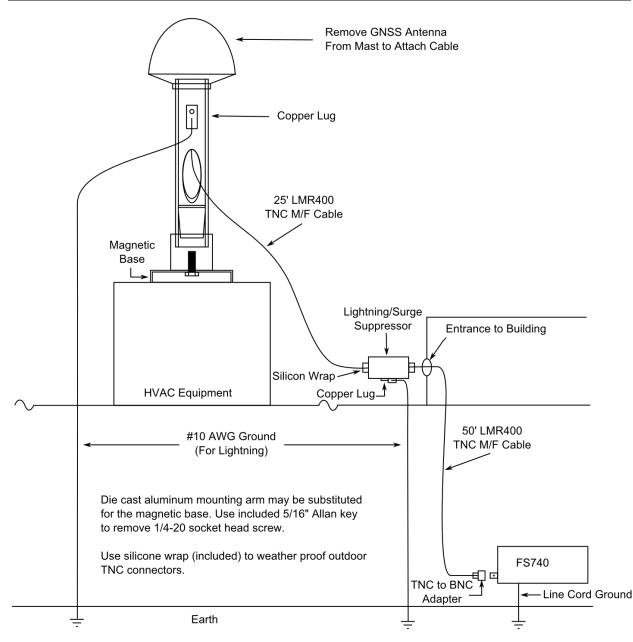


Figure 3: Antenna installation

Troubleshooting

Symptom	Solution
No satellites found, or stuck searching for GNSS satellites.	Most likely caused by low SNR due to a poorly positioned antenna. Verify that the connection to the antenna is good. Then try moving the antenna to a location with a clear view of the sky to see if this improves the situation. For good results, the unit should have an SNR > 40 once satellites are found.
Instrument is stuck in holdover even after satellites have been found.	This can happen if you were unlocked for a long time or because the instrument lost lock before the timebase had stabilized. To fix, use the front panel display and navigate to
	Timebase > Config timebase > Leave holdover by
	Then select either
	"Jump to good 1pps" or "Slew to good 1pps"
	Note that it should be rare for the instrument to lose lock to satellites if the antenna has a clear view of the sky. Try to get a $SNR > 40$ once satellites are found.

Introduction

Feature Overview

The FS740 GPS Time and Frequency System is primarily designed to provide continuously calibrated time and frequency distribution to a local laboratory. Calibration is maintained by locking its internal reference to the time of day signals broadcast by the GNSS satellites. The satellites which make up the various GNSS networks are equipped with rubidium and cesium clocks which are monitored and controlled by government agencies, such as the U.S. Air Force for GPS, which steer the timing of the GNSS satellites to maintain synchronicity with UTC. The FS740 includes a GNSS receiver that is specifically designed to generate precise timing. When locked to GNSS satellites, the FS740 can align its outputs and time tag signals on its inputs to UTC with a relative precision of 5 ps, an RMS deviation of less than 20 ns and an absolute accuracy of 100 ns.

On its front panel, the FS740 provides three user configurable outputs: a sine output, an aux output, and a pulse output. The sine output supports the generation of frequencies from 1 mHz to 30.1 MHz and amplitudes ranging from 10 mV_{PP} to 1.414 V_{PP} . Its phase can be adjusted with 1 millidegree of relative precision. Furthermore, if the FS740 is locked to GNSS satellites, the zero crossings of the output can be synchronized to UTC if desired.

The aux output supports the generation of several different signals: sine waves, triangle waves, zero-centered square waves, a fixed 100 MHz sine wave, and an AM modulated IRIG-B timing code. Frequencies up to 10 MHz are supported for sine waves, and up to 1 MHz for triangle and square waves. Like the sine output, amplitudes for these three signals may range from 10 mV_{PP} to 1.414 V_{PP}. Its phase can be adjusted with 1 millidegree of relative precision, and synchronized to UTC if desired. The 100 MHz sine output has a fixed amplitude (2.75 dBm) and frequency and is intended for synchronization of high frequency equipment. Finally, the IRIG-B signal may be used for time of day distribution

The pulse output generates 5 V CMOS waveforms with frequencies ranging from 1 mHz to 25 MHz, and pulse widths ranging from 5 ns to the period -5 ns. The user may specify a period and pulse width, or a frequency and duty cycle. Periods and pulse width may be specified with 1 ps of resolution. Frequencies may be specified with 1 uHz resolution. The phase of the pulses can be adjusted with 5 ps of resolution. If the FS740 is locked to GNSS satellites, the rising edge of the pulse output can be synchronized to UTC if desired. Finally, the pulse output can also be configured to generate pulse-width-modulated IRIG-B timing codes for time of day distribution.

For expanded distribution, the FS740 comes standard with copies of the three front panel outputs as well as a 10 MHz output on its rear panel. Any of these outputs, including the 10 MHz output, can be expanded with up to 15 more buffered outputs with the installation of up to three option boards on the rear panel, thereby providing ample distribution capability for a local laboratory.

In addition to distributing time and frequency signals to other instrumentation, the FS740 also includes the ability to measure time and frequency of external signals. It can time tag an event relative to UTC with less than 50 ps of jitter. Alternatively, it can measure frequencies of up to 120 MHz with gates ranging from 10 ms to 1000 s, providing up to 12 digits of resolution in a 1 second gate interval. Two measurement inputs are available to the user: one on the front panel and one on the rear panel. Both inputs may be operated independently, and simultaneously.

Finally, the FS740 is ideally suited to making frequency stability measurements. It generates averaged time tags at 10 ms intervals with no dead time enabling it to compute Allan deviation stability results for intervals from 10 ms to 50 million seconds automatically. Measurements can be easily configured from the front panel and results viewed in real time without an external computer. Long term stability measurements can be initiated and left to run autonomously for months at time if desired. Results may be periodically downloaded while the measurement continues to run.

Front-Panel Overview

FS740 GPS TIME &	FREQUENCY SYSTEM		NO TIME	COM ACTIVITY ERROR	O POWER	- Status LEDs
Timebase	1	HOLDOVER	ANTENNA	REMOTE		
Timebase State Locked to GPS Duration 7.24 hr Loop TC 4000 s Time Err 3.8 ns	Timebase events Count 4 Event Power up Date 11/22/2016 Time 09:34:39		GPS SOURCE AUX OUT	CONFIG	CONFIG MEASURE TIME / FREQ	Hardware Keys
Ave Err 2.4 ns Type Rb	CLEAR				Front Rear	
Freq control 1.979353 V	Config timebase Holdover mode, limits	DC to 30 MHz 50 Ω Source	ARB, IRIG-8 or Sine 50 Ω Source	PWM or IRIG-8 50 Ω Source	1 MΩ/22 pF Input	
SRS Stanford R	esearch Systems, Inc.			\bigcirc		
<u></u>	/	<u>`</u>			/	
Touch Scre	en LCD Display		BNC C	onnectors	;	

Figure 4: The FS740 front panel

The FS740 front panel consists of a touch screen, color, LCD display with 4 BNC connectors at the bottom right and 8 hardware buttons divided into 5 sections: reference, communications, system, source outputs, and measurement inputs. Each section is color coded to assist the user in identifying common functionality. The hardware buttons in each section provide direct access to status and settings related to that section or function. Dedicated LEDs highlight important status related to the given section. A red box surrounds the reference section which provides information on the internal timebase and the GNSS receiver. The timebase is directly coupled to the GNSS receiver which provides absolute timing pulses to which the timebase locks. A yellow box surrounds the communications section which provides access to remote interface configuration and status. A purple box surrounds the system section which provides access to overall system configuration. A blue box surrounds the 3 source outputs: sine out, aux out, and pulse out. Dedicated keys provide direct access to the configuration of each output. Finally, a green box surrounds the measurement input. This section enables the user to configure time and frequency measurements of signals applied to either the front or rear input.

Front Panel Display

A touch screen, color LCD display provides easy access to status and configuration information for the FS740. All settings of the FS740 may be easily updated through interaction with the display.

Display Navigation

Dedicated hardware keys on the right-hand side of the front panel enable the user to immediately navigate to status and configuration information related to that section or item. Virtual cards and buttons on the touch screen, itself, allow the user to further navigate through all the configuration parameters associated with a given section. The front panel display is organized as follows. At the top is a title bar which displays the overall title for the screen. It is color coded to match the section color on the right-hand side of the front panel to which it applies. Below the title, the screen is divided into virtual cards that display information on a specific function Virtual cards are separated from each other by white space to clearly delineate them. Each card contains a subtitle followed by abbreviated configuration and status information related to it. Finally, at the far right of the title bar is a virtual button consisting of 3 white dots aligned vertically. This button provides access to a menu of settings for lesser used configuration parameters and options. All of these features are highlighted in Figure 5, which shows the main display when the hardware GPS key in the REFERENCE section of the front panel is pressed.

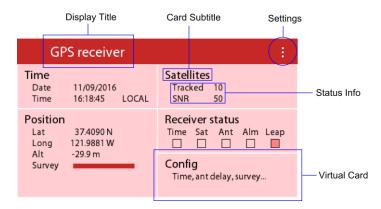


Figure 5: Display organization with various components highlighted.

Pressing a virtual card will normally enable the user to alter a configuration parameter, or display more detailed information about it. Pressing the Satellites card shown in Figure 5 will cause the FS740 to display more detailed information on the GPS Satellites as shown in Figure 6.

Navigate Back					
← GPS satellites					
Tracked	ID	SNR	Azimuth	Elevation	
10 satellites	10	51	295	67	
TO satellites	18	50	34	64	
N	21	57	100	53	
	27	50	292	49	
	32	54	189	38	
W PE	15	50	44	18	
	8	41	319	16	
	24	46	88	14	
S	14	48	197	12	
5	16	37	248	11	

Figure 6: Detailed display with navigate back highlighted.

Detailed information screens may or may not have additional cards that refine the information display. Nevertheless, all of them will have a virtual button with a left facing arrow located at the top left of the title bar. Use this button to navigate back to the previous display. In this case it leads back to the GPS Receiver display.

Navigation Sequences

In this manual we will often need to refer to navigation sequences which describe how to modify or configure a specific parameter. The navigation sequence is the sequence of virtual key presses that take you to a specific display. The sequence starts with the title of the main display followed by the title of each virtual card pressed to get to the display of interest. Each key press is separated by a greater than sign (>). For example, the detailed satellite information shown in Figure 6 has the following navigation sequence:

GPS receiver > Satellites

The sequence starts with the GPS receiver display. This is one of eight top level displays associated with the eight hardware keys located on the right hand side of the front panel above the BNCs. Press the appropriate hardware key to arrive at desired top level display. After that, the navigation sequence identifies the subtitles of cards pressed to arrive at the display of interest. In this case the user should press the virtual card Satellites to navigate to the GPS satellites display.

Parameter Modification

Numeric Parameters

Many parameters take numerical values. In this case the user has a number of options for entering or modifying the parameter. To enter the sine output frequency, for example, navigate to Sine Output > Frequency. A sample screen is shown in Figure 7. The user has two options: enter a new value directly, or modify the existing value.

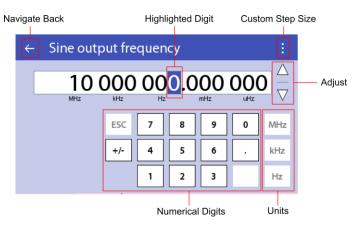


Figure 7: Parameter modification.

Enter a New Value

To enter a new value use the numerical digit keys to enter the number and complete the entry by selecting the desired units for the entry. To enter 5 MHz, for example, press the keys '5' and 'MHz' in sequence.

Modify an Existing Value

To modify the existing value, use the up and down arrow keys to adjust the value up and down, respectively. The highlighted digit identifies the step size for the adjustment. For the display shown in Figure 7, the value will be adjusted in 1 Hz steps. The user can easily change the step size to any desired resolution by touching the digit he wants to be highlighted.

The user can also enter a custom step size using the Settings button (three vertical dots) at the far right of the title bar. Select 'Custom step size' and enter the desired step size using the virtual numeric keypad. Then use the up and down arrows to step the value at the custom step size. The highlighted digit will reflect the most significant digit of the custom step size.

Navigating Back

When entering values directly, the screen will typically navigate back to the previous screen, automatically, once the numeric entry is completed. This is not the case when

modifying values, however. Here, the user must press the left facing arrow at the left of the title bar to navigate back.

Enumerations

Some parameters are not numeric in nature. Rather, they take on one of a small set of enumerated values. The Aux output configuration is an example of this. Navigate to Aux output > Config, and the display will be similar to that shown in Figure 8.

Aux or	Aux configuration	:
Confic	Sine	
Ampli	O Triangle	
, unpu	O Square	
Frequ	O 100 MHz Sine	MHz
Phase	O AM IRIG B	

Figure 8: Parameter enumeration.

The display shows that Sine is the currently configured waveform. Simply press one of the other options to change the selection. Press anywhere else to cancel the selection process.

Boolean Check Boxes

Some functions are either on or off. These are often represented with check boxes. When checked, the function is enabled. When unchecked, the function is disabled or off. An example of this is shown in Figure 9.

Limit
0 s
100.0 ns

Figure 9: Boolean check boxes

Here the alarm is asserted if the time of day has not been set by the GNSS satellites or if the timebase goes into holdover. It is not affected by the measured offset from UTC. The user can easily toggle a selection by touching the desired check box.

Actions

Sometimes, rather than setting a value, the user may need to initiate an action. This is usually accomplished with an action button. Action buttons are usually represented as a single word or short phrase written in dark-green, capital letters. An example of this is shown in Figure 10.

Latitude 37.409 009 693 N Longitude 121.988 090 352 W Altitude -25.7 m Survey progress 20 % RESTART	←	GPS position		
		Longitude	121.988 090 35	
		Survey progr		RESTART

Figure 10: Action button

Here, pressing the RESTART button would restart the position survey, which is currently 20% complete.

Top Level Displays and Buttons

On the right hand side of the front panel, above the 4 BNCs, are 8 physical buttons identified as hardware keys in Figure 4. Each button is associated with a top level display that enables the user to view status and configuration information for a given area of functionality.

Timebase

The top level timebase display provides configuration and status information for the internal timebase. It is composed of four virtual cards: timebase status, timebase events, frequency control, and configuration. A sample display is shown in Figure 11.

Timebase	:
TimebaseStatusLocked to GPSDuration21.02 hrLoop TC4000 sTime Err4.7 nsAve Err-2.6 nsTypeRb	Timebase events Count 4 Event Power up Date 11/10/2016 Time 15:28:52 CLEAR
Freq control 1.983794 V	Config timebase Holdover mode, limits

Figure 11: Top level timebase display

The timebase card shows the current state of the internal timebase, how long it has been in that state, detailed information on the phase lock loop that locks the internal timebase to the GNSS satellites, and the type of timebase installed.

The phase lock loop information includes the current loop time constant as well as the most recent timing error and average timing error of the timebase relative to GNSS. Positive errors indicate the timebase lags GNSS. Negative errors indicate the timebase leads GNSS.

The FS740 automatically captures each time the state of the timebase changes as an event. Every time the timebase either locks or unlocks from the GNSS satellites, for instance, the event will be logged. These events may be viewed one by one on the Timebase events card.

The frequency control voltage is the voltage applied to the frequency input of the timebase to maintain lock to GPS. It is updated every second when the receiver is generating timing pulses. When the timebase is locked to GPS, the frequency control value cannot be changed by the user. If the timebase is not locked to GPS, the user may change the frequency of the timebase by updating this voltage.

GPS

The top level GPS receiver display provides configuration and status information for the GNSS receiver. It is composed of five virtual cards: time of day, position, satellites, receiver status, and configuration. A sample display is shown in Figure 12.

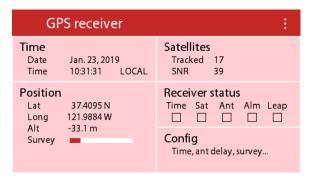


Figure 12: Top level GPS receiver display

The time of day card shows the current date and time of day as discerned by the GNSS receiver. If the time of day is unknown, it will warn that the time is unset.

The position card shows the latitude, longitude and altitude of the antenna for the receiver. Latitude and longitude are presented in degrees. The altitude is in meters above average sea levels. Also shown is a bar graph indicating how much of the position survey has been completed. In Figure 12, we see that it is 100 % complete.

The satellites card shows the number of satellites being tracked and the average signal to noise ratio of the detected GNSS signal for each of the satellites.

The receiver status card indicates items that might affect the quality of the information collected. In the example, we see that a leap second is pending.

Finally, the configuration card allows navigation to screens which configure the operation of the receiver and the alignment of its timing pulses.

Communications

The top level communications display provides configuration and status information for the RS232 and Ethernet LAN remote interfaces. It is composed of four virtual cards: activity, RS232 configuration, Ethernet LAN configuration, and TCP/IP configuration. A sample display is shown in Figure 13.

Communications	
Activity Interface rs232_0 Errors No errors	RS232 Config Baud 115200 Frame 8/N/1 Flow RTS/CTS
EthernetMAC00:19:b3:0b:00:06StatusDisconnectedSpeed100 Base T	TCP/IP Config Method Static IP IP Addr 0.0.0.0

Figure 13: Top level communications display

The activity card shows which interface was most recently active, and the number of errors detected on that interface.

The RS232 configuration card shows the current configuration for the port, including the baud rate for sending and receiving data.

The Ethernet card shows the MAC address for the FS740 as well as whether the FS740 is currently connected to the LAN. Finally, it shows the configured speed of the connection.

The TCP/IP configuration card shows the current IP address of the FS740 and the method used to obtain that IP address.

System

The top level system display provides configuration and status information for the FS740 as a whole. It is composed of five virtual cards: user settings, display, device info, alarm status, and rear options. A sample display is shown in Figure 14.

System configuration	
User settings	Alarm status
SAVE RECALL	Inactive
Display	Rear options
Pwr down Never	None installed
Device info SN_000006	

Figure 14: Top level system display

The user settings card enables the user to save and recall instrument settings from nonvolatile memory. Up to nine different user settings may be saved.

The display card controls the duration of front panel inactivity after which the display is powered down. This period of inactivity may range from 10 minutes to never.

The device info card navigates to detailed information on serial number, installed options, the Ethernet MAC address, and firmware versions installed on this device.

The alarm status card shows the current status of the rear panel alarm and navigates to options for configuring the alarm.

Finally, the rear options card navigates to information and configuration of any installed rear option boards.

Sine output

The top level sine output display provides configuration information for the sine output. It enables the user to set the amplitude, frequency and phase of the output. A sample display is shown in Figure 15.

Sine output		1
Amplitude	1.000 V _{PP}	
Frequency	10.000 000 000 MHz	
Phase	0.000 Deg	

Figure 15: Top level sine output display

Aux output

The top level aux output display provides configuration information for the aux output. It enables the user to set the waveform, amplitude, frequency and phase of the output. A sample display is shown in Figure 16.

Aux output	:
Config	Sine
Amplitude	1.000 V _{PP}
Frequency	1.000 000 000 MHz
Phase	0.000 Deg

Figure 16: Top level aux output display

Pulse output

The top level pulse output display provides configuration information for the pulse output. It enables the user to set the frequency and duty cycle, or period and width of the output. It also allows the user to adjust the phase of the output. A sample display is shown in Figure 17.

Pulse output		:
Config	Period / Width	
Period	1.000 000 000 000 s	
Width	500.000 000 000 ms	
Phase	0.000 Deg	

Figure 17: Top level pulse output display

Measurements

The top level measurement display provides configuration information for the front and rear measurement inputs. It enables the user to make time and frequency measurements on the front and rear inputs and view the results. A sample display is shown in Figure 18.

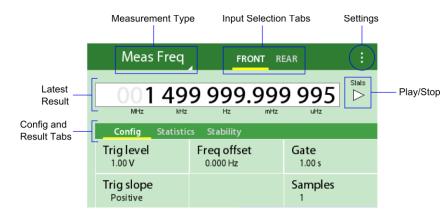


Figure 18: Top level measurement display

The title bar identifies the current measurement. In this case it is a frequency measurement. The measurement type can be easily changed by pressing the current measurement type and then selecting a new one. Next to the title are two tabs: front and rear. In Figure 18, the yellow bar indicates that the front input is selected. The user may easily switch tabs by pressing the desired input. Immediately below the title bar is the most recent frequency measurement. Below this is another bar of tabs which display configuration and results. In the figure, the yellow bar indicates that configuration data is being displayed. The user may press the Statistics or Stability tabs to display relevant measurement results in those areas.

When in local mode, frequency measurements are automatically triggered and displayed as they become available. However, these automatically triggered results are only visible from the front panel and cannot be retrieved over the remote interfaces. Nor do they contribute to statistics or stability results. To do that the user must explicitly initiate a measurement by pressing the Play/Stop button or by requesting it over the remote interface with an INITiate command or something similar. When a measurement is explicitly initiated, the FS740 will make the requested number of measurements, and calculate statistics and stability based on the results. Up to 250,000 results can be stored in internal memory for retrieval over the remote interfaces.

The Settings button (three vertical dots in the upper right corner) can be used to enable or disable automatic triggering of measurements and adjust the measurement timeout duration. The latter may need adjustment if the signal frequency is below 1 Hz.

Front Panel Connectors

The front panel contains four BNC connectors labeled: Sine out, Aux out, Pulse out, and Time/Freq. The first three are source outputs and the fourth is a measurement input.

Sine Out

The sine output provides the user with a Sine wave output whose frequency can vary from 1 mHz to 30.1 MHz. Its amplitude can vary from 10 mV_{PP} to 1.414 V_{PP}. The user may control the phase of this output and align its zero crossing to coincide with the FS740's best estimate of UTC.

Aux Out

The aux output provides the user with several possible waveforms with user selectable frequencies. These include, a sine wave, a triangle wave, a square wave centered about zero volts, a 100 MHz sine wave, and an AM modulated IRIG-B output. The sine wave supports frequencies from 1 mHz to 10 MHz. The triangle and square waves support frequencies from 1 mHz to 1 MHz. The phase of the sine, triangle, and square waveforms can be adjusted by the user and synchronized to UTC if desired. The 100 MHz sine wave is at a fixed frequency and amplitude and its phase cannot be adjusted or synchronized. The IRIG-B waveform provides time of day encoding for time distribution.

Pulse Out

The pulse output provides the user with a CMOS output at a configurable frequency and duty cycle from 1 mHz to 25 MHz. The phase of the pulse output can be adjusted by the user and synchronized to UTC if desired. The output may also be configured to generate pulse modulated IRIG-B for use in time distribution.

TIME / FREQ

The time and frequency input enables the user to make time or frequency measurements of an applied signal. The user can set the trigger level and slope of the input. Frequencies up to 120 MHz can be measured with gate times from 10 ms to 1000 s supported. Timing measurements enable the user to time stamp a signal relative to the FS740's best estimate of UTC with <50 ps jitter.

Rear-Panel Overview

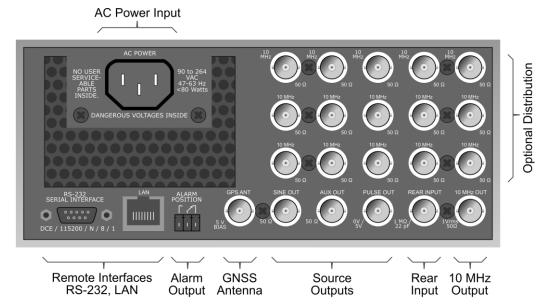


Figure 19: The FS740 Rear Panel

The rear panel provides connectors for AC power, remote computer interfaces, a switch tied to the system alarm, a GNSS antenna input, replicas of the front panel source outputs, an independent rear panel measurement input, and a 10 MHz output. Space is available for the installation of 3 optional distribution boards, each with 5 connectors a piece. The optional boards may be used to expand the distribution capability of the instrument. Distribution is available for 10 MHz, Sine/Aux outputs, and Pulse outputs.

AC Power

Connect the unit to a power source through the power cord provided with the instrument. The center pin is connected to the chassis so that the entire box is earth grounded. The unit will operate with an AC input from 90 to 264 V, and with a frequency of 47 to 63 Hz. The instrument requires 80W and implements power factor correction. Connect only to a properly grounded outlet. Consult an electrician if necessary. There is no power on/off switch, as the FS740 is intended to be operated continuously.

Remote Interfaces

The instruments support remote control via RS-232, or an Ethernet local area network (LAN). A computer can perform any operation that is accessible from the front panel. Programming the instrument is discussed in the Remote Programming chapter.

RS-232

The RS-232 port uses a standard 9 pin, female, subminiature-D connector. It is configured as a DCE and supports baud rates from 4.8 kb/s to 115 kb/s. The remaining communication parameters are fixed at 8 Data bits, 1 Stop bit, No Parity, with RTS/CTS hardware flow control.

Ethernet

The Ethernet uses a standard RJ-45 connector to connect to a local area network (LAN) using standard Category-5 or Category-6 cable. It supports both 10 and 100 Base-T Ethernet connections and a variety of TCP/IP configuration methods.

Alarm Relay

This connector is tied to a 3A, SPDT switch, with normally open and normally closed connections. The alarm may be manually controlled, or configured to assert when in holdover or the timing error is large.

GNSS Antenna

In order to lock to GNSS satellites, the FS740 must be connected to a GNSS antenna. The FS740 provides 5V power on the antenna input to support active antennas with more gain. The FS740 tries to detect fault conditions related to the antenna to alert the user of potential problems. If the current draw is too large, an antenna short fault is reported. Alternately, if the current draw is too small, an antenna open fault is reported.

Rear Measurement Input

The FS740 provides a rear input for making time and frequency measurements that has completely independent measurement circuitry, which can function in parallel with the front panel input.

Source Outputs

Sine Out

This is a duplicate of the front panel sine output. Its phase cannot be independently modified relative to the front panel output.

Aux Out

This is a duplicate of the front panel aux output. Its phase cannot be independently modified relative to the front panel output.

Pulse Out

This is a duplicate of the front panel pulse output. Its phase cannot be independently modified relative to the front panel output.

10 MHz Out

The instrument also provides a 10 MHz output for referencing other instrumentation to the FS740's internal reference. Its phase cannot be synchronized to UTC.

Option Boards

The rear panel has space for the installation of up to 3 option boards for expanded distribution. Three different types of option boards are offered: Sine/Aux distribution, Pulse distribution, and 10 MHz distribution. The user may mix and match the installed options to meet application needs. Each board provides 5 buffered outputs of the desired signal. The Sine/Aux distribution options may be dynamically configured to provide 5 buffered duplicates of the Sine output, or 5 buffered duplicates of the Aux output. If

multiple Sine/Aux distribution option boards are installed, each one may be configured independently of the others. The other option boards have fixed configurations.

Operation

Introduction

The previous chapter provided an overview of the instrument's features and layout. This chapter describes the operation of the FS740 in detail and provides step by step instructions for setting up and configuring the FS740.

Global Navigation Systems

Global navigation systems are satellite-based systems designed to provide a user with inexpensive, yet precise, position and timing information. There are four major constellations in operation today as detailed in Table 2. Collectively, these navigation systems are often referred to via the acronym GNSS.

GNSS System	Controlling Governments
GPS	United States
GLONASS	Russia
BEIDOU	China
GALILEO	European Union

Table 2: GNSS Navigation Systems

GPS was the first navigation system deployed in 1995. It is the oldest and most mature navigation system in operation today. Russia soon followed with GLONASS. More recently, China's BEIDOU and the European Union's GALILEO navigation systems are coming online.

How Does GPS Work

All four systems have similar performance and specifications. While the details between the various systems differ, the basic theory of operation is the same. For simplicity of presentation, we will highlight the various components that make up the GPS system. However, the basic concepts apply to other systems as well.

The Global Positioning System, or GPS, is a radio-navigation system which allows users with a clear view of the sky to identify their current position and time of day from any location around the globe. The system was originally designed for the military, but has been used for a wide variety of civil applications since its deployment, particularly in automobile and marine navigation. The system is managed and controlled by the United States Air Force (USAF). It consists of three parts: a space segment, a ground-based control segment, and the user segment.

The space segment consists of 24 satellites orbiting earth in 12 hour orbits at an altitude of approximately 20,200 km. The satellites are arranged into 6 equally spaced orbital planes with 4 satellites allocated to each plane. The organization is designed so that a user will always be able to view at least 4 satellites from virtually any location around the world. Atomic clocks on board the satellites maintain precise time of day information. The

satellites then broadcast ephemeris and time of day information to the user segment. A user with a view of at least 4 satellites can use this information to triangulate their position and time.

The control segment monitors the health of the satellites and uploads corrections and updates to the navigational information stored in the satellites. It is also in charge of decommissioning satellites when they have reached end of life, and the commissioning of new satellites to replace them. It consists of a master control station and a number of antennas and monitoring sites spread throughout the world.

The user segment consists of an antenna and a receiver which extracts the signals broadcast by the satellites. If the user can track at least 4 satellites, it has enough information to triangulate its position (latitude, longitude, height), and time of day.

Position can be resolved to a few meters. Time of day can be resolved to a few nanoseconds. For the FS740, it is this latter metric which is of significant importance. GPS time is monitored and maintained by a network of atomic clocks on the ground and aboard the satellites which are collectively steered to follow universal coordinated time (UTC) as maintained by the United States Naval Observatory (USNO). Thus, by locking its internal timebase to GPS, the FS740 can provide long term frequency stability on par with the best time keeping instrumentation in world, but at a fraction of the cost.

Timebase Stability

While the long term stability of GNSS is excellent, its short term stability is rather poor in comparison to modern oscillators. The FS740 may be configured at the time of purchase with one of three different oscillators: a TCXO, an OCXO, or a Rb atomic frequency standard. Each oscillator has a different short term stability profile and offers a trade off in performance and holdover capability. Figure 20 shows the typical measured stability of the FS740 locked to GNSS for each of the different timebases. The stability of GNSS is also shown for comparison purposes.

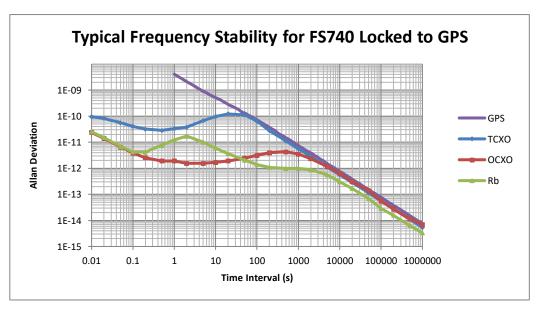


Figure 20: Frequency stability of FS740 with different timebases installed.

Notice that all three timebases offer superior stability to that of GNSS at a 1 second time interval. Here the OCXO offers the best performance. For time intervals beyond about

50 s the Rb oscillator outperforms. And for time intervals beyond about 5,000 s, all three timebases follow the performance of GNSS, with the Rb oscillator slightly outperforming the other timebases due to its ability to effectively average the GNSS signal over a longer time interval.

The differences between the three oscillators are more striking when you look at their stability when not locked to GNSS as shown in Figure 21. This indicates the performance of the FS740 if the signal to GNSS is lost. Here, the superiority of the Rb oscillator over the other timebases is clearly evident in that its stability surpasses GNSS out to 10,000 seconds where its stability exceeds that of the OCXO by more than a factor of 10.

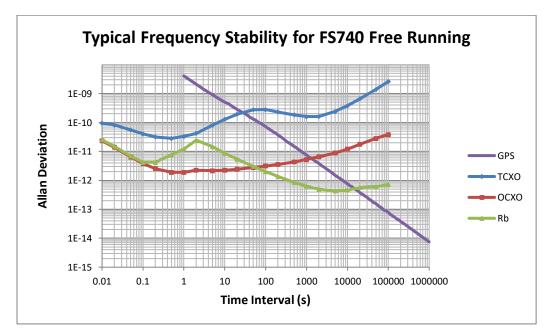


Figure 21: Frequency stability of FS740 when free running.

Phase Wander vs UTC

Frequency stability is not the only performance criteria to consider. Another metric to consider is the wander of the phase of the FS740 when it is locked to GNSS relative to UTC. The wander in phase relative to UTC is a function of the quality of the GNSS receiver and how tightly the oscillator is locked to GNSS. At short loop time constants the FS740 faithfully follows the performance of the receiver. At long loop time constants the FS740 will wander further away from UTC, but display much better short term stability.

Loop Time Constants

The differences in stability of the three timebases affect the optimum time constant with which it is locked to GNSS. If the time constant is too small, the short term stability is degraded by GNSS. If the time constant is too large, the long term stability will underperform raw GNSS. We want to choose a time constant that provides the best stability over all time scales. Stability is not the only concern, however. The accuracy of UTC must also be considered. Long time constants may improve the short term stability of Rb, for example, but they significantly degrade the accuracy of the FS740's estimate of

UTC. Thus, the selection of the loop time constant represents a tradeoff between several metrics of performance.

Timebase

The top level timebase display provides configuration and status information for the internal timebase. It is composed of four virtual cards: timebase status, timebase events, frequency control, and configuration. A sample display is shown in Figure 22.

Timebase	:
TimebaseStateLocked to GPSDuration7.24 hrLoop TC4000 sTime Err3.8 nsAve Err2.4 nsTypeRb	Timebase events Count 4 Event Power up Date 11/22/2016 Time 09:34:39 CLEAR
Freq control 1.979353 V	Config timebase Holdover mode, limits

Figure 22: Top level timebase display

State

For assessing timebase stability, the most important information to consider is the current state of the timebase, which is shown at the top of the timebase card. In the figure, the timebase is "Locked to GNSS," meaning that the timebase is tracking and following the timing provided by GNSS. The state of the timebase may take one of the following values detailed in Table 3.

State	Meaning	
Power up	Device was recently powered on. Timebase is still warming up.	
Searching for GPS	Device has warmed up, but no GNSS satellites have been found,	
	yet.	
Stabilizing	GNSS satellites have been found. Making sure timebase is stable	
	enough to lock to GNSS.	
Validating time	Verifying that the time of day extracted from GNSS is stable and	
	consistent. The FS740 instrument time is set at exit of this state.	
Locked to GPS	Timebase is locked to GNSS.	
Holdover, manual	Timebase is not locked to GNSS at the user's request.	
Holdover, no GPS	Timebase is not locked to GNSS because the receiver is not	
	generating timing pulses. This is usually because no satellites are	
	being tracked.	
Holdover, timing	Timebase is not locked to GNSS because the timing error	
	between the timebase and GNSS is too large.	
Rb unlocked	Timebase is not locked to GNSS because the installed Rb	
	timebase is unlocked.	

 Table 3: Enumeration of timebase states

A simplified state diagram for the timebase showing the most common transitions is presented in Figure 23. At power on, the timebase always starts in "Power up." Then, as

conditions merit, the timebase moves to succeeding states one by one until the time of day is received from the satellites and lock is achieved. Once locked, timing and status are monitored and if lock is no longer possible the time base will jump to one of the holdover states. When conditions improve, the timebase will jump back to the locked state.

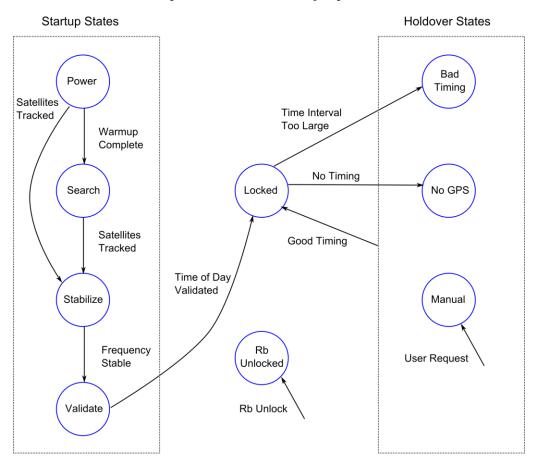


Figure 23: A simplified timebase state diagram showing the most common transitions.

Related Commands

TBASe:STATe?

Duration

In Figure 22, listed directly below the timebase state is the duration. This informs the user the amount of time the FS740 has been in one of three broad categories: startup, lock, or holdover. In Figure 23, boxes are drawn around the start up and holdover states. Startup refers to all states the timebase might traverse before the time of day of the instrument is set. Holdover refers to all states where the timebase has unlocked from GNSS after the time of day of the instrument has been set. Lock, of course, refers to when the instrument is locked to GNSS, identified by the single state, Locked.

Related Commands

```
TBASe:STATe:HOLDover:DURation?
TBASe:STATe:LOCK:DURation?
TBASe:STATe:WARMup:DURation?
```

Phase Locking to GNSS

The phase lock loop used by the FS740 to lock a TCXO to GNSS can be described by the diagram in Figure 24.

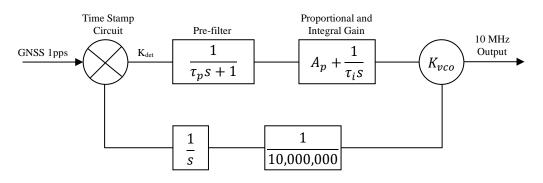


Figure 24: GPS phase lock loop

The symbols in the diagram have the following definitions:

- K_{vco} VCO gain

The basic architecture is that of a 2^{nd} order phase lock loop with proportional and integral gain. This basic loop is then augmented with the insertion of a pre-filter designed to reduce the loop's sensitivity to the broadband noise of GNSS. Given the definitions above, we define the natural loop time constant, τ_n , and use it to compute the following variables in the phase lock loop:

$$A_p = \frac{2}{K_{det}K_{vco}\tau_n}$$
$$\tau_i = \tau_n^2 K_{det}K_{vco}$$
$$\tau_p = \frac{\tau_n}{6}$$

Given these definitions and ignoring the pre-filter for the moment, the loop would have the following response to a step in frequency and phase:

$$\Delta T(t) = t[F_0 - \Delta T(0)/\tau_n]e^{-\frac{t}{\tau_n}} + \Delta T(0)e^{-\frac{t}{\tau_n}}$$

with the following symbol definitions:

t	Time
$\Delta T(t)$	The phase deviation as a function of time
$\Delta T(0)$	The initial phase deviation at time $t = 0$
F ₀	The initial frequency offset at time $t = 0$
τ_n	The natural loop time constant for the phase lock loop

The insertion of the pre-filter perturbs this solution slightly, but the overall response is very similar. The speed with which the FS740 follows GNSS is controlled by the natural loop time constant, τ_n . By shortening, the time constant, the FS740 will follow GNSS more faithfully, including the broadband noise of GNSS. By extending the time constant to longer time scales, the FS740 will continue to follow GNSS over the long term, but rely on its own stability for short term performance. The goal is to select a time constant that reflects the best balance between short and long term performance for the loop.

Predictive Filtering

The superior short term stabilities of the OCXO and Rb timebases enable the usage of predictive filtering to improve the stability of the FS740 by up to 3 times over traditional methods. Predictive filtering uses state space methods to predict the phase of the local timebase relative to GNSS. The technique is quite similar to Kalman filtering. The benefit is that the FS740 can average the GNSS signal much more effectively, resulting in a significantly more stable signal with a much shorter time constant than would be possible with traditional filtering.

Optimum Time Constant

The FS740 may be configured at the time of purchase with one of three different timebases: a TCXO, an OCXO, and a Rb atomic frequency standard. The optimum time constant for locking each of these timebases to GNSS is different, and detailed in Table 4.

Timebase	Optimum loop time constant
TCXO	8 s
OCXO	250 s
Rb	2000 s

Table 4: Optimum loop time constants

Although these are the optimum time constants when everything has stabilized, they are not ideal during warm-up or when the FS740 first locks to GNSS. During these times it is preferable to have a short time constant so that the FS740 may quickly align its phase and frequency with GNSS. Therefore, the FS740 will automatically reduce the time constant to as little as 3 s so that it may quickly align its phase to that of GNSS. Once adequate phase alignment has been achieved, the time constant will be gradually increased to the optimum time constant detailed in Table 4. Optimum frequency stability is not achieved, however, until the time constant reaches the optimum time constant.

Current Time Constant and Timing Error

In Figure 22 on page 28, listed directly below duration, is the current loop time constant for the phase lock loop, the most recent timing error, and the average timing error of the timebase relative to GNSS. Positive errors indicate the timebase lags GNSS. Negative errors indicate the timebase leads GNSS. The most recent error represents the output of the time stamp circuit in Figure 24. The average error represents the output of the pre-filter.

Related Commands

TBASe:TCONstant TBASe:TINTerval

Installed Timebase

In Figure 22, listed at the bottom of the Timebase card is the installed timebase. In the figure the timebase is a Rb atomic frequency standard.

Related Commands

*OPT?

Timebase Events

The FS740 automatically captures each time the state of the timebase changes as an event. Every time the timebase either locks or unlocks from GNSS, for instance, the event will be logged. These events may be viewed one by one on the Timebase events card. The FS740 has room to store up to 10 events. If more than 10 events occur, the oldest event is discarded to make room.

The event queue provides the user with automatic self monitoring capability. The user need not continually query the state of the timebase. Rather, he or she can view the event log to see if anything happened over the time period of interest. By comparing time stamps, one can easily deduce how long the timebase spent in each state.

Related Commands

TBASe:EVENt:CLEar TBASe:EVENt:COUNt TBASe:EVENt:NEXT?

Frequency Control

The frequency control voltage is the voltage applied to the electronic frequency control input of the timebase to maintain lock to GNSS. It is updated every second by the digital phase lock loop when the receiver is generating timing pulses. Every 24 hours of phase lock to GPS the FS740 will automatically save the current frequency control value so that the timebase will power up at a value close to optimum if GNSS is not present.

When the timebase is locked to GNSS, the frequency control value cannot be changed by the user. If the timebase is not locked to GNSS, however, the user may change the frequency of the timebase by updating this voltage. The user may force the FS740 to unlock from GNSS, if necessary, to make this possible. See section Lock to GNSS on page 33 for details.

Related Commands

TBASe:FCONtrol TBASe:FCONtrol:SAVe

Configuration

By default, the FS740 will initially lock to GNSS with a short time constant and then gradually extend the time constant to the optimum value for the given timebase when phase alignment is achieved. The user may modify this default configuration by pressing the Config timebase card located at the lower right portion of the Timebase screen as shown in Figure 22. This should lead to the Timebase configuration display as shown in Figure 25.

The user may enable or disable lock to GNSS, adjust the bandwidth or loop time constant of the phase lock loop and stipulate the conditions under which the phase lock loop will enter and leave holdover.

← Timebase configu	ration
Lock to GPS	Enter holdover if
Enabled	Time error > 1.000 us
Loop bandwidth	Leave holdover by
^{Auto}	Waiting for good 1 pps
Loop time constant 30 s	

Figure 25: Timebase configuration display

Lock to GNSS

By default the FS740 will lock to GNSS when satellites are being tracked. If the user prefers manual control of the frequency, he should choose to disable lock to GPS by pressing the "Lock to GPS" card and choosing "Disabled."

When lock to GPS is disabled, the FS740 will still attempt to retrieve the time of day from the GPS satellites. However, after the instrument time of day has been set, the timebase will enter manual holdover and it will not attempt to maintain phase alignment thereafter. Rather, its frequency will be maintained at the last known saved good value.

The user may also adjust the frequency calibration of the FS740 by modifying frequency control voltage. See section Frequency Control on page 32 for information on how to modify the frequency control voltage.

Related Commands

TBASe:CONFig:LOCK

Loop Bandwidth

By default, the FS740 will automatically throttle the bandwidth with which it locks to GPS in order to maintain good phase alignment with GPS. When good phase alignment has been achieved and the timebase frequency is stable, the FS740 will automatically reduce the bandwidth to improve its overall frequency stability.

Advanced users may want to specify the bandwidth or loop time constant with which the FS740 locks to GPS. To do this press the "Loop Bandwidth" card and select "Manual." This will enable the "Loop time constant" card so that a manual time constant can be selected.

Related Commands

TBASe:CONFig:BWIDth

Loop Time Constant

The "Loop time constant" card is only enabled when manual loop bandwidth control is selected. See section Loop Bandwidth above for details. This setting enables the user to

specify the phase lock loop time constant with which the FS740 locks to GPS. To change the time constant, press the "Loop time constant" card and enter a new time constant in seconds. See section Phase Locking to GNSS on page 30 for details on the phase lock loop used by the FS740 to lock to GPS and the optimum time constants for each timebase. Short time constants force the FS740 to faithfully follow the phase of GPS including its noise. Longer time constants improve the short term stability of the FS740 but also may increase the wander of its estimate of UTC.

Related Commands

TBASe: TCONstant

Criteria to Enter Holdover

When locked to GPS the FS740 will try to adjust its frequency to maintain good phase alignment with GPS. Under normal conditions this is preferred. Under abnormal conditions, however, this may no longer be desirable, particularly if the measured timing error is large.

There are two scenarios worth considering. In the more common scenario the FS740 may lose the GPS signal for an extended period of time, during which the phase of the FS740 will drift away from alignment. At some point the FS740 may reacquire the GPS signal and see that its phase has drifted significantly away from alignment. How should the FS740 recover? Should it slew the phase back by adjusting its frequency, or should it jump phase instantaneously to the new location?

The second scenario to consider is when the GPS receiver generates rogue timing pulses due to processing incorrect timing information from a failing satellite, having timing data corrupted by noise, or possibly a firmware bug within the GPS receiver itself. In this scenario the GPS timing pulses may suddenly jump in phase. Again the user must decide how the FS740 should recover.

The decision can be broken down into two parts. The first, to be decided here, is the maximum measured timing error allowed before the FS740 will abandon lock and enter holdover. The default is 1 μ s. To modify this limit, press the card "Enter holdover if" and enter a new limit.

The second part, to be decided in the next section, is how to recover from holdover.

Related Commands

TBASe:CONFig:TINTerval:LIMit

Criteria to Leave Holdover

The FS740 may enter holdover for a number of reasons, the most common of which is that it lost the GPS signal for a time. When it regains the GPS signal, how should it respond? If the timing error is less than the threshold set above, then the FS740 will proceed as if it never lost lock. If the timing error is greater than the threshold set above, then the FS740 has three options:

- 1. Wait for the timing error to fall below the threshold and then proceed as if it never lost lock.
- 2. Jump phase instantaneously to the new location and resume lock.

3. Momentarily ignore the threshold and slew the phase to the new location by adjusting the frequency of the timebase.

Option 1 may be preferred for the case where the receiver outputs rogue pulses for a time and then later recovers. Option 2 may be preferred if the user is primarily concerned about frequency calibration and doesn't want the frequency to be disturbed, merely because the phase is out of alignment. Option 3 may be preferred if the user needs phase alignment but instrumentation connected to the FS740 cannot handle a sudden hiccup in phase.

To make a selection, press the "Leave holdover by" card and select the desired behavior. The display will look similar to that shown in Figure 26.

← Timebase con	figuration
Lock to GPS	Leave holdover by
Enabled	Waiting for good 1 pps
Loop bandwidth	O Jumping to good 1 pps
Auto	O Slewing to good 1 pps
Loop time constant 30 s	

Figure 26: Selecting the criteria for leaving holdover.

Related Commands

TBASe:CONFig:HMODe

Timebase Status LEDs

Status LEDs in the reference section of the front panel provide continuous information on the current state of the timebase. The three LEDs above the timebase button are specific to the timebase, as highlighted in Figure 27.

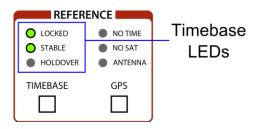


Figure 27: Timebase status LEDs.

The first LED labeled "LOCKED" indicates whether the internal timebase is locked to GPS. The second LED labeled "STABLE" indicates whether the internal timebase has reached optimum stability. Optimum stability is only reached when the timing error is small and the loop time constant has reached the optimum time constant for the installed timebase. The last LED labeled "HOLDOVER" indicates when the FS740 has lost lock from GPS and is in holdover.

GPS

The top level GPS display provides configuration and status information for the FS740's GPS receiver. It is composed of five virtual cards: time of day, position, satellites, receiver status, and configuration. A sample display is shown in Figure 28.

G	PS receiver	:
Time Date Time	Jan. 23, 2019 10:31:31 LOCAL	Satellites Tracked 17 SNR 39
Position Lat Long	37.4095 N 121.9884 W	Receiver status Time Sat Ant Alm Leap
Alt Survey	-33.1 m	Config Time, ant delay, survey

Figure 28: Top level GPS display

Date and Time

The "Time" card shows the current date and time. At power on the time is set to January 6, 1980 at midnight, which is the start of GPS time. The displayed time will be marked as "UNSET" until the time of day has been set by GPS. Once the time has been set by GPS, the displayed time can be configured to be UTC, GPS, or local time. In Figure 28, local time is being displayed. Pressing the "Time" card presents the user with a full screen display of the current date and time. A sample display is shown in Figure 29.



Figure 29: GPS time display

Related Commands

SYSTem:DATe SYSTem:TIMe

Position

The "Position" card shows the current surveyed position of the GPS antenna. Latitude is shown in degrees north or south. Longitude is shown is degrees east or west. Altitude is shown in meters above mean sea level. Finally the current progress of the survey of position is shown as a bar graph. Pressing the "Position" card results in the display of more detailed numbers regarding the position as shown in Figure 30

←	GPS position	
	Latitude Longitude Altitude	37.409 009 953 N 121.988 089 482 W -25.7 m
	Survey progre	255 100 % restart

Figure 30: GPS position display

Here the position is displayed with greater precision. The user is also given the opportunity to restart the survey, if desired. This may be desirable if the antenna is ever moved or replaced.

Related Commands

```
GPS:POSition?
GPS:POSition:SURVey:PROGress?
GPS:POSition:SURVey:STARt
GPS:POSition:SURVey:STATe?
```

Satellites

The "Satellites" card shows the number of GPS satellites being tracked and the average SNR with which they are being tracked. The receiver has the capability of tracking 32 satellites simultaneously. It is quite rare to have that many satellites visible, however. Pressing the "Satellites" card results in the display of detailed information about the satellites being tracked, including their position in the sky and the signal to noise ratio with which they are being followed. A sample display is shown in Figure 31.

← GPS satellite	S			
Tracked	ID	SNR	Azimuth	Elevation
10 satellites	10	51	295	67
TO satemites	18	50	34	64
Ν	21	57	100	53
	27	50	292	49
	32	54	189	38
W NE	15	50	44	18
	8	41	319	16
	24	46	88	14
	14	48	197	12
5	16	37	248	11

Figure 31: GPS satellites display

Related Commands

GPS:SATellite:TRACking? GPS:SATellite:TRACking:STATus?

Receiver Status

The "Receiver status" card shows summary status for the GPS receiver. It indicates if time has been set by GPS, whether satellites are being tracked, whether the antenna is properly connected, whether an almanac has been downloaded, and whether a leap second is

pending. In Figure 28, we see that a leap second is pending. Pressing the "Receiver status" card results in the more detailed display as shown in Figure 32

← GPS receiver stat	us	
Receiver mode Over determined clock mode	Flags Time not from GPS No usable satellites Antenna open	
Decoding status Doing fixes	Antenna short Almanac incomplete Leap second pending	

Figure 32: GPS receiver status display

In this display, the meaning of each of the flags is written out for easier comprehension. Additional information about the mode and decoding status of the receiver is also provided. The receiver mode indicates whether position fixes are being computed and if a survey is in progress. In over determined clock mode, position fixes are not being computed. Instead, the surveyed position is being substituted so that all satellites can be dedicated to timing. The decoding status indicates whether a timing fix is being computed or if the receiver is searching for usable satellites.

Related Commands

STATUS:GPS:CONDition? STATUS:GPS:EVENt?

Configuration

The "Config" card enables the user to configure constellations tracked, the position survey, timing alignment, timing quality, local time offset, and antenna cable delay corrections. Pressing the "Config" card results in the display shown in Figure 33.

← GPS configuration	
GNSS Constellations	Survey
Gps Glonass	Mode: Redo at power on
Beidou Galileo	Fixes: 2000
Timing alignment	Antenna corrections
Align with UTC	Cable delay 0.0 ns
Timing quality	Local time offset
Require 3 satellites	-8.00 hr

Figure 33: GPS configuration display

Six virtual cards show the current configuration and enable the user to modify the configuration to match their application.

GNSS Constellations

The FS740's GNSS receiver can track multiple constellations simultaneously. It is equipped with two separate tuners. Since each GNSS constellation generally operates at a separate frequency, one tuner must be dedicated to each constellation tracked. Thus,

generally only two constellations may be tracked simultaneously. It so happens, however, that GPS and GALILEO operate at the same frequency. Therefore, only one tuner is required to track both of these constellations.

By default, the FS740 is configured to track GPS and GLONASS, which are the two most mature constellations. If desired the user may change this selection by checking the desired constellations and pressing "UPDATE". If the receiver is unable to track the given combination, it will revert back to the previous configuration.

Note that changing the configuration of tracked constellations will force the receiver to reset. It will lose track of all followed satellites and be forced to reacquire the satellite signals as if the unit had been power cycled.

Timing Alignment

The user can choose to have its timing aligned to GPS time or UTC. Universal coordinated time (UTC) is the official time of day accepted by the international community. It is based on atomic time, but it is occasionally modified with the insertion of a leap second in order to keep it synchronized to mean solar time. These corrections ensure that the time of sunrise and sunset do not shift over time. GPS time, on the other hand, is strictly atomic time. It is not modified by the insertion of leap seconds. Therefore, as of January 2017, GPS time is 18 seconds ahead of UTC. This difference is called the UTC offset.

Although GPS time is atomic time and is based on a network of cesium atomic standards, just like UTC, it is an independent clock and therefore its phase can deviate from that of UTC. This phase is continuously monitored by the ground control segment of GPS, however, and they can and do steer GPS time to ensure that the phase of GPS does not deviate by more than 1 μ s from UTC (USNO). In practice, the deviation is usually less than 10 ns. Both the current UTC offset and the current UTC to GPS phase deviation are broadcast by the GPS satellites as part of the almanac.

If the user chooses to align FS740 time to GPS, then both the displayed time of day and the physical phase of the FS740 will be aligned to GPS rather than UTC, and vice versa. The default alignment is to UTC.

Related Commands

```
GPS:CONFig:ALIGnment
GPS:UTC:OFFSet?
```

Timing Quality

Normally, GPS receivers must track at least 4 satellites before they can generate a position and timing fix. This stems from the fact that there are 4 unknowns to be solved: latitude, longitude, altitude, and time. 4 equations are required to solve for 4 unknowns. However, if the receiver is not moving, then it need not re-compute its position each time. Rather, it can use the position computed from before, since it is not changing. In this case only 1 satellite is needed to compute time.

In normal operation, the FS740 will automatically survey its position for 2000 seconds to accurately determine its position. After that, the receiver will enter over determined clock mode and all satellites will be dedicated to generating the best possible timing. Only one satellite is required to generate a solution. However, the quality of such a solution increases as more satellites are incorporated into it.

There is a tradeoff to consider. Should the receiver generate potentially noisy timing pulses when tracking just one satellite? Or should it wait until it is tracking at least three satellites before generating timing pulses. The quality of the timing is significantly better for three satellites, but it also increases the likelihood that the FS740 will be forced into holdover. Noisier timing may be preferred to no timing at all.

When the antenna has a clear view of the sky, emphasizing quality makes sense. When this is not the case, having noisy timing may be preferred over no timing at all. The factory default is 3 satellites.

Related Commands

GPS:CONFig:QUALity

Local Time Offset

The user may prefer to have the local time of day displayed, rather than UTC. To display local time, the user must enter the offset in hours between UTC and the local time. If the offset is zero, UTC or GPS time will be displayed according to the selected timing alignment. When the offset is nonzero, the local version of UTC or GPS time will be displayed.

Related Commands

SYSTem:TIMe:LOFFset

Survey

The FS740's GPS receiver provides the best timing performance when the antenna is stationary and not moving. It gets enhanced performance by surveying its position for a time and then using that position to improve the timing. The FS740 support three modes of operation:

- 1. Disable survey
- 2. Redo survey at power on
- 3. Remember previous survey at power on and reuse it

The factory default is to remember the previous survey results at power on. It is most appropriate when the FS740 is installed in a static location and never moved. If the FS740 is static when powered, but may move from one location to another between power cycles, then the survey should be repeated at power on. Finally, the survey should be disabled if the FS740 is installed in a mobile environment where its position might change during operation.

Related Commands

GPS:CONFig:SURVey:Mode

Position Fixes in Survey

The FS740 position survey is designed to accurately identify the receiver's current position by averaging together the position fixes computed when the receiver is not moving. By default, the survey will average together 2,000 position fixes to obtain its

surveyed position. If desired, the user may change the number of fixes included in the survey.

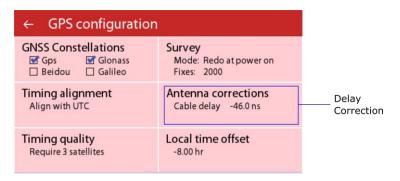
Related Commands

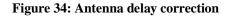
GPS:CONFig:SURVey:FIXes

Antenna Corrections

The FS740's GPS receiver computes position and time based on the position of the antenna. However, the antenna signal must travel through a potentially long cable before it reaches the GPS receiver input on the FS740. Thus, the signal reaching the receiver is delayed compared to the case where the antenna is attached directly to the receiver with no intervening cable. The typical delay for most BNC cables is 1.54 ns per foot. For a 30 ft cable, the delay would be $1.54 \times 30 = 46$ ns. If uncorrected, the FS740's estimate of UTC would be 46 ns later than a properly calibrated unit.

The user may correct for this delay, however, by entering a negative antenna cable delay correction. The user would correct for a 30 ft cable by entering a correction of -46 ns. The correction will be stored in nonvolatile memory and need not be re-entered when the unit is power cycled. When entered correctly, the display will look like that shown in Figure 34.





Related Commands

GPS:CONFig:ADELay

GPS Status LEDs

Status LEDs in the reference section of the front panel provide continuous information on the current state of the GPS receiver. The three LEDs above the GPS button are specific to the receiver, as highlighted in Figure 35.

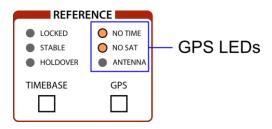


Figure 35: GPS status LEDs.

The first LED labeled "NO TIME" indicates whether the receiver has obtained the time of day from the GPS satellites. The second LED labeled "NO SAT" indicates whether the receiver is successfully tracking GPS satellites. The last LED labeled "ANTENNA" indicates when the FS740 thinks there might be a problem with the antenna connected to the FS740. The LED turns on when the connection appears to be an open or a short circuit. See section Antenna Warning LED on page 2 for more details.

Communications

The FS740 comes with support to communicate with remote hosts via RS232 and Ethernet. The communications display enables the monitoring and configuration of remote interfaces. The top level communications display provides information on the most recent remote interface activity and the current configuration of the communication interfaces. A sample display is shown in Figure 36.

Communications	
Activity Interface rs232_0 Errors No errors	RS232 Config Baud 115200 Frame 8/N/1 Flow RTS/CTS
EthernetMAC00:19:b3:0b:00:06StatusDisconnectedSpeed100 Base T	TCP/IP Config Method Static IP IP Addr 0.0.0.0



Remote Mode

When the FS740 receives commands over a remote interface, it will typically enter remote mode. In this mode the front panel interface will be locked out and the orange REMOTE LED in the COMM section of the front panel will be highlighted. Any attempt to interact with the front panel will result in a pop up window notifying the user about remote mode and giving the user the opportunity to return to local mode if desired.

Cor	nmunications			1
Activity Interface Errors	No errors	RS232 Co Baud Frame	115200 8/N/1 PTS/CTS	
Ethernet	In remote mode. G GOTO	LOCAL	der	
MAC Status Speed	00: 19:03:00:00:06 Disconnected 100 Base T	Method IP Addr	Static IP 0.0.0.0	

Figure 37: Remote mode pop up window

Press the virtual button GO TO LOCAL to regain access to the front panel user interface.

Activity

The "Activity" card shows which interface has most recently communicated with instrument. In Figure 36 we see that the RS232 interface was most recently active and that

no errors have been detected on that interface. If an error is detected, the red LED in the COMM section of the front panel will be highlighted and the number of errors.

Navigating into the "Activity" card leads to more detailed information about the active interface as shown in Figure 38

← Com	munications activity
Activity Interface Received Sent	rs232_0 *idn? <cr><lf> rch Systems,FS740,s/n000006,ver2.29.11<cr><lf></lf></cr></lf></cr>
Errors Count Latest	0 0: No error CLEAR CLEAR ALL

Figure 38: Communications activity display

The active interface and the latest characters received and sent over the interface are displayed. This can be useful when troubleshooting communications and command execution. The user can verify that the FS740 is actually receiving what was sent and that the remote interface is receiving the response. In the figure we see that the FS740 received the **IDN*? command and that it responded with its identification string. The green ACTIVITY LED in the COMM section of the front panel will flash when characters are sent and received. This may also serve as a helpful diagnostic when troubleshooting communication problems.

The number of errors and the latest error are also displayed. Errors may be dismissed one by one by pressing CLEAR. All errors may be flushed by pressing CLEAR ALL.

Related Commands

SYSTem:ERRor?

RS-232 Configuration

The FS740 supports communication over an RS-232 port. The rear panel contains a standard 9-pin, female, subminiature-D connector. It is configured as a DCE and supports baud rates from 4,800 to 115,200 baud. The remaining communication parameters are fixed at 8 Data bits, 1 Stop bit, No Parity, with RTS/CTS hardware flow control. The factory default baud rate is 115,200 baud.

The "RS232 Config" card shows the current configuration for the RS-232 port. Navigating into the "RS232 Config" card provides more detailed information and the opportunity to select the desired baud rate for the port. A sample display is shown in Figure 39.

← RS232	2 settings
User setting	S
Baud rate	115200
Fixed setting	gs
Data bits	8
Parity	None
Stop bits	1
Flow control	RTS/CTS

Figure 39: RS232 settings display

Both the FS740 and the remote host must agree on all configuration parameters for communication to succeed. Press "Baud rate" to modify the baud rate as shown in Figure 40.

User settings O 4800
Baud rate O 9600
Fixed setting O 19200
Data bits O 38400
Parity Stop bits O 57600
Flow control 0 115200

Figure 40: Selecting an RS232 baud rate.

In the figure, the current baud rate is shown as 115200. Select a different baud rate to change it, if desired. If a new baud rate is selected, the interface will be reset and brought back up with the new baud rate configured.

Related Commands

```
SYSTem:COMMunicate:SERial:BAUD
SYSTem:COMMunicate:SERial:RESet
```

Ethernet

The FS740 may be connected to an Ethernet based local area network (LAN). The rear panel contains a standard RJ-45 connector which accepts Category-5 or Category-6 cable. It supports both 10 and 100 Base-T Ethernet connection speeds.

MAC Address

Every device connected to an Ethernet network must have a unique media access address, or MAC address. This address cannot be changed by the user, but it is sometimes useful to know because some networks use the MAC addresses to identify and regulate which devices can connect to the network. The "Ethernet" card displays the MAC address.

Status

Below the MAC address is the status of the Ethernet connection. This shows whether the FS740 is currently connected to the Ethernet or not. Status will show "Connected" or "Disconnected"

Speed

The FS740 supports both 10 and 100 Base-T Ethernet connection speeds. The "Ethernet" card shows the current speed. The factory default is 100 Base-T. The user may change this by pressing the "Ethernet" card as shown in Figure 41.

Communications					
Activity Interface rs232_0 Errors No errors		RS232 Co Baud Frame Flow	nfig 115200 8/N/1 RTS/CTS		
		Ethernet speed			
Ethernet MAC 00: Status Dis		O 10 Base	Г	onfig Static IP 0.0.0.0	
		🔵 100 Base T		0.0.0.0	

Figure 41: Selecting the Ethernet speed.

In the figure, the Ethernet speed is currently 100 Base-T. Press "10 Base T" to change it.

Related Commands

```
SYSTem:COMMunicate:LAN:MAC?
SYSTem:COMMunicate:LAN:EPHY?
SYSTem:COMMunicate:LAN:EPHY:SPEed
```

TCP/IP Configuration

In order to function properly on a TCP/IP network, the FS740 must be configured with a proper IP address, subnet mask, and gateway or router address. The FS740 supports 3 different methods of obtaining its network configuration: DHCP, Auto IP, and Static IP. The "TCP/IP Config" card shows the method used to obtain the FS740's current network configuration and its IP address. Full configuration details may be obtained by navigating into the "TCP/IP Config" card. The display will be similar to that of Figure 42.

← TCP/IP settings	
Config Method DHCP	Current Config IP addr 0.0.0.0 Subnet 0.0.0.0
Static Config IP addr 0.0.0.0	Gateway 0.0.00
Subnet 0.0.0.0	
Gateway 0.0.0.0	RESET

Figure 42: TCP/IP settings display.

Configuration Method

The FS740 supports three methods of obtaining its network configuration: DHCP, Auto IP, and Static IP. The user should check with his network administrator to ascertain the preferred method before connecting the FS740 to a network.

Dynamic Host Configuration Protocol (DHCP) is an automated method of obtaining network configuration parameters. In this method the FS740 asks for its configuration

from a DHCP server which then responds with its proper network configuration. Many routers support this configuration method. This is the factory default method of configuration.

Auto IP refers to the automated selection of a link local private address in the 169.264.x.x address space. When the FS740 has an IP address in this address space, it cannot communicate with hosts beyond the local network.

Static IP refers to manual configuration. In this method, the user must manually enter the proper network configuration parameters for the FS740 to use.

To select a configuration method, press the current configuration method. The display will be similar to that of Figure 43.

← TCP/IP settings					
Config Metl	TCP/IP config)	nfig .0.0.0 .0.0.0		
	g 🔿 Static IP		.0.0.0		
	.0.0.0				
Gateway 0	.0.0.0		RESET		

Figure 43:TCP/IP configuration method.

In the figure, DHCP is selected. For Auto IP or static configuration, choose "Static IP." Auto IP is used when "Static IP" is selected and the static IP address is 0.0.0.0. Static IP configuration is used for all other IP addresses. Static IP is also used as a fall back configuration option when DHCP fails.

Static Configuration

When static IP configuration is selected, the user must explicitly enter the IP address, subnet mask and gateway address. Navigate to the given parameter and enter it using the virtual keypad as shown in Figure 44.

÷	Static IP address						
			19	92.	168	.0.2	2
		ESC	7	8	9	0	ENT
		+/-	4	5	6		
			1	2	3		

Figure 44: Entering an IP address.

IP addresses are composed of 4 numbers in the range from 0 to 255 separated by a decimal point (.). In the figure the IP address "192.168.0.2" is shown. The same procedure is used to enter the subnet mask and gateway address for static configurations.

Reset

When the IP configuration is changed, the interface should be reset to force the new configuration to take effect. The user can initiate a reset of the interface by pressing the virtual RESET button.

Current Configuration

The current IP configuration is shown at the top right of the TCP/IP settings display. See Figure 42. Note that the current configuration may differ from the manual configuration parameters entered in the static configuration section, especially if DHCP is used to obtain its address. The current configuration is what the user should refer to when trying to communicate with the FS740 over a TCP/IP connection.

Related Commands

```
SYSTem:COMMunicate:LAN:DHCP
SYSTem:COMMunicate:LAN:IPADress
SYSTem:COMMunicate:LAN:SMASk
SYSTem:COMMunicate:LAN:GATeway
```

Communication Status LEDs

Status LEDs in the communication section of the front panel provide information on the activity of the remote interfaces, as highlighted in Figure 45.

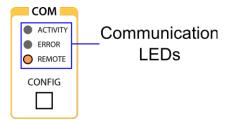


Figure 45: Communication status LEDs.

The first LED labeled "ACTIVITY" flashes when a character is received or sent over one of the remote interfaces. This can be useful when diagnosing communication problems. The second LED labeled "ERROR" indicates that the FS740 did not execute a command due to an error. Details about the error or errors can be found by navigating to Communications > Activity. The last LED indicates if the FS740 is in remote mode. When in remote mode the front panel of the instrument is locked out. All key presses will result in the display of a message indicating that remote control is active and the option to go to local mode. The user must click the "GO TO LOCAL" virtual button to regain front panel control of the instrument.

System

The top level systems display provides information about alarms, installed options, and the overall configuration of the FS740. A sample display is shown in Figure 46. It enables the user to save and recall user settings, configure the power down of the display, configure the rear panel alarm, configure installed options, and view device information.

System configuration				
User settings	Alarm status			
SAVE RECALL	Inactive			
Display	Rear options			
Pwr down Never	Config			
Device info SN_000005				

Figure 46: Top level system configuration display.

Save and Recall User Settings

The user may save and recall up to nine different user settings. The settings are stored in nonvolatile memory, so that they may be accessed even if the unit is power cycled. User settings include the configuration of the source outputs and measurement inputs. System settings related to the Timebase, GPS, and communication configuration are not stored or recalled.

Save Settings

To save user settings press the virtual button SAVE. The display will be similar to that of Figure 47. Then select a location to which settings should be saved.

System configuration :						
User settir SAVE	Save to	locatio	n 3	rm status Inactive		
Display Pwr down.	4	5	6	o r options one installed		
Device info SN_000006	7	8	9]		

Figure 47: Saving user settings.

Recall Settings

To recall previously saved settings press the virtual button RECALL. The display will be similar to that of Figure 48. Then select the location from which settings should be recalled.

System configuration :						
User settir	Recall from location			rm status		
SAVE	1	2	3	Inactive		
Display Pwr down.	4	5	6	r options		
	7	8	9			
Device info SN_000006	Fac	tory pre	sets			

Figure 48: Recalling user settings.

In addition to recalling previously saved settings, the user may recall factory presets. When this is chosen, user settings are restored to factory default settings. This is similar to executing the command *RST.

Related Commands

*SAV *RCL *RST

Display

The user can optionally power down the display after a period of inactivity. The factory default is to never power down the display. If the display is powered down, the user need only touch the display to reactivate it. To change the current configuration, press the "Display" card. The display will be similar to that shown in Figure 49.

System c	Power down LCD display	:
User settings	O Now	
SAVE R	O After ten min	tive
Display	O After one hr	
Pwr down New	O After ten hr	
Device info	O After one day	
SN_000006	O Never	

Figure 49: LCD display settings.

In the figure, the current selection is "Never." Select a different time period to change the selection. If "Now" is selected, the display will power down immediately, but the previous selection will still be active. For example, if "Never" is the current selection and the user selects to power down the display "Now," the display will power down immediately. However, "Never" will remain the current selection, so once the display is awakened, it won't power down again.

Related Commands

SYSTem:DISPlay:POWer

Device Information

Navigating into the "Device info" card presents detailed information about the overall system configuration of the FS740. It includes information such as the serial number, the firmware versions instrument and front panel, installed options and timebases, and information about the GPS receiver. The display is similar to that of Figure 50.

\leftarrow Device info	
Serial Number	SN_001182
Instrument firmware	4.22.11
Front panel firmware	2.10
Ethernet mac	00:19:b3:0b:04:9e
Installed timebase	Rb
Option Top	10MHz distribution
Option Mid	Sine/Aux distribution
Option Bottom	Pulse distribution
GPS receiver	NEO-M8T-0
GPS firmware	3.01

Figure 50: Device information display.

Related Commands

*IDN? *OPT?

Alarm

The rear panel of the FS740 contains screw terminals to a SPDT switch actuated by the system alarm. The system alarm may be controlled manually, or it may be configured to assert in response to anomalous conditions, such as detecting the timebase is in holdover, or has drifted more than 100 ns from UTC. The "Alarm status" card shows the current state of the alarm. Navigating into the "Alarm status" card brings up a display similar to that of Figure 54 when the alarm is asserted.

← Alarm	
	uses me not from GPS CLEAR
Mode Track current condition	Assert alarm when Time not from GPS

Figure 51: System alarm display.

The top portion of the display shows the current status of the alarm. When the alarm is asserted, the display also shows what condition caused the alarm to assert. In the figure we see that the alarm is being asserted because time of day has not been extracted from the GPS receiver, yet. When the alarm is in manual mode, the user is also given the option to SET or CLEAR the alarm.

Related Commands

```
SYSTem:ALARm?
SYSTem:ALARm:CONDition?
SYSTem:ALARm:EVENt?
SYSTem:ALARm:CLEar
SYSTem:ALARm:FORCe:STATe
```

Alarm Mode

The system alarm can operate in one of three modes: tracking, latching, or manual. The user may choose the mode by navigating into the "Mode" card and making the desired selection as shown in Figure 52.

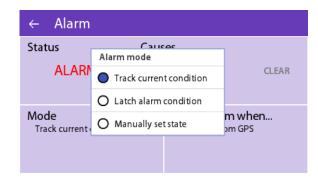


Figure 52: System alarm mode display.

In tracking mode, the alarm is asserted when a configured condition is true, and deasserted when the configured condition is false. The user cannot forcibly clear the alarm except by changing the mode to manual or removing the condition.

In latching mode, the alarm is asserted when a configured condition is true. Unlike tracking mode, however, it is not de-asserted when the configured condition becomes false. Rather, it remains asserted until the user explicitly clears the alarm. The user will not succeed in clearing the alarm if the configured condition is still true because it will merely be reasserted. In this case the alarm can only cleared by removing the condition or changing the mode to manual.

In manual mode, the user explicitly sets the state of the alarm. The state can be toggled by pressing the virtual SET and CLEAR buttons.

Related Commands

```
SYSTem:ALARm:MODe
SYSTem:ALARm:FORCe:STATe
```

Alarm Conditions

When the system alarm is in tracking or latching mode, the user must specify the conditions which will trigger the alarm. The "Assert alarm when..." card shows which conditions will trigger an alarm. The user modifies the conditions by navigating into the card and modifying the selections. The display will look similar to that of Figure 53

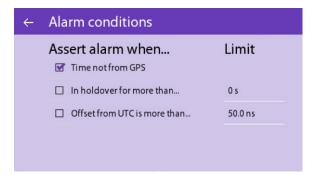


Figure 53: System alarm conditions display.

In the figure, the alarm is asserted when the time of day has not been set by GPS. The user may also set limits for how long the FS740 must be in holdover, and for how large the measured deviation from UTC can be before the alarm is asserted.

Related Commands

```
SYSTem:ALARm:ENABleSYSTem:ALARm:GPS:TINTerval SYSTem:ALARm:HOLDover:Duration
```

Rear Panel Options

The rear panel options display clearly shows which options have been installed and enables the user to configure the Sine/Aux distribution options to output a copy of either the Sine output or the Aux output. The display is similar to that of Figure 54. It clearly indicates what has been installed and gives the user the option to configure the Sine/Aux distribution boards if installed.

← Rear panel options				
Option 1	10MHz distribution	CONFIG		
Option 2	Pulse distribution	CONFIG		
Option 3	Sine distribution	CONFIG		

Figure 54: Rear options configuration.

In the figure, option 3 is currently configured for Sine distribution. This may be changed to Aux distribution by pressing the virtual button CONFIG, and selecting Aux distribution.

Related Commands

ROUTe:OPTion *OPT?

System Status LEDs

Status LEDs in the system section of the front panel provide information on the state of the alarm and overall system power as highlighted in Figure 55.

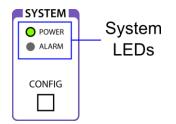


Figure 55: System status LEDs.

The first LED labeled "POWER" will be on whenever power is applied to the instrument. The second LED labeled "ALARM" is on whenever the system alarm is asserted. When lit, navigate to System > Alarm for details on why the alarm has been asserted.

Source Outputs

The front panel has three source outputs: sine, aux, and pulse. The rear panel provides copies of these outputs and a dedicated 10 MHz output. The user may purchase additional distribution capability for any of these outputs by ordering optional boards installed on the rear panel of the FS740.

The configuration of the individual outputs is similar. The hardware key on the right hand side of the front panel, above the output's BNC connector, takes the user to the top level display for that output. The user can then modify the amplitude, frequency, and phase of that output.

Amplitude

The user can adjust the amplitude of the sine and aux outputs. The top level display for the output shows the current amplitude as shown in Figure 56 for the sine output.

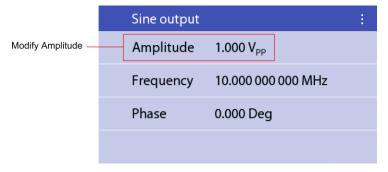


Figure 56: Modifying amplitude.

Press the current value to modify it. The amplitude can be adjusted or explicitly changed using the techniques discussed in the section Numeric Parameters on page 13.

Units

Sinusoidal waveforms may be specified in three different units: V_{PP} , V_{RMS} , and dBm. Other waveforms may only be specified in V_{PP} . The current units may be changed by pressing the UNITS button and selecting the desired units as shown in Figure 57. When entering an amplitude explicitly, use the numeric keypad and complete the entry with the desired units.

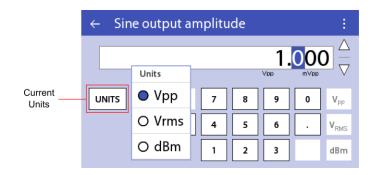


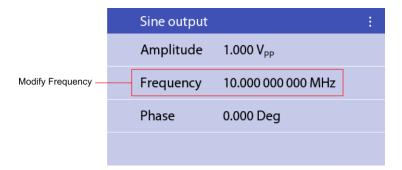
Figure 57: Changing amplitude units.

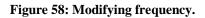
Related Commands

SOURce:VOLTage SOURce:VOLTage:UNITs

Frequency

The top level display for the output shows the current frequency as shown in Figure 58 for the sine output.





Press the current value to modify it. The frequency can be adjusted or explicitly changed using the techniques discussed in the section Numeric Parameters on page 13.

Related Commands

SOURce:FREQuency

Phase

The top level display for the output shows the current phase for the output as shown in Figure 59 for the sine output.

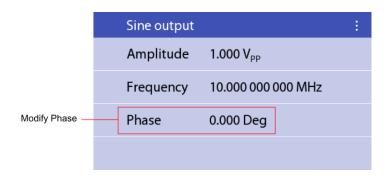


Figure 59: Modifying phase.

Press the current value to modify it. The phase can be adjusted or explicitly changed using the techniques discussed in the section Numeric Parameters on page 13. Phase can be adjusted by up to ± 360 degrees at a time. After moving the phase the display is renormalized modulo 360 degrees. For example, if the current phase is 350 degrees, the user may legally enter 370 degrees because this is only a phase shift of 20 degrees. After the phase shift, the display will show 10 degrees, because 370 modulo 360 is 10.

Units

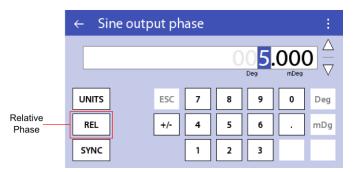
Phase may be specified in degrees, radians, or time. The current units may be changed by pressing the UNITS button and selecting the desired units as shown in Figure 60.

	← Sir	ne output p	bhase				1
		Units	1	0		.00(mDeq) ⊽
Change Units		 Deg 	7	8	9	0	Deg
	REL	O Rad	4	5	6		mDg
	SYNC	O Sec	1	2	3		

Figure 60: Changing units of phase.

Relative Phase

Sometimes it is convenient to define the current phase to be zero, without physically changing the phase. This may be accomplished by pressing the REL button as shown in Figure 61.





This is useful when the user wants to align the phase of the FS740 with some external reference phase and then define that as zero degrees of phase. Once the phase is aligned and REL'd, the user could put the FS740 in quadrature with the reference signal by entering 90 degrees.

Synchronize Phase to UTC

If the FS740 has received the time of day from GPS, then the phase of the various source outputs may be synchronized to the FS740's best estimate of UTC. This may be accomplished by pressing the SYNC button as shown in Figure 62.

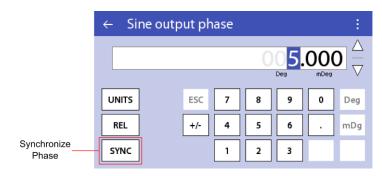


Figure 62: Synchronizing phase to UTC.

When the phase is synchronized the output will be momentarily disabled and then reenabled such that the zero crossing or rising edge of the output will coincide with UTC. The displayed phase will be reset to zero as well.

Auto Sync

Each of the three source outputs may be configured to automatically synchronize to UTC whenever the frequency is changed, or if the FS740 must jump phase to align itself with UTC. The selection is made by pressing the "Settings" button, which is the 3 vertically aligned dots at the right of the title bar, and toggling the "Auto sync" setting on or off as desired. The factory default is off.

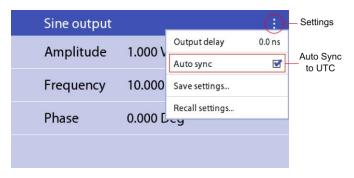


Figure 63: Auto synchronize output to UTC.

As noted before, when the FS740 synchronizes an output with UTC, it will disable the output and then re-enable it such that the zero crossing or rising edge of the output will coincide with UTC. Therefore the output may be disabled for up to a second when synchronizing to UTC.

Output Delay

The FS740 is calibrated so that the zero crossing or rising edge of the output at the BNC corresponds to UTC. However, the user's equipment may be located some distance away from the FS740. Thus, it may be desirable to advance or delay the signal so that rising edge of the output coincides with UTC at the input to the user's equipment. This is achieved by pressing the "Settings" button, which is the 3 vertically aligned dots at the right of the title bar, and pressing the "Output delay" menu item. Enter a negative delay to advance the signal. Enter a positive delay to retard it. The factory default is 0.0 ns.

Sine output			0	 Settings
Amplitude	1.000 \	Output delay	0.0 ns	 Output Delay
Ampiltude	1.000 1	Auto sync		
Frequency	10.000	Save settings		
Phase	0.000 L	Recall settings		

Figure 64: Adjust timing of source output.

For example, to compensate for 4 feet of RG-58 cable, which has a delay of 1.5417 ns/ft, the user would enter an output delay of -6.17 ns, to advance the signal so that it will arrive at the end of the cable when the UTC second transition occurs.

Related Commands

```
SOURce:PHASe
SOURce:PHASe:REFerence
SOURce:PHASe:SYNChronize
SOURce:PHASe:SYNChronize:AUTo
SOURce:PHASe:SYNChronize:TDELay
```

Sine Output

The top level sine output display is shown in Figure 65. The user can navigate to this display by pressing the hardware key on the front panel above the sine output BNC. From here the amplitude, frequency and phase of the sine output can be configured using the techniques discussed above.

Sine output		-
Amplitude	1.000 V _{PP}	
Frequency	10.000 000 000 MHz	
Phase	0.000 Deg	

Figure 65: Top level sine output display.

The sine output supports amplitudes ranging from 0.010 to 1.414 V_{PP} . It supports frequencies from 1 mHz to 30.1 MHz. Its phase can be synchronized to UTC and stepped

by up to 360 degrees in a single step. The phase can be adjusted beyond 360 degrees if it is done in multiple steps.

Aux Output

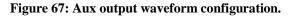
The top level aux output display is shown in Figure 66Figure 65. The user can navigate to this display by pressing the hardware key on the front panel above the aux output BNC. The aux output can generate several different types of waveforms including sine, triangle and square waves. The amplitude, frequency and phase of these waveforms can be configured using the techniques discussed above. The aux output can also generate two special purpose outputs, a fixed 100 MHz sine output and an AM modulated IRIG B signal.

Aux output	:
Config	Sine
Amplitude	1.000 V _{PP}
Frequency	1.000 000 000 MHz
Phase	0.000 Deg

Figure 66: Top level aux output display.

The user selects the waveform output on the aux output by pressing the current configuration, which is "Sine" in Figure 66. This enables the user to select the desired configuration as shown in Figure 67.

Aux o	Aux configuration	:
Confic	Sine	
Ampli	O Triangle	
	O Square	
Frequ	O 100 MHz Sine	MHz
Phase	O AM IRIG B	



The aux output supports amplitudes ranging from 0.010 to 1.414 V_{PP} . It supports frequencies from 1 mHz to 10 MHz for sine wave outputs, and 1 mHz to 1 MHz for the triangle and square wave outputs. The phase of these waveforms can be synchronized to UTC and stepped by up to 360 degrees in a single step. The phase can be adjusted beyond 360 degrees if it is done in multiple steps. The phase of the IRIG B is specified by the standard, but it can be shifted by modifying its output delay. The 100 MHz waveform is of a fixed amplitude and phase and cannot be synchronized to UTC.

Related Commands

SOURce2:FUNCtion

Pulse Output

The top level pulse output display is shown in Figure 68Figure 65. The user can navigate to this display by pressing the hardware key on the front panel above the pulse output BNC. The pulse output generates digital 5V CMOS levels. The user can specify a period and pulse width, or alternatively, a frequency and duty cycle. Like the other source outputs, the rising edge of the pulse output can be synchronized to UTC, and its phase adjusted by up 360 degrees in a single step using the same techniques discussed above.

Pulse outpu	t	1
Config	Period / Width	
Period	1.000 000 000 000 s	
Width	500.000 000 000 ms	
Phase	0.000 Deg	

Figure 68: Top level pulse output display.

The pulse output can also generate a pulse coded IRIG B waveform. Like the AM modulated IRIG B waveform, the phase of the pulse coded IRIG B waveform is specified by the standard, but it can be shifted by modifying the output delay for the pulse output as discussed above.

The user can change the pulse output configuration by pressing the current configuration, which is "Period/Width" in Figure 68. This enables the user to select the desired configuration as shown in Figure 69.

Pulse	Pulse output					
Config	Pulse configuration	h				
	Period / Width					
Perioc	O Freq / Duty	000 s				
Width	O Pulse IRIG B	00 ms				
Phase	0.000 Deg					

Figure 69: Pulse output configuration.

The pulse period can range from 40 ns to 1000 s. and can be specified with 1 ps resolution. The frequency can range from 1 mHz to 25 MHz and can be specified with 1 μ Hz resolution. The pulse width may range from 5 ns to the period – 5 ns. These limits also constrain the minimum and maximum duty cycle.

Related Commands

```
SOURce3:FUNCtion
SOURce3:PULSe:DCYCle
SOURce3:PULSe:PERiod
SOURce3:PULSe:WIDTh
SOURce3:PULSe:VIEW
```

Measure

The FS740 can make independent time and frequency measurements on its front and rear inputs. It can time stamp an event with 50 ps of resolution relative to its estimate of UTC. The FS740 also has a built in counter which, when combined with the time stamp circuitry, enables successive frequency measurements with no dead time. As such, the FS740 is particularly well suited to making frequency stability measurements over time intervals ranging from 0.01 s to 50 million seconds. Furthermore, by averaging up to 625 time stamps in a single 10 ms gate, the FS740 can reduce the inherent noise in the time stamp circuitry to about 1 ps. Thus, with an OCXO installed, the FS740 can measure stabilities approaching 2×10^{-12} in a 1 second interval.

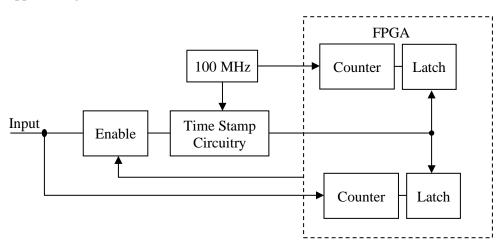


Figure 70: Frequency measurement circuitry.

A simplified diagram of the frequency measurement circuitry used by the FS740 is shown in Figure 70. A 100 MHz clock drives a free running counter in the FPGA which keeps track of system time with 10 ns of resolution. The input drives a second free running counter which tracks the number of edges generated by the input signal. When enabled, the time stamp circuitry latches the two counters and then measures the time between the 100 MHz clock edge and the input signal edge with a time to amplitude converter. Once the time tag has been recorded the FPGA resets the circuitry and re-enables the input. Since the counters are free running, no events are lost. Therefore, successive frequency measurements can be made with zero dead time as are needed when making frequency stability measurements. The time stamp circuitry can make a measurement once every 16 μ s for a total of 625 measurements in a 10 ms gate. By averaging these time stamps together, the baseline noise of the measurement can be reduced to about 1 ps. At this performance level, the noise of the measurement is completely determined by the stability of the timebase for time intervals larger than 1 second.

For time stamping of events, the same circuitry is used, except that the event counter is ignored and no averaging of time stamps takes place. Therefore, the noise floor is set by the single shot jitter of the time stamp circuitry, which is about 50 ps. Since no aggregating of data occurs, the maximum rate at which time tags can be processed is I/O limited to about 1 kHz and nondeterministic.

The FS740 provides two measurement input channels: one on the front panel and another on the rear panel. Each channel has separate, dedicated time stamp circuitry that can operate in parallel making it possible to time stamp two simultaneous events relative to a common clock.

Making Measurements

The hardware key on the right hand side of the front panel, above the BNC connector located in the MEASURE section takes the user to the top level display for measurements. From here the user can configure and view time and frequency measurement results. A sample display is shown in Figure 71.

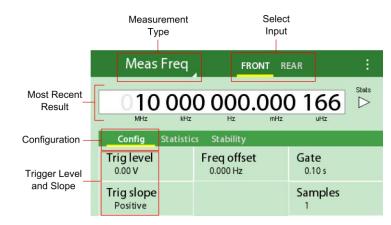


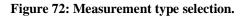
Figure 71: Top level measurement display.

At the top of the display in the title bar, the user makes two selections: the input channel being configured, and the measurement type for that channel. In the figure, the front input is selected as indicated by the yellow bar, and frequency is being measured on that input. Directly below the title bar is the result of the most recent measurement for the front input. When the user is operating the unit from the front panel, results are normally continuously updated and shown here. Finally, below the results are virtual tabs and cards which enable the user to configure and view more detailed information about the selected measurement. For frequency measurements, extra tabs are available for viewing measurement statistics and stability results. In the figure, configuration details are being shown.

Measurement Configuration

When configuring measurements, typically the first two items to select are the input channel and the measurement type. Input selection is made by pressing the desired input: "FRONT" or "REAR." The measurement type is selected by pressing the current measurement and selecting the desired measurement as shown in Figure 72.

	Meas Freq	FRONT RI	EAR
MeasTime			Stats
	Meas Freq	D 000.000	UHz
	Config Statistic	s Stability	
	ig level 0.00 V	Freq offset 0.000 Hz	Gate 0.10 s
	ig slope Positive		Samples



Related Commands

MEASure:FREQuency? CONFigure:FREQuency

```
MEASure:TIMe?
CONFigure:TIMe
```

Input Configuration

For both frequency and timing measurements the input trigger level and slope must be configured. The trigger level defines the voltage level that must be crossed for an event to be time stamped or counted. The trigger slope defines the direction or slope the input voltage must have to trigger an event. Positive slope indicates that the voltage should be rising when the trigger level is crossed. Negative slope indicates that the voltage should be falling when the trigger level is crossed. Both parameters may be modified using the techniques discussed in the section Parameter Modification on page 13.

Related Commands

```
INPut:LEVel
INPut:SLOPe
```

Frequency Measurements

The configuration process for frequency measurements is usually quite simple:

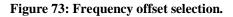
- 1. Select the input channel.
- 2. Select frequency for the measurement type.
- 3. Adjust trigger level and slope as appropriate for your input signal.

The location for each of these parameters is highlighted in Figure 71. The LED above the front panel BNC input will flash or light when the corresponding input is successfully triggered. If the FS740 is not being controlled by a remote interface, the unit will immediately commence making frequency measurements, continuously displaying the latest result. If not, see the section Auto Triggering below.

Frequency Offset

Sometime it is desirable to view measured frequency results relative to some specified offset, so that small deviations in the results are more easily analyzed. This is easily accomplished by setting the frequency offset. Pressing the "Freq offset" card presents the user with a window similar to that shown in Figure 73.

Mea	s Freq	F	RONT	REAR		
RELATIVE						Stats
000		00-0).0(00	136	\triangleright
MHz	kHz	Hz	m	Hz	uHz	
Config	Reference	e frequency	offset			
Trig leve 0.00 V	Current	10 000 000.			ate 0.10 s	
Trig slop	SET	CLEAR	SPEC	IFY	amples	



In the figure, we see that the current frequency offset is 10 MHz, and that the latest measurement was 136 μ Hz below 10 MHz. The user is presented with three options: set,

clear, or specify. Pressing "SET" causes the frequency offset to be set to the latest measurement result, which would be 136 μ Hz below 10 MHz or 9,999,999,999,864 Hz for the example shown in the figure. Pressing "CLEAR" forces the offset to zero, which is the default. Finally, pressing "SPECIFY" enables the user to enter a specific offset if desired.

Gate

To make a frequency measurement, the FS740 must make two measurements. It must time stamp the edge of the signal at the start of the measurement, and again at the end of the measurement. The frequency is computed as the total counts divided by the difference in the time stamps. The gate for a frequency measurement defines the minimum allowed time between the two measurements. Since the jitter of each time stamp is typically constant, the resolution of the measurement generally increases or decreases in proportion to the gate interval. For the default gate interval of 0.1 s, the FS740 can generally provide 11 digits of resolution. This increases to 12 digits for a 1 s gate, and decreases to 10 digits for a 0.01 s gate. The FS740 accepts gate intervals from 0.01 s to 1000 s.

Samples

The FS740 has enough internal storage to hold 500,000 frequency results. It can also compute some common statistical measures for a group of measurements, such as the min, max, mean, and Allan deviation. The "Samples" card enables the user to set the number of samples in a group of measurements from 1 to 1 billion. Although the latest measurement is often auto-triggered and displayed immediately, groups of measurements must be explicitly initiated by the user by pressing the play button as shown in Figure 74



Figure 74: Initiating a group of measurements.

Once a group of measurements is initiated, statistics and frequency stability calculations for those measurements will be automatically computed. Although, the latest result is always displayed on the front panel, stored results can only be downloaded via one of the remote interfaces.

Auto Triggering

The user explicitly initiates a measurement or a group of measurements by pressing the play button as shown in Figure 74. Measurement results which are explicitly initiated are automatically stored in internal memory and may be downloaded by the user via one of the remote interfaces. However, when operated from the front panel, the FS740 will normally automatically trigger measurements and display the most recent result on the front panel. Automatic triggering of measurements is convenient during setup and initial characterization of a signal as it provides the user with immediate feedback. However, automatically triggered results are not stored in internal memory and are generally not

available over the remote interfaces. If desired, automatic triggering may be turned off via the settings button, the three vertically aligned dots at the top right corner of the display, as shown in Figure 75.



Figure 75: Auxiliary frequency settings.

Uncheck auto trigger to turn off auto triggering. When auto triggering is off, all measurements must be explicitly requested by pressing the play button.

Fast Averaging

As mentioned above, the FS740 has be ability to make 625 time tag measurements in a 10 ms gate. By averaging these measurements together, the jitter in the results can be reduced from 50 ps to 1 ps. When making frequency measurements, this is normally desirable. Thus, this averaging is enabled by default. The user may disable it, however, if desired. Uncheck freq averaging to turn it off as shown in Figure 75.

Timeout

The time required to make a frequency measurement is normally determined by the gate for the measurement. However, if a signal is removed during a frequency measurement, the measurement cannot complete normally, because it must wait for a final trigger which will never occur. In this case, the measurement will timeout and the result will be undefined. Undefined results return 9.91e37 when queried over a remote interface. The default timeout period of 1.0 s should work well for most signals. If the signal period is longer than 1.0 s, then the timeout period should be extended to be longer than the period of the signal. Press "Timeout" in frequency settings to modify the timeout period as shown in Figure 75.

Related Commands

```
MEASure:FREQuency?
CONFigure:FREQuency
INPut:LEVel
INPut:SLOPe
CALCulate:REFerence
SENSe:FREQuency:GATE
SAMPle:COUNt
```

Frequency Statistics

When a group of measurements is initiated by pressing the play button as shown in Figure 74, the FS740 automatically computes some summary statistics on the measured results including the mean, Allan deviation, min, max, and count. These may be easily viewed from the front panel by pressing the "Statistics" virtual tab as shown in Figure 76.

	Mea	as Freq	FR	ONT RE	AR	÷
Statistics	MHz	9 9999 _{kHz}	999. ^{Hz}	.999 mHz	9 866 uHz	Stats
Tab	Config	Statistics	Stability			
	ADev	9 999 999.999 98 0.000 08	88		Gate 0.10 s	
	Min 9 999 999.999 764 Max 10 000 000.000 247 Cnt 1 000				Samples 1 000	

Figure 76: Viewing frequency statistics.

Frequency statistics are updated on the fly as measurements are completed.

Related Commands

CALCulate:STATistics

Frequency Stability

Frequency stability is commonly measured by computing the Allan variance of a series of measurements. The Allan variance is defined as follows:

$$\sigma_{y}^{2}(\tau) = \frac{1}{2} \langle (y_{n+1} - y_{n})^{2} \rangle = \frac{1}{2\tau^{2}} \langle (x_{n+2} - 2x_{n+1} + x_{n})^{2} \rangle$$

where τ is the observation or gate interval for the measurement while y_n is the fractional frequency, and x_n , the time error, of the nth interval. The brackets $\langle \rangle$ denote the ensemble average of the sequence. The Allan deviation is merely the square root of the Allan variance:

$$\sigma_y(\tau) = \sqrt{\sigma_y^2(\tau)}$$

To make Allan deviation measurements, the user must collect a series of time tags of the appropriate interval with no dead time and compute the average frequency deviation from one interval to the next in the series. Furthermore, users are often interested in computing the Allan deviation over a wide range of observational intervals, τ , not just one. Making these measurements correctly is often difficult and time consuming to setup and compute.

The FS740, however, makes Allan deviation measurements easy. The FS740 is continuously making time tag measurements with no dead time, regardless of the configured gate. Instead of discarding these measurements, they are used to compute the Allan deviation for all time intervals in a 1, 2, 5, sequence from 0.01 s to 50 million seconds. The user need only configure the total time interval for the measurement which is the gate interval times the number of samples. For example, to get Allan deviation results for a 1 million second time record, one could configure a measurement with a 1 second gate and a million samples.

For quicker convergence when computing the ensemble averages, the FS740 uses an algorithm similar to that used in the overlapped Allan variance calculation. In the overlapped Allan variance calculation all time tags are included when computing the ensemble average for a given interval. This is not feasible for the FS740 due to memory constraints. Instead, the FS740 retains a maximum of 50 time tags at each time interval.

The time tags are spread evenly over the interval, however, to maximize the independent degrees of freedom of the measurement.

Making Frequency Stability Measurements

When a group of measurements is initiated by pressing the play button as shown in Figure 74, the FS740 automatically computes frequency stability results, i.e. Allan deviations, for time intervals from 0.01 s to 50 million seconds. The results may be easily viewed by pressing the "Stability" virtual tab as shown in Figure 77.



Figure 77: Viewing frequency stability.

Results are shown in tabular format for intervals from 0.01 s to 50 million seconds in a 1, 2, 5 sequence. In Figure 77, the first column of results represents the Allan deviations for time intervals 0.1, 0.2, and 0.5 s. the second column represents the Allan deviations for time intervals 1.0, 2.0, and 5.0 s. The third and forth columns are interpreted similarly with the interval increasing by a factor of 10 with each column. Longer and shorter intervals in the table may be viewed by pressing the display interval arrows, as noted in the figure. The FS740 returns zero for stability measurements that have not completed, yet.

Related Commands

CALCulate:STABility

FS740 Baseline Measurement Stability

The time tagging circuitry of the FS740 has a typical jitter of approximately 30 ps. By enabling averaging, this performance improves by more than 10 fold. However, the time to amplitude converters also contain systematic nonlinearities that contribute jitter to measurements which depend on the frequency of the signal in question. The nonlinearities are partially attributable to curvature in the slope of the time to amplitude converters. However, they are also attributable to interference with other signals within the FS740. If the signal being measured is nearly synchronous with one of these interfering noise sources, the jitter performance will be degraded.

Signals with a period that is an integer multiple of 10 ns are synchronous with the FS740's timebase and measurement stability with be superior at these frequencies because nonlinearities and interference in the time to amplitude converters are eliminated. When the frequency is no longer synchronous, jitter performance will be degraded depending on the frequency offset and whether frequency averaging is enabled.

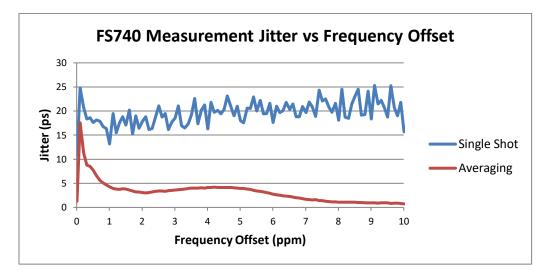
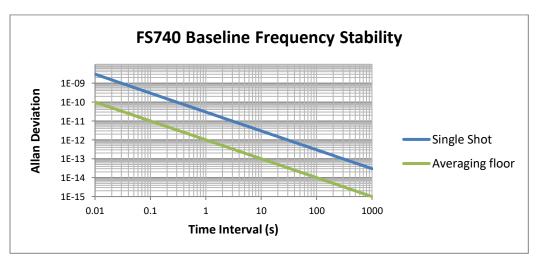
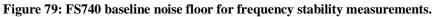


Figure 78: FS740 measurement noise vs frequency offset from a synchronous frequency

Figure 78 details typical measurement jitter of the FS740 time tags as the signal frequency deviates from a synchronous frequency. If frequency averaging is turned off the measurement jitter is roughly constant at about 20 ps, regardless of offset frequency. When frequency averaging is turned on, however, random noise is effectively averaged away and the noise drops to about 1 ps at synchronous frequencies. At asynchronous frequencies the noise increases to about 17 ps at a frequency offset of 0.1 ppm, and then gradually drops below 5 ps at a frequency offset of 1 ppm and then gradually falls to 1 ps at 10 ppm. The increased noise at 0.1 ppm is due to the additional jitter from interference and nonlinearities in the time to amplitude converters that are systematic on a time scale of 10 ms and cannot be averaged away. At large frequency offsets, these additional noise sources start to appear random again, and averaging effectively removes it.

For white noise the frequency stability is just the jitter divided by the time interval. Thus, 30 ps of jitter corresponds to a baseline frequency stability of 3.0e-9 for a 10 ms interval and 3.0e-11 for a 1 s interval. This is graphically depicted in Figure 79.





FS740 Timebase Stability

When making stability measurements, one must also consider the stability of the FS740's installed timebase which is reproduced in Figure 80 for the various available timebases.

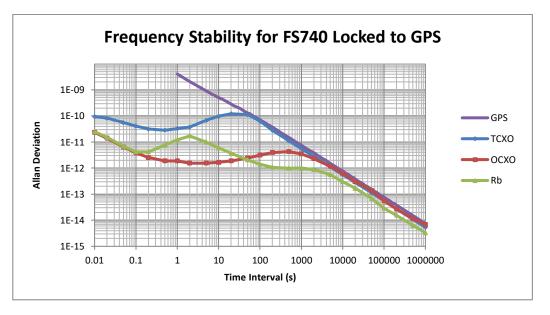


Figure 80: Frequency stability of FS740 with different timebases installed.

Notice that the timebase stability for the OCXO and Rb actually exceeds the baseline measurement stability shown in Figure 79 for time intervals shorter than 1 second. Thus for time intervals less than 1 second the measured stability will be limited by the baseline noise of the measurement as depicted in Figure 79. Conversely, for time intervals greater than 1 second, the measured stability will be limited to stability of the installed timebase as depicted in Figure 80.

Effects of Averaging on Frequency Stability

As noted above, the baseline frequency performance of the FS740 is improved by up to a factor of 25 by averaging together up to 625 time tags in a 10 ms gate. The improvement is achieved because the jitter in the time to amplitude converters is averaged away. However, it should also be noted that broadband noise in the signal under analysis will also be averaged away for the same reason. The averaging effectively inserts into the measurement a low pass filter with a 3 dB point at 44 Hz. As a result, for clocks with significant broadband noise, the FS740 will report short term stabilities that are better than reality. Users who wish to include such broadband noise in their stability analysis should turn off frequency averaging (see Figure 75). Doing so, however, will necessarily degrade the baseline noise of the FS740 (see Figure 79), and limit the maximum performance that can be measured.

Timing Measurements

The FS740 can time tag external events with a resolution of better than 50 ps. The event is time tagged relative to the FS740's best estimate of UTC. The absolute accuracy is 100 ns, but the variation is typically better than 10 ns. Finally, the relative precision of two events is better than 50 ps plus the timebase error. Time tagging has multiple applications in astronomy, physics, and the power industry.

The configuration process for timing measurements is quite simple:

- 1. Select the input channel.
- 2. Select time for the measurement type.

- 3. Adjust trigger level and slope as appropriate for your input signal.
- 4. Set the desired number of samples.
- 5. Press play button to initiate the capture of time tags.

The location for each of these parameters is highlighted in Figure 81. The LED above the front panel BNC input will flash or light when the corresponding input is successfully triggered. If the FS740 is not being controlled by a remote interface, the unit will immediately commence making timing measurements, continuously displaying the latest result. If not, see the section Auto Triggering on page 63.

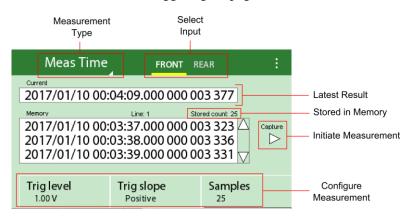


Figure 81: Timing measurement configuration.

The FS740 has enough internal memory to store up to 250,000 measurements. By default, when the memory fills up, the oldest result will be discarded to make room for the newest result. Alternatively, the user may choose to keep the oldest results and discard the newest results. To do this press the settings button and check the box labeled "Keep first tag," as shown in Figure 82.

	Meas Time	FRO	ONT RE	AR	<u></u> :-	Settings
	Current		Auto tr	rigger	S	
	2017/01/24 19:	18:56.000	Keep fi	rettag		—— Keep First Tag
	Memory	Line: 1	кеерп	istag		Reepinstrag
	2017/01/24 19:	17:05.000	Timeo	ut	1.0 s	
2017/01/24 19:17:06.000 2017/01/24 19:17:07.000		Save se	ettings			
			Recall	settings		
	Trig level 1.00 V	Trig slope Positive		Samples 25		

Figure 82: Setting time tag buffering behavior.

The user may view the first few results via the front panel user interface. For large data sets, however, it will only make sense to download the results via one of the remote interfaces.

Factory Default Settings

The factory default settings for the FS740 are shown in Table 5. The settings are divided into two categories: system settings and user settings. User settings largely apply to the configuration of the source outputs and the measurement inputs. The user may force these

parameters to their default settings by executing the *RST command or recalling factory presets via the front panel interface. These parameters are identified by a check mark at the far right of Table 5.

System settings, on the other hand, largely apply to the configuration of the timebase, GPS, communications parameters, and system alarms. They are unaffected by the execution of the *RST command or a recall of factory presets from the front panel. They are stored in nonvolatile memory and retain their configuration even when power is cycled. These parameters are generally intended to be set once and then left alone.

Parameter	Value	Set by *RST	
Display	Timebase Display	\checkmark	
Display power down	Never		
Sine frequency	10 MHz	√	
Sine amplitude	1 Vpp	✓	
Sine amplitude units	Vpp	√	
Sine phase	0 Degrees	√	
Sine phase units	Degrees	\checkmark	
Sine phase auto sync	Off		
Sine phase time delay	0 ps		
Aux waveform	Sine wave	\checkmark	
Aux frequency	1 MHz	√	
Aux amplitude	1 Vpp	✓	
Aux amplitude units	Vpp	√	
Aux phase	0 Degrees	√	
Aux phase units	Degrees	√	
Aux phase auto sync	Off		
Aux phase time delay	0 ps		
Pulse waveform	Pulse	√	
Pulse view	Period/Width	√	
Pulse frequency	1 Hz	√	
Pulse duty cycle	50 %	✓	
Pulse period	1 s	\checkmark	
Pulse width	500 ms	√	
Pulse phase	0 Degrees	√	
Pulse phase units	Degrees	✓	
Pulse phase auto sync	Off		
Pulse phase time delay	0 ps		
Input level	0 V	✓	
Input slope	Positive	✓	
Input measurement	Frequency	✓	
Input frequency offset	0 Hz	✓	
Input frequency gate	0.1 s	\checkmark	
Input sample size	1	✓	
Input auto trigger	On	✓	
Input frequency averaging	On	~	
Input time out	1 s	~	
Input time tag buffer mode	Keep last	~	
Timebase GPS lock	Enabled		

Table 5: Factory default settings

Timebase holdover mode	Wait for good 1pps timing from GPS
Timebase bandwidth mode	Auto bandwidth control
Timebase time interval limit	1 μs
Timebase manual time constant	30 s
GPS timing alignment	UTC
GPS timing quality	Require 3 satellites
GPS survey mode	Redo survey at power on
GPS position fixes in survey	2000
GPS antenna cable delay	0 ns
Local time offset	0 hr
RS-232 baud rate	115200 baud
Ethernet speed	100 Base T
TCP/IP configuration method	DHCP
TCP/IP static IP address	0.0.0.0
TCP/IP static subnet address	0.0.0.0
TCP/IP static gateway address	0.0.0.0
System alarm mode	Manually set state
System alarm manual state	Off
System alarm holdover duration	0 s
limit	
System alarm timing error limit	100 ns
Option sin/aux routing	Sine out

Forcing User Settings to Factory Defaults

The user may easily force user settings to their factory default values from the front panel by pressing Settings > Recall Settings, and then choosing "Factory Presets"

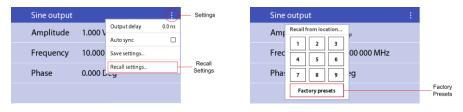


Figure 83: Setting user settings to factory presets.

This is equivalent to executing the remote interface command *RST. It forces parameters in Table 5 with a check mark at the right to the default setting.

Related Commands

*RST

Forcing All Settings to Factory Defaults

Occasionally it may be useful to force ALL instrument settings to their factory default state. This may be necessary, for example, when transferring a unit from a secure location. Perform the following procedure to wipe the instrument of all user settings and force all system settings to their factory default values:

1. Unplug the power cord to the FS740.

2. Press the front panel System Config key.

SYSTEM	1
O POWER	
ALARM	
CONFIG	System
	Config Key

3. While pressing the System Config key, re-plug in the power cord to the FS740.

The FS740 will display a message that all settings are being restored to their default values.

Related Commands

SYSTem:SECurity:IMMediate

Remote Programming

Introduction

The FS740 may be programmed via remote interfaces included with the instrument. Any host computer interfaced to the instrument can easily control and monitor its operation. The front panel can even be locked out when necessary for complete computer control. This might be desirable as part of an automated test environment. The FS740 supports two standard remote interfaces: RS-232 and an Ethernet based local area network (LAN) interface which supports TCP/IP communication.

RS-232

An RS-232 communications port is included on the rear panel of the unit. The RS-232 interface connector is a standard 9 pin, type D, female connector configured as a DCE (transmit on pin 2, receive on pin 3). In order to communicate properly over RS-232, the instrument and the host computer both must be configured to use the same settings. The following baud rates are supported: 115200 (default), 57600, 38400, 19200, 9600, and 4800. The rest of the communication parameters are fixed at 8 data bits, 1 stop bit, no parity, and RTS/CTS hardware flow control. See section RS-232 Configuration on page 43 for details on how to configure the RS-232 port from the front panel.

Ethernet

A rear panel RJ-45 connector may be used to connect the instrument to a 10/100 Base-T Ethernet LAN. In order to function properly on an Ethernet LAN, the unit needs to obtain a valid TCP/IP configuration, which includes an IP address, a subnet mask, and a default gateway or router address. The FS740 supports three methods for obtaining these parameters: DHCP for automatic IP configuration, Auto-IP for link local addressing, and Static IP for manual configuration. Check with your network administrator for the proper method of configuration of instruments on your network before attaching the FS740 to your network. See section TCP/IP Configuration on page 45 for details on how to select the proper method of TCP/IP configuration from the front panel.

Once connected to the network, the user can connect to the FS740 using one of the following protocols: telnet, bare TCP stream connections, and VXI-11.

Telnet

The FS740 accepts telnet connections on port 5024. Telnet is useful for interactive sessions because it supports line based command execution with automatic echoing of typed characters. This enables users to easily type (and correct) commands manually from the keyboard. Telnet, however, should not be used for automated computer control, however, because the echoing of characters and processing of telnet commands will significantly complicate the endeavor.

Bare TCP

The FS740 accepts bare TCP stream connections on port 5025. Bare TCP connections are ideal for automated computer control. All bytes are passed directly to the input queue of

the FS740 and all responses sent directly back to the user application. This connection is very similar in style to RS-232 connections.

VXI-11

VXI-11 is a TCP based network connection that mimics a GPIB interface. Like the other connections, the user can write to the input queue of the FS740 and read back responses from its output buffer, but it also enables the user to issue GPIB commands such as a device clear, or a serial poll and it supports request for service (RQS) notifications. Interfacing to this server, however, requires the installation of a VISA library on the host computer. The user makes calls into the VISA library to connect and communicate with the FS740. The VISA library then issues the low level calls to the VXI-11 server on the FS740. Unfortunately, SRS does not supply an implementation of this library. However, it can be purchased from several third party vendors, such as National Instruments and Keysight. In fact, the library is often bundled for free with the purchase of hardware instrumentation from either of these companies.

Network Security

Network security is an important consideration for all TCP/IP networks. Please bear in mind that the FS740 does NOT provide security controls, such as passwords or encryption, for controlling access. If such controls are needed, you must provide it at a higher level on your network. This might be achieved, for example, by setting up a firewall and operating the instrument behind it.

Front-Panel Indicators

To assist in programming, there are three front panel indicators located under the COM section of the front panel: ACTIVITY, ERROR, and REMOTE. The location of the LEDs is shown in Figure 84.

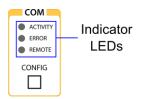


Figure 84: Communications indicator LEDs.

The REMOTE LED is on when the instrument is in remote lock out. In this mode, the front panel interface is locked out and the instrument can only be controlled via the remote interface. To go back to local mode, the user must touch the LCD display and then press the virtual button GO TO LOCAL.

The ACTIVITY LED serves as an activity indicator that flashes every time a character is received or transmitted over one of the remote interfaces. This is useful when troubleshooting connections because it clearly indicates when the FS740 successfully received and responded to a command.

The ERROR LED will be highlighted when a remote command fails to execute due to illegal syntax or invalid parameters. Once highlighted, the LED will remain lit until the error queue is cleared. Errors may be viewed and cleared by navigating to Communications > Activity. The most recent error is displayed at the bottom. Press the virtual button CLEAR to dismiss the error. Press CLEAR ALL to dismiss all errors.

SCPI Command Language

The FS740 uses the SCPI (Standard Commands for Programmable Instruments) language for controlling the instrument over a remote interface. The SCPI language is an ASCII based command language that organizes functions into a hierarchical tree of commands with branches of the tree separated by colons.

SubSystems

The base or root of the tree represents a subsystem of the instrument. Each succeeding branch of the tree subdivides the subsystem into related categories of functionality. The final branch of the tree identifies a command related to the subsystem that can be executed by the FS740. This structure facilitates understanding of the functions carried out by commands. As an example, consider the subset of the STATus subsystem shown below.

```
STATUS:

GPS:

CONDition?

ENABle

ENABle?

[:EVENt]?

OPERation:

CONDition?

ENABle

ENABle?

[:EVENt]?
```

STATus is a subsystem of the FS740 and it is at the root of the tree. At the next level down, the STATus subsystem is divided into two branches: GPS and OPERation. Each of these categories is then further subdivided into four virtually identical commands: CONDition, ENABle, ENABle?, and [:EVENt]?. However, because of the hierarchical structure of the language, we can infer that the commands listed under the GPS branch refer to GPS receiver status, while those listed under OPERation carry out the same functions but refer to OPERation status rather than GPS status. Thus, the hierarchical structure of the commands aids in the understanding of the operations carried out by the individual commands.

Understanding Command Syntax

SCPI commands often take one or more parameters which modify or identify the numerical value a variable should take. Some parameters are required. Others may be optional. Furthermore, the data types for each parameter may differ. Thus, for brevity, we need a set of conventions for defining commands which clearly identifies all the valid variations of the command without having the list each possibility separately. These conventions are set forth here.

An example command is illustrated below:

```
SOURce[{1|2}]:VOLTage[:LEVel] {<voltage>|MINimum|MAXimum|DEFault}
```

Keyword Case

Keywords are defined with a mixture of upper-case and lower-case letters. The upper-case letters indicate the short or abbreviated version of the keyword. This is usually the first 3 or 4 letters of the keyword. The user may send either the short version or the entire long version of the keyword in their programs. The case of the letters sent to the FS740 does not matter. It is only used here to succinctly identify the two versions of the keyword. Thus, SOUR, source, and Sour are all acceptable forms of the keyword. Other forms, such as SOU, or SOURC, are not. Given the definition above, the following commands are all identical:

```
SOUR:VOLT MIN
SOURCE:VOLTAGE MINIMUM
SOUR:VOLTAGE MIN
```

Punctuation Used in Definitions

The following punctuation is used to identify variations and options for the command:

- Braces ({ }) enclose different parameter choices. The braces, themselves, are not sent with the command
- A vertical bar (|) separates alternative parameter choices for the command. In the example above, the choices are a <voltage> or one of the keywords: MINimum, MAXimum, or DEFault. The vertical bar is not sent with the command.
- Triangle brackets (<>) indicate that you must specify a numerical value. In the example above, <voltage> would be specified as a number. Thus, one could set the voltage using the following command: SOUR:VOLT 1.253. The triangle brackets are not sent with the command.
- Square brackets identify optional keywords or parameters in the command. Optional items may be omitted if desired. In such case a default value is normally substituted for the parameter. In the example above, the keyword LEVel is optional and may be omitted. Thus, the command SOUR:VOLT:LEVEL 1.253 is identical to the command that omits the keyword: SOUR:VOLT 1.253.

Numeric Suffix

Some keywords can have a numeric suffix appended to the keyword. In the example SOURce may be followed with a 1 or 2. These suffixes identify multiple channels of the same subsystem. Thus, SOUR1 identifies channel 1, and SOUR2 identifies channel 2. The numeric suffix is optional and if omitted, channel 1 is assumed.

Examples

Putting it all together, all of the following commands are valid given the example definition presented above.

```
SOUR:VOLT MIN
SOUR2:VOLT DEFAULT
SOURCE1:VOLTAGE 1.234
SOURCE:VOLT MAXIMUM
```

Queries

Command queries are usually formed by appending a question mark (?) to the command. To query the output voltage of channel 1, we use the following command: SOUR:VOLT?

Separators

As mentioned above, a colon (:) separates the different keywords that make up a command. If a command takes a parameter, a space MUST separate the last keyword of a command and the first parameter of that command. If a command takes multiple parameters, they are separated from each other with a comma (,). Finally, a semicolon (;) is used to separate multiple commands on the same line. If the following command is in the same subsystem as the preceding command must be fully specified and preceded by a colon. Given the example command tree presented in section SubSystems above, the following commands are valid:

```
STAT:GPS:ENAB 1; EVENT?
STAT:GPS:COND?; :STAT:OPER:COND?
```

In the first line, both ENABle and EVENt are in the same subsystem, STAT:GPS, so that portion of the command is omitted for the EVENt? query. However, the two condition queries are in different subsystems, so the operational condition query is preceded by a colon and fully specified on the command line.

When multiple queries, separated by semicolons, are made in a single command line, the responses from the individual queries are separated by a semicolon as well.

IEEE 488.2 Common Commands

The IEEE 488.2 standard defines several common commands that nearly all instruments support. Common commands start with an asterisk (*) followed by three letters. Like with SCPI commands, a space MUST separate the command and any parameters which follow. Multiple common commands may executed in a single line by separating the commands with a semicolon (;). An example is given below.

*RST; *OPC?

Parameter Types

The SCPI language supports several different data types for use with command parameters.

Numeric Values

Parameters that take numeric values accept all common decimal representations of numbers, including optional signs, decimal points, or scientific notation. Hexadecimal values specified with a prefix of 0x prefix as used in the C language are also accepted. If only certain values are allowed, numeric entries will be rounded to the nearest allowed value. The following examples are all valid numeric entries:

```
100
-123.456
+1.23456e2
-.456
0x64
```

The last example, 0x64, is the hexadecimal representation for the decimal number 100.

Many commands that take numeric parameters will also accept the keywords MINimum, MAXimum, or DEFault to set the parameter to the requested value for that parameter.

Units

Many numeric values may be followed with a unit designation. The most common engineering prefixes are also accepted. For example, source frequency may be specified in Hz as SOUR:FREQ 10 KHZ. The FS740 accepts the units specified in Table 6:

Freq.	VDC	VAC			Time	Pha	ase	Percent
		V _{PP}	V _{RMS}	dB		Deg	Rad	
Hz	nV	nVpp	nVrms	dBnW	ps	nDeg	pRad	%
kHz	uV	uVpp	uVrms	dBuW	ns	uDeg	nRad	
MHz	mV	mVpp	mVrms	dBm	us	mDeg	uRad	
MAHz				dBmW		_		
GHz	V	Vpp	Vrms	dBW	ms	Deg	mRad	
	kV	kVpp	kVrms		S		Rad	
	MAV	MAVpp	MAVrms					

 Table 6: Units accepted by the FS740

Note that since the SCPI language is case insensitive, it cannot use the case of the letter "m" to distinguish between mV (millivolts) and MV (megavolts). Thus, the prefix MA is used to designate Mega in SCPI. The one exception to this is for frequency where convention prevails and the unit designations MHz and MAHz both represent megahertz.

Special Numbers

The SCPI language defines 3 special numbers: infinity, negative infinity, and not a number. These are defined to take the values shown in Table 7

Abbreviation	Meaning	Value	
INF	Infinity	+9.90e37	
NINF	Negative infinity	-9.90e37	
NAN	Not a number	+9.91e37	

 Table 7: SCPI Special Numbers

These special numbers may be returned by commands when data is invalid. A measurement of frequency, for example, may time out. In this case, NAN will be returned as its value. The physical values were chosen to be so large as to be not confused with normally expected physical values, but small enough to be easily representable by a single precision floating point number format.

Discrete Parameters

Some parameters take one of a small list of allowed keywords. They often have a short form and a long form, just like command keywords. In the command definition, the upper case letters indicate the short form. Either case may be used when sending the short or long form of the value to the instrument. Queries will always return the short form. Consider the following command definitions:

```
TBASe:CONFig:BWIDth [{ AUTo | MANual }]
TBASe:CONFig:BWIDth?
```

The user may specify auto bandwidth control by sending the command TBAS:CONF:BWID AUTO. The query will return AUT, which is the short form of the value.

String Parameters

Quoted string parameters allow one to send almost any sequence of characters, including characters that are normally reserved as separator characters, such as a comma, semicolon, or colon. The string must begin and end with the same quote character: either a single quote, or a double quote. The quote delimiter may itself be included in the string if it is typed twice without any characters in between.

Command Termination

Commands should be terminated with a line feed $\langle LF \rangle$. They may optionally be terminated with a carriage return $\langle CR \rangle$ followed by a line feed $\langle LF \rangle$. As previously noted, multiple commands may be sent in a single line if they separated by a semicolon (;). Commands are executed in the order received and execution commences once the command separator or terminator is received.

Status Reporting

Architecture

The FS740 reports on its status via a hierarchy of status registers. Instrument status is stored in three 16-bit registers: the questionable status register, the operational status register, and the GPS receiver status register. Parsing and command execution status is reported via the standard event register (*ESR?). Summaries of all these registers are reported as bits in the serial poll status byte for the instrument (*STB?). The serial poll status byte may be configured to generate a request for service, RQS, from a remote interface when a given bit is set. This scheme enables the user to be notified when events of interest occur, and to ignore events that are not of interest. Detailed status is always available in the source registers. However, with proper configuration, these registers need not be queried until an event of interest actually occurs.

Each instrument status register has three associated status words: a condition register, an event register and an enable register. The relationship of these three registers is depicted in Figure 85.

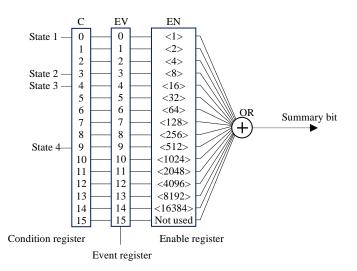


Figure 85: Organization of status registers

Condition Register

The condition register reports on the current state of the instrument. At the far left of Figure 85 are listed four items of state which feed into four different bit locations of the condition register. When the instrument is in the given state, then the corresponding bit in the condition register is set. When the instrument leaves the given state the corresponding bit is cleared. Bits in the condition register which are set indicate items of state that are true at the time of the query. Bits in the condition register which are clear indicate items of state that are false at the time of the query. Querying the condition register does not alter the bits in the register. Only changes in the actual instrument state alter the bits of the condition register.

When the condition register is queried, only one number is returned which is the binary sum of all bits in the register which are set. The binary weight of each bit in the register is shown in the enable register at the far right of Figure 85. The binary weight increases by a factor of two for each bit. Bit 0 has a weight of 1. Bit 1 has a weight of 2. Bit 2 has a

weight of 4, and so on up to bit 14 which has a weight of 16384. The number returned by a query of the condition register is the sum of weights of the bits which are set.

For example, in Figure 85, State 1 feeds into bit 0 and State 2 feeds into bit 3. If both State 1 and State 2 are true, then both bits 0 and 3 will be set. If all other states are false, then the number returned by a query of the condition register will be the binary sum of bit 0 and bit 3, which is 1 + 8 = 9. If only State 2 is true, then only bit 3 will be set and a query of the condition register will return 8. Similarly, if only State 1 is true, then only bit 0 will be set and the query will return 1. Finally, if none of the states is true, the query will return 0.

Event Register

Bits from the condition register feed into corresponding bits in the event register. The event register differs from the condition register, however, in that the bits are sticky. Once a bit is set, it remains set until explicitly cleared by a query of the event register. The event register, therefore, enables the user to capture all events that have occurred since the previous query of the register, even if the states in question are short lived and not true at the moment of the query.

Like the condition register, a query of the event register returns a single number which is the binary sum of all bits in the register which are set. (See the discussion of the condition register above for a detailed explanation of this process.)

Unlike the condition register, a query of the event register clears any bits which were previously set. Executing the *CLS command will also clear this register. Of course if corresponding bits in the condition register are still set, these bits will immediately be set again after the clear from the query.

Enable Register

The enable register is a mask register that controls which bits from the event register will set the overall summary bit. If a bit in the enable register is set, then the corresponding bit in the event register will be combined with other enabled bits of the event register via a logical OR operation to create an overall summary bit.

The user sets the enable register with a single number which is the binary sum of all bits in the register which should be set. (See the discussion of the condition register above for a detailed explanation of this process.) Continuing with the example from Figure 85, If the enable register is set to 9 = 1 + 8, then the summary bit will be set if either bit 0 or bit 3 of the event register is set. Therefore, if the user detects that the summary bit is set, he can infer that either State 1 or State 2 or both were at least momentarily true since the last query of the event register.

Enable bits are set via a command. They are not cleared by a query or the execution of the *CLS command. To clear enabled bits, the user must send another set command with those bits set to zero. Sending the number zero will clear all bits of the enable register and prevent the summary bit from ever being set.

FS740 Status

The FS740 status is reported through the standard event register and three instrument status registers. The organization and hierarchy of these registers is depicted in Figure 86. There are three instrument status registers: GPS receiver status, questionable status, and operational status. These are all 16-bit registers which report on the status of the instrument and its operation. The 8-bit standard event register reports on the status of command parsing and execution. The summary bits from each of these registers feed into a single, 8-bit condition register called the serial poll status byte. Summary bits for the error queue and the output buffer also feed into this status byte. The serial poll status byte, therefore, provides summary status for the entire instrument.

The serial poll status byte (*STB) may be configured to generate a request for service interrupt to the remote interface, if desired. This is achieved with the help of an enable register (*SRE) associated with it that allows bits in the serial poll status byte to be combined into a single summary bit, also in the serial poll status byte located at bit 6. When this bit is set, the instrument will generate a request for service interrupt to the remote interface if supported.

Serial Poll Status Byte

The serial poll status byte provides summary status for the instrument as a whole. The interpretation for bits in the serial poll status byte is shown in Table 8.

Bit	Name	Meaning
0		
1	GPS	An unmasked bit in the GPS receiver status has been set.
2	ERR	There is at least one error in the error queue. Query the error with the command SYST:ERR?
3	OUES	
3	QUES	An unmasked bit in the QUES status register has been set.
4	MAV	The interface output buffer has at least one character in it.
		Perform a read of instrument to retrieve it.
5	ESR	An unmasked bit in the standard event status register (*ESR) has
		been set.
6	MSS	Master summary bit. Indicates that the instrument is requesting
		service because an unmasked bit in this register has been set.
7	OPER	An unmasked bit in the OPER status register has been set.

 Table 8: Interpretation of serial poll status bits

The serial poll status byte may be queried with the *STB? command. The service request enable register (*SRE) may be used to control when the instrument asserts a request-for-service on interfaces where that is supported.

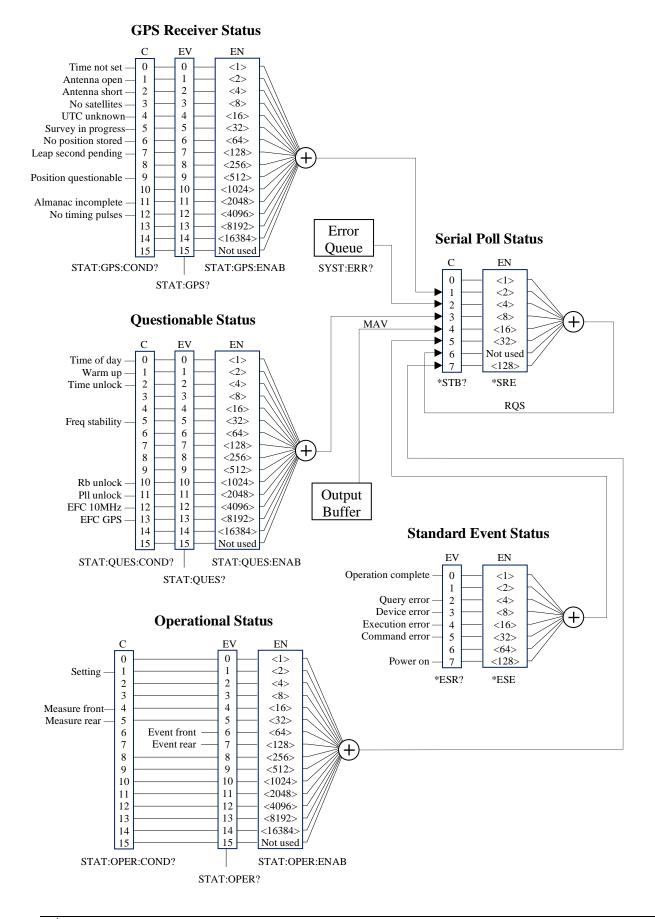


Figure 86: FS740 Status reporting

Standard Event Status Register

The standard event register provides status information on command parsing and execution. The interpretation for bits in the standard event status register is shown in Table 9.

Bit	Name	Meaning
0	OPC	Operation complete. All previous commands have completed.
		See command *OPC.
1		
2	QYE	Query error occurred.
3	DDE	Device dependent error occurred.
4	EXE	Execution error. A command failed to execute correctly because
		a parameter was invalid.
5	CME	Command error. The parser detected a syntax error.
6		
7	PON	Power on. The unit has been power cycled.

The standard event status register may be queried with the *ESR? command. The standard event status enable register (*ESE) may be used to control the setting of the ESR summary bit in the serial poll status byte (*STB).

Questionable Status

Bits in the questionable status register warn the user when the validity of some instrument function is in question. For example, bit 0 of the questionable status register will be set until the GPS receiver has successfully decoded the time of day from the GPS satellites. Until this happens, all time of day information reported by the FS740 is invalid. Other bits in the questionable status register provide information on the frequency stability of the timebase.

The interpretation for bits in the questionable status register is shown in Table 10

Bit	Name	Meaning
0	Time of day	Instrument time of day has not been set by the GPS receiver. Absolute time measurements are invalid.
1	Warm up	The timebase is still warming up. Frequency drift will be much larger than normal.
2	Time unlock	The timebase is not locked to GPS. Time and frequency measurements may be degraded.
3		
4		
5	Freq stability	The timebase has not been locked to GPS long enough to reach optimum frequency stability.
6		
7		
8		
9		
10	Rb unlock	The installed Rb timebase is unlocked. Its frequency is not stable
11	Pll unlock	One of the internal Pll circuits in the FS740 has come unlocked. This may signal a need for instrument repair.
12	EFC 10MHz	Indicates that the frequency control of the internal TCXO is near the rail.
13	EFC GPS	Indicates that the frequency control for the installed timebase is saturated. This might indicate a large timing error.
14		
15		

Table 10: Interpretation of questionable status bits

The condition, event, and enable registers for questionable status are queried using the following commands, respectively.

```
STAT:QUES:COND?
STAT:QUES?
STAT:QUES:ENAB?
```

Operation Status

Bits in the operational status register provide information on the operation of the instrument. For example, bit 1 of the operational status register indicates that a hardware setting in the FS740 has changed. Most settings change quickly, so this bit will normally only be detected via the event register.

The interpretation for bits in the operational status register is shown in Table 11

Bit	Name	Meaning
0		
1	Setting	Hardware instrument settings are changing
2		
3		
4	Measure front	Measurement on front input in progress
5	Measure rear	Measurement on rear input in progress
6	Event front	Timing event detected on front input.
7	Event rear	Timing event detected on rear input.
8		
9		
10		
11		
12		
13		
14		
15		

 Table 11: Interpretation of operation status bits

Bits 4 and 5 indicate that a measurement is in progress on the given input. Both bits 4 and 5 must be false before the command *OPC? returns 1.

Bits 6 and 7 will only be set if the input is configured for a timing measurement, CONF:TIM, and a successful time tag is recorded on the configured input.

The condition, event, and enable registers for operational status are queried using the following commands, respectively.

STAT:OPER:COND?
STAT:OPER?
STAT:OPER:ENAB?

GPS Receiver Status

Bits in the GPS receiver status register provide information on the status of the GPS receiver and its ability to track the GPS satellites.

The interpretation for bits in the GPS receiver status register is shown in Table 12

Bit	Name	Meaning	
0	Time not set	Time of day information has not been received from the satellites, yet.	
1	Antenna open	The GPS antenna does not appear to be connected to the receiver input.	
2	Antenna short	The receiver input appears to be shorted.	
3	No satellites	No GPS satellites have been found	
4	UTC unknown	The UTC offset from GPS is unknown. The offset is recorded in the almanac which can take up to 15 minutes to download from the satellites.	
5	Survey in progress	A position survey is in progress.	
6	No position stored	No surveyed position has been stored in nonvolatile memory.	
7	Leap second pending	A leap second is pending. When pending, they are normally scheduled for the end of the day on June 30^{th} or December 31^{st} .	
8			
9	Position questionable	The stored position does not appear to be correct according to data now being collected. A new survey may need to be collected.	
10			
11	Almanac incomplete	A complete almanac has not been downloaded from the GPS satellites, yet. It can take up to 15 minutes of continuous tracking of satellites to download the almanac.	
12	No timing pulses	Timing pulses are not being generated by the receiver. Timing pulses must be generated in order for the FS740 to lock its timebase to GPS.	
13			
14			
15			

Table 12: Interpretation of GPS receiver status bits

The condition, event, and enable registers for GPS receiver status are queried using the following commands, respectively.

```
STAT:GPS:COND?
STAT:GPS?
STAT:GPS:ENAB?
```

Remote and Local Access Control

Normally, when a user sends commands over a remote interface, the FS740 will block front panel access to the unit. This behavior is called 'Remote Mode.' When in remote mode, the user can only regain front panel control by pressing the 'GO TO LOCAL' button on the front panel screen when it appears. This mode is useful when operating the FS740 within an automated test control environment in order to prevent an inadvertent change of settings while the unit is under remote control.

The FS740 can optionally be configured to operate in 'Local Mode.' In this mode the user maintains full front panel access, even when commands are simultaneously being executed over one of the remote interfaces. This mode is useful when the user is collecting data over a remote interface for long periods at regular intervals, but the user wants to monitor the progress of the data collection from the front panel. In this scenario, remote mode is burdensome because the user wants to regain front panel access, but the regular logging of data continually locks the user out even if he did regain control for a short period by pressing the 'GO TO LOCAL' button.

The FS740 always powers up in 'Remote Mode.' The user can switch back and forth between 'Remote Mode' and 'Local Mode' by executing one of two following commands:

```
REMote
LOCal
```

The first command puts the unit in 'Remote Mode,' the default. The second command puts the unit in 'Local Mode.' If you generally want to operate in 'Local Mode,' we suggest that you start your program with the LOCal command.

Making Measurements

The FS740 can make frequency and timing measurements of an external signal source. The front and rear inputs have independent circuitry enabling simultaneous measurements. All the measurement commands take an optional numerical suffix of 1 or 2. The value 1 refers to the front input. The value 2 refers to the rear input. If omitted, the front input is assumed. The SCPI language provides several ways to configure and initiate measurements, which vary in complexity and control.

Simple Measurements

The MEASure commands provide the simplest method of quickly configuring a measurement and reading the result in one command.

Syntax

```
MEASure[{1|2}]:FREQuency? [{<expected>|MINimum|MAXimum|DEFault}
  [,{<resolution>|MINimum|MAXimum|DEFault}]]
MEASure[{1|2}]:TIMe?
```

Description

The first version configures a frequency measurement with default parameters. The second version configures a measurement of time. In both cases the measurement is triggered immediately and the result sent directly to the output buffer. The frequency measurement takes two optional parameters. The first is an expected frequency for the measurement. If omitted, 10 MHz is assumed. The second is the desired resolution of the

measurement. If omitted, a resolution is selected such that the gate for the measurement will be 0.1 s resulting in about 11 digits of precision.

Examples

To make single measurements of frequency on the front and rear inputs, use the following commands:

MEAS:FREQ? MEAS2:FREQ?

Similarly, to make single measurements of time on the front and rear inputs, use the following commands:

MEAS:TIM? MEAS2:TIM?

Configure and Read

The MEASure commands configure a measurement and trigger it immediately. This does not allow the user to refine the measurement configuration. To enable finer control of the configuration, use the CONFigure and READ commands. The CONFigure commands have the same syntax and meaning as the MEASure commands discussed above, except that they are set commands rather than queries, reflecting the fact that the measurement is not triggered, and so no results will be forthcoming to read. The hardware for a given measurement is configured with default settings. The user should send additional commands to customize the configuration before the measurement is triggered. Once the configuration is complete, the user can trigger a measurement and read the result with the READ command.

Syntax

```
CONFigure[{1|2}]:FREQ [{<expected>|MINimum|MAXimum|DEFault}
   [, {<resolution>|MINimum|MAXimum|DEFault}]]
CONFigure[{1|2}]:TIMe
READ[{1|2}]?
```

Examples

To configure a frequency measurement on the front input with a 1 second gate, use the following commands:

```
CONF:FREQ
SENS:FREQ:GATE 1.0
READ?
```

The first line configures the front input for a frequency measurement with default settings. The second line changes the gate from the default to 1.0 seconds. The last line initiates the measurement and sends it to the output buffer for reading.

The next example configures the rear input for 10 timing measurements and triggers a measurement:

```
CONF2:TIM
SAMP2:COUN 10
READ2?
```

The first line configures the rear input for an absolute time measurement. The second line changes the sample size of the measurement to 10. The last line initiates the measurement and sends the results to the output buffer for reading.

Initiate and Fetch

The READ command discussed above triggers a measurement and sends the results immediately to the output. This is the desired result in most cases. However, sometimes it is useful to separate the initiation of the measurement and the reading of the results. This is achieved with the INITiate and FETCh commands. The initiate triggers a measurement but does not send the results to the output buffer. Instead they are sent to an internal memory buffer, which has enough space to hold the last 250,000 results. The FETCh command causes the results to be copied from the internal memory to the output buffer. A READ command is equivalent to an INITiate followed immediately by a FETCh.

Syntax

```
INITiate[{1|2}][:IMMediate]
FETCh[{1|2}]?
```

Separating measurement initiation from the reading of the results is particularly useful when the measurement takes a long time or the sample size is large. In the former case, separating the INITiate from the FETCh enables the user to query the status registers to monitor the progress of the measurement without having to depend on long timeouts and an unresponsive unit. In the latter case when the sample size is large, it may be that the user is uninterested in the individual results and only wants to query the statistics for the measurement. In this case the FETCH command need not be sent at all. Instead, the CALC:STAT command is sent after all measurements complete.

Like the READ command, the FETCh command won't complete until all samples in the measurement have completed. For large data sets this may be undesirable. In this case the user can use the DATA subsystem to query how much data is available and read only a portion of the data at a time.

Common IEEE-488.2 Commands

*CLS

Clear Status

Syntax

*CLS

Description

This command immediately clears all status registers as well as the SYST:ERR queue.

*ESE

Standard Event Status Enable

Syntax

*ESE <value> *ESE?

Description

Set the Standard Event Status Enable register to <value>. The value may range from 0 to 255. Bits set in this register cause ESR (in *STB) to be set when the corresponding bit is set in the *ESR register. The query returns the current value of the enable register. Definitions for the bits in the standard event register are given on page 84.

Example

*ESE 1

Enable bit 0 so that an operation complete event will set the ESR bit in the serial poll status byte.

*ESR?

Standard Event Status Register

Syntax

*ESR?

Description

Query the Standard Event Status Register. After the query, the returned bits of the *ESR register are cleared. The bits in the ESR register have the following meaning:

- Bit Meaning
- 0 OPC operation complete
- 1 Reserved
- 2 QYE query error
- 3 DDE device dependent error
- 4 EXE execution error
- 5 CME command error
- 6 Reserved
- 7 PON power-on

See page 84 for more detailed information on the event status register.

Example

*ESR?

A return of '176' would indicate that PON, CME, and EXE are set.

*IDN?

Syntax

*IDN?

Description

Query the instrument identification string.

Example

*IDN?

Returns a string similar to 'Stanford Research Systems, FS740, s/n004025, ver2.26.11'

*OPC

Operation Complete

Identification String

Syntax

*OPC *OPC?

Description

The set form sets the OPC flag in the *ESR register when all prior commands have completed. The query form returns '1' when all prior commands have completed, but does not affect the *ESR register.

*OPT?

Options

Syntax

*OPT?

Description

The query returns a comma separated list of the four possible installed options in the following order: installed timebase, top rear panel board, middle rear panel board, and bottom rear panel board. They may take on the following values:

Туре	Option	Value
Timebase	TCXO	0
	OCXO	1
	Rb	2
Board	10 MHz distribution	Α
	Sine/Aux output distribution	В
	Pulse output distribution	C
	Not installed	D

Example

*OPT?

The query returns the current installed options. A return of "2,A,B,C" would indicate that a Rb timebase is installed; a 10 MHz distribution board is installed in the top slot; a Sine/Aux distribution board is installed in the middle slot; a pulse distribution board is installed in the bottom slot.

Power-on Status Clear

Syntax

*PSC <value> *PSC?

Description

Set the Power-on Status Clear flag to <value>. The Power-on Status Clear flag is stored in nonvolatile memory in the unit, and thus, maintains its value through power-cycle events.

If the value of the flag is 0, then the Service Request Enable and Standard Event Status Enable Registers (*SRE, *ESE) are stored in non-volatile memory, and retain their values through power-cycle events. If the value of the flag is 1, then these two registers are cleared upon power-cycle.

Example

Use the following commands to set power on status clear to 1 and then query the setting.

*PSC 1 *PSC?

*RCL

Recall Instrument Settings

Syntax

*RCL <location>

Description

Recall instrument settings from <location>. The <location> may range from 0 to 9. Locations 1 to 9 are for arbitrary use. Location 0 is reserved for the recall of default instrument settings.

Example

*RCL 3

Recall instruments settings from location 3.

*RST

Reset Instrument

Syntax

*RST

Description

Reset the instrument to default settings. This is equivalent to *RCL 0. See Factory Default Settings on page 69 for a list of default settings.

*SAV

Save Instrument Settings

Syntax

*SAV <location>

Description

Save instrument settings to <location>. The <location> may range from 0 to 9. However, location 0 is reserved for current instrument settings. It will be overwritten after each front panel key press.

*PSC

Example

*SAV 3

Save current instrument settings to location 3.

*SRE

Service Request Enable

Status Byte

Syntax

*SRE <value> *SRE?

Description

Set the Service Request Enable register to <value>. Bits set in this register cause the FS740 to generate a service request when the corresponding bit is set in the serial poll status register, *STB.

Example

*SRE 16

Set bit 4 of the enable register. This will generate a service request when the FS740 has bytes in its output buffer ready to be read. Definitions for the bits in the serial poll status byte are given on page 82.

*STB?

Syntax

*STB?

Description

Query the standard IEEE 488.2 serial poll status byte. The bits in the STB register have the following meaning:

- <u>Bit</u> <u>Meaning</u>
- 0 Reserved
- 1 GPS status summary bit
- 2 Error queue is not empty
- 3 Questionable status summary bit
- 4 Message available, MAV.
- 5 ESR status summary bit
- 6 MSS master summary bit
- 7 Operational status summary bit

See page 82 for more detailed information on the serial poll status byte.

Example

*STB?

A return of '114' would indicate that GPS, MAV, ESR, and MSS are set. GPS indicates that an enabled bit in STAT:GPS is set. MAV indicates that a message is available in the output queue. ESR indicates that an enabled bit in the *ESR is set. MSS reflects the fact that at least one of the summary enable bits is set and the instrument is requesting service.

*WAI

Wait for Command Execution

Syntax

*WAI

Description

The instrument will not process further commands until all prior commands including this one have completed.

Example

*WAI

Wait for all prior commands to execute before continuing.

Remote and Local Control Commands

Remote and local control commands control the behavior of the FS740 while it is executing remote commands. In remote mode, the default, front panel access is blocked when remote commands are being executed until the user presses the 'GO TO LOCAL' button. In local mode, there is no such restriction and front panel access is allowed, even when remote commands are being executed. For more information about these modes, see section Remote and Local Access Control on page 88.

LOCal

Syntax

LOCal

Description

Go to local mode. In this mode front panel access is enabled even when remote commands are being executed.

LOCal:KEY

Press Local Key

Go to Remote Mode

Go to Local Mode

Syntax

LOCal:KEY

Description

This is command is equivalent to pressing the 'GO TO LOCAL' button on the front panel. It does not put the instrument into local mode, but it does all the user front panel access until the next command is executed.

REMote

Syntax

REMote

Description

Go to remote mode. The FS740 powers up in this mode. In this mode front panel access is blocked when remote commands are being executed.

Measurement Commands

Measurement commands can apply to either the front or rear input. The user selects the input by optionally appending a 1 or 2 to the root keyword of the command. When the suffix is 1 or omitted, the front input is selected. When the suffix is 2, the rear input is selected. For example, the following commands all apply to the front input:

```
MEAS:FREQ?
CONF1:TIM
READ1?
CONF:FREQ
INIT1
FETC?
```

Notice that the suffix is optional when referring to the front input. Modify the commands as follows to make them apply to the rear input:

```
MEAS2:FREQ?
CONF2:TIM
READ2?
CONF2:FREQ
INIT2
FETC2?
```

Here, the suffix is required.

MEASure:FREQuency?

Measure Frequency

Syntax

MEASure[{1|2}]:FREQuency? [{<expected>|MINimum|MAXimum|DEFault}
[, {<resolution>|MINimum|MAXimum|DEFault}]]

Description

Configures hardware for a frequency measurement and immediately triggers a measurement and sends the result to the output buffer. The first parameter is optional and informs the instrument of the expected frequency of the signal. The second parameter is also optional. It sets the requested resolution of the measurement. Neither parameter is used directly by the FS740. Instead the ratio of the resolution to the expected frequency is used to set the gate time for the measurement. If the parameters are omitted, a gate time of 0.1 second is used which corresponds to approximately 11 digits of precision. Measurements are returned as floating point values in units of Hz. If a measurement times out NAN is returned.

Example

MEAS:FREQ?

Configure a frequency measurement on the front panel input, using the default 0.1 s gate. Trigger the measurement immediately and send the result to the output buffer for reading.

MEASure:TIMe?

Measure Time

Syntax

MEASure[{1|2}]:TIMe?

Description

Configures hardware for a measurement of time and immediately triggers a measurement and sends the result to the output buffer. A single result consists of 11 comma separated integer values in the

following order: timing metric, year, month, day, hour, minute, seconds, milliseconds, microseconds, nanoseconds, picoseconds. The timing metric is a copy of the questionable status register at the time of the measurement.

Example

MEAS2:TIM?

Configure a measurement of time on the rear panel input. Trigger the measurement immediately and send the result to the output buffer for reading.

CONFigure?

Configure

Syntax

CONFigure[{1|2}]?

Description

Query the current measurement configuration. The command returns a quoted string with the measurement type and parameters used to configure the measurement.

Example

CONF:FREQ CONF?

Configure a measurement of frequency on the front panel input. The query will return: FREQ 1.0e+07,1.0e-04.

CONFigure:FREQuency

Configure Frequency

Syntax

CONFigure[{1|2}]:FREQuency [{<expected>|MINimum|MAXimum|DEFault}
[, {<resolution>|MINimum|MAXimum|DEFault}]]

Description

Configure the hardware for a frequency measurement. This is identical to the MEASure command except that the measurement isn't triggered and sent to the output buffer. Like the MEASure command, the first parameter is optional and informs the instrument of the expected frequency of the signal. The second parameter is also optional. It sets the requested resolution of the measurement. Neither parameter is used directly by the FS740. Instead the ratio of the resolution to the expected frequency is used to set the gate time for the measurement. If the parameters are omitted, a gate time of 0.1 second is used which corresponds to approximately 11 digits of precision. Measurement results are returned with a READ command as floating point values in units of Hz. If a measurement times out, NAN is returned.

Example

```
CONF:FREQ
SENS:FREQ:GATE 1.0
READ?
```

Configure a frequency measurement on the front panel input, using the default 0.1 s gate. Then change the gate to 1.0 s. Finally trigger a measurement and read the result.

CONFigure:TIMe

Configure Time

Syntax

CONFigure[{1|2}]:TIMe

Description

Configures hardware for a measurement of time and immediately triggers a measurement and sends the result to the output buffer. Results are returned with a READ command. A single result consists of 11 comma separated integer values in the following order: timing metric, year, month, day, hour, minute, seconds, milliseconds, microseconds, nanoseconds, picoseconds. The timing metric is a copy of the questionable status register at the time of the measurement.

Example

CONF2:TIM SAMP2:COUN 10 READ2?

Configure a measurement of time on the rear panel input. Change the sample count from 1 to 10. Finally trigger the measurement and read the results.

READ?

Read Results

Syntax

READ[{1|2}]?

Description

Trigger a measurement using the current configuration and read the result. See commands MEASure:FREQuency and MEASure:TIMe for details on the format of results returned. When the sample size is greater than one, results are separated from each other by commas (,).

Example

```
CONF:FREQ
SENS:FREQ:GATE 1.0
READ?
```

Configure a measurement of frequency on the front panel input. Then change the gate time for the measurement to 1.0 s. Finally trigger the measurement and read the result.

INITiate

Initiate Measurement

Syntax

INITiate[{1|2}][:IMMediate]

Description

Trigger a measurement using the current configuration but leave the results in internal memory. The internal memory has enough space to store the last 250,000 measurements. The user should send the FETCh command to retrieve the results from internal memory. Alternatively, the user may use commands in the DATA subsystem to read only a portion of the results.

Example

```
CONF:FREQ
SAMP:COUN 1000
INIT
FETC?
```

Configure a measurement of frequency on the front panel input using default settings. Then change the sample count from 1 to 1000. Then initiate a measurement. Finally read out the results.

FETCh?

Fetch Results

Syntax

FETCh[{1|2}]?

Description

Copy results stored in the internal buffer to the output buffer for reading. Like the READ command, this command will not complete until all measurements have completed. See commands MEASure:FREQuency and MEASure:TIMe for details on the format of results returned. When the sample size is greater than one, results are separated from each other by commas (,).

Example

```
CONF:FREQ
SAMP:COUN 1000
INIT
FETC?
```

Configure a measurement of frequency on the front panel input using default settings. Then change the sample count from 1 to 1000. Next initiate a measurement. Finally read out the results, which should contain 1000 frequency measurements.

ABORt

Abort Measurement

Syntax

ABORt[{1|2}]

Description

Abort any measurement in progress and discard any results produced by it.

Example

ABOR

Abort any measurement initiated on the front input.

STOP

Stop Measurement

Syntax

STOP[{1|2}]

Description

Stop any measurement in progress, but do not discard any results produced by it.

Example

CONF:FREQ SAMP:COUN 1000 INIT STOP FETC? Configure the front input for a frequency measurement. Change the sample count to 1000. Initiate the measurement. Stop the measurement but do not discard any results already produced. Fetch those results

Calculate Subsystem

Commands in the Calculate Subsystem can apply to either the front or rear input. The user selects the input by optionally appending a 1 or 2 to the CALCulate keyword. When the suffix is 1 or omitted, the front input is selected. When the suffix is 2, the rear input is selected.

CALCulate:FILTer

Calculation Filter

Syntax

CALCulate[{1|2}]:FILTer {NONE|FAST} CALCulate[{1|2}]:FILTer?

Description

The first definition changes input filter for frequency measurements. The second definition queries the current input filter. There are two filter options: NONE and FAST. If NONE is selected, then just two time tags are used to generate a frequency measurement, one at the beginning of the gate interval and one at the end. When the FAST filter is selected, up to 625 time tags are averaged together at the beginning of the gate interval to produce an average starting time tag. Another 625 time tags are averaged together at the end of the gate interval to produce an average ending time tag. These two averaged time tags are used to compute a frequency measurement. The benefit of this filter is that it is effective in removing broadband noise inherent in the measurement. Noise can be reduced by more than a factor of 10 with the use of this filter. The default filter is FAST and it is the recommended setting for most measurements. The following example shows how to turn off the filter, if desired.

Example

CONF:FREQ CALC:FILT NONE READ?

Configure front input for a frequency measurement. Turn off the FAST filter. Trigger a measurement and read the results.

CALCulate:REFerence

Calculation Reference Frequency

Syntax

```
CALCulate[{1|2}]:REFerence [{<frequency>|MINimum|MAXimum|DEFault}]
CALCulate[{1|2}]:REFerence?
```

Description

For each frequency measurement, the reference frequency is subtracted from the measured frequency to produce the final result. This enables one to monitor the deviation of the frequency from a specified target value rather than the absolute frequency itself. The first definition sets the reference frequency to <frequency>. If <frequency> is omitted, it is set to the value of the most recent measurement. The second definition queries the current reference frequency. The default reference frequency is 0 Hz.

Example

CONF:FREQ CALC:REF 10MHz READ?

Configure front input for a frequency measurement. Set the reference frequency to 10 MHz. Measure the deviation of the input from 10MHz.

CALCulate:STABility

Calculate Frequency Stability

Syntax

CALCulate[{1|2}]:STABility[:ALL]?

Description

This command computes the frequency stability, or Allan deviation, of all frequency measurements for time intervals from 10 ms to 50 million seconds in a 1, 2, 5 sequence and returns them as a comma delimited list of relative Allan deviations. The first is the computed stability for a 10 ms interval. The second is for a 20 ms interval. The third is for a 50 ms interval and so forth. Each succeeding stability measurement is for an interval that increases in a 1, 2, 5 sequence with the 30th value corresponding to an interval of 50 million seconds. If the data set is not large enough to compute a valid stability for a given interval, zero is returned for that entry. Note that the FS740 is computing averaged time tags every 10 ms with no dead time, regardless of the configured gate. This enables the FS740 to compute the frequency stability for all time intervals, not just the configured gate interval. Furthermore, the user need not wait for the measurement to complete before sending this command. It will return the computed stability of all measurements completed at the time of the query.

Example

```
CONF:FREQ
SENS:FREQ:GATE 1.0
SAMP:COUN 1000000
INIT
...
CALC:STAB?
```

Configure front input for a frequency measurement. Set the gate to 1.0 s and the sample size to 1 million. Start the measurement. Wait. Then query the computed frequency stability of the measurements. Note that one need not wait for the measurement to complete. The FS740 will return the computed stability for all measurements completed so far.

CALCulate:STATistics

Calculate Measurement Statistics

Syntax

```
CALCulate[{1|2}]:STATistics[:ALL]?
```

Description

This command computes some basic statistics of the current measurement and returns the following values in a comma separated list: the mean, the Allan deviation, the minimum, the maximum, and the number of measurements made. The statistical values returned are in Hz, including the Allan deviation. To get a relative stability, divide the returned Allan deviation by the mean. The Allan deviation returned is only for the configured gate interval, and is computed only from the measurements stored in internal memory. This is in contrast to the results returned by the CALC:STAB command which incorporates many more time tags not included in the frequency measurements stored in internal memory.

Example

```
CONF:FREQ
SENS:FREQ:GATE 1.0
SAMP:COUN 1000
INIT
...
CALC:STAT?
```

Configure front input for a frequency measurement. Set the gate to 1.0s and the sample size to 1000. Start the measurement. Wait. Then query the statistics for the measurements. Note that one need not wait for the measurement to complete. The FS740 will return the computed statistics for all measurements completed so far.

Data Subsystem

FS740 has enough internal memory to store 250,000 results for both the front and rear input. The Data Subsystem enables the user to query and process these results. Commands in the Data Subsystem can apply to either the front or rear input. The user selects the input by optionally appending a 1 or 2 to the DATA keyword. When the suffix is 1 or omitted, the front input is selected. When the suffix is 2, the rear input is selected.

DATA:COUNt?

Data Count

Syntax

DATA[{1|2}]:COUNt?

Description

This command returns the total number of measurements completed so far.

Example

```
CONF:FREQ
SAMP:COUN 100
INIT
...
DATA:COUN?
```

Configure front input for a frequency measurement. Set the sample size to 100. Start the measurement. Wait. Then query the number of measurements completed for the front input. When all measurements are complete, the returned value should agree with the configured sample count.

DATA:POINts?

Data Points

Syntax

```
DATA[{1|2}]:POINts?
```

Description

This command returns the total number of measurements stored in internal memory. This number may differ from the DATA:COUNT if some data has been removed with a DATA:REM command or if the total number of measurements causes the internal memory to overflow. In the latter case, only the most recent measurements are kept. The internal memory has space to store up to 250,000 measurements.

Example

CONF2:FREQ

```
SAMP2:COUN 100
INIT2
...
DATA2:POIN?
```

Configure rear input for a frequency measurement. Set the sample size to 100. Start the measurement. Wait. Then query the number of measurements stored in internal memory for the rear input. These values may be read immediately using a DATA:READ or DATA:REM command.

DATA:READ?

Data Read

Syntax

DATA[{1|2}]:READ? [<index>][,<count>]

Description

This command returns <count> measurements stored in internal memory, starting with the one located at <index>. The first measurement in memory has an <index> of 0. The second has an <index> of 1, and so on. The user should send the DATA:POIN command to determine how many measurements are stored in memory. If omitted, <index> is assumed to be 0. If omitted, <count> is assumed to be 1. If <index> or <count> is out of range, error -222, "Data out of range," is generated and no data returned. See commands MEASure:FREQuency and MEASure:TIMe for details on the format of results returned. When the sample size is greater than one, results are separated from each other by commas (,).

Example

```
CONF2:FREQ
SAMP2:COUN 100
INIT2
...
DATA2:POIN?
DATA2:READ? 10, 5
```

Configure rear input for a frequency measurement. Set the sample size to 100. Start the measurement. Wait. Then query the number of measurements stored in internal memory for the rear input. Retrieve 5 measurements starting with the measurement at index 10.

DATA:REMove?

Data Remove

Syntax

DATA[{1|2}]:REMove? <count>

Description

This command returns the first <count> measurements stored in internal memory and removes them from memory. If the requested <count> exceeds the amount of data available, error -222, "Data out of range," is generated and no data is returned. This command is useful if the configured sample count is larger than can be stored in internal memory. It enables the user to retrieve measurements as they become available to free up space in internal memory so that no measurement results are lost. See commands MEASure:FREQuency and MEASure:TIMe for details on the format of results returned. When the sample size is greater than one, results are separated from each other by commas (,).

Example

CONF:FREQ SAMP:COUN 1000000 INIT

```
DATA:POIN?
DATA:REM? 100
```

Configure front input for a frequency measurement. Set the sample size to 1 million. Start the measurement. Wait. Then query the number of measurements stored in internal memory for the front input. Retrieve the first 100 measurements and remove them from memory.

GPS Subsystem

Commands in the GPS Subsystem enable configuration of the GPS receiver and report on its operation.

GPS:CONFig:CONStellation

GPS Configure Constellation

Syntax

```
GPS:CONFig:CONStellation <constellation mask>
GPS:CONFig:CONStellation?
```

Description

The first definition enables the user to set the combination of satellites tracked. The second definition queries the current combination of satellites being tracked. The constellation mask is a single number from 1 to 15 whose binary bits identify the combination of satellites that should be tracked as identified in Table 13. The default constellation mask is 3, which has bits 0 and 1 set, meaning GPS and GLONASS will be tracked. The user must execute the command GPS:CONF:SAVE to save the current values to nonvolatile memory. Note that not all combinations are supported. If an unsupported combination is requested, the command will be ignored without reporting an error.

Bit	Constellation
0	GPS
1	GLONASS
2	BEIDOU
3	GALILEO

Table 13: Constellation bit definitions

Example

GPS:CONF:CONS 3

Configure the GNSS receiver to track GPS and GLONASS.

GPS:CONFig:MODe

GPS Configure Mode

Syntax

```
GPS:CONFig:MODe <anti-jamming>, <elevation mask>, <signal mask>
GPS:CONFig:MODe?
```

Description

The first definition enables the user to set anti-jamming mode, the elevation mask and the signal mask. The second definition queries the current values for these parameters. <Anti-jamming> is a Boolean value which enables or disables anti-jamming in the receiver. The factory default is enabled. <Elevation mask> is the elevation angle in radians, below which satellites are ignored in over determined clock mode. It can range from 0 to $\pi/2$. <Signal mask> is the minimum signal level in

dbHz, below which satellites are ignored in over determined clock mode. It can range from 0 to 55 dBHz. The default value for both masks is 0. The user must execute the command GPS:CONF:SAVE to save the current values to nonvolatile memory.

Example

GPS:CONF:MODE 1,0.2618,10

Enable anti-jamming. Set elevation mask to 15 degrees = 0.2618 radians. Set the minimum signal level to 10 dbHz. These limits only apply in over determined clock mode.

GPS:CONFig:SAVe

GPS Configure Save

Syntax

GPS:CONFig:SAVe

Description

The user uses commands in the GPS:CONFIG subsystem to configure the operation of the receiver. The configuration is lost, however, if the power is cycled unless this command is executed. It saves the current GPS receiver configuration to nonvolatile memory, so that it may be automatically recalled when the power is cycled.

Example

GPS:CONF:SAV

Save the current GPS receiver configuration to nonvolatile memory.

GPS:CONFig:SURVey:Mode

GPS Configure Survey Mode

Syntax

```
GPS:CONFig:SURVey[:MODe] [{DISabled|REDo|REMember}]
GPS:CONFig:SURVey[:MODe]?
```

Description

The first definition sets the GPS survey mode to the given configuration. If mode is omitted, the default mode is REDo. The second definition queries the current GPS survey mode. When DISabled is selected no survey is carried out. This mode is appropriate in mobile environments. REDo causes the survey to be repeated each time the instrument is power cycled. REMember causes the results of the survey to be saved in nonvolatile memory. When the instrument is power cycled, the surveyed position is recalled from memory and the survey is not repeated. The user must execute the command GPS:CONF:SAVE to save the current value to nonvolatile memory.

Example

GPS:CONF:SURV REM

Configure the GPS receiver to do a survey at startup the first time, but to remember the results of the first survey from then on rather than repeating the survey.

GPS:CONFig:SURVey:FIXes

GPS Configure Survey Fixes

Syntax

```
GPS:CONFig:SURVey:FIXes [<fixes>]
GPS:CONFig:SURVey:FIXes?
```

Description

The first definition sets the number of position fixes in the survey. If <fixes> is omitted, the default number is 2000. The second definition queries the current number of position fixes in the position survey. This is the number of position fixes that get averaged together to define the GPS antennas location. Once the position is well known, the receiver can be put into over determined clock mode and the receiver can provide improved timing by dedicating the signal from all satellites to timing. The user must execute the command GPS:CONF:SAVE to save the current value to nonvolatile memory.

Example

GPS:CONF:SURV:FIX 3000

Configure the GPS receiver to include 3000 position fixes in the position survey.

GPS:CONFig:ALIGnment

GPS Configure Timing Alignment

Syntax

```
GPS:CONFig[:TIMing]:ALIGnment [{GPS|UTC}]
GPS:CONFig[:TIMing]:ALIGnment?
```

Description

The first definition sets the GPS 1pps alignment. If alignment is omitted, the default alignment is UTC. The second definition queries the current GPS 1pps alignment. When GPS is selected, all timing is aligned to GPS. When UTC is selected, all timing is aligned to UTC. The user must execute the command GPS:CONF:SAVE to save the current value to nonvolatile memory.

Example

GPS:CONF:ALIG UTC

Alignment of the GPS 1pps is to UTC.

GPS:CONFig:QUALity

GPS Configure Timing Quality

Syntax

GPS:CONFig[:TIMing]:QUALity [{1SAT|3SAT}]
GPS:CONFig[:TIMing]:QUALity?

Description

The first definition sets the minimum number of satellites the receiver must track before outputting a hardware 1pps pulse. If omitted, the default quality is 3 satellites. The second definition queries the current timing quality. Timing quality generally increases as the number of satellites increases. However, the user must also consider reliability and holdover performance. Degraded performance may be preferred over no timing whatsoever. The user must execute the command GPS:CONF:SAVE to save the current value to nonvolatile memory.

Example

GPS:CONF:QUAL 3SAT

Require the GPS receiver to track 3 satellites before outputting a hardware 1pps pulse for the timebase to track.

GPS:CONFig:ADELay

GPS Configure Timing Antenna Delay

Syntax

```
GPS:CONFig[:TIMing]:ADELay <delay>
GPS:CONFig[:TIMing]:ADELay?
```

Description

The first definition sets the antenna delay to $\langle delay \rangle$ in seconds. The second definition queries the current antenna delay in seconds. The $\langle delay \rangle$ may range from -0.1 s to +0.1 s. Note that the user should enter a negative number here to compensate for the length of their antenna cable. It affects the timing of all inputs and outputs. The user must execute the command GPS:CONF:SAVE to save the current value to nonvolatile memory.

Example

```
GPS:CONF:ADEL -100ns
```

Set delay to -100 ns. This advances the timing generated by the GPS receiver by 100 ns.

GPS:POSition?

GPS Position

Syntax

GPS:POSition?

Description

Query the GPS position. This routine returns the surveyed average position of the receiver in latitude, longitude, and altitude. Latitude is specified in radians, with positive values indicating north, and negative values indicating south. Longitude is specified in radians, with positive values indicating east, and negative values indicating west. Altitude is specified in meters above average sea levels.

Example

GPS:POS?

Query the current surveyed position of the GPS receiver.

GPS:POSition:HOLD:STATe?

GPS Position Hold State

Syntax

GPS:POSition:HOLD:STATe?

Description

Query whether the GPS receiver is in position hold mode where all satellites are being used for maximum timing performance. The query will return 1 if the receiver is in position hold mode, otherwise 0. The receiver typically enters position hold mode once the position survey is complete.

Example

GPS:POS:HOLD:STAT?

Query whether the GPS receiver has entered position hold mode.

GPS:POSition:SURVey:DELete

GPS Position Survey Delete

Syntax

GPS:POSition:SURVey:DELete

GPS Position Survey Progress

Description

Delete the surveyed position stored in nonvolatile memory, if any.

Example

GPS:POS:SURV:DEL

Delete the current stored position in nonvolatile memory.

GPS:POSition:SURVey:PROGress?

Syntax

GPS:POSition:SURVey:PROGress?

Description

Query how much of the position survey has completed. The FS740 will return an integer between 0 and 100 %.

Example

GPS:POS:SURV:PROG?

Query the progress of the position survey by the GPS receiver.

GPS:POSition:SURVey:SAVe

GPS Position Survey Save

Syntax

GPS:POSition:SURVey:SAVe

Description

Save the current position in nonvolatile memory. The receiver will subsequently use it to enter position hold mode where all satellites are used for maximum timing performance.

Example

GPS:POS:SURV:SAV

Save the current position in nonvolatile memory.

GPS:POSition:SURVey:STARt

GPS Position Survey Start

Syntax

GPS:POSition:SURVey:STARt

Description

Restart the GPS receiver's position survey. Note that previously saved results are not deleted by this command.

Example

GPS:POS:SURV:STAR

Restart the GPS receiver's position survey.

GPS:POSition:SURVey:STATe?

GPS Position Survey State

SRS Stanford Research Systems

FS740 GPS Time and Frequency System

Syntax

GPS:POSition:SURVey:STATe?

Description

Query whether a position survey is in progress or not. The query returns 1 if the survey is in progress, otherwise 0.

Example

GPS:POS:SURV:STAT

Query whether a position survey is in progress.

GPS:SATellite:TRACking?

GPS Satellite Tracking

Syntax

GPS:SATellite:TRACking?

Description

Query which GPS satellites are being tracked by the receiver. The query returns the number of satellites being tracked, followed by the IDs of the satellites as a comma (,) separated list.

Example

GPS:SAT:TRAC?

Query the number and IDs of the satellites being tracked by the receiver.

GPS:SATellite:TRACking:STATus?

GPS Satellite Tracking Status

Syntax

GPS:SATellite:TRACking:STATus?

Description

The receiver has 20 channels for tracking satellites. This command returns the information shown in Table 14 for each channel, successively:

Table 14:	Satellite	tracking	information
-----------	-----------	----------	-------------

Index	Parameter
0	Satellite ID number
1	Acquired
2	Ephemeris
3	Is old
4	Signal level in dbHz
5	Elevation in degrees
6	Azimuth in degrees
7	Space vehicle type

If a channel is not tracking a satellite, it will return zero for all parameters. In all, $20 \times 8 = 160$ parameters are returned as a comma (,) separated list.

Example

GPS:SAT:TRAC:STAT?

Return tracking information on all satellites being followed.

GPS:UTC:OFFSet?

GPS UTC Offset

Syntax

GPS:UTC:OFFSet?

Description

Query the current offset between UTC and GPS in seconds. As of January 1, 2017, UTC, which has leap seconds inserted intermittently, is 18 seconds behind GPS which does not have leap seconds inserted. Note that this command will return 0 until the time of day has been set properly.

Example

GPS:UTC:OFFS?

Query the current offset between UTC and GPS in seconds.

Input Subsystem

Commands in the Input Subsystem can apply to either the front or rear input. The user selects the input by optionally appending a 1 or 2 to the DATA keyword. When the suffix is 1 or omitted, the front input is selected. When the suffix is 2, the rear input is selected.

INPut:LEVel

Input Trigger Level

Input Trigger Slope

Syntax

```
INPut[{1|2}]:LEVel {<level>|MINimum|MAXimum|DEFault}
INPut[{1|2}]:LEVel?
```

Description

The first definition sets the input trigger level to <level> in volts. The second definition queries the current input trigger level. The <level> may vary from -3.0 to +3.0 V. The default trigger level is 0.0 V.

Example

INP:LEV 1.0 INP2:LEV 2.0 INP:LEV?

Set the trigger level from the front input to 1.0 V. Set the trigger level for the rear input to 2.0 V. Then query the current trigger level for the front input.

INPut:SLOPe

Syntax

```
INPut[{1|2}]:SLOPe {NEGative|POSitive|DEFault}
INPut[{1|2}]:LEVel?
```

Description

The first definition sets the input trigger slope to the desired polarity. The second definition queries the current input trigger slope. The default trigger slope is positive.

Example

```
INP:SLOP POS
INP2:SLOP NEG
INP:SLOP?
```

Set the front input trigger slope to positive. Set the rear input trigger slope to negative. Then query the current trigger slope for the front input.

Route Subsystem

Commands in the Route Subsystem enable the users to configure the routing of signals to the Sine/Aux option boards. The rear panel of the FS740 accepts the installation of 1 to 3 option boards for the distribution of 10 MHz, the Sine/Aux outputs, or the Pulse outputs. The Sine/Aux option boards can distribute either the Sine outputs or the Aux outputs. Commands in the Route Subsystem enable the user to select which signal to distribute on these boards.

ROUTe:OPTion

Route Option

Syntax

```
ROUTe:OPTion[{1|2|3}] [{SINe|AUX}]
ROUTe:OPTion[{1|2|3}]?
```

Description

The first definition sets the desired distribution signal for the given option. The second definition returns the current routing for the given option. These values only have significance if a Sine/Aux option is actually installed in the appropriate slot. This value is not affected by a *RST and is stored in nonvolatile memory so that it is automatically recalled when the instrument is power cycled.

Example

ROUT:OPT1 AUX ROUT:OPT2 SIN

Route the Aux signal to be distributed on option 1. Route the Sine signal to be distributed on option 2.

Sample Subsystem

Commands in the Sample Subsystem can apply to either the front or rear input. The user selects the input by optionally appending a 1 or 2 to the SAMPle keyword. When the suffix is 1 or omitted, the front input is selected. When the suffix is 2, the rear input is selected.

SAMPle:COUNt

Sample Count

Syntax

```
SAMPle[{1|2}]:COUNt {<count>|MINimum|MAXimum|DEFault}
SAMPle[{1|2}]:COUNt?
```

Description

The first definition changes the number of samples for a configured measurement to <count>. The second definition queries the current sample count. The <count> may vary from 1 to 1,000,000,000. The default count is 1.

Example

```
CONF:FREQ
SAMP:COUN 1000
READ?
```

Configure front input for a frequency measurement. Change the sample count to 1000. Trigger a measurement and read the results. The following command queries the current sample count for the rear input.

SAMP2:COUN?

Sense Subsystem

The Sense Subsystem enables the user to refine the selected measurement configuration. Commands in the Sense Subsystem can apply to either the front or rear input. The user selects the input by optionally appending a 1 or 2 to the SENSe keyword. When the suffix is 1 or omitted, the front input is selected. When the suffix is 2, the rear input is selected.

SENSe:FREQuency:GATE

Frequency Gate Interval

Syntax

SENSe[{1|2}]:FREQuency:GATE[:TIME] {<duration>|MINimum|MAXimum|DEFault} SENSe[{1|2}]:FREQuency:GATE[:TIME]? [{MINimum|MAXimum|DEFault}]

Description

The first definition sets gate interval for frequency measurements to <duration> in seconds. The gate interval may range from 10 ms to 1000 s. The default is 0.1 s. The user may alternatively use the keywords to set the duration to the desired limit. The second definition queries the current gate interval when the optional keywords are omitted. Otherwise, the specified limit is returned.

Example

```
CONF:FREQ
SENS:FREQ:GATE 1.0
CONF2:FREQ
SENS2:FREQ:GATE MIN
SENS2:FREQ:GATE?
READ?
READ2?
```

Configure the front input for frequency measurements. Set the gate interval to 1.0 for the front input. Configure the rear input for frequency measurements. Set the gate interval to the minimum allowed value for the rear input. Then query the current gate interval for the rear input. Trigger a frequency measurement and read the result for the front input. Trigger a frequency measurement and read the result for the rear input.

SENSe:FREQuency:TIMeout

Frequency Timeout

Syntax

```
SENSe[{1|2}]:FREQuency:TIMeout {<timeout>|MINimum|MAXimum|DEFault|INFinity}
SENSe[{1|2}]:FREQuency:TIMeout? [{MINimum|MAXimum|DEFault}]
```

Description

The first definition sets time out period for frequency measurements to <timeout> in seconds. The timeout may range from 10 ms to 2000 s. The default is 1.0 s. The user may alternatively use the

keywords to set the duration to the desired limit. The second definition queries the current frequency time out period when the optional keywords are omitted. Otherwise, the specified limit is returned.

Note that measurement time outs are tied to the arrival of triggers on the input. A measurement will time out if the arrival between two successive edges on the input exceeds the time out interval. With this scheme, one need not worry about configuring time outs for most signals. For the default time out of 1 s, a time out will not occur if the signal frequency is greater than 1 Hz, regardless of the configured gate interval. Total measurement time, however, will closely follow the gate interval in most cases.

When a time out does occur during a frequency measurement, the FS740 returns NAN for that sample, and moves onto the next sample in the set of measurements. NAN is defined by SCPI to be 9.91e37.

Example

```
CONF:FREQ
SENS:FREQ:GATE 20.0
SENS:FREQ:TIM 10.0
READ?
```

Configure the front input for frequency measurements. Set the gate interval to 20 s for the front input. Set the measurement time out to 10 s Trigger a frequency measurement and read the result for the rear input. Changing the time out to 10 s is appropriate for signals whose frequency is between 0.1 and 1.0 Hz.

SENSe:TIMe:BMODe

Time Buffer Mode

Syntax

```
SENSe[{1|2}]:TIMe:BMODe {KFIRst|KLASt}
SENSe[{1|2}]:TIMe:BMODe?
```

Description

The first definition sets buffer mode for time measurements. The second definition queries the current buffer mode for time measurements. The internal buffer has space to hold 250,000 time measurements. This command controls the behavior of the FS740 when more than 250,000 measurements are made. If KFIRst (Keep First) is specified then older measurements are preserved and new measurements are dropped. If KLASt (Keep Last) is specified then older measurements are dropped and newer measurements are preserved. The default value is KLASt.

Example

```
CONF:TIM
SENS:TIM:BMOD KFIR
SAMP:COUN 1000000
INIT
```

Configure the front input for time measurements. Set the buffer mode to keep first. Set the sample size to 1 million. Start the measurement. After 250,000 time tags are recorded, newer time tags will be dropped unless space is created by removing measurements with the DATA:REMove command.

Source Subsystem

The Source Subsystem enables users to configure the frequency and amplitude of the FS740's various source outputs. Commands can apply to one of three possible outputs: the sine output, the aux output, or the pulse output. The user selects the output by optionally appending a 1, 2 or 3 to the SOURCe keyword. When the suffix is 1 or omitted, the sine output is selected. When the suffix is 2,

the aux output is selected. When the suffix is 3 the pulse output is selected. Note that some commands may not apply to all outputs. In those cases the allowed suffixes are restricted to those outputs for which the command is supported.

SOURce:FREQuency

Source Frequency

Syntax

```
SOURce[{1|2|3}]:FREQuency[{:CW|:FIXed}] {<freq>|MINimum|MAXimum|DEFault}
SOURce[{1|2|3}]:FREQuency[{:CW|:FIXed}]? [{MINimum|MAXimum}]
```

Description

The first definition sets the output frequency for the selected output to <freq> in Hz. The second definition queries the current frequency for the selected output, or the given limit when the optional parameter is included. The range of allowed frequencies for each output is shown in Table 15.

 Table 15: Allowed frequency ranges for each output

Output	Frequency Range
Sine	1 mHz to 30.1 MHz
Aux	1 mHz to 1 MHz
Aux (sinusoid)	1 mHz to 10 MHz
Pulse	1 mHz to 25 MHz

Example

```
SOUR:FREQ 10 MHz
SOUR2:FREQ 50 kHz
SOUR3:FREQ 2.5 MHz
```

Set the frequency of the sine output to 10 MHz. Set the frequency of the aux output to 50 kHz. Set the frequency of the pulse output to 2.5 MHz.

SOURce2:FUNCtion

Aux Output Function

Syntax

```
SOURce2:FUNCtion[:SHAPe] {SINusoid|TRIangle|SQUare|HMHZ|IRIG}
SOURce2:FUNCtion[:SHAPe]?
```

Description

The first definition sets the function for the Aux output. The second definition queries the current function for the Aux output. The allowed keywords correspond to the waveforms detailed in Table 16

Keyword	Waveform
SINusoid	Sinusoidal waveform
TRIangle	Triangle waveform
SQUare	Square waveform
HMHZ	100 MHz sine wave
IRIG	AM modulated IRIG-B

Table 16: Allowed waveforms for the Aux output

Example

SOUR2:FUNC SIN SOUR2:FREQ 5 MHz Select a sinusoidal waveform for the Aux output. Set its frequency to 5 MHz.

SOURce3:FUNCtion

Pulse Output Function

Syntax

```
SOURce3:FUNCtion[:SHAPe] {PULSe|IRIG}
SOURce3:FUNCtion[:SHAPe]?
```

Description

The first definition sets the function for the Pulse output. The second definition queries the current function for the Pulse output. The allowed keywords correspond to the waveforms detailed in Table 17.

Table 17: Allowed waveforms for the Pulse output

Keyword	Waveform
PULSe	Pulse waveform
IRIG	Pulse modulated IRIG-B

When pulse waveform is selected, the user can specify its pulse width and period or its frequency and duty cycle.

Example

SOUR3:FUNC PULS SOUR3:FREQ 2 MHz SOUR3:PULS:DCYC 50%

Select the pulse waveform for the Pulse output. Set its frequency to 2 MHz. Set its duty cycle to 50%.

SOURce:PHASe

Source Phase Adjust

Syntax

```
SOURce[{1|2|3}]:PHASe[:ADJust] {<phase>|MINimum|MAXimum|DEFault}
SOURce[{1|2|3}]:PHASe[:ADJust]? [{MINimum|MAXimum}]
```

Description

The first definition adjusts the phase of the selected output to <phase> or one of the keyword values. The second definition queries the current phase for the selected output. <Phase> may be specified in degrees, radians, or seconds. See section Units on page 78 for more information on specifying units. Command queries are returned in units specified by the SOUR:PHAS:UNITS command. These units are also assumed for <phase> if units are omitted in the set command. At *RST the default units are degrees. Positive values of <phase> cause the phase to lead the reference. Negative values of <phase> cause the phase to lead the reference. Negative values of <phase> cause the phase to lag the reference. The phase may be adjusted by up to 360 degrees at a time. After the phase is adjusted, the new value is normalized modulo 360 degrees. If the current phase is 350 degrees, for example, the user may legally set the phase to 370 degrees. This will advance the phase by 20 degrees. Afterward the phase will be renormalized and return 10 degrees when queried.

Example

SOUR:PHAS:SYNC SOUR:PHAS 45 Deg SOUR2:PHAS:SYNC SOUR2:PHAS -90 Deg



```
SOUR3:PHAS:SYNC
SOUR3:PHAS:UNITS sec
SOUR3:PHAS 10e-9
```

Synchronize the phase for the Sine output to UTC. Set the phase of the Sine output to 45 Deg. Synchronize the phase for the Aux output to UTC. Set the phase of the Aux output to -90 Deg. Synchronize the phase for the Pulse output to UTC Set the default units of phase for the Pulse output to seconds. Set the phase of the pulse output to 10 ns.

SOURce:PHASe:REFerence

Source Phase Reference

Syntax

SOURce[{1|2|3}]:PHASe:REFerence

Description

Make the current phase for the selected output the reference for future phase adjustments. The current phase will be zero after this command but the physical output is not changed in any way.

Example

```
SOUR:PHAS:SYNC
SOUR:PHAS 45 Deg
SOUR:PHAS:REF
SOUR:PHAS?
```

Synchronize the phase for the Sine output to UTC. Set the phase of the Sine output to 45 degrees. Make it so that 45 degrees from UTC is now 0 degrees. The query will return 0.

SOURce:PHASe:SYNChronize

Source Phase Synchronize

Syntax

SOURce[{1|2|3}]:PHASe:SYNChronize

Description

Adjust the phase for the selected output to align with UTC, if possible. If UTC is not yet known, then phase is aligned to a common internal reference. For the Sine and Aux outputs, the zero crossing of the rising edge of the waveform is aligned. Outputs are disabled and re-enabled on the next second boundary of UTC. Thus, this command may take up to 1 second to complete.

Example

SOUR: PHAS: SYNC

Synchronize the phase for the Sine output to UTC.

SOURce:PHASe:SYNChronize:AUTo

Source Phase Synchronize Auto

Syntax

```
SOURce[{1|2|3}]:PHASe:SYNChronize:AUTo {ON|1|OFF|0}
SOURce[{1|2|3}]:PHASe:SYNChronize:AUTo?
```

Description

When auto synchronization is on, the phase for the given output will be re-aligned to UTC any time its frequency is changed. This will ensure the phase will stay in alignment with UTC, but it also means the output will be disabled for up to 1 second each time a frequency change is made. When auto synchronization is off, no such re-alignment occurs and frequency changes are seamless. The

first definition above allows the user to turn auto synchronization on or off. The second definition queries the curry state of auto synchronization. The factory default is off. This is a system setting which is unaffected by a *RST command or a recall of default settings. The setting is stored in nonvolatile memory and automatically restored at power on.

Example

SOUR: PHAS: SYNC

Synchronize the phase for the Sine output to UTC.

SOURce:PHASe:SYNChronize:TDELay

Source Phase Synchronize Time Delay

Syntax

```
SOURce[{1|2|3}]:PHASe:SYNChronize:TDELay {<delay>|MINiumum|MAXimum|DEFault}
SOURce[{1|2|3}]:PHASe:SYNChronize:TDELay?
```

Description

This command enables the user to control alignment of the signal of an output relative to UTC. The first definition sets the time delay to <delay> or the given limit. The second definition queries the current value of the time delay. The <delay> can range from -1.0 to +1.0 seconds. Negative delays advance the phase of the signal. Positive delays retard the phase of the signal. This command is useful for correcting insertion delays of cables used to get signals from the FS740 to application equipment. The factory default is 0.0 seconds. This is a system setting which is unaffected by a *RST command or a recall of default settings. The setting is stored in nonvolatile memory and automatically restored at power on.

Example

SOUR: PHAS: SYNC: TDEL -100 ns

Advance the phase of the Sine output by 100 ns. This will correct for several feet of cable delay in getting the signal to application equipment.

SOURce3:PULSe:DCYCle

Source Pulse Duty Cycle

Syntax

```
SOURce3:PULSe:DCYCle {<duty cycle>|MINiumum|MAXimum|DEFault}
SOURce3:PULSe:DCYCle? [{MINimum|MAXimum}]
```

Description

The first definition sets the duty cycle of the Pulse output to <duty cycle> or the selected limit. The second definition queries the current duty cycle of the Pulse output. Duty cycle is specified in percent, and can range from 0 to 100 %. The actual limits vary with frequency because the pulse width must obey the following constraint: 5 ns \leq pulse width \leq pulse period – 5 ns. Once the duty cycle is set, the instrument will try to maintain that duty cycle for future changes in frequency or period of the Pulse output.

Example

SOUR3:FREQ 1 kHz SOUR3:PULSe:DCYC 25%

Set the frequency of the pulse output to 1 kHz. Set the duty cycle of the waveform to 25 %.

SOURce3:PULSe:PERiod

Source Pulse Period

Syntax SOURce3:PULSe:PERiod {<period>|MINimum|MAXimum|DEFault} SOURce3:PULSe:PERiod? [{MINimum|MAXimum}]

Description

The first definition sets the period of the Pulse output to <period> in seconds or the selected limit. The second definition queries the current period of the Pulse output. The <period> can range from 40 ns to 1000 s. The default period is 1 s. Note that the user can alternatively set the frequency of the Pulse output with the SOUR3:FREQ command. When the pulse period is modified, the pulse width may also change. If a duty cycle was specified, then the pulse width will be modified to maintain the specified duty cycle. Alternatively, if a pulse width was explicitly set, then its setting will be preserved, unless doing so would violate the constraint that it be less the period – 5 ns, in which case it will be clipped to that limit.

Example

SOUR3:PULSe:PER 1 us SOUR3:PULSe:WIDT 10 ns

Set the pulse period to 1 µs and the pulse width to 10 ns.

SOURce3:PULSe:VIEW

Source Pulse Period

Syntax

```
SOURce3:PULSe:VIEW {PERiod|FREQuency}
SOURce3:PULSe:VIEW?
```

Description

The first definition sets the front panel view for the Pulse output to Period/Width or Freq/Duty. The second definition queries the current view.

Example

SOUR3:PULSe:VIEW FREQ

Set the front panel view for pulse output to Freq/Duty.

SOURce3:PULSe:WIDTh

Source Pulse Width

Syntax

```
SOURce3:PULSe:WIDTh {<width>|MINiumum|MAXimum|DEFault}
SOURce3:PULSe:WIDTh? [{MINimum|MAXimum}]
```

Description

The first definition sets the pulse width of the Pulse output to \langle width \rangle in seconds or the selected limit. The second definition queries the current pulse width of the Pulse output. The \langle width \rangle can range from 5 ns to the pulse period – 5 ns. The default pulse width is that which gives a 50 % duty cycle. Once the pulse width is set with this command, the instrument will try to maintain that pulse width for future changes in frequency or period of the Pulse output, if possible.

Example

SOUR3:PULSe:PER 1 us SOUR3:PULSe:WIDT 10 ns

Set the pulse period to 1 μ s and the pulse width to 10 ns.

SOURce:VOLTage

Source Voltage

Syntax

```
SOURce[{1|2}]:VOLTage[:LEVel] {<voltage>|MINimum|MAXimum|DEFault}
SOURce[{1|2}]:VOLTage[:LEVel]? [{MINimum|MAXimum}]
```

Description

The first definition sets the AC voltage level for the output to <voltage> or the selected limit. The second definition queries the current AC voltage level for the output. The <voltage> may be specified in V_{PP} , V_{RMS} , or dBm. Note that only V_{PP} is accepted for the Aux output when non sinusoidal waveforms are selected. See section Units on page 78 for more details on specifying units. Queries are returned in units specified by the SOUR:VOLT:UNIT command. These units are also assumed for <voltage> if units are omitted in the set command. At *RST the default units are V_{PP} .

Example

SOUR:VOLT 0.25 Vrms SOUR2:VOLT 1.0 Vpp

Set the amplitude of the Sine output to 0.25 V_{RMS} . Set the amplitude of the Aux output to 1.0 V_{PP} .

SOURce:VOLTage:UNITs

Source Voltage Units

Syntax

SOURce[{1|2}]:VOLTage:UNITs {VPP|VRMS|DBM} SOURce[{1|2}]:VOLTage:UNITs?

Description

The first definition selects the default units when specifying or querying AC voltage levels with the command SOUR:VOLT. At *RST the default units will be V_{PP} .

Example

SOUR:VOLT 0.25 Vrms SOUR2:VOLT 1.0 Vpp

Set the amplitude of the Sine output to 0.25 V_{RMS} . Set the amplitude of the Aux output to 1.0 V_{PP} .

Status Subsystem

Commands in the Status Subsystem report on instrument status. Each element of status has 3 registers associated with it: a condition register, an event register, and an enable register. For a detailed discussion of these registers and how they are related see Status Reporting on page 80.

STATus:GPS:CONDition?

Status GPS Condition

Syntax

STATus:GPS:CONDition?

Description

Query the current condition of the GPS receiver. See section GPS Receiver Status on page 87 for detailed information on the interpretation of GPS receiver status. See Status Reporting on page 80 for more information on condition registers.

Example

STAT:GPS:COND?

Query the current condition of the GPS receiver status register.

STATus:GPS:ENABle

Status GPS Enable

Syntax

STATus:GPS:ENABle <mask>
STATus:GPS:ENABle?

Description

The first definition sets the mask for combining GPS receiver status bits into the summary bit located in the serial poll status byte. The second definition queries the current mask. See section GPS Receiver Status on page 87 for detailed information on the interpretation of GPS receiver status. See section Status Reporting on page 80 for more information about enable registers.

Example

STAT:GPS:ENAB 1

Set the summary bit in the serial poll status byte if the time of day of the instrument has not been set by the GPS receiver.

STATus:GPS:EVENt?

Status GPS Event

Syntax

STATus:GPS[:EVENt]?

Description

Query the GPS receiver status event register. See section GPS Receiver Status on page 87 for detailed information on the interpretation of GPS receiver status. See Status Reporting on page 80 for more information on event registers.

Example

STAT:GPS?

Query the event register for GPS receiver status. This returns all bits that have been set since the previous query. The query then clears all bits.

STATus:OPERation:CONDition?

Status Operation Condition

Syntax

STATus: OPERation: CONDition?

Description

Query the current condition of operational status for the FS740. See section Operation Status on page 86 for detailed information on the interpretation of the operation status bits. See Status Reporting on page 80 for more information on condition registers.

Example

STAT: OPER: COND?

Query the current condition of operational status for the FS740.

Status Operation Enable

STATus:OPERation:ENABle

Syntax

STATus:OPERation:ENABle <mask> STATus:OPERation:ENABle?

Description

The first definition sets the mask for combining operational status bits into the summary bit located in the serial poll status byte. The second definition returns the current mask. See section Operation Status on page 86 for detailed information on the interpretation of operational status bits. See section Status Reporting on page 80 for more information about enable registers.

Example

STAT:OPER:ENAB 64

Set the summary bit in the serial poll status byte if an event was detected on the front input since the previous query of the event register.

STATus:OPERation:EVENt?

Status Operation Event

Syntax

STATus:OPERation[:EVENt]?

Description

Query the event register of operational status for the FS740. See section Operation Status on page 86 for detailed information on the interpretation of the operation status bits. See Status Reporting on page 80 for more information on event registers.

Example

STAT: OPER?

Query the event register for operational status. This returns all bits that have been set since the previous query. The query then clears all bits.

STATus:QUEStionable:CONDition?

Status Questionable Condition

Syntax

STATus:QUEStionable:CONDition?

Description

Query the current condition of questionable status for the FS740. See section Questionable Status on page 85 for detailed information on the interpretation of the questionable status bits. See Status Reporting on page 80 for more information on condition registers.

Example

STAT:QUES:COND?

Query the current condition of questionable status for the FS740.

STATus:QUEStionable:ENABle

Status Questionable Enable

Syntax

STATus:QUEStionable:ENABle <mask>

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STATus:QUEStionable:ENABle?

Description

The first definition sets the mask for combining questionable status bits into the summary bit located in the serial poll status byte. The second definition returns the current mask. See section Questionable Status on page 85 for detailed information on the interpretation of questionable status bits. See section Status Reporting on page 80 for more information about enable registers.

Example

STAT:QUES:ENAB 32

Set the summary bit in the serial poll status byte if the timebase was not at optimum frequency stability since the previous query of the event register.

STATus:QUEStionable:EVENt?

Status Questionable Event

Syntax

STATus:QUEStionable[:EVENt]?

Description

Query the event register of questionable status for the FS740. See section Questionable Status on page 85 for detailed information on the interpretation of the questionable status bits. See Status Reporting on page 80 for more information on event registers.

Example

STAT:QUES?

Query the event register for questionable status. This returns all bits that have been set since the previous query. The query then clears all bits.

System Subsystem

Commands in the System Subsystem control overall system behavior. System settings are typically not affected by a *RST and are stored in nonvolatile memory so that they may be recalled automatically when the power is cycled.

SYSTem:ALARm?

System Alarm

Syntax

SYSTem:ALARm?

Description

Query the current state of the system alarm. The FS740 will return 1 if the alarm is asserted, otherwise 0.

Example

SYST:ALAR?

Query the current state of the system alarm.

SYSTem:ALARm:CLEar

System Alarm Clear

Syntax

SYSTem:ALARm:CLEar

Description

Clear the event register for the system alarm. When the current mode for command SYST:ALARm:MODe is LATCh, this will clear the alarm assuming current limits are not being exceeded.

Example

SYST:ALAR:CLE

Clear the event register for the system alarm.

SYSTem:ALARm:CONDition?

System Alarm Condition

Syntax

SYSTem:ALARm:CONDition?

Description

Query the condition register for the system alarm. This register indicates which of the possible alarm conditions are currently true. The system alarm will only be asserted if a condition is true and it is enabled in the enable register.

Example

SYST:ALAR:COND?

Query the condition register for the system alarm.

SYSTem:ALARm:ENABle

System Alarm Enable

Syntax

SYSTem:ALARm:ENABle <mask>
SYSTem:ALARm:ENABle?

Description

Mask possible alarm conditions so that only those that are enabled here can cause the system alarm to be asserted. When the current mode for command SYST:ALARm:MODe is TRACk, this register masks the condition register for the system alarm, SYST:ALARm:CONDition. When the current mode for command SYST:ALARm:MODe is LATCh, this register masks the event register for the system alarm, SYST:ALARm:EVENt.

Example

SYST:ALAR:ENAB 1

Enable alarm if the time of day has not been set by GPS.

SYSTem:ALARm:EVENt?

System Alarm Event

Syntax

SYSTem:ALARm:EVENt?

Description

Query the event register for the system alarm. This register indicates which of the possible alarm conditions that have been latched since the last time the event register was cleared. When the current mode for command SYST:ALARm:MODe is LATCh the system alarm will be asserted if an event condition is true AND it is enabled in the enable register. Note that unlike the event registers in the Status Subsystem, reading this register does not clear it. It must be explicitly cleared with the SYSTem:ALARm:CLEar command.

Example

SYST:ALAR:EVENt?

Query the condition register for the system alarm.

SYSTem:ALARm:FORCe:STATe

System Alarm Force State

Syntax

```
SYSTem:ALARm:FORCe[:STATe] {1|ON|0|OFF}
SYSTem:ALARm:FORCe[:STATe]?
```

Description

The first definition sets the forced state of the alarm. The second definition queries the current forced state of the alarm. This value only has significance if the current mode for command SYST:ALARm:MODe is FORCe.

Example

SYST:ALAR:FORC ON

Assert the alarm if the alarm mode is FORCe.

SYSTem:ALARm:MODe

System Alarm Mode

Syntax

```
SYSTem:ALARm:MODe {TRACk|LATCh|FORCe}
SYSTem:ALARm:MODe?
```

Description

The first definition sets the alarm mode to one of three options: track, latch, or force. The second definition queries the current alarm mode.

Tracking mode causes the alarm to follow current conditions. The alarm is asserted when current limits are exceeded. The alarm is de-asserted when current limits are no longer exceeded.

Latching mode causes the alarm to be asserted when current limits are exceeded. However, the alarm will not be de-asserted until explicitly requested to do so and the limit is no longer exceeded.

In force mode, the user manually sets the state of the alarm.

Example

SYST:ALAR:MODe

Query the current mode for the system alarm.

SYSTem:ALARm:GPS:TINTerval

System Alarm GPS Time Interval

Syntax

```
SYSTem:ALARm[:GPS]:TINTerval {<time error>|MINimum|MAXimum|DEFault}
SYSTem:ALARm[:GPS]:TINTerval?
```

Description

The first definition sets the time interval between GPS and the internal timebase that must be exceeded before the alarm condition for a timing error is asserted. The <time error> may range from 50 ns to 1 s. The default is 100 ns. The second definition queries the current value for the time interval.

Example

SYST:ALAR:TINT 1 us

Set the timing error limit to 1 μ s. This means that the alarm condition for timing errors will not be set unless the measured time interval between GPS and the internal timebase exceeds 1 μ s. Note that the system alarm will not actually be asserted unless this condition is also enabled with the SYST:ALARm:ENABle command.

SYSTem:ALARm:HOLDover:Duration

System Alarm Holdover Duration

Syntax

SYSTem:ALARm[:HOLDover]:DURation {<duration>|MINimum|MAXimum|DEFault} SYSTem:ALARm[:HOLDover]:DURation?

Description

The first definition sets the amount of time in seconds that the FS740 must be in holdover before the alarm condition for holdover is asserted. The <duration> may be any 32 bit unsigned integer. The default is 0. The second definition queries the current value for the duration.

Example

SYST:ALAR:DUR 100

Set the holdover duration to 100 seconds. This means that the alarm condition for holdover will not be set unless the FS740 is in holdover for more than 100 seconds. Note that the alarm will not actually be asserted unless this condition is also enabled with the SYST:ALARm:ENABle command.

SYSTem:COMMunicate:LAN:EPHY?

System Communicate LAN EPHY

Syntax

SYSTem:COMMunicate:LAN[:EPHY]?

Description

Query whether the FS740 is connected to the Ethernet LAN. The query returns 1 if connected, otherwise 0.

Example

SYST:COMM:LAN?

Query whether the FS740 is connected to the Ethernet LAN.

SYSTem:COMMunicate:LAN:EPHY:SPEed

System Communicate LAN EPHY Speed

Syntax SYSTem:COMMunicate:LAN[:EPHY]:SPEed [{10BASET|100BASET}] SYSTem:COMMunicate:LAN[:EPHY]:SPEed?

Description

The first definition configures the speed of the Ethernet network to which the FS740 is connected, 10BaseT or 100BaseT. If omitted the command defaults to 100BaseT. The second definition queries the current configured speed. Note that changes to this configuration do not take effect until the LAN is reset via a SYSTem:COMMunicate:LAN:RESet command or the power is cycled.

Example

```
SYST:COMM:LAN:SPE 10BaseT
SYST:COMM:LAN:RESET
```

Configure the FS740 to connect to a 10BaseT Ethernet network. Then reset the LAN so that the new configuration takes effect.

SYSTem:COMMunicate:LAN:DHCP

System Communicate LAN DHCP

Syntax

```
SYSTem:COMMunicate:LAN:DHCP [{1|ON|0|OFF}]
SYSTem:COMMunicate:LAN:DHCP?
```

Description

The first definition enables or disables DHCP for configuring the TCP/IP address of the FS740. Note that the new configuration does not take effect until the LAN is reset via a SYSTem:COMMunicate:LAN:RESet command or the power is cycled.

Example

SYST:COMM:LAN:DHCP ON SYST:COMM:LAN:RESET

Configure the FS740 to use DHCP to configure the TCP/IP address of the instrument. Then reset the LAN so that the new method of configuration becomes active.

SYSTem:COMMunicate:LAN:GATeway

System Communicate LAN Gateway

Syntax

```
SYSTem:COMMunicate:LAN:GATeway <ip address>
SYSTem:COMMunicate:LAN:GATeway? [{CURRent|STATic}]
```

Description

The first definition sets the IP address of the gateway or router on the users TCP/IP network to be used in static configurations. The second definition queries either the current gateway address or the gateway address to be used in static configurations. If the parameter is omitted, the current gateway address is returned. The <ip address> should be specified as a string in the form "xxx.xxx.xxx" where each xxx is replaced by an integer in the range from 0 to 255. Each integer should be separated by a decimal point (.) with no spaces.

Example

```
SYST:COMM:LAN:DHCP OFF
SYST:COMM:LAN:IPAD "192.168.0.10"
SYST:COMM:LAN:SMAS "255.255.255.0"
SYST:COMM:LAN:GAT "192.168.0.1"
```

SYST:COMM:LAN:RESET

Disable DHCP. Set the IP address to 192.168.0.10. Set the subnet mask to 255.255.255.0. Set the gateway to 192.168.0.1. Then reset the LAN so that the new configuration will take effect.

SYSTem:COMMunicate:LAN:IPADress

System Communicate LAN IP Address

Syntax

SYSTem:COMMunicate:LAN:IPADress <ip address>
SYSTem:COMMunicate:LAN:IPADress? [{CURRent|STATic}]

Description

The first definition sets the IP address of the FS740 on the users TCP/IP network to be used in static configurations. The second definition queries either the current IP address or the IP address to be used in static configurations. If the parameter is omitted, the current IP address is returned. These may differ, for example, if DHCP is enabled. The <ip address> should be specified as a string in the form "xxx.xxx.xxx" where each xxx is replaced by an integer in the range from 0 to 255. Each integer should be separated by a decimal point (.) with no spaces.

Example

```
SYST:COMM:LAN:DHCP OFF
SYST:COMM:LAN:IPAD "192.168.0.10"
SYST:COMM:LAN:SMAS "255.255.255.0"
SYST:COMM:LAN:GAT "192.168.0.1"
SYST:COMM:LAN:RESET
```

Disable DHCP. Set the IP address to 192.168.0.10. Set the subnet mask to 255.255.255.0. Set the gateway to 192.168.0.1. Then reset the LAN so that the new configuration will take effect.

SYSTem:COMMunicate:LAN:MAC?

System Communicate LAN MAC address

Syntax

SYSTem:COMMunicate:LAN:MAC?

Description

Query the Ethernet MAC address for the FS740. It returns a string of the form "00:19:b3:0b:00:03" identifying the MAC address for the device.

Example

SYST:COMM:LAN:MAC?

Query the Ethernet MAC address for the FS740.

SYSTem:COMMunicate:LAN:SMASk

System Communicate LAN Subnet Mask

Syntax

```
SYSTem:COMMunicate:LAN:SMASk <ip address>
SYSTem:COMMunicate:LAN:SMASk? [{CURRent|STATic}]
```

Description

The first definition sets the subnet mask for the users TCP/IP network to be used in static configurations. The second definition queries either the current subnet mask or the subnet mask to be used in static configurations. If the parameter is omitted, the current subnet mask is returned. These may differ, for example, if DHCP is enabled. The <ip address> should be specified as a string in the



form "xxx.xxx.xxx" where each xxx is replaced by an integer in the range from 0 to 255. Each integer should be separated by a decimal point (.) with no spaces.

Example

```
SYST:COMM:LAN:DHCP OFF
SYST:COMM:LAN:IPAD "192.168.0.10"
SYST:COMM:LAN:SMAS "255.255.255.0"
SYST:COMM:LAN:GAT "192.168.0.1"
SYST:COMM:LAN:RESET
```

Disable DHCP. Set the IP address to 192.168.0.10. Set the subnet mask to 255.255.255.0. Set the gateway to 192.168.0.1. Then reset the LAN so that the new configuration will take effect.

SYSTem:COMMunicate:SERial:BAUD

```
System Communicate Serial Baudrate
```

Syntax

```
SYSTem:COMMunicate:SERial:BAUD {4800|9600|19200|38400|57600|115200}
SYSTem:COMMunicate:SERial:BAUD?
```

Description

The first definition configures the RS-232 port to operate at the selected baud rate. The second definition queries the current baud rate. Note that the new configuration does not take effect until the port is reset via a SYSTem:COMMunicate:SERial:RESet command or the power is cycled.

Example

SYST:COMM:SER:BAUD 115200 SYST:COMM:SER:RESET

Set the serial port baud rate to 115200 baud. Then reset the port so that the new baud rate becomes active.

SYSTem:COMMunicate:SERial:RESet

System Communicate Serial Reset

Syntax

SYSTem:COMMunicate:SERial:RESet

Description

Reset the serial port and activate it using the current configured baud rate

Example

SYST:COMM:SER:BAUD 115200 SYST:COMM:SER:RESET

Set the serial port baud rate to 115200 baud. Then reset the port so that the new baud rate becomes active.

SYSTem:COMMunicate:LOCK?

System Communicate Lock

Syntax

SYSTem:COMMunicate:LOCK?

Description

Request an exclusive lock on communication with the FS740. The FS740 will return 1 if the request is granted, otherwise 0. When an interface has an exclusive lock on communication with the FS740,

other remote interfaces as well as the front panel are prevented from changing the instrument state. The user should call the command SYSTem:COMMunicate:UNLock command to release the exclusive lock when it is no longer needed.

Example

SYST:COMM:LOCK? SOUR:FREQ 5 MHz SOUR2:FREQ 1 MHz SYST:COMM:UNL?

Request a communications lock. If all is well, the FS740 will return 1, indicating it has granted the lock. Set the frequency for the Sine output to 5 MHz. Set the frequency for the Aux output to 1 MHz. Finally, release the communications lock.

SYSTem:COMMunicate:UNLock?

System Communicate Unlock

Syntax

SYSTem:COMMunicate:UNLock?

Description

Release an exclusive lock on communication with the FS740 that was previously granted with the SYSTem:COMMunicate:LOCK command. The FS740 will return 1 if the lock was released, otherwise 0.

Example

SYST:COMM:LOCK? SOUR:FREQ 5 MHz SOUR2:FREQ 1 MHz SYST:COMM:UNL?

Request a communications lock. If all is well, the FS740 will return 1, indicating it has granted the lock. Set the frequency for the Sine output to 5 MHz. Set the frequency for the Aux output to 1 MHz. Finally, release the communications lock.

SYSTem:DATe

System Date

Syntax

```
SYSTem:DATe <year>,<month>,<day>
SYSTem:DATe?
```

Description

The first definition sets the FS740 date if it has not been set by GPS. If the date has already been set by GPS, error -221, "Settings conflict," will be generated and the requested date ignored. The second definition queries the current date. It returns the year, month, and day as a comma (,) separated list.

Example

SYST:DATE 2016,12,15

Set the current date for the FS740 to December 15, 2016, if the date has not already been set by GPS.

SYSTem:DISPlay:POWer

System Display Power

Syntax

```
SYSTem:DISPlay:POWer {NOW|TMIN|OHR|THR|ODAY|NEVer}
SYSTem:DISPlay:POWer?
```

Description

The first definition sets the period of inactivity, after which the display is powered down. It may be one of the values detailed in Table 18. The second definition queries the current setting.

Keyword	If no activity power down display		
NOW	Immediately		
TMIN	After 10 minutes		
OHR	After 1 hour		
THR	After 10 hours		
ODAY	After 1 day		
NEVer	Never power down display		

 Table 18: Allowed display power down settings

Note that the keyword NOW is special in that it forces the display to power down immediately, but it does not change the previous setting. Thus, if the previous setting was NEVer, then executing the command SYST:DISP:POW NOW will cause the display to power down immediately, but leave the setting at NEVer.

Example

SYST:DISP:POW TMIN

Set the display to power down after 10 minutes of inactivity.

SYSTem:DISPlay:SCReen

System Display Screen

Syntax

```
SYSTem:DISPlay[:SCReen]
   [{TBASe|GPS|COMMunicate|SYSTem|SINe|AUX|PULSe|MEASure1|MEASure2}]
SYSTem:DISPlay[:SCReen]?
```

Description

The first definition sets the display. This is equivalent to pressing one of the 8 keys located in the right hand portion of the front panel display. Allowed values are detailed in Table 19. If omitted the display defaults to timebase status and configuration. The second definition queries the current display setting.

Keyword	Display setting	
TBASe	Timebase status and configuration	
GPS	GPS receiver status and configuration	
COMMunicate	Communication settings	
SYSTem	System settings	
SINe	Sine output configuration	
AUX	Aux output configuration	
PULSe	Pulse output configuration	
MEASure1	Front panel measurement display	
MEASure2	Rear panel measurement display	

Table 19: Allowed display settings

System Error

Example

SYST:DISP SYST

Set the display to system settings.

SYSTem:ERRor?

Syntax

SYSTem:ERRor[:NEXT]?

Description

Query the next error at the front of the error queue and then remove it. The error queue can store up to 10 errors. If the error queue overflows, the last error in the queue will be replaced with the error: -350, "Error queue overflow."

Example

SYST:ERR?

Query the next error in the error queue. If no error is in the queue, then 0, "No error," is returned.

SYSTem:SECurity:IMMediate

System Security Immediate

Syntax

SYSTem:SECurity:IMMediate

Description

This command wipes the instrument of user settings and restores the unit to factory default settings. All settings stored in nonvolatile memory will be erased except for firmware and calibration data. This includes configuration settings for the GPS receiver and all the remote interfaces. All system configuration settings will be replaced with factory defaults. Execution of this command is not recommended in normal use, as system configuration settings will be lost. However, it may be required when removing the instrument from a secure area. This command may take up to 10 seconds to complete. It should not generally be executed frequently. Use *RST for general use.

Example

SYST:SEC:IMM

Wipe the instrument of user settings and restore instrument to factory default settings.

SYSTem:TIMe

System Time

Syntax

SYSTem:TIMe <hour>,<minute>,<second>
SYSTem:TIMe?

Description

The first definition sets the FS740 time of day if it has not been set by GPS. If the time has already been set by GPS, error -221, "Settings conflict," will be generated and the requested time ignored. The second definition queries the current time of day. It returns the hour, minute, and second as a comma (,) separated list of integers. The second field will be returned as a decimal fraction with 10 ns of resolution representing the precise time that the query was executed.

Example

SYST:TIM 16,23,43

Set the current time to 16:23:43, if the time has not already been set by GPS.

SYSTem:TIMe:LOFFset

System Time Local Offset

Syntax

```
SYSTem:TIMe:LOFFset <offset>
SYSTem:TIMe:LOFFset?
```

Description

The first definition sets the local offset from GPS or UTC to local time in seconds. The second definition queries the current local offset in seconds. This setting is not affected by a *RST command. Its value is stored in nonvolatile memory and will be automatically restored when the power is cycled.

Example

SYST:TIM:LOFF -3600

Set the local time offset to -1 hour. With this offset in effect, times reported by the FS740 will be 1 hour earlier than UTC.

SYSTem:TIMe:POWeron

System Time Power On

Syntax

SYSTem:TIMe:POWeron?

Description

Query the date and time at which the FS740 was powered on. The FS740 returns the year, month, day, hour, minute, and second as a comma (,) separated list. Until the date and time are set by GPS this command will report power on to be midnight, January 6, 1980, which is the start date of GPS. Once time has been set by GPS, the true date and time of power on will be returned.

Example

SYST:TIM:POW?

Query the date and time at which the FS740 was powered on.

Timebase Subsystem

Commands in the Timebase Subsystem control the operation of the internal timebase, including whether it locks to GPS, when it comes unlocked from GPS, and how it recovers from the unlocked state. Note that commands in this subsystem are not affected by a *RST. They control system configuration and are automatically saved to nonvolatile memory.

TBASe:CONFig:BWIDth

Timebase Configure Bandwidth

Syntax

```
TBASe:CONFig:BWIDth [{AUTo|MANual}]
TBASe:CONFig:BWIDth?
```

Description

The first definition sets the desired bandwidth control. The second definition queries the current value for bandwidth control. When AUTo is selected, the bandwidth with which the timebase follows GPS is automatically adjusted based on the measured timing errors. When the timing error is large bandwidth is increased. Conversely, when timing errors are small bandwidth is decreased. When MANual is selected, the bandwidth is fixed and the time constant of the phase lock loop is governed by the value set with the TBASe:TCONstant command. When the parameter is omitted, the value is assumed to be AUTo.

Example

TBAS:CONF:BWID AUT

Configure the timebase to automatically increase bandwidth when timing errors are large and then gradually narrow the bandwidth when lock is stable.

TBASe:CONFig:HMODe

Timebase Configure Holdover Mode

Syntax

```
TBASe:CONFig:HMODe [{WAIT|JUMP|SLEW}]
TBASe:CONFig:HMODe?
```

Description

The first definition controls how the timebase leaves holdover mode when timing offsets are larger than allowed. The second definition queries the current behavior for leaving holdover mode. When WAIT is selected, the timebase will wait for the timing offsets to improve before leaving holdover mode. If JUMP is selected, the timebase will leave holdover by jumping from its current phase to that of GPS to correct the offset immediately. If SLEW is selected the timebase will leave holdover by slewing its phase from its current value to that of GPS to correct the offset.

Example

TBAS:CONF:HMOD JUMP

Configure the timebase to leave holdover by suddenly jumping its phase to that of GPS if the current timing error exceeds the configured limit.

TBASe:CONFig:LOCK

Timebase Configure Lock

Syntax

```
TBASe:CONFig:LOCK [{1|ON|0|OFF}]
TBASe:CONFig:LOCK?
```

Description

The first definition controls whether the timebase locks to GPS or not. When set to 1 or ON, the timebase will lock to GPS if it is generating timing pulses. When set to 0 or OFF, the timebase will not lock to GPS. If the parameter is omitted, it is assumed to be ON. The second definition queries the current setting.

Example

TBAS:CONF:LOCK 1

Configure the timebase to lock to GPS when possible.

TBASe:CONFig:TINTerval:LIMit	Timebase Configure Time Interval Limit

Syntax

```
TBASe:CONFig[:TINTerval]:LIMit <time error>
TBASe:CONFig[:TINTerval]:LIMit?
```

Description

The first definition sets the limit for timing errors to <time error> in seconds. The second definition queries the current limit. The <time error> may range from 50 ns to 1.0 s. The factory default value is 1 μ s. When the measured timing error of the timebase relative to GPS exceeds this limit, the timebase will unlock from GPS and enter holdover.

Example

TBAS:CONF:LIM 100 ns

Configure the timebase to unlock from GPS if the time interval error exceeds 100 ns.

TBASe:EVENt:CLEar

Timebase Event Clear

Syntax

TBASe:EVENt:CLEar

Description

Discard all events in the timebase event queue

Example

TBAS:EVEN:CLE

Discard all events in the timebase event queue.

TBASe:EVENt:COUNt

Syntax

TBASe:EVENt:COUNt?

Description

Query the number of events in the timebase event queue.

Example

TBAS:EVEN:COUN?

Query the number of events in the timebase event queue.

TBASe:EVENt:NEXT?

Syntax

TBASe:EVENt[:NEXT]?

Description

Query the queue of timebase events for the next event. The command returns the name of the event, followed by the year, month, day, hour, minute, and second that the event occurred as a comma (,) separated list. Then the event is removed from the queue and discarded. If no event has occurred, then NONe is returned with the current time. Allowed events are detailed in Table 20.

Timebase Event Count

Timebase Event Next

Event	Name	Meaning	
NONe	None	No events in the queue	
POWerup	Power up	Time at which FS740 powered up	
UNLock	Unlock	Rb timebase came unlocked	
SEARch	Searching for GPS	Searching for GPS satellites	
STABilize	Stabilizing	Waiting for timebase frequency to stabilize	
VTIMe	Validate time	Validating time of day before setting it.	
LOCK	Lock	Locked to GPS	
MANual	Manual holdover	Entered holdover at user request	
NGPS	No GPS	Entered holdover because timing pulses are not being generated by the GPS receiver.	
BGPS	Bad GPS	Entered holdover because the timing error of the	
		timebase relative to GPS exceeds the limit specified	
		in the command TBAS:CONF:LIM.	

Table 20: Possible timebase events

Example

TBAS: EVEN?

Query the queue of timebase events for the next event.

TBASe:FCONtrol

Timebase Frequency Control

Syntax

TBASe:FCONtrol <fc> TBASe:FCONtrol?

Description

The first definition sets the frequency control value for the timebase to <fc>. The second definition returns the current frequency control value. Valid values may range from 0 to 4.096. Error -221, "Settings conflict," is generated if the user tries to manually set the frequency control value when the timebase is locked to GPS. This setting is not automatically saved to nonvolatile memory. It must be explicitly saved with the TBASe:FCONtrol:SAVe command if desired.

Example

TBAS:FCON 2.0

Set the frequency control for the timebase to 2.0.

TBASe:FCONtrol:SAVe

Timebase Frequency Control Save

Syntax

TBASe:FCONtrol:SAVe

Description

Save the current frequency control value to nonvolatile memory. This value will be restored when the FS740 is power cycled. It will control the frequency of the timebase until it locks to GPS again.

Example

TBAS:FCON:SAV

Save the current frequency control value to nonvolatile memory.

TBASe:STATe?

Timebase State

Syntax

TBASe[:STATe]?

Description

Query the current state of the timebase. Allowed states for the timebase are detailed in Table 21. Table 21: Allowed states for the timebase

State	Meaning	
POWerup	Instrument has been recently powered up	
SEARch	GPS receiver is searching for satellites	
STABilize	Waiting for frequency of the timebase to stabilize	
VTIMe	Validating time of day reported by GPS	
LOCK	Locked to GPS	
MANual	Manual: in holdover at the request of the user	
NGPS	No GPS: in holdover because timing pulses are not	
	being generated by the GPS receiver.	
BGPS	Bad GPS: in holdover because timing error of the	
	timebase relative to GPS exceeds the limit specified	
	in the command TBAS:CONF:LIM.	
UNLock	Installed Rb oscillator is unlocked	

Example

TBAS?

Query the current state of the timebase.

TBASe:STATe:HOLDover:DURation?

Syntax

TBASe[:STATe]:HOLDover[:DURation]?

Description

Query the length of time in seconds the FS740 has been in holdover. If the FS740 is not currently in holdover, it returns 0.

Example

TBAS:HOLD?

Query the holdover duration.

TBASe:STATe:LOCK:DURation?

Syntax

TBASe[:STATe]:LOCK[:DURation]?

Timebase Holdover Duration

Timebase Lock Duration

Description

Query the length of time the FS740 has been locked to GPS. If the FS740 is not currently locked to GPS, it will return 0.

Example

TBAS:LOCK?

Query the timebase lock duration.

TBASe:STATe:WARMup:DURation?

Timebase Warm Up Duration

Syntax

TBASe[:STATe]:WARMup[:DURation]?

Description

Query the time in seconds that passed between when the FS740 was powered on and it first locked to GPS. If it has not successfully locked to GPS, then it returns the time in seconds since power on.

Example

TBAS:WARM?

Query the warm up duration.

TBASe:TCONstant

Timebase Time Constant

Syntax

TBASe:TCONstant <time constant>
TBASe:TCONstant? [{CURRent|TARGet|MANual}]

Description

The first definition sets the time constant for the phase lock loop that locks the timebase to GPS when MANual is selected for the command TBASe:CONFig:BWIDth. The second definition queries one of three different time constants: the current time constant, the target time constant, and the manual time constant set with the first definition above. If the parameter is omitted, the current time constant is returned. If the timebase is configured for automatic bandwidth control (the default), the current time constant may vary from 3 s up to the target time constant for the installed timebase. The target time constant is a factory setting which identifies the optimum time constant for the installed timebase that should be used when the timebase has fully stabilized and timing errors are small.

Example

TBAS:TCON 40 TBAS:TCON? TBAS:TCON? MAN

Set the manual time constant to 40 s. Query the current time constant. Query the manual time constant set above. It should be 40.

TBASe:TINTerval

Timebase Time Interval

Syntax

TBASe:TINTerval? [{CURRent|AVERage}]

Description

Query the current or average measured time interval in seconds between the internal timebase and GPS. If the parameter is omitted, the current time interval is returned. The current time interval is the measured time interval between the internal timebase and the latest GPS timing pulse. The average time interval reported is an exponential average of the current time interval with a time constant equal to 1/6 of the time constant of the phase lock loop. See the TBASe:TCONstant command. Positive values indicate the internal timebase is lagging GPS. Negative values indicate the internal timebase is lagging GPS. Negative values indicate the internal timebase is leading GPS. If time of day has not yet been set by the GPS receiver, this command generates error -230, "Data corrupt or stale." Alternatively, if GPS is lost after time has been set, this command returns the last known time interval as the current time interval and zero for the average time interval.

Example

TBAS:TINT?

Query the current time interval between the internal timebase and GPS.

Trigger Subsystem

Commands in the Trigger Subsystem control the triggering of measurements. Normally when under local control, measurements are triggered continuously in order to provide continuous feedback while interacting with the instrument. Conversely, under remote control, measurements are only triggered when requested so that the data displayed corresponds closely with data retrieved. Commands in this subsystem enable the user to alter this behavior.

TRIGger:CONTinuous

Trigger Continuous

Syntax

```
TRIGger:CONTinuous [{1|ON|0|OFF}]
TBASe:CONFig:BWIDth?
```

Description

The first definition sets the desired trigger mode. The second definition queries the current trigger mode. When the parameter is omitted,

Example

TBAS:CONF:BWID AUT

Configure the timebase to automatically increase bandwidth when timing errors are large and then gradually narrow the bandwidth when lock is stable.

Error Codes

The instrument contains an error buffer that may store up to 10 error codes associated with errors encountered during power-on self tests, command parsing, or command execution. The ERR LED will be highlighted when a remote command fails for any reason. The errors in the buffer may be read one by one by executing successive SYST:ERR commands. The user may also view the errors from the front panel by navigating to Communication > Activity. Press CLEAR to discard the error. Errors are displayed in the order in which they occurred. The ERR LED will go off when all errors have been discarded.

The meaning of each of the error codes is described below.

Command Errors

-100 Command Error

A nonspecific command error occurred.

-104 Data type error

A parameter has the wrong data type.

-108 Parameter not allowed

A parameter was supplied that is not allowed.

-109 Missing parameter

A required parameter was missing.

-113 Undefined header

The supplied command is undefined.

-114 Header suffix out of range

A numeric suffix for one of the command keywords was out of range.

-120 Numeric data error

A numeric value was supplied that could not be represented internally. This can happen if a number with an exponent larger than ± 43 is supplied.

-131 Invalid suffix

A supplied parameter contained invalid units.

-141 Invalid character data

A supplied character data keyword was invalid or undefined.

-148 Character data not allowed

The character data keyword supplied is defined but not allowed.

-151 Invalid string data

The supplied string did not contain matched quotes.

-190 Command buffer overflow

The supplied command exceeded 256 characters and the command buffer overflowed.

Execution Errors

-200 Execution error

A nonspecific execution error occurred.

-213 Init ignored

An INITiate command was received but a measurement was already in progress, so the command was ignored.

-221 Settings conflict

A valid command was received, but it cannot be executed because current settings of the instrument are incompatible with the command. This may occur, for example, if one tries to manually set the frequency of the timebase when it is locked to GPS.

-222 Data out of range

A supplied parameter is out of range.

-230 Data corrupt or stale

An attempt to read data failed because it is already been discarded, corrupted, or lost.

Device Specific Errors

-300 Device specific error

A device specific error occurred.

-314 Save/recall memory lost

A *SAV or *RCL command failed because the settings stored in nonvolatile memory were corrupted or lost.

-350 Error queue overflow

More have errors occurred, but they were discarded because the error queue overflowed.

-360 Communications error

A framing or parity error occurred on the communications interface.

-363 Input buffer overrun

The input buffer for the communications interface overflowed. All data was flushed and the communications interface reset.

-365 Time out error

The instrument timed out waiting for data over the remote interface.

Query Errors

-400 Query error

A nonspecific query error occurred.

-410 Query INTERRUPTED

A new command was received before the previous query was read by the remote interface. The old query will be discarded.

-450 Query lost data

The output buffer for the communications interface overflowed. The query result was discarded.

-451 Query no data

The query resulted in no data.

Instrument Errors

500 GPS time out error

A command was sent to the GPS receiver, but the instrument time out waiting for a response.

501 GPS failed

A command was sent to the GPS receiver, but the receiver rejected it as invalid.

514 Not allowed

A command was received, but rejected not allowed because another remote interface has an exclusive lock on the instrument.

800 EEPROM read/write failed

A read or write to nonvolatile EEPROM failed.

801 FPGA failed

The FPGA failed to initialize.

900 Self test failed

The instrument self test failed.

Example Programming Code

The following program can be used as sample code for communicating with the instrument over TCP/IP. The program is written in the C++ language and should compile correctly on a Windows based computer. It could be made to work on other platforms with minor modifications. In order to use the program, you will need to connect the unit to your LAN and configure it with an appropriate IP address. Contact your network administrator for details on how to do this. To identify the unit's current IP address from the front panel, navigate to Communication > TCP/IP Config. The current IP address will be displayed under Current Config.

Copy the program into a file named "fs740_ctrl.cpp". To avoid typing in the program manually, download the electronic version of this manual from the SRS website (www.thinksrs.com). Select the program text and copy/paste it into the text editor of your choice. Compile the program into the executable "fs740_ctrl.exe". At the command line type something like the following:

fs740_ctrl 192.168.0.5

where you should replace "192.168.0.5" with the IP address of the unit. You should see something like the following:

```
Connection Succeeded
Stanford Research Systems, FS740, s/n001013, ver2.26.11
Closed connection
```

The program connects to the unit at the supplied IP address sets several parameters and then closes. If successful, the sine output frequency should be set to 1 MHz and the sine output voltage level should be set to $0.5 V_{PP}$.

```
/* fs740 ctrl.c : Sample program for controlling the FS740 via TCP/IP */
#include "Winsock2.h"
#include <stdio.h>
/* prototypes */
void init_tcpip(void);
int fs740 connect(unsigned long ip);
int fs740_close(void);
int fs740 write(char *str);
int fs740 write bytes (const void *data, unsigned num);
int fs740 read(char *buffer, unsigned num);
                                /* FS740 tcpip socket */
SOCKET sFS740;
unsigned fs740 timeout = 6000; /* Read timeout in milliseconds */
int main(int argc, char * argv[])
{
 char buffer[1024];
  /* Make sure ip address is supplied on the command line */
 if (argc < 2) {
   printf("Usage: fs740 ctrl IP ADDRESS\n");
   exit(1);
  }
  /* Initialize the sockets library */
  init tcpip();
  /* Connect to the FS740 */
 if ( fs740 connect( inet addr(argv[1]) ) ) {
   printf("Connection Succeeded\n");
    /* Get identification string */
    fs740 write("*idn?\n");
    if ( fs740 read(buffer, sizeof(buffer)) )
      printf(buffer);
    else
     printf("Timeout\n");
    /* Reset instrument */
    fs740 write("*rst\n");
    /* Set sine output frequency to 1 MHz */
    fs740 write("sour:freq le6\n");
    /* Set sine output voltage level to 0.5 Vpp */
    fs740 write("sour:volt 0.5\n");
    /* Make sure all commands have executed before closing connection */
    fs740 write("*opc?\n");
    if ( !fs740 read(buffer, sizeof(buffer)) )
     printf("Timeout\n");
    /* Close the connection */
    if (fs740 close())
     printf("Closed connection\n");
    else
     printf("Unable to close connection");
  }
 else
   printf("Connection Failed\n");
  return 0;
}
```

```
void init tcpip(void)
{
  WSADATA wsadata;
  if (WSAStartup(2, &wsadata) != 0 ) {
    printf("Unable to load windows socket library\n");
    exit(1);
  }
}
int fs740 connect(unsigned long ip)
{
  /* Connect to the FS740 */
  struct sockaddr in intrAddr;
  int status;
  sFS740 = socket(AF INET, SOCK STREAM, 0);
  if ( sFS740 == INVALID SOCKET )
   return 0;
  /* Bind to a local port */
  memset(&intrAddr,0,sizeof(intrAddr));
  intrAddr.sin family = AF INET;
  intrAddr.sin port = htons(0);
  intrAddr.sin addr.S un.S addr = htonl(INADDR ANY);
  if ( SOCKET ERROR == bind(sFS740, (const struct sockaddr *)&intrAddr, sizeof(intrAddr)) ) {
    closesocket(sFS740);
    sFS740 = INVALID SOCKET;
   return 0;
  }
  /* Setup address for the connection to fs740 on port 5025 */
  memset(&intrAddr,0,sizeof(intrAddr));
  intrAddr.sin_family = AF_INET;
  intrAddr.sin_port = htons(5025);
  intrAddr.sin addr.S un.S addr = ip;
  status = connect(sFS740, (const struct sockaddr *)&intrAddr, sizeof(intrAddr));
  if (status) {
    closesocket(sFS740);
   sFS740 = INVALID_SOCKET;
   return 0;
  }
  return 1;
}
int fs740 close(void)
{
  if ( closesocket(sFS740) != SOCKET ERROR )
    return 1;
  else
   return 0;
}
int fs740 write(char *str)
{
  /* Write string to connection */
  int result;
  result = send(sFS740, str, (int) strlen(str), 0);
  if ( SOCKET ERROR == result )
    result = \overline{0};
  return result;
}
```

```
int fs740 write bytes (const void *data, unsigned num)
{
  /* Write string to connection */
  int result;
  result = send(sFS740, (const char *)data, (int)num, 0);
  if ( SOCKET ERROR == result )
   result = \overline{0};
 return result;
}
int fs740 read(char *buffer, unsigned num)
{
  /* Read up to num bytes from connection */
 int count;
  fd set setRead, setWrite, setExcept;
  TIMEVAL tm;
  /* Use select() so we can timeout gracefully */
  tm.tv sec = fs740 timeout/1000;
  tm.tv usec = (fs740 timeout % 1000) * 1000;
  FD ZERO(&setRead);
  FD ZERO(&setWrite);
  FD ZERO(&setExcept);
  FD SET(sFS740, &setRead);
  count = select(0,&setRead,&setWrite,&setExcept,&tm);
  if ( count == SOCKET ERROR ) {
    printf("select failed: connection aborted\n");
    closesocket(sFS740);
    exit(1);
  }
  count = 0;
  if ( FD ISSET(sFS740,&setRead) ) {
    /* We've received something */
    count = (int)recv(sFS740,buffer,num-1,0);
    if ( SOCKET ERROR == count ) {
      printf("Receive failed: connection aborted\n");
     closesocket(sFS740);
      exit(1);
    }
    else if (count ) {
     buffer[count] = ' \setminus 0';
    }
    else {
      printf("Connection closed by remote host\n");
      closesocket(sFS740);
      exit(1);
    }
  }
  return count;
}
```

FS740 Operation Verification

Overview

The operation of an FS740 may be evaluated by running a series of tests designed to measure the accuracy of its inputs and outputs and comparing the results with their associated specifications. While the verification tests presented here are not as extensive as the tests performed at the factory, one can nevertheless have confidence that a unit that passes these tests is functioning properly and within specification.

Equipment Required

In addition to the FS740 under test, the following equipment will be required to carry out the performance tests:

- Agilent U2004A power meter: 9 kHz to 6 GHz
- Agilent 34410A DVM
- SRS SR620 time interval counter
- SRS CG635 clock generator

Equivalent equipment may be substituted as desired as long as they have similar or superior specifications. Standard BNC cables will be required to connect the test equipment to the FS740. Additional accessories required include 50 Ω terminators and various adapters.

Source Output Tests

The source output tests are intended to test the integrity of the source outputs: sine out, aux out, and pulse out.

Sine Output Amplitude Test

The sine output test requires the setup shown in Figure 87. The 50 Ω terminator should be applied at the Sine output so that cable losses do not affect the measurements.

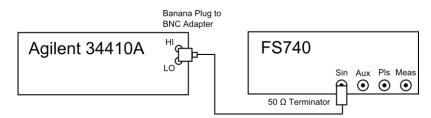


Figure 87: Sine output test setup

Configure the DVM for AC voltage measurements. Enable the math function for dBm calculations with a reference resistor of 50 Ω . Set the FS740 sine output frequency to 10 kHz. Then set the sine output amplitude to the values shown in the first column of Table 22 and record the value measured by the DVM in the second column.

Amplitude (dBm)	Recorded Value (dBm)	Error
5.00		
0.00		
-5.00		
-10.00		
-15.00		
-20.00		
-25.00		
-30.00		
-35.00		

 Table 22: Sine output amplitude test values

Compute the error by subtracting the set amplitude from the recorded value and enter it in the third column. The absolute value of the error should be less than 0.4 dBm

Repeat the test for the rear sine output.

Aux Output Amplitude Test

The aux output test requires the setup shown in Figure 88. The 50 Ω terminator should be applied at the Aux output so that cable losses do not affect the measurements.

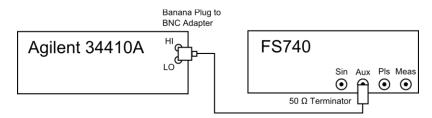


Figure 88: Aux output test setup

Configure the DVM for AC voltage measurements. Enable the math function for dBm calculations with a reference resistor of 50 Ω . Set the FS740 aux waveform to sine and output frequency to 10 kHz. Then set the aux output amplitude to the values shown in the first column of Table 23 and record the value measured by the DVM in the second column.

Amplitude (dBm)	Recorded Value (dBm)	Error
5.00		
0.00		
-5.00		
-10.00		
-15.00		
-20.00		
-25.00		
-30.00		
-35.00		

Compute the error by subtracting the set amplitude from the recorded value and enter it in the third column. The absolute value of the error should be less than 0.4 dBm

Repeat the test for the rear aux output.

Aux 100 MHz Output Amplitude Test

The aux 100 MHz output amplitude test requires the setup shown in Figure 89.

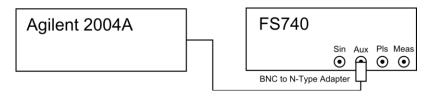


Figure 89: Aux 100 MHz output test setup

Ideally the Agilent power meter should be connected directly to the output with no intervening cables. Set the FS740 aux output to 100 MHz. Measure the power with the Agilent power meter. It should be 2.75 ± 0.5 dBm.

Sine Output Frequency Test

The sine output frequency test requires the setup shown in Figure 90.

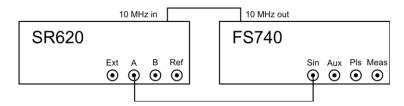


Figure 90: Sine output frequency test setup

Configure the SR620 to measure frequency on channel A, with a gate of 1.0 s, a sample size of 1, and a trigger level of 0.0 V, terminated into 50 Ω . Set the FS740 sine output amplitude to 1.0 V_{PP}. Set the sine output frequency to each test value shown in Table 24 and record the frequency measured by the SR620 next to it in column 2.

Table 24: Sine output frequency test values

Set Frequency (MHz)	Recorded Frequency (Hz)	Relative Error
5.0		
10.0		
15.0		
20.0		
25.0		
30.0		

Compute the relative error for each measurement using the following equation:

$$Relative Error = \frac{Recorded \ Frequency - Set \ Frequency}{Set \ Frequency}$$

The absolute value of the relative error should be less than 1e-9.

Repeat the test for the rear sine output.

Aux Output Frequency Test

The aux output frequency test requires the setup shown in Figure 91.

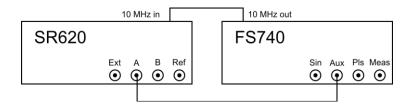


Figure 91: Aux output frequency test setup

Configure the SR620 to measure frequency on channel A, with a gate of 1.0 s, a sample size of 1, and a trigger level of 0.0 V, terminated into 50 Ω . Set the FS740 aux output to sine waves with amplitude 1.0 V_{PP}. Set the aux output frequency to each test value shown in Table 25 and record the frequency measured by the SR620 next to it in column 2. For the final measurement, change the output waveform from sine waves to 100 MHz.

Table 25: Aux output frequency test values

Set Frequency (MHz)	Recorded Frequency (Hz)	Relative Error
2.0		
4.0		
6.0		
8.0		
10.0		
100 MHz waveform		

Compute the relative error for each measurement using the following equation:

 $Relative Error = \frac{Recorded \ Frequency - Set \ Frequency}{Set \ Frequency}$

The absolute value of the relative error should be less than 1e-9.

Repeat the test for the rear aux output.

Pulse Width Test

The pulse width test requires the setup shown in Figure 92.

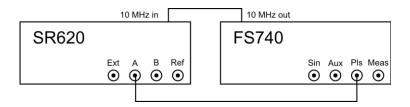


Figure 92: Pulse width test setup.

Configure the SR620 to measure pulse width on channel A with a sample size of 1000 and the trigger level set to 2.0 V. Configure the FS740 with a pulse period of 1.01 μ s and a pulse width of 100 ns. Take a measurement with the SR620 and then set the REL. New measurements should be close to zero. Now increase the pulse width of the FS740 in 1 ns steps and record the results in Table 26.

Set Width (ns)	Recorded Width (ns)	Expected Width (ns)	Error
100.0		0.0	
101.0		1.0	
102.0		2.0	
103.0		3.0	
104.0		4.0	
105.0		5.0	
106.0		6.0	
107.0		7.0	
108.0		8.0	
109.0		9.0	
110.0		10.0	

Table 26: Pulse width test values

Compute the error by subtracting the expected value from the recorded value. The absolute value of the error should be less than 0.1 ns.

Repeat the test for the rear pulse output.

Pulse Frequency Test

The pulse frequency test uses the same setup as the pulse width test shown in Figure 92. Configure the SR620 for frequency measurements on channel A, a gate of 1 second, a sample size of 1, and a trigger level of 2.0 V. Configure the FS740 pulse output to source 1 MHz with a 50 % duty cycle. Record the frequency measured by the SR620 at the top of the second column in Table 27. Next, set the FS740 pulse output frequency to each frequency listed in Table 27, and record the frequency measured by the SR620 next to it in the table.

Set Frequency (Hz)	Recorded Frequency (Hz)	Error
1,000,000.0		
1,000,001.0		
1,000,002.0		
1,000,003.0		
1,000,004.0		
1,000,005.0		
1,000,006.0		
1,000,007.0		
1,000,008.0		
1,000,009.0		
1,000,010.0		

Table 27: Pulse frequency test values

Compute the error for each measurement by subtracting the recorded measurement from the set frequency. The absolute value of the error should be less than 0.001 Hz.

Repeat the test for the rear pulse output.

Measurement Input Tests

The measurement input tests are designed to test the functionality of the front and rear measurement inputs. The frequency test setup is shown in Figure 93.

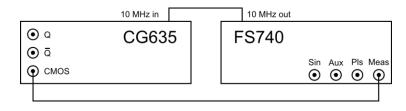


Figure 93: Measurement input frequency test setup.

Configure the CG635 for CMOS 3.3 V levels. Configure the FS740 for frequency measurements, and set trigger input level for 1.5 V. Configure the gate for 1.0 s and sample size to 10. Set the CG635 to the frequencies specified in the first column of Table 28. Make a measurement and use the statistics and stability tabs to record the average frequency and the 1 second stability of the measurement.

Table 28: Measurement input test frequencies

Set Frequency (Hz)	Recorded Frequency (Hz)	Relative Error	Stability
10,000,000.1			
50,000,000.5			
60,000,000.6			
70,000,000.7			
80,000,000.8			
90,000,000.9			
100,000,001.0			
110,000,001.1			
120,000,001.2			

Compute the relative error for each measurement using the following equation:

 $Relative Error = \frac{Recorded \ Frequency - Set \ Frequency}{Set \ Frequency}$

The absolute value of the relative error should be less than 1e-11. The recorded stability should be less than 1e-10.

Repeat the test for the rear measurement input.

Conclusions

The tests described in this document are designed to test the basic functionality of the unit. They are not intended to be a substitute for the complete performance test which is performed at the factory. Nevertheless, one can have reasonable confidence that instruments that pass the tests described in this document are operating correctly. As always, if an instrument fails to pass a test, verify that the setup has been duplicated correctly, and that the individual procedures have been followed as specified. Instruments that have failed to meet specifications may be returned to SRS for repair.

FS740 Circuit Description

Overview

The FS740 provides a 10 MHz frequency reference which is disciplined by GNSS with a long term stability of better than 1:10¹³. The instrument can also time tag external events with respect to UTC or GNSS and measure the frequency of user inputs. The instrument also has DDS synthesized frequency outputs, adjustable rate (and width) pulse outputs, and an AUX output for arbitrary waveforms including an IRIG-B timecode output. A GUI (graphical user interface) allows the user to configure the instrument and see the results of time and frequency measurements.

The performance of the 10 MHz output depends on the installed timebase. The standard timebase provides $1:10^9$ short term frequency stability and phase noise of less than -100 dBc/Hz at 10 Hz offset. An optional OCXO (ovenized crystal oscillator) timebase provides $1:10^{11}$ short term frequency stability and phase noise of less than -130 dBc/Hz at 10 Hz offset. An optional rubidium timebase provides $1:10^{12}$ short term frequency stability, phase noise of less than -130 dBc/Hz at 10 Hz offset, and a long term holdover (lost GNSS signal) of better than 1 μ s/day.

Either optional timebase (OCXO or rubidium) provides a dramatic improvement in the holdover characteristics, a 30 dB reduction in the phase noise and a tenfold reduction in the TDEV. There are some users who would not need this performance improvement. For example, users who only need time tags with 1 μ s accuracy or frequency measurements with 1:10⁸ accuracy could use the standard timebase.

The FS740 provides bias for a remote active GNSS antenna. The unit's GNSS receiver tracks up to 12 satellites, will automatically survey and fix its position, then use all received signals to optimize its timing solution. The FS740 time-tags the 1 pps output from the receiver, corrects the result for the receiver's sawtooth error, then phase locks the timebase to the GNSS 1 pps with an adjustable time constant between 10 seconds and 4000 s. The TDEV (rms timing deviation) between two instruments is a few nanoseconds.

If the GNSS signal is lost, the timebase is left at the last locked frequency value. The timebase will age or drift in frequency by up to ± 2 ppm (for the standard timebase), ± 0.05 ppm/year and ± 0.002 ppm (0 to 45° C) for the OCXO, and ± 0.001 ppm/year and ± 0.001 ppm (0 to 45° C) for the rubidium timebase.

There are two user inputs (one on the front, one on the rear panel) for frequency and time tag events. The inputs have adjustable thresholds and slopes. Frequencies are measured with a precision of $1:10^{11}$ in 1 s, $1:10^{12}$ in 10 s, and $1:10^{13}$ in 100 s. Time tags are reported with 1 ps resolution commensurate with the short term stability of the OCXO and rubidium timebases. Time tags will have an error of about 10 ns rms with respect to UTC or GNSS time.

The FS740 has a rear panel low phase noise 10 MHz sine output with an amplitude of 1 Vrms. Up to 15 additional copies of the 10MHz output are available via optional rear panel outputs.

The FS740 has front and rear panel sine outputs which provide sine outputs from 1 mHz to 30.1 MHz with 1 μ Hz resolution, or a fixed 100 MHz, with adjustable amplitude from 100 mV to 1.2 V rms. Up to 15 additional copies of the sine outputs are available via optional rear panel outputs.

The FS740 has front and rear panel pulse outputs which can provide low jitter pulses from 1 mHz to 25 MHz. The pulse outputs have adjustable phase with respect to UTC and the pulse width can be set as narrow as 5 ns, or as wide as the entire pulse period minus 5 ns, with 1 ps resolution. Up to 15 additional copies of the pulse outputs are available via optional rear panel outputs.

The FS740 has front and rear panel auxiliary (aux) output which can generate standard or arbitrary waveforms (sine, ramp, triangle, etc.) The aux output can also provide an AM modulated IRIG-B timecode output. Up to 15 additional copies of the aux output are available via optional rear panel outputs.

A rear panel alarm relay is set if power is lost or under user defined conditions including: timebase fault, loss of GNSS reception, or any failure to maintain phase lock between the timebase and GNSS. The relay has both normally open and closed outputs.

Optional distribution amplifiers, each providing five additional rear panel outputs for the 10 MHz, SINE, PULSE, AUX or IRIG-B outputs, can be installed. Up to three distribution amplifiers can be installed and configured from the front panel. Each output has its own driver which provides high isolation between outputs.

The instrument may be used without GNSS. The (optional) rubidium timebase has a lifetime aging of only a few parts per billion, and can serve as an autonomous laboratory timebase in many applications.

Sub-Systems

The FS740 has five sub-systems: The front panel, the motherboard, the power supply, the (optional), rear-panel distribution amplifiers and the (optional) timebase. When reading circuit descriptions it is useful to know that the first digit of a component reference is the same as the sheet number in the schematics. Hence, R321 would be found on the third schematic sheet of a particular sub-assembly.

Front panel

The main display is a 480x272 color TFT LCD with white backlights and a capacitive touch screen. The front panel PCB uses a 32-bit ARM MPU (U105, an LPC1788FBD208) to drive the LCD, interpret touch screen commands, and send commands to the motherboard. A USB port, which was used during product development and may be used in future products, is not used in the FS740.

There are two large memories on the front panel PCB. A $32 \times 8M$ dynamic RAM and a $16 \times 16M$ flash. The flash is primarily used for display fonts, and the RAM is used as program memory and as 512k sample storage for the motherboard.

The front panel controls the FS740 very much like a remote computer would do. For example, when a user enters a frequency for the SINE output, the front panel MPU displays the number as it is being entered, and sends a command to the motherboard to

Page 1

change the frequency only after the User presses the Enter key. Similarly, if the User asks to see the result of a frequency measurement, the front panel sends a query to the motherboard, the motherboard responds with the result, and the front panel MPU displays it.

The interface between the front panel and the motherboard is via the 16 pin header, J201. There is a LVDS pair with the 10 MHz frequency reference passed up from the motherboard on J201. A line receiver, U201, converts this to a CMOS logic level. The MPU's 12 MHz clock is phase locked to the 10 MHz reference to avoid clock-walk interference between the display PCB and the motherboard. The MPU provides 10 MHz to the phase detector from one of its PWMs. The PLL consists of a phase detector (U104), a LPF (R114, R116 and C125), and a varactor (D105).

A switch-mode boost regulator provides about 40 mA at about 19.2 V to power the display backlight LEDs. The regulator operates at nominal 1 MHz switching frequency, and has under voltage lockout, and over voltage and thermal protection.

Motherboard

10 MHz, 20 MHz and 100 MHz

A temperature controlled 20 MHz timebase is the reference source used in all instrument configurations. A 20 MHz, 3^{rd} overtone, AT-cut resonator (Y100) is operated in a Colpitts oscillator, with an NPN transistor (Q102) as the active element. The bias current and voltage of Q102 are carefully controlled to reduce drift and aging. The bias voltage to the collector of Q102 is set by the +4.096 systems voltage reference, reduced by the base-emitter drop of Q101. The collector bias currents are maintained at 4 mA by U101 (operating as an integrator) which controls the base current to Q102 via the 100 k Ω resistor, R118. U101 servos the voltage drop across the 1.00 k Ω shunt resistor (R104) to the +4.096 V system voltage reference.

The temperature of the 20 MHz oscillator is controlled to about 55 C, which is the upper turning point for the 3rd OT, AT-cut resonator. The temperature controller consists of an NTP thermistor (R120), an integrator (U104B), a level shifter (U104A), and two heaters (U100 and Q100).

The 20 MHz sine across L102 is amplified by U106, and limited by U110, to produce a clean 20 MHz square wave. The 20 MHz square wave is used as the reference to the 100 MHz PLL. It is also divided by two to generate a 10 MHz square wave to clock three hex buffers. All of the hex buffers drive the primary of RF transformers (T101-T103) that have 2:1 turn ratios, matching 50 Ω loads to the 200 Ω source. One of the RF transformer outputs drives an analog mixer, which is part of the PLL which locks the 20 MHz Colpitts oscillator to an optional timebase. Two of the RF transformer outputs are filtered by 5th order Cauer low pass filters (11 MHz) that have notches at 30 MHz. One of these filters drives the rear panel 10 MHz sinewave output, the other is the source for the 10 MHz optional rear panel distribution amplifiers.

The varactor frequency control (D101) for the 20 MHz reference oscillator is provided by either the high resolution DAC (BIG_DAC) or, in the case of an installed optional timebase, by the output of the PLL integrator, U102B. The logic signal DAC/-PLL determines the source. When DAC/-PLL is low, the input to the integrator comes from the

phase detector, U105, which is a +13 dBm level doubly-balanced diode mixer. When DAC/-PLL is high, the output of the PLL integrator is servo'd to BIG_DAC.

The reference frequency for the 20 MHz oscillator PLL comes from one of the optional timebases (either a 10 MHz OCXO or a rubidium frequency standard). The optional timebase is held with a bracket, and plugs into the motherboard via the 10-pin header, J100. The presence and type of optional oscillator is automatically detected by the motherboard.

The instrument uses a 100 MHz timebase for all timing functions. A 100 MHz VCXO (U119) is phase locked to the 20 MHz crystal timebase (which may itself be phase locked to an optional OCXO or rubidium frequency standard). A five channel ECL driver (U120) provides five source terminated, 100 Ω , LVDS 100 MHz system clocks (for the waveform DACs, FPGA, CPU, time-tagging TACs, and the pulse generator). The 100 MHz can also be sourced as an AUX output when U116 drives a 120 MHz low-pass filter (with notches at 200 MHz and 300 MHz). This 100 MHz sinewave is transformed into a balanced signal by T103 that is sourced and terminated by 100 Ω .

GNSS Timing Receiver and Time-Tagging

Page 2

An OEM GNSS timing receiver is used to provide GNSS and GLONASS timing as a 1 pps pulse and a serial message. The timing receiver, U206, requires an active antenna. Bias current, short-circuit current protection, and current monitoring for the antenna is provided by U201, U201 and Q203. The dc bias is decoupled from the satellite signals (1575.42 MHz for GNSS) by L204, a 0.12 μ H inductor which is self-resonant near that frequency.

The TPS2030 is a 33 m Ω high-side MOSFET switch that limits the antenna bias current to 300 mA. The device also has a thermal shutdown and an overcurrent logic output. The antenna current is measured with the 1 Ω shunt resistor, R213. A current mirror, U201 and Q203, cascodes 1% of the antenna current into R217, providing a voltage of 1 V per 100 mA of antenna current for measurement by the MPU's ADC.

The 1 pps output from the GNSS timing receiver is aligned with UTC and time-tagged with sub-picosecond resolution. One of two inputs can be selected as the input to the time-tagging circuit by U211: A calibration signal, ±CAL_TRIG1 or the 1 pps from the timing receiver. The selected signal is converted to LVDS by U213 and transmitted to the time-tagging input, U214. The rising edge of the output of U214 is the time-tagged event.

A 100 MHz free running counter in the FPGA (Sheet 4) is used to time-tag events with 10 ns of resolution (digital time). A time-to-amplitude converter (TAC) is used to measure the time between the event and the second edge of the 100 MHz clock after the event (an interval between 10 ns and 20 ns). The output of the TAC is digitized, scaled, offset and subtracted from the digital time to provide a time tag with picosecond resolution.

The time-tagging circuit has several requirements: To provide a SYNC clock to the FPGA with has been re-sync'd to the 100 MHz system clock. To enable a current source for the interval between the event and the second 100 MHz clock edge after the event. To integrate the current and so convert the time interval to a voltage. And to be reset prior to the next event.

There are four D-type flip flops which are part of the time-tagging circuit. These are very fast CMOS flip-flop, operated from +2.5 V, and with CLK-Q propagation delays between

0.5 ns and 1.4 ns. The first two (U207 and U208) are clocked by the event, and the event delayed by about 4 ns. The last two flip-flops (U209 and U210) are clocked by the 100 MHz system clock. An important part of the design methodology is the avoidance on metastability (the modulation of the propagation delay from the clock input to the data output when the clock edge is close to a change in data, set, or reset inputs).

The first flip-flop (U207) is clocked by the event input. It is possible that the CLR input to this flip-flop was just removed, and so to avoid metastability problems, the output of the first flip-flop is resynchronized by clocking a second flip-flop (U208) with the delayed event. The output of the second flip-flop is synchronous with the event and free of any metastability artifacts. This output is used to start the TAC interval, by pulsing the analog integrator reset (U204) high, reverse biasing D200, and allowing the integrator current (from Q201B) to start charging C203.

The output of the second flip-flop is clocked serially into the third flip-flop (U209) and the fourth (U210). The output of the fourth flip-flop stops the TAC interval by turning off the current from Q201B. The double resynchronization serves two purposes: to remove the metastability between the event and the 100 MHz clock, and to make the minimum TAC interval 10 ns.

The integrator's current source is controlled by U200 and Q200. The feedback network provides a virtual null to the op amp inputs when +4.096/2 is across the 200 Ω shunt resistor, R201. The current through the shunt, about 10.24 mA, is cascoded through Q200. The collector current from Q200 is switched between Q201A and Q201B under the control of the flip-flop U210.

During the TAC interval, the current integrates on C203. The voltage on C203 is buffered by U203, a fast FET input op amp configured with a gain of two. The output of the buffer amp is digitized by U403 (Sheet 4). The output voltage has a scale factor of about 2 V/10 ns. The +4.096 V full-scale 16-bit ADC provides a timing resolution of about 0.3 ps. The TAC voltage is a measure of the time between the event and the second clock edge of the 100 MHz system clock.

The integrator is reset by U204. When the time-tagger is reset from the prior event, the first flip-flop (U207) is cleared by EN_TAG1 going low. The Q output from U207 clears the other three flip-flops, returning the non-inverting input of U204 to ground. The diode, D201, is biased with about 10 mA of current, creating a voltage of about +0.7 V. The op amp has a gain of minus one, and so its output is at about -0.7 V, compensating for the voltage drop across D200. The integrating capacitor, C203, will be reset to about +0.5 V (the voltage across R221 with 10 mA passing though it). The RC time-constant is about 5 ns.

Front and Rear Panel Time-Tags

Page 3

There are three time-tagging channels in the FS740. The first, described above, is dedicated to time-tagging the GNSS 1 pps output. The other two are general purpose time-taggers available to the user via front and rear panel BNC "MEASURE" inputs. These inputs can be used to time-tag events with respect to UTC or to measure frequency and frequency stability.

The input discriminators for these time-tagging channels are located on Sheet 7 of the motherboard schematics. The dc coupled, 1 M $\Omega/22$ pF, input comparators can be selected and have their outputs converted to LVDS. (Calibration timing signals can also be

selected. They are the LVDS signals \pm CAL_TRIG2 and \pm CAL_TRIG3. These signals are used to determine offsets and scale factors for the TACs which are part of the time-tagging circuits.)

The time-tagging circuitry for the front and rear panel are very similar to that used for the GNSS time-tagging, except they are designed to support a high conversion rate. For example, when measuring 100 MHz, each cycle of the 100 MHz signal is counted by the FPGA via the \pm CNT2 or \pm CNT3 LVDS signals, and time-tags of particular zero crossings can be made every 16 μ s.

FPGA

Page 4

A 250,000 gate Xilinx FPGA, operating from +3.3 V, +2.5 V, and +1.2 V, is used to timetag events and generate output waveforms. The FPGA is clocked at 100 MHz and is serially connected to a 16-bit ADC (to digitize the TACs, etc.) and to the MPU. The serial interface between the MPU and the FPGA allows the MPU to program, control, and read data from the FPGA.

A free running counter on the FPGA, clocked at 100 MHz, can be latched by any of three SYNC inputs to provide the digital portion of the time-tag. Three asynchronous CNT inputs clock counters and can be latched by their corresponding TAG inputs. The CNT inputs are used to count cycles of a frequency source, which together with time-tags, provide high resolution frequency measurements.

A 16-bit ADC is serially interfaced to the FPGA. The ADC is read constantly to digitize the TACs, which provide the analog portion (0-10 ns) of the time-tags. The ADC operates for an internal +4.096 V voltage reference.

The FPGA provides parallel data to four 14-bit DACs at a 100 MHz sample rate. The AUX data is used to generate the analog AUX output (sine, triangle, square, and AM IRIG-B). The FREQ data is used to generate a sine wave output between 0.001 Hz and 30.1 MHz. The START and STOP data are used to adjust the timing of the leading and trailing pulse output edges allowing any pulse frequency from 0.001 Hz to 25 MHz. The FPGA also provides the counting logic and outputs to control the pulse generator and time-tagging circuitry.

Fast Analog Waveforms

Page 5

Four 14-bit DACs, updated by the FPGA at a 100 MHz sample rate, are shown on Sheet 5. DAC outputs for the SINE and AUX outputs are filtered for waveform reconstruction. The SINE waveform is filtered with a differential, 7th order, Cauer low pass filter, with a 33 MHz passband and >80 dB attenuation above 65 MHz. The AUX output is filtered with a differential, 7th order, Bessel low pass filter with a 12 MHz passband and 90 dB attenuation at 90 MHz. All filters have a 200 Ω source and load termination, and each drives three differential buffer amplifiers (AD8131s). The differential buffer amplifiers pass copies of the analog waveforms to the front, rear, and optional rear panel outputs.

Both the SINE and AUX DACs have their own amplitude control. The 12-bit system DAC (U818 on Sheet 8) provides FREQ_AMPL and AUX_AMPL which program the DAC set currents to control the amplitude. Both halves of the op amp, U508, are operated with a gain of 3x. Increasing FREQ_AMPL or AUX_AMPL drives the corresponding output lower, increasing the current through the programming resistors (R523 and R530), and so increasing the output amplitude.

Two of the 14-bit DACs provide agile, unfiltered, differential waveforms with a 100 Ω source impedance. These waveforms are used to control the timing of the leading (start) and trailing (stop) edges of the PULSE generator output. The pulse generator can be operated at any frequency between 0.001 Hz and 25 MHz. The timing of each pulse edge is controlled by the FPGA, which determines both the analog (0-10 ns) and digital (n x 10 ns) timing of both leading and trailing edges of the pulse output.

Agile Pulse Generator

Page 6

The term "agile" refers to the ability of the pulse generator to determine the timing of each pulse generator edge on-the-fly. Certain pulse generator frequencies are easy to generate from a fixed 100 MHz system clock. For example, a 1 MHz output is had by simply dividing the system clock by 100. Other frequencies require more work. For example, a 9 MHz output has a period of 111.111111 ns. To arrange this we would count 11 cycles of the 100 MHz clock (for 110 ns of delay) and increase the analog delay by 1.111111 ns for each cycle. After 9 cycles, the analog delay would return to zero and we increase the cycle count to 12 for just one period. All this is computed and controlled by the FPGA in real time.

The agile characteristic make it easy to adjust the phase of the pulse generator output, for example, to align the leading edge to UTC. It also allows any frequency to be generated, not just submultiples of the 100 MHz system clock. Further, it allows an unlimited duty cycle range for the output pulse. The only significant downside is jitter, which can be as large as 50 ps rms for outputs which are not submultiples of the 100 MHz system clock.

The pulse generator output is the XOR (U614) between the DELAYED_START (U606) and the DELAYED_STOP (U626). The start and stop are initiated by PULSE_START and PULSE_STOP, which are 20 ns logic signals from the FPGA. The circuits for the START and STOP channels are virtually the same, and so only the START path will be described.

The pulse is initiated when the FPGA asserts PULSE_START. This signal is re-sync'd to the 100 MHz system clock by the flip-flop, U602. When the Q output from U602 goes high (to +2.5 V) the output of the op amp, U600A with a gain of 2x, goes down by 5.0 V. This reverse biases D600, which had been holding the integrating capacitor (C609) in it preset condition (a diode drop below +8.192 V). The constant current source (Q603) linearly discharges C609.

The differential pair, Q602A and Q602B, are used as a fast, low gain comparator. When the voltage on C609 ramps down to the output of U611 (which is controlled by the 14-bit START_DAC), the comparator will cross over, clocking U606 via U608, and so asserting the DELAYED_START.

The analog delay span is adjusted to exactly 10 ns via CAL_START's control of the constant current source which controls the ramp speed on C609. In this way, the resolution of the analog delay is about 10 ns / $2^{14} = 0.61$ ps.

The XOR output, U614, is high for the interval between the DELAYED_START and the DELAYED_STOP. When DELAYED_STOP is asserted, an 8 ns reset pulse, -EOC, is generated by U633, which resets both flip-flops (and de-glitches the XOR output as the flip-flops are reset). The XOR output can be held off by PULSE_EN (U618) or inverted by PULSE_INV (U617).

Three LVDS copies of the pulse output are generated by U603, U612, and U609, for the front, rear and optional outputs. Output drivers for the front PULSE output consists of an LVDS line receiver (U604), a 0.7 V offset source (Q601), a delay equalizer (U630) and an output driver (U601). The output source impedance is about 50 Ω , and the output pulse shape is improved with the C602/L600/R600/C600 network. The rear panel PULSE output is the same.

By enabling EN_PULSE_CAL, which sources the pulse generator to the time-tagging TACs, the two systems can be used to calibrate each other. For both circuits, it is important to calibrate the full scale analog delay, or analog time-tag, to be 10 ns. When the pulse generator output is being measured by the time-tagger, the value of the CAL_START DAC is adjusted until the full scale analog delay is equal to the duration of one 100 MHz clock cycle. Similarly, by adjusting the pulse generator output to a boundary of a 100 MHz clock cycle, the full scale span of the TAC can be measured.

Inputs and Outputs

Page 7

There are two identical input discriminators, one for the front panel and one for the rear. The front panel circuit will be described here. The front panel MEASURE input BNC has an input impedance modeled by 1 M Ω in parallel with 22 pF. The high impedance, dc coupled, input network attenuates the signal by $\frac{1}{2}$, and level shifts the input by +2 V. The current from the level shifter is balanced by an equal and opposite current through R708, so that no level shift is seen at the BNC input to the instrument. The attenuated and shifted input is compared to the FRONT_LVL DAC voltage by U701, whose output can be inverted, or not, by U702. The output of U702 can be selected to drive an LVDS transmitter to drive the time-tagging input on Sheet 3.

Four differential analog line receivers and output drivers (U700, U706, U713, and U714) are used to drive the front and rear panel SINE and AUX outputs. The line receivers provide a high CMRR, some gain, drive the output via a 50 Ω series resistor. The output amplitude, terminated into 50 Ω , can be set between 10 mV_{pp} and 1.414 V_{pp}. (Output amplitudes double when unterminated.)

The interface to the optional rear panel outputs is via J706. Three different distribution amplifiers are available, and each has 5 identical outputs. Opt A provides 10 MHz outputs (typically used to provide external 10 MHz inputs to other instruments). Opt B provides either SINE or AUX outputs. Opt C provides +5 V pulse outputs (or +2.5 V into 50 Ω). The FS740 automatically identifies what type card populates each of the three available rear panel slots.

Microcontroller

Page 8

The instrument uses an MCF52235CAL60 microcontroller (MPU). The part has internal RAM, ROM, SPI, UART, and Ethernet interfaces. Most peripherals are communicated with via the SPI. The SPI addresses are split into two domains. The Noisy Domain is for parts (such as memory) which are tolerant of clock and data noise when the SPI is communicating to other devices. The Quiet Domain is for devices which cannot tolerate the interference from an active SPI bus when they are not being addressed (such as PLL synthesizers). The Quiet Domain's SPI CLK and DATA are gated off when not addressing a device in the Quiet Domain.

The MPU operates from +3.3 V using a 25 MHz clock. The 25 MHz clock is derived by dividing the 100 MHz system clock by four with U812 and U813. An 8 MB serial flash

memory is connected to the MPU via the SPI. This memory holds the configuration data for the FPGA.

A very quiet 16-bit DAC (U819, an AD5760) provides a low noise, high resolution signal to control the frequency of the 20 MHz oscillator, or the optional OCXO or rubidium oscillators. The resolution of this DAC is extended by scaling and summing a 12-bit DAC with hysteresis.

An octal 12-bit DAC, U818, provides eight analog voltages for system control and calibration. They are:

- 1. BIG_DAC_TWEEK divided by 1000 and summed with BIG_DAC
- 2. TEMP_CTL to control the temperature of the 20 MHz oscillator
- 3. CAL_START to calibrate the analog delay of the pulse generator START
- 4. CAL_STOP to calibrate the analog delay of the pulse generator STOP
- 5. FRONT_LVL to adjust the threshold for the front panel MEASURE input
- 6. REAR_LVL to adjust the threshold for the rear panel MEASURE input
- 7. FREQ_AMPL to adjust the amplitude of the SINE OUT
- 8. AUX_AMPL to adjust the amplitude of the AUX OUT

The instrument has both RS232 and LAN interfaces. The RS232 is level shifted to +3.3 V logic by U807. (Low cost RS2332/USB dongles are available to connect the instrument to computers via the USB.) There is also an Alarm Relay output on the rear panel. Both Normally Open and Normally Closed contacts are available.

The front panel interfaces to the motherboard via the 16-pin header, J803. The front panel GUI uses a touch screen display and an NXP1788 MPU. The front panel MPU clock is phase locked to the 10 MHz from the motherboard to stop clock-walk interference.

Power Supplies

Page 9

The instrument is powered from a separate, enclosed, line powered supply which provides un-switched +24 V (for the timebases), ± 15 V, ± 5 V, and +3.3 V. The power supply plugs into the motherboard via the 10-pin header, J900. The power supply inverter is operated at 100 kHz by providing a 200 kHz pulse train to the power supply. The power supply cannot be switched off.

Power Supply

The power supply for the unit is contained in a separate shielded enclosure. The unit accommodates universal input voltages (90-264 VAC, 47-63 Hz) and provides a variety of dc voltages to the motherboard (+24, +15, +5, +3.3, -5, -15 V.) The unit will lock its dc-dc converter to a 200 kHz sync signal provided by the motherboard. The unit also has a thermostatically controlled fan whose speed increases with increasing temperature.

An OEM power supply (CUI Inc. VSBU-120-24) provides up to 5 A at +24 V from the line voltage input. This power supply is "on" whenever the line voltage is present, supplying +24 V to the motherboard to power the timebase (either the standard ovenized crystal or optional rubidium oscillator.) The +24 V supplied to the motherboard is filtered by L1 & C1 to remove ripples from the OEM power supply. The OEM supply also provides +24 V for a dc-dc converter to generate the other regulated voltages used in the system. The dc-dc converter and fan are always "on" in the FS740.

The dc-dc converter is disabled when the –DISABLE (pin 8 on the motherboard interface) is held low. When –DISABLE is released the switching power supply controller, U7, generates complementary square waves at about 100 kHz to drive the MOSFETs (Q2 & Q3) into conduction during alternate half-cycles. The MOSFETs drive the primary of a transformer. The secondary voltages are rectified, filtered, and regulated to provide the +15, +5, +3.3, -5, & -15 V system voltages.

The regulated outputs have Schottky diodes on their outputs which prevent the power supplies from being pulled to the wrong polarity by loads which are connected to other supplies with opposite polarities. This is most important during start-up and to avoid SCR action in CMOS ICs in the case that one of the supplies should fail.

A thermostatic fan speed control helps to regulate the operating temperature of the entire instrument. This circuit uses an LM45 ($10mV/^{\circ}C$) as a temperature sensor. The output from the temperature sensor is offset, multiplied, and limited to a 0-15 V range. This voltage is drives a 12 V medium speed fan via the emitter follower, Q1.

Optional Rear Panel Outputs

There is room for three optional distribution amplifiers on the rear panel of the instrument, and there are three different types of distribution amplifier available. Each distribution amplifier provides five outputs of the same signal. The instrument will recognize and configure these options and they can be installed in any combination or order.

A small vertical PCB is used to connect the option boards to the motherboard. In addition to connecting all the differential signals and various power supplies, this vertical PCB provides the correct termination impedance of each signal.

Optional 10 MHz Outputs

Option A is a distribution amplifier which provides five 10 MHz outputs at 1 V_{RMS} (+13 dBm) into a 50 Ω load. The floating, transformer coupled, 10 MHz on pin 1&2 of the vertical PCB is converted to a single-ended signal by simply grounding one side. The input amplifier, U1, provides gain and drives a common line which is the input to each to the five output drivers. Throughout, the LC tanks (750 pF and 0.33 μ H) which are resonant at 10 MHz, provide bandpass filtering and remove dc offsets and each power supply pin is filtered with a bead and a bypass capacitor. The five output drivers provide isolation, gain, and a 50 Ω source impedance. The non-inverted feedback of the MOSI to the MISO on the SPI identifies the installed option.

Optional SINE/AUX Outputs

Option B is a distribution amplifier which provides five SINE or AUX outputs into a 50 Ω load. The selection of the output, and its amplitude and frequency, is controlled from the front panel GUI. There are two differential line receivers, U1 and U4, which convert the differential SINE and AUX signal to single-ended signals with gain. An analog multiplexer, U2, selects either SINE or AUX, which is buffered and amplified by U3A. Each of five output buffers provides gain and a 50 Ω source impedance.

The SPI interface latches a single bit on MOSI into U7 to control the analog multiplexer. The latched bit is level shifted from +3.3/0 V to ± 2.5 V by U8. The latched bit is also returned via MISO. The one clock cycle delay on the SPI identifies the installed option.

Optional Pulse Outputs

Option B is a distribution amplifier which provides five pulse outputs via a 50 Ω source impedance. The LVDS pulse waveform is converted to +3.3/0 V logic by U3. The output of U3 is level shifted by Q1 and buffered by U1, which drives a 75 Ω bus. The five output buffers provide output pulses via a 50 Ω source impedance. The power supply filter on each output buffer provides isolation and reduces output overshoot. The inverted feedback of the MOSI to the MISO on the SPI identifies the installed option.

Optional Timebases

The standard instrument uses a temperature controlled, 20 MHz, 3rd OT, AT-cut resonator for its timebase. When an optional timebase is installed, the 20 MHz oscillator is phase locked to the 10 MHz from the optional timebase.

There are two optional timebases. The OCXO option is an oven controlled oscillator with a 3rd OT SC-cut resonator. The OCXO provides a substantial reduction in the in-close phase noise and much lower aging than the standard oscillator. The other option is a rubidium frequency standard which also has low phase noise and has about 100x lower aging than the OCXO. One of these options should be ordered if low phase noise is important. The rubidium option should be ordered if low frequency drift in the absence of the GNSS reference is needed.

Both optional timebases can use the same mounting bracket and interface PCB. They are both powered by +24 Vdc and are frequency controlled by an analog voltage (BIG_DAC). The FS740 automatically detects the presence, and type, of an installed optional timebase. The status of the rubidium timebase can be queried over a serial interface (MORI and MIRO), which allows the FS740 to determine its lock status, etc.

Appendix A: Parts List

Front Display (Assembly 746)

Ref	Value	Description	SRS P/N
C102	100000P	Capacitor, 0603, X7R	5-00764
C103	100000P	Capacitor, 0603, X7R	5-00764
C104	100000P	Capacitor, 0603, X7R	5-00764
C105	100000P	Capacitor, 0603, X7R	5-00764
C106	100000P	Capacitor, 0603, X7R	5-00764
C107	100000P	Capacitor, 0603, X7R Capacitor, 0603, X7R	5-00764
C108 C109	100000P 100000P	Capacitor, 0603, X7R	5-00764 5-00764
C105	100000P	Capacitor, 0603, X7R	5-00764
C111	100000P	Capacitor, 0603, X7R	5-00764
C112	100000P	Capacitor, 0603, X7R	5-00764
C113	100000P	Capacitor, 0603, X7R	5-00764
C114	100000P	Capacitor, 0603, X7R	5-00764
C115	100000P	Capacitor, 0603, X7R	5-00764
C116	100000P	Capacitor, 0603, X7R	5-00764
C121 C122	4.7UF / 50V X5R 100000P	Ceramic, 16V, X5R Capacitor, 0603, X7R	5-00807 5-00764
C122	100000P	Capacitor, 0603, X7R	5-00764
C124	1000P / X7R	Capacitor	5-00911
C125	100000P	Capacitor, 0603, X7R	5-00764
C126	5.6P	Capacitor, 0603, NPO	5-00684
C130	100000P	Capacitor, 0603, X7R	5-00764
C131	15U/T35	Cap, Tantalum, SMT	5-00518
C201	100000P	Capacitor, 0603, X7R	5-00764
C204	1UF 16V /0603	Ceramic, 16V, X5R	5-00661
C205 C206	100000P 10UF / X5R	Capacitor, 0603, X7R Capacitor, Ceramic Or Mylar	5-00764 5-00910
C200	1001 / X3K 1UF 16V /0603	Ceramic, 16V, X5R	5-00510
C208	0.01UF / 16V	Ceramic, 16V, X5R	5-00604
C209	100000P	Capacitor, 0603, X7R	5-00764
C210	10UF / X5R	Capacitor, Ceramic Or Mylar	5-00910
C211	100000P	Capacitor, 0603, X7R	5-00764
C212	1UF 16V /0603	Ceramic, 16V, X5R	5-00661
C213	47P / X7R	Capacitor, Ceramic Disc	5-00912
C214 C301	47P / X7R 100000P	Capacitor, Ceramic Disc Capacitor, 0603, X7R	5-00912 5-00764
C301	100000P	Capacitor, 0603, X7R	5-00764
C303	100000P	Capacitor, 0603, X7R	5-00764
C304	100000P	Capacitor, 0603, X7R	5-00764
C305	100000P	Capacitor, 0603, X7R	5-00764
C306	100000P	Capacitor, 0603, X7R	5-00764
C307	100000P	Capacitor, 0603, X7R	5-00764
C308	100000P	Capacitor, 0603, X7R	5-00764
C309 C310	100000P 100000P	Capacitor, 0603, X7R Capacitor, 0603, X7R	5-00764 5-00764
C310	100000P	Capacitor, 0603, X7R	5-00764
C312	100000P	Capacitor, 0603, X7R	5-00764
C313	100000P	Capacitor, 0603, X7R	5-00764
C314	100000P	Capacitor, 0603, X7R	5-00764
D102	GREEN	LED, T-3/4	3-00424
D105	SMV1213	Integrated Circuit	3-02392
D201	MBRX160-TP	Diode, SMT	3-01701
J101 J201	20 PIN DI TSW-108-07-F-D	Connector Connector	1-00008 1-01423
J201 J202	TSW-108-07-F-D	Connector	1-01423
J203	USB MICRO	Connector	1-01395
J204	40-pin FLEX	Connector	1-01425
J205	6-pin MOLEX	Connector	1-01426
J206	8 PIN DI TSW 07	Connector	1-00290
L102	2506031517Y0	Ferrite bead, SMT	6-00759
L103	2506031517Y0	Ferrite bead, SMT	6-00759
L104 L105	2506031517Y0 2506031517Y0	Ferrite bead, SMT Ferrite bead, SMT	6-00759 6-00759
L105	250603151710 2506031517Y0	Ferrite bead, SMT	6-00759
L100	SRF0504-152Y	Choke, Misc.	6-01127
L201	2506031517Y0	Ferrite bead, SMT	6-00759

L202	2506031517Y0	Ferrite bead, SMT	6-00759
L203	15uH/ 1210	Fixed inductor	6-01128
L204	2506031517Y0	Ferrite bead, SMT	6-00759
L205	2506031517Y0	Ferrite bead, SMT	6-00759
L301	2506031517Y0	Ferrite bead, SMT	6-00759
L302	2506031517Y0	Ferrite bead, SMT	6-00759
L303	2506031517Y0	Ferrite bead, SMT	6-00759
PCB0	FS740 Display P	Fabricated component	7-02460
R102	470	Resistor, 0603, Thick Film	4-01861
R111	10K	Resistor, 0603, Thick Film	4-01893
R112	10K	Resistor, 0603, Thick Film	4-01893
R113	10K	Resistor, 0603, Thick Film	4-01893
R114	7.5K	Resistor, 0603, Thick Film	4-01890
R115	100K	Resistor, 0603, Thick Film	4-01917
R116	1.00K	Resistor, 0603, Thin Film	4-02157
R201	10K	Resistor, 0603, Thick Film	4-01893
R205	10K	Resistor, 0603, Thick Film	4-01893
R206	910K	Resistor, 0603, Thick Film	4-01940
R207	5.1	Resistor, 0603, Thick Film	4-01814
R208	27К	Resistor, 0603, Thick Film	4-01903
R211	33	Resistor, 0603, Thick Film	4-01833
R212	33	Resistor, 0603, Thick Film	4-01833
R213	10K	Resistor, 0603, Thick Film	4-01893
R216	10K	Resistor, 0603, Thick Film	4-01893
R217	10K	Resistor, 0603, Thick Film	4-01893
R224	100	Resistor, 0603, Thick Film	4-01845
R301	10K	Resistor, 0603, Thick Film	4-01893
R302	10K	Resistor, 0603, Thick Film	4-01893
RN101	10KX4D	Resistor network	4-00912
SW101	SW-SMT	Switch, Momentary	2-00075
SW102	SW-SMT	Switch, Momentary	2-00075
U102	74LVC3G04DCTR	Integrated Circuit	3-01999
U103	DS1816R-20	Integrated Circuit	3-02084
U104	74hct1g86	Integrated Circuit	3-02403
U105	32bit-ARM-Corte	Integrated Circuit	3-02397
U106	LM2937ESX-3.3	Integrated Circuit	3-02404
U201	65LVDS2DBV	Integrated Circuit	3-01770
U202	74LVC1G3157	Integrated Circuit	3-02046
U203	74LVC1G3157	Integrated Circuit	3-02046
U204	U_REG_40V-20mA	Integrated Circuit	3-02389
U205	FT230XQ	Integrated Circuit	3-02314
U301	FLASH 256MBit	Integrated Circuit	3-02400
U302	SDRAM 256MBit	Integrated Circuit	3-02399
Y101	12MHz	Crystal	6-01126
Z	CMT-1603	Misc. Components	6-00793
Z	SIM-PCB S/N	Label	9-01570

Front Keypad (Assembly 741)

Ref	Value	Description	SRS P/N
C101	100000P	Capacitor, 0603, X7R	5-00764
C102	100000P	Capacitor, 0603, X7R	5-00764
C103	100000P	Capacitor, 0603, X7R	5-00764
C104	100000P	Capacitor, 0603, X7R	5-00764
D101	GREEN	LED, T-3/4	3-00424
D102	GREEN	LED, T-3/4	3-00424
D103	RED	LED, T-3/4	3-00425
D104	YELLOW	LED, T-3/4	3-00426
D105	YELLOW	LED, T-3/4	3-00426
D106	YELLOW	LED, T-3/4	3-00426
D107	GREEN	LED, T-3/4	3-00424
D108	RED	LED, T-3/4	3-00425
D109	YELLOW	LED, T-3/4	3-00426
D110	GREEN	LED, T-3/4	3-00424
D111	RED	LED, T-3/4	3-00425
D112	RED	LED, T-3/4	3-00425
D113	GREEN	LED, T-3/4	3-00424
D114	GREEN	LED, T-3/4	3-00424
J101	8 PIN DI TSW 07	Connector	1-00290

SRS Stanford Research Systems

PC1	FS740 PCB	Fabricated component	7-02461
R101	49.9K	Resistor, 0603, Thin Film	4-02320
R102	20.0K	Resistor, 0603, Thin Film	4-02282
R103	499	Resistor, 0603, Thin Film	4-02128
R104	499	Resistor, 0603, Thin Film	4-02128
RN101	8X100	Resistor, Misc.	4-02497
RN102	8X100	Resistor, Misc.	4-02497
RN103	10KX4	Resistor network	4-01789
RN104	10KX4	Resistor network	4-01789
SW101	B3F-1052	Switch, Momentary	2-00053
SW102	B3F-1052	Switch, Momentary	2-00053
SW103	B3F-1052	Switch, Momentary	2-00053
SW104	B3F-1052	Switch, Momentary	2-00053
SW105	B3F-1052	Switch, Momentary	2-00053
SW106	B3F-1052	Switch, Momentary	2-00053
SW107	B3F-1052	Switch, Momentary	2-00053
SW108	B3F-1052	Switch, Momentary	2-00053
U101	74LVC2G04	Integrated Circuit	3-01968
U102	74HC165	Integrated Circuit	3-01969
U103	74LVC1G125DBV	Integrated Circuit	3-01886
U104	74HC595ADT	Integrated Circuit	3-00672
U105	74HC595ADT	Integrated Circuit	3-00672
U106	74LVC2G08DCT	Integrated Circuit	3-01656
U107	ADCMP371	Integrated Circuit	3-01970
Z	BUTTON CAP	Hardware	0-00996

Motherboard (Assembly 742)

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Ref	Value	Description	SRS P/N	
C100	10000P	Capacitor, 0603, X7R	5-00752	
C101	.01U	Capacitor, Metal Film	5-00052	
C102	1.0U	Capacitor, Mylar/Poly	5-00245	
C103	1000P	Capacitor, 0603, NPO	5-00740	
C104	1.0U	Capacitor, Mylar/Poly	5-00245	
C105	10000P	Capacitor, 0603, X7R	5-00752	
C106	100000P	Capacitor, 0603, X7R	5-00764	
C107	10000P	Capacitor, 0603, X7R	5-00752	
C108	100000P	Capacitor, 0603, X7R	5-00764	
C109	100000P	Capacitor, 0603, X7R	5-00764	
C110	47P	Capacitor, 0603, NPO	5-00708	
C111	0.01UF / 16V	Ceramic, 16V, X5R	5-00604	
C112	1000P	Capacitor, 0603, NPO	5-00740	
C113	100000P	Capacitor, 0603, X7R	5-00764	
C114	.047U	Capacitor, Metal Film	5-00054	
C115	470P	Capacitor, 0603, NPO	5-00732	
C117	100000P	Capacitor, 0603, X7R	5-00764	
C118	100000P	Capacitor, 0603, X7R	5-00764	
C119	150P	Capacitor, 0603, NPO	5-00720	
C120	100000P	Capacitor, 0603, X7R	5-00764	
C121	100000P	Capacitor, 0603, X7R	5-00764	
C122	100000P	Capacitor, 0603, X7R	5-00764	
C123	100000P	Capacitor, 0603, X7R	5-00764	
C124	100000P	Capacitor, 0603, X7R	5-00764	
C125	150P	Capacitor, 0603, NPO	5-00720	
C126	2.2U/T35	Cap, Tantalum, SMT	5-00318	
C127	100000P	Capacitor, 0603, X7R	5-00764	
C128	100000P	Capacitor, 0603, X7R	5-00764	
C129	10000P	Capacitor, 0603, X7R	5-00764	
C130	2.2U/T35	Cap, Tantalum, SMT	5-00318	
C131	33P	Capacitor, 1206, NPO	5-00369	
C132	100P	Capacitor, 1206, NPO	5-00375	
C133	150P	Capacitor, 0603, NPO	5-00720	
C134	100000P	Capacitor, 0603, X7R	5-00764	
C135	150P	Capacitor, 0603, NPO	5-00720	
C136	560P	Capacitor, 0603, NPO	5-00734	
C137	270P	Capacitor, 1206, NPO	5-00380	
C138	100000P	Capacitor, 0603, X7R	5-00764	
C139	100000P	Capacitor, 0603, X7R	5-00764	
C140	33P	Capacitor, 1206, NPO	5-00369	
C141	100P	Capacitor, 1206, NPO	5-00375	
C142	150P	Capacitor, 0603, NPO	5-00720	
C143	150P	Capacitor, 0603, NPO	5-00720	
C144	560P	Capacitor, 1206, NPO	5-00384	
C145	270P	Capacitor, 1206, NPO	5-00380	

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Capacitor, 0603, NPO 5-00673 C146 1.8P C147 5.6P 5-00684 Capacitor, 0603, NPO C148 .47U / 16V Capacitor, 1206, X7R 5-00527 .47U / 16V 5-00527 C149 Capacitor, 1206, X7R 10000P 5-00752 C150 Capacitor, 0603, X7R Capacitor, 0603, NPO 5-00698 C151 18P C152 27P Capacitor, 0603, NPO 5-00702 C153 15P Capacitor, 0603, NPO 5-00696 C154 100000P Capacitor, 0603, X7R 5-00764 100000P 5-00764 C155 Capacitor, 0603, X7R C156 100000P Capacitor, 0603, X7R 5-00764 C157 1000P Capacitor, 0603, NPO 5-00740 C158 100P Capacitor, 0603, NPO 5-00716 100000P 5-00764 C159 Capacitor, 0603, X7R 0.01UF / 16V C160 Ceramic, 16V, X5R 5-00604 C161 330P Capacitor, 0603, NPO 5-00728 0.01UF / 16V C162 Ceramic, 16V, X5R 5-00604 .047U 5-00054 Capacitor, Metal Film C163 C164 10000P Capacitor, 0603, X7R 5-00752 C170 100000P Capacitor, 0603, X7R 5-00764 C200 100000P Capacitor, 0603, X7R 5-00764 100000P 5-00764 C201 Capacitor, 0603, X7R Capacitor, 0603. X7R C202 100000P 5-00764 C203 100P Capacitor, 0603, NPO 5-00716 Capacitor, 0603, NPO C204 10P 5-00692 1000P Capacitor, 0603, NPO 5-00740 C205 100000P C206 Capacitor, 0603, X7R 5-00764 C207 100000P Capacitor, 0603, X7R 5-00764 100000P Capacitor, 0603, X7R 5-00764 C208 C209 1.5P Capacitor, 0603, NPO 5-00671 100000P C210 Capacitor, 0603, X7R 5-00764 C211 100000P Capacitor, 0603, X7R 5-00764 C212 100000P Capacitor, 0603, X7R 5-00764 C213 100000P Capacitor, 0603, X7R 5-00764 100000P 5-00764 Capacitor, 0603, X7R C214 5-00764 100000P C215 Capacitor, 0603, X7R C216 100000P Capacitor, 0603, X7R 5-00764 C218 100000P Capacitor, 0603, X7R 5-00764 C219 100000P Capacitor, 0603, X7R 5-00764 100000P 5-00764 C220 Capacitor, 0603, X7R C300 100000P Capacitor, 0603, X7R 5-00764 5-00764 C301 100000P Capacitor, 0603, X7R C302 100000P 5-00764 Capacitor, 0603, X7R C303 100000P Capacitor, 0603, X7R 5-00764 C304 100000P Capacitor, 0603, X7R 5-00764 Capacitor, 0603, X7R C305 100000P 5-00764 C306 Capacitor, 0603, NPO 5-00716 100P C307 100P Capacitor, 0603, NPO 5-00716 C308 10P Capacitor, 0603, NPO 5-00692 Capacitor, 0603, NPO C309 10P 5-00692 C310 100000P Capacitor, 0603, X7R 5-00764 C311 100000P Capacitor, 0603, X7R 5-00764 C312 1.5P Capacitor, 0603, NPO 5-00671 C313 Capacitor, 0603, NPO 5-00671 1.5P C314 100000P Capacitor, 0603, X7R 5-00764 C315 100000P Capacitor, 0603, X7R 5-00764 C316 100000P Capacitor, 0603, X7R 5-00764 C317 100000P Capacitor, 0603, X7R 5-00764 C318 100000P Capacitor, 0603, X7R 5-00764 5-00764 C319 100000P Capacitor, 0603, X7R C320 100000P Capacitor, 0603, X7R 5-00764 C321 100000P Capacitor, 0603, X7R 5-00764 C322 100000P Capacitor, 0603, X7R 5-00764 100000P 5-00764 C323 Capacitor, 0603, X7R C324 100000P 5-00764 Capacitor, 0603, X7R C325 100000P Capacitor, 0603, X7R 5-00764 100000P 5-00764 C326 Capacitor, 0603, X7R C327 100000P 5-00764 Capacitor, 0603, X7R 100000P C340 Capacitor, 0603, X7R 5-00764 C341 100000P Capacitor, 0603, X7R 5-00764 C342 100000P Capacitor, 0603, X7R 5-00764 C343 100000P Capacitor, 0603, X7R 5-00764 C400 100000P Capacitor, 0603, X7R 5-00764 C401 100000P Capacitor, 0603, X7R 5-00764 C402 100000P Capacitor, 0603, X7R 5-00764 C403 100000P Capacitor, 0603, X7R 5-00764 C404 100000P Capacitor, 0603, X7R 5-00764 C405 100000P Capacitor, 0603, X7R 5-00764

C406	100000P	Capacitor, 0603, X7R	5-00764	C611	100000P	Capacitor, 0603, X7R	5-00764
C407	100000P	Capacitor, 0603, X7R	5-00764	C612	100000P	Capacitor, 0603, X7R	5-00764
C408	100000P	Capacitor, 0603, X7R	5-00764	C613	100000P	Capacitor, 0603, X7R	5-00764
C409	100000P	Capacitor, 0603, X7R	5-00764	C614	100000P	Capacitor, 0603, X7R	5-00764
C410	100000P	Capacitor, 0603, X7R	5-00764	C615	100000P	Capacitor, 0603, X7R	5-00764
C411	100000P	Capacitor, 0603, X7R	5-00764	C616	100P	Capacitor, 0603, NPO	5-00716
C412	100000P	Capacitor, 0603, X7R	5-00764	C617	100000P	Capacitor, 0603, X7R	5-00764
C413	100000P	Capacitor, 0603, X7R	5-00764	C618	100000P	Capacitor, 0603, X7R	5-00764
		1 7 7					
C414	100000P	Capacitor, 0603, X7R	5-00764	C620	100000P	Capacitor, 0603, X7R	5-00764
C415	100000P	Capacitor, 0603, X7R	5-00764	C621	100000P	Capacitor, 0603, X7R	5-00764
C416	100000P	Capacitor, 0603, X7R	5-00764	C622	100000P	Capacitor, 0603, X7R	5-00764
C417	100000P	Capacitor, 0603, X7R	5-00764	C623	100000P	Capacitor, 0603, X7R	5-00764
C418	100000P	Capacitor, 0603, X7R	5-00764	C624	100000P	Capacitor, 0603, X7R	5-00764
C419	100000P	Capacitor, 0603, X7R	5-00764	C625	100000P	Capacitor, 0603, X7R	5-00764
C420	100000P	Capacitor, 0603, X7R	5-00764	C626	100000P	Capacitor, 0603, X7R	5-00764
		1 7 7					
C421	10U / 25V	Ceramic, 16V, X5R	5-00894	C627	100000P	Capacitor, 0603, X7R	5-00764
C500	100000P	Capacitor, 0603, X7R	5-00764	C628	100000P	Capacitor, 0603, X7R	5-00764
C501	100000P	Capacitor, 0603, X7R	5-00764	C629	100000P	Capacitor, 0603, X7R	5-00764
C502	100000P	Capacitor, 0603, X7R	5-00764	C630	100P	Capacitor, 0603, NPO	5-00716
C503	100000P	Capacitor, 0603, X7R	5-00764	C631	100000P	Capacitor, 0603, X7R	5-00764
C504	100000P	Capacitor, 0603, X7R	5-00764	C632	100000P	Capacitor, 0603, X7R	5-00764
C505	100000P	Capacitor, 0603, X7R	5-00764	C633	100000P	Capacitor, 0603, X7R	5-00764
C506	100000P	Capacitor, 0603, X7R	5-00764	C634	100P	Capacitor, 0603, NPO	5-00716
C507	100000P	Capacitor, 0603, X7R	5-00764	C635	100000P	Capacitor, 0603, X7R	5-00764
C508	2.2P	Capacitor, 0603, NPO	5-00675	C636	100000P	Capacitor, 0603, X7R	5-00764
C509	10P	Capacitor, 0603, NPO	5-00692	C637	100000P	Capacitor, 0603, X7R	5-00764
C510	7.5P	Capacitor, 0603, NPO	5-00689	C638	100000P	Capacitor, 0603, X7R	5-00764
	100000P				100000P		
C511		Capacitor, 0603, X7R	5-00764	C639		Capacitor, 0603, X7R	5-00764
C512	100000P	Capacitor, 0603, X7R	5-00764	C640	100000P	Capacitor, 0603, X7R	5-00764
C513	47P	Capacitor, 0603, NPO	5-00708	C641	100000P	Capacitor, 0603, X7R	5-00764
C514	82P	Capacitor, 0603, NPO	5-00714	C642	100000P	Capacitor, 0603, X7R	5-00764
C515	82P	Capacitor, 0603, NPO	5-00714	C643	10P	Capacitor, 0603, NPO	5-00692
C516	39P	Capacitor, 0603, NPO	5-00706	C644	100000P	Capacitor, 0603, X7R	5-00764
	100000P						
C517		Capacitor, 0603, X7R	5-00764	C645	100000P	Capacitor, 0603, X7R	5-00764
C518	100000P	Capacitor, 0603, X7R	5-00764	C650	100000P	Capacitor, 0603, X7R	5-00764
C519	47P	Capacitor, 0603, NPO	5-00708	C700	100000P	Capacitor, 0603, X7R	5-00764
C520	82P	Capacitor, 0603, NPO	5-00714	C701	100000P	Capacitor, 0603, X7R	5-00764
C521	82P	Capacitor, 0603, NPO	5-00714	C702	100000P	Capacitor, 0603, X7R	5-00764
C522	39P	Capacitor, 0603, NPO	5-00706	C703	100000P	Capacitor, 0603, X7R	5-00764
C523	100P	Capacitor, 0603, NPO	5-00716	C704	100000P	Capacitor, 0603, X7R	5-00764
C524	2.2P	Capacitor, 0603, NPO	5-00675	C705	33P	Capacitor, 1206, NPO	5-00369
C525	10P	Capacitor, 0603, NPO	5-00692	C706	100000P	Capacitor, 0603, X7R	5-00764
C526	7.5P	Capacitor, 0603, NPO	5-00689	C707	27P	Capacitor, 1206, NPO	5-00368
C527	100000P	Capacitor, 0603, X7R	5-00764	C708	100000P	Capacitor, 0603, X7R	5-00764
C528	100000P	Capacitor, 0603, X7R	5-00764	C709	100000P	Capacitor, 0603, X7R	5-00764
C529	100000P	Capacitor, 0603, X7R	5-00764	C710	100000P	Capacitor, 0603, X7R	5-00764
C530	100000P	Capacitor, 0603, X7R	5-00764	C711	100000P	Capacitor, 0603, X7R	
		1 7 7				1 , ,	5-00764
C531	100000P	Capacitor, 0603, X7R	5-00764	C712	100000P	Capacitor, 0603, X7R	5-00764
C532	100000P	Capacitor, 0603, X7R	5-00764	C713	100000P	Capacitor, 0603, X7R	5-00764
C533	100000P	Capacitor, 0603, X7R	5-00764	C714	100000P	Capacitor, 0603, X7R	5-00764
C534	100000P	Capacitor, 0603, X7R	5-00764	C715	33P	Capacitor, 1206, NPO	5-00369
C535	100000P	Capacitor, 0603, X7R	5-00764	C716	100000P	Capacitor, 0603, X7R	5-00764
C536	100000P	Capacitor, 0603, X7R	5-00764	C717	27P	Capacitor, 1206, NPO	5-00368
	100000P	1 7 7				Capacitor, 0603, X7R	
C537		Capacitor, 0603, X7R	5-00764	C718	100000P	1 1 1	5-00764
C538	100000P	Capacitor, 0603, X7R	5-00764	C719	100000P	Capacitor, 0603, X7R	5-00764
C539	15P	Capacitor, 0603, NPO	5-00696	C720	100000P	Capacitor, 0603, X7R	5-00764
C540	75P	Capacitor, 0603, NPO	5-00713	C721	100000P	Capacitor, 0603, X7R	5-00764
C541	120P	Capacitor, 0603, NPO	5-00718	C722	100000P	Capacitor, 0603, X7R	5-00764
C542	330P	Capacitor, 0603, NPO	5-00728	C723	100000P	Capacitor, 0603, X7R	5-00764
C543	100000P	Capacitor, 0603, X7R	5-00764	C724	100000P	Capacitor, 0603, X7R	5-00764
C544	100000P	Capacitor, 0603, X7R	5-00764	C725	100000P	Capacitor, 0603, X7R	5-00764
C545	15P	Capacitor, 0603, NPO	5-00696	C726	100000P	Capacitor, 0603, X7R	5-00764
C546	75P	Capacitor, 0603, NPO	5-00713	C740	1000P	Capacitor, 0603, NPO	5-00740
C547	120P	Capacitor, 0603, NPO	5-00718	C741	1000P	Capacitor, 0603, NPO	5-00740
C548	330P	Capacitor, 0603, NPO	5-00728	C742	100000P	Capacitor, 0603, X7R	5-00764
C549	100000P	Capacitor, 0603, X7R	5-00764	C743	100000P	Capacitor, 0603, X7R	5-00764
C550	100P	Capacitor, 0603, NPO	5-00716	C800	.22U / 16V	Capacitor	5-00836
C600	100000P	Capacitor, 0603, X7R	5-00764	C801	100000P	Capacitor, 0603, X7R	5-00764
C601	100000P	Capacitor, 0603, X7R	5-00764	C802	100000P	Capacitor, 0603, X7R	5-00764
C602	100000P	Capacitor, 0603, X7R	5-00764	C803	.22U / 16V	Capacitor	5-00836
C603	100000P	Capacitor, 0603, X7R	5-00764	C804	.22U / 16V	Capacitor	5-00836
C604	100000P	Capacitor, 0603, X7R	5-00764	C805	.22U / 16V	Capacitor	5-00836
C605	100P	Capacitor, 0603, NPO	5-00716	C806	.22U / 16V	Capacitor	5-00836
C606	100000P	Capacitor, 0603, X7R	5-00764	C807	.22U / 16V	Capacitor	5-00836
C607	100000P	Capacitor, 0603, X7R	5-00764	C809	.22U / 16V	Capacitor	5-00836
C608	100000P	Capacitor, 0603, X7R	5-00764	C810	.22U / 16V	Capacitor	5-00836
C609	100P	Capacitor, 0603, NPO	5-00716	C811	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807
C610	100000P	Capacitor, 0603, X7R	5-00764	C812	100000P	Capacitor, 0603, X7R	5-00764
0010	2000001	capacitor, 0000, A/M	3 30704	2012	200000	capacitor, 0000, Arm	5 00704

C813	100000P	Capacitor, 0603, X7R	5-00764	L102	.68UH	Fixed inductor	6-00988
C814	100000P	Capacitor, 0603, X7R	5-00764	L103	2506031517Y0	Ferrite bead, SMT	6-00759
			5-00764	L105	2506031517Y0		
C815	100000P	Capacitor, 0603, X7R				Ferrite bead, SMT	6-00759
C816	100000P	Capacitor, 0603, X7R	5-00764	L105	2506031517Y0	Ferrite bead, SMT	6-00759
C817	100P	Capacitor, 0603, NPO	5-00716	L106	.82UH - SMT	Fixed inductor	6-00651
C818	100P	Capacitor, 0603, NPO	5-00716	L107	.68UH	Fixed inductor	6-00988
C819	100000P	Capacitor, 0603, X7R	5-00764	L108	2506031517Y0	Ferrite bead, SMT	6-00759
C820	100000P	Capacitor, 0603, X7R	5-00764	L109	.82UH - SMT	Fixed inductor	6-00651
		1 7 7					
C821	100000P	Capacitor, 0603, X7R	5-00764	L110	.68UH	Fixed inductor	6-00988
C822	100000P	Capacitor, 0603, X7R	5-00764	L111	2506031517Y0	Ferrite bead, SMT	6-00759
C823	100000P	Capacitor, 0603, X7R	5-00764	L112	0.15U	Fixed inductor	6-00672
C824	100000P	Capacitor, 0603, X7R	5-00764	L113	120NH	Fixed inductor	6-00991
C825	100000P	Capacitor, 0603, X7R		L114	2506031517Y0		6-00759
			5-00764			Ferrite bead, SMT	
C826	100000P	Capacitor, 0603, X7R	5-00764	L115	2506031517Y0	Ferrite bead, SMT	6-00759
C827	10000P	Capacitor, 0603, X7R	5-00752	L116	2506031517Y0	Ferrite bead, SMT	6-00759
C828	100000P	Capacitor, 0603, X7R	5-00764	L201	2506031517Y0	Ferrite bead, SMT	6-00759
C830	10000P	Capacitor, 0603, X7R	5-00752	L202	2506031517Y0	Ferrite bead, SMT	6-00759
C900	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807	L203	2506031517Y0	Ferrite bead, SMT	6-00759
C901	1000P	Capacitor, 0603, NPO	5-00740	L204	120NH	Fixed inductor	6-00991
C902	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807	L205	2506031517Y0	Ferrite bead, SMT	6-00759
C903	100000P	Capacitor, 0603, X7R	5-00764	L206	2506031517Y0	Ferrite bead, SMT	6-00759
C904	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807	L207	2506031517Y0	Ferrite bead, SMT	6-00759
C905	100000P	Capacitor, 0603, X7R	5-00764	L300	2506031517Y0	Ferrite bead, SMT	6-00759
C906	4.7U / 63V 5%	Capacitor, Poly	5-00615	L301	2506031517Y0	Ferrite bead, SMT	6-00759
C907	4.7U / 63V 5%	Capacitor, Poly	5-00615	L302	2506031517Y0	Ferrite bead, SMT	6-00759
C908	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807	L303	2506031517Y0	Ferrite bead, SMT	6-00759
C909	100000P	Capacitor, 0603, X7R	5-00764	L304	2506031517Y0	Ferrite bead, SMT	6-00759
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C910	100000P	Capacitor, 0603, X7R	5-00764	L305	2506031517Y0	Ferrite bead, SMT	6-00759
C911	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807	L400	2506031517Y0	Ferrite bead, SMT	6-00759
C912	100000P	Capacitor, 0603, X7R	5-00764	L401	2506031517Y0	Ferrite bead, SMT	6-00759
C913	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807	L402	2506031517Y0	Ferrite bead, SMT	6-00759
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C914	100000P	Capacitor, 0603, X7R	5-00764	L403	2506031517Y0	Ferrite bead, SMT	6-00759
C915	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807	L404	2506031517Y0	Ferrite bead, SMT	6-00759
C916	10U / 25V	Ceramic, 16V, X5R	5-00894	L500	2506031517Y0	Ferrite bead, SMT	6-00759
C917	100000P	Capacitor, 0603, X7R	5-00764	L501	2506031517Y0	Ferrite bead, SMT	6-00759
C918	1000P	Capacitor, 0603, NPO	5-00740	L502	2506031517Y0	Ferrite bead, SMT	6-00759
C919	100000P	Capacitor, 0603, X7R	5-00764	L503	2506031517Y0	Ferrite bead, SMT	6-00759
C920	10U / 25V	Ceramic, 16V, X5R	5-00894	L504	2506031517Y0	Ferrite bead, SMT	6-00759
C921	100000P	Capacitor, 0603, X7R	5-00764	L505	2506031517Y0	Ferrite bead, SMT	6-00759
C922	10000P	Capacitor, 0603, X7R	5-00752	L506	2506031517Y0	Ferrite bead, SMT	6-00759
C923	100000P	Capacitor, 0603, X7R	5-00764	L507	2506031517Y0	Ferrite bead, SMT	6-00759
C930	4.7UF / 50V X5R	Ceramic, 16V, X5R	5-00807	L508	.68UH	Fixed inductor	6-00988
C931	100000P	Capacitor, 0603, X7R	5-00764	L509	.68UH	Fixed inductor	6-00988
D100	BAW56LT1G -ROHS	Integrated Circuit	3-00649	L510	.56UH	Fixed inductor	6-00595
D101	MMBV609	Integrated Circuit	3-00803	L511	2506031517Y0	Ferrite bead, SMT	6-00759
		-		L512			
D200	MMBD1701A	Integrated Circuit	3-01753		2506031517Y0	Ferrite bead, SMT	6-00759
D201	MMBD1701A	Integrated Circuit	3-01753	L513	2506031517Y0	Ferrite bead, SMT	6-00759
D300	MMBD1701A	Integrated Circuit	3-01753	L514	2506031517Y0	Ferrite bead, SMT	6-00759
D301	MMBD1701A	Integrated Circuit	3-01753	L515	.68UH	Fixed inductor	6-00988
D302	MMBD1701A	Integrated Circuit	3-01753	L516	.68UH	Fixed inductor	6-00988
D303		•	3-01753	L510	.56UH		6-00595
	MMBD1701A	Integrated Circuit				Fixed inductor	
D600	MMBD1701A	Integrated Circuit	3-01753	L518	2506031517Y0	Ferrite bead, SMT	6-00759
D601	MMBD1701A	Integrated Circuit	3-01753	L519	2506031517Y0	Ferrite bead, SMT	6-00759
D602	MMBD1701A	Integrated Circuit	3-01753	L520	2506031517Y0	Ferrite bead, SMT	6-00759
D603	MMBZ5232BLT1	Diode	3-01384	L521	2506031517Y0	Ferrite bead, SMT	6-00759
D800	BAW56LT1G -ROHS	Integrated Circuit	3-00649	L522	.47UH - SMT	Fixed inductor	6-00650
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D900	RED	LED, T-3/4	3-00425	L523	1.0UH - SMT	Fixed inductor	6-00172
J100	26-48-1101	Connector	1-01057	L524	1.5UH	Fixed inductor	6-00597
J101	73100-0195	Connector	1-01158	L525	2506031517Y0	Ferrite bead, SMT	6-00759
J200	73100-0195	Connector	1-01158	L526	2506031517Y0	Ferrite bead, SMT	6-00759
J400	TSW-106-08-G-S	Connector	1-01146	L527	2506031517Y0	Ferrite bead, SMT	6-00759
J600	73100-0195	Connector	1-01158	L528	.47UH - SMT	Fixed inductor	6-00650
J601	73100-0195	Connector	1-01158	L529	1.0UH - SMT	Fixed inductor	6-00172
J700	73100-0195	Connector	1-01158	L530	1.5UH	Fixed inductor	6-00597
J701	73100-0195	Connector	1-01158	L531	2506031517Y0	Ferrite bead, SMT	6-00759
J701	73100-0195	Connector	1-01158	L600	2506031517Y0	Ferrite bead, SMT	6-00759
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J703	73100-0195	Connector	1-01158	L601	2506031517Y0	Ferrite bead, SMT	6-00759
J704	73100-0195	Connector	1-01158	L602	2506031517Y0	Ferrite bead, SMT	6-00759
J705	73100-0195	Connector	1-01158	L603	2506031517Y0	Ferrite bead, SMT	6-00759
J706	25 PIN	Connector	1-01255	L604	2506031517Y0	Ferrite bead, SMT	6-00759
J800	26 PIN	Connector	1-01178	L605	2506031517Y0	Ferrite bead, SMT	6-00759
		Connector	1-01422	L606	2506031517Y0	Ferrite bead, SMT	6-00759
J801	3POS_RELAY_CNTR	Connector			250002454700		
J801 J802	3POS_RELAY_CNTR DEKL-9SAT-E	Connector	1-01031	L607	2506031517Y0	Ferrite bead, SMT	6-00759
J802	DEKL-9SAT-E	Connector					
J802 J803	DEKL-9SAT-E TSW-108-07-F-D	Connector Connector	1-01423	L608	2506031517Y0	Ferrite bead, SMT	6-00759
J802 J803 J804	DEKL-9SAT-E TSW-108-07-F-D J1011F21PNL	Connector Connector Connector	1-01423 1-01292	L608 L700	2506031517Y0 2506031517Y0	Ferrite bead, SMT Ferrite bead, SMT	6-00759 6-00759
J802 J803 J804 J900	DEKL-9SAT-E TSW-108-07-F-D J1011F21PNL 10M156(LONG)	Connector Connector Connector Connector	1-01423 1-01292 1-00555	L608 L700 L701	2506031517Y0 2506031517Y0 2506031517Y0	Ferrite bead, SMT Ferrite bead, SMT Ferrite bead, SMT	6-00759 6-00759 6-00759
J802 J803 J804 J900 L100	DEKL-9SAT-E TSW-108-07-F-D J1011F21PNL 10M156(LONG) 2A / 1806	Connector Connector Connector Connector Ferrite bead, SMT	1-01423 1-01292 1-00555 6-00744	L608 L700 L701 L702	2506031517Y0 2506031517Y0 2506031517Y0 2506031517Y0	Ferrite bead, SMT Ferrite bead, SMT Ferrite bead, SMT Ferrite bead, SMT	6-00759 6-00759 6-00759 6-00759
J802 J803 J804 J900	DEKL-9SAT-E TSW-108-07-F-D J1011F21PNL 10M156(LONG)	Connector Connector Connector Connector	1-01423 1-01292 1-00555	L608 L700 L701	2506031517Y0 2506031517Y0 2506031517Y0	Ferrite bead, SMT Ferrite bead, SMT Ferrite bead, SMT	6-00759 6-00759 6-00759

L704	2506031517Y0	Ferrite bead, SMT	6-00759	R127	10	Resistor, 0603, Thin Film	4-01965
L705	2506031517Y0	Ferrite bead, SMT	6-00759	R128	49.9	Resistor, 0603, Thin Film	4-02032
L706	2506031517Y0	Ferrite bead, SMT	6-00759	R129	499	Resistor, 0603, Thin Film	4-02128
L707	2506031517Y0	Ferrite bead, SMT	6-00759	R130	1.00K	Resistor, 0603, Thin Film	4-02157
L708	2506031517Y0	Ferrite bead, SMT	6-00759	R131	100K	Resistor, 0603, Thin Film	4-02349
L709	2506031517Y0	Ferrite bead, SMT	6-00759	R132	4.99K	Resistor, 0603, Thin Film	4-02224
L710	2506031517Y0	Ferrite bead, SMT	6-00759	R133	49.9	Resistor, 0603, Thin Film	4-02032
L711	2506031517Y0	Ferrite bead, SMT	6-00759	R134	49.9K	Resistor, 0603, Thin Film	4-02320
L800	2506031517Y0	Ferrite bead, SMT	6-00759	R135	249	Resistor, 0603, Thin Film	4-02099
L801	2506031517Y0	Ferrite bead, SMT	6-00759	R137	10.0K	Resistor, 0603, Thin Film	4-02253
L802	2506031517Y0	Ferrite bead, SMT	6-00759	R138	24.9	Resistor, 0603, Thin Film	4-02003
L803	2506031517Y0	Ferrite bead, SMT	6-00759	R139	100	Resistor, 0603, Thin Film	4-02061
L804	2506031517Y0	Ferrite bead, SMT	6-00759	R140	499	Resistor, 0603, Thin Film	4-02128
L806	2506031517Y0	Ferrite bead, SMT	6-00759	R141	499	Resistor, 0603, Thin Film	4-02128
L807	2506031517Y0	Ferrite bead, SMT	6-00759	R142	100	Resistor, 0603, Thin Film	4-02061
L808	2506031517Y0	Ferrite bead, SMT	6-00759	R144	9.09K	Resistor, 0603, Thin Film	4-02249
L809	2506031517Y0	Ferrite bead, SMT	6-00759	R145	121K	Resistor, 0603, Thin Film	4-02357
L900	2A / 1806	Ferrite bead, SMT	6-00744	R146	1.00K	Resistor, 0603, Thin Film	4-02157
L901	2A / 1806	Ferrite bead, SMT	6-00744	R147	10.0K	Resistor, 0603, Thin Film	4-02253
L902	2A / 1806	Ferrite bead, SMT	6-00744	R148	1.00K	Resistor, 0603, Thin Film	4-02157
L903	2A / 1806	Ferrite bead, SMT	6-00744	R149	10.0K	Resistor, 0603, Thin Film	4-02253
L904	2A / 1806	Ferrite bead, SMT	6-00744	R151	1.00K	Resistor, 0603, Thin Film	4-02157
L905	2506031517Y0	Ferrite bead, SMT	6-00759	R152	121K	Resistor, 0603, Thin Film	4-02357
L906	2A / 1806	Ferrite bead, SMT	6-00744	R153	1.00K	Resistor, 0603, Thin Film	4-02157
L907	2A / 1806	Ferrite bead, SMT	6-00744	R154	9.09K	Resistor, 0603, Thin Film	4-02249
L908	2A / 1806	Ferrite bead, SMT	6-00744	R155	30.1	Resistor, 0603, Thin Film	4-02011
L909	2A / 1806	Ferrite bead, SMT	6-00744	R157	249	Resistor, 0603, Thin Film	4-02099
PCB0	FS740 Motherboa	Fabricated component	7-02459	R158	182	Resistor, 0603, Thin Film	4-02086
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PCB1	FS740 PCB	Fabricated component	7-02484	R159	182	Resistor, 0603, Thin Film	4-02086
PCB2	FS740 BNC PCB	Fabricated component	7-02526	R160	1.00K	Resistor, 0603, Thin Film	4-02157
Q100	TIP107 THK	Voltage Regulator	3-02510	R161	10.0K	Resistor, 0603, Thin Film	4-02253
Q101	MMBT5179	Integrated Circuit	3-00808	R162	4.99K	Resistor, 0603, Thin Film	4-02224
		-	3-00808				
Q102	MMBT5179	Integrated Circuit		R163	49.9	Resistor, 0603, Thin Film	4-02032
Q103	MMBT3906LT1	Integrated Circuit	3-00580	R164	10.0K	Resistor, 0603, Thin Film	4-02253
Q200	MMBTH81LT1	Integrated Circuit	3-00809	R165	49.9	Resistor, 0603, Thin Film	4-02032
Q201	MBT3906DW1	Integrated Circuit	3-01419	R166	49.9	Resistor, 0603, Thin Film	4-02032
Q203	MMBT3906LT1	Integrated Circuit	3-00580	R170	49.9	Resistor, 0603, Thin Film	4-02032
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Q204	MBT3904DW1T1	Integrated Circuit	3-01154	R200	10.2K	Resistor, 0603, Thin Film	4-02254
Q300	MMBTH81LT1	Integrated Circuit	3-00809	R201	200	Resistor, 0603, Thick Film	4-01852
Q301	MMBTH81LT1	Integrated Circuit	3-00809	R202	10.0K	Resistor, 0603, Thin Film	4-02253
Q302	MBT3906DW1	Integrated Circuit	3-01419	R203	806	Resistor, Thin Film, MELF	4-01108
Q304	MBT3906DW1	Integrated Circuit	3-01419	R204	49.9	Resistor, 0603, Thin Film	4-02032
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Q306	MBT3904DW1T1	Integrated Circuit	3-01154	R205	10.0K	Resistor, 0603, Thin Film	4-02253
Q308	MBT3904DW1T1	Integrated Circuit	3-01154	R206	10.0K	Resistor, 0603, Thin Film	4-02253
Q600	MBT3906DW1	Integrated Circuit	3-01419	R207	10	Resistor, 0603, Thin Film	4-01965
Q601	MMBT3904LT1	Integrated Circuit	3-00601	R208	10	Resistor, 0603, Thin Film	4-01965
Q602	MBT3906DW1	Integrated Circuit	3-01419	R209	100	Resistor, 0603, Thin Film	4-02061
Q603	MMBT5179	Integrated Circuit	3-00808	R210	100	Resistor, 0603, Thin Film	4-02061
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Q604	MMBT3904LT1	Integrated Circuit	3-00601	R211	100	Resistor, 0603, Thin Film	4-02061
Q605	MBT3906DW1	Integrated Circuit	3-01419	R212	100K	Resistor, 0603, Thin Film	4-02349
Q606	MBT3906DW1	Integrated Circuit	3-01419	R213	1	Resistor, Misc.	4-02630
Q607	MMBT5179	Integrated Circuit	3-00808	R214	24.9	Resistor, 0603, Thin Film	4-02003
Q800	MMBT3904LT1	Integrated Circuit	3-00601	R215	24.9	Resistor, 0603, Thin Film	4-02003
R101	1.00K	Resistor, 0603, Thin Film	4-02157	R216	100	Resistor, 0603, Thick Film	4-01845
R102	10.0K	Resistor, 0603, Thin Film	4-02253	R217	1.00K	Resistor, 0603, Thin Film	4-02157
R103	249K	Resistor, 0603, Thin Film	4-02387	R218	1.00K	Resistor, 0603, Thin Film	4-02157
R104	1.00K	Resistor, 0603, Thin Film	4-02157	R219	200	Resistor, 0603, Thick Film	4-01852
R105	20.0K	Resistor, Thin Film, MELF	4-01242	R220	1.00K	Resistor, 0603, Thin Film	4-02157
		Resistor, 0603, Thin Film					
R106	10.0K	, ,	4-02253	R221	49.9	Resistor, 0603, Thin Film	4-02032
R107	10	Resistor, 0603, Thin Film	4-01965	R223	249	Resistor, 0603, Thin Film	4-02099
R108	200	Resistor, 0603, Thin Film	4-02090	R224	1.50K	Resistor, 0603, Thin Film	4-02174
R109	10M	Resistor, Thick Film, Chip	4-01575	R225	24.9	Resistor, 0603, Thin Film	4-02003
R110	10.0K	Resistor, 0603, Thin Film	4-02253	R226	24.9	Resistor, 0603, Thin Film	4-02003
R111	4.02K	Resistor, Thin Film, MELF	4-01175	R227	499	Resistor, 0603, Thin Film	4-02128
R112	1.00K	Resistor, 0603, Thin Film	4-02157	R228	499	Resistor, 0603, Thin Film	4-02128
R113	10.0K	Resistor, 0603, Thin Film	4-02253	R229	200	Resistor, 0603, Thick Film	4-01852
R114	49.9K	Resistor, 0603, Thin Film	4-02320	R230	200	Resistor, 0603, Thick Film	4-01852
R115	20.0K	Resistor, 0603, Thin Film	4-02282	R232	100	Resistor, 0603, Thin Film	4-02061
R116	100	Resistor, 0603, Thin Film	4-02061	R233	100	Resistor, 0603, Thin Film	4-02061
R117	249K	Resistor, 0603, Thin Film	4-02387	R234	100	Resistor, 0603, Thin Film	4-02061
R118	100K	Resistor, 0603, Thin Film	4-02349	R235	100	Resistor, 0603, Thin Film	4-02061
R119	49.9K	Resistor, 0603, Thin Film	4-02320	R236	100	Resistor, 0603, Thin Film	4-02061
R120	P1H104-T-NTC	Thermistor, various	4-00899	R237	100	Resistor, 0603, Thin Film	4-02061
R121	20.0K	Resistor, 0603, Thin Film	4-02282	R238	49.9	Resistor, 0603, Thin Film	4-02032
R122	10	Resistor, 0603, Thin Film	4-01965	R239	49.9	Resistor, 0603, Thin Film	4-02032
R124	30.1K	Resistor, 0603, Thin Film	4-02299	R240	75	Resistor, 0603, Thick Film	4-01842
R125	10.0K	Resistor, 0603, Thin Film	4-02253	R241	10.0K	Resistor, 0603, Thin Film	4-02253
R126	4.99K	Resistor, 0603, Thin Film	4-02224	R242	1.00K	Resistor, 0603, Thin Film	4-02157
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R243	75	Resistor, 0603, Thick Film	4-01842	R404	100	Resistor, 0603, Thin Film	4-02061
R244	10.0K	Resistor, 0603, Thin Film	4-02253	R405	100	Resistor, 0603, Thin Film	4-02061
R250	200	Resistor, 0603, Thick Film	4-01852	R500	49.9	Resistor, 0603, Thin Film	4-02032
R300	10.2K	Resistor, 0603, Thin Film	4-02254	R501	49.9	Resistor, 0603, Thin Film	4-02032
R301	10.2K	Resistor, 0603, Thin Film	4-02254	R502	49.9	Resistor, 0603, Thin Film	4-02032
R302	200	Resistor, 0603, Thick Film	4-01852	R503	49.9	Resistor, 0603, Thin Film	4-02032
R303	200	Resistor, 0603, Thick Film	4-01852	R504	165	Resistor, 0603, Thin Film	4-02082
R304	10.0K	Resistor, 0603, Thin Film	4-02253	R505	165	Resistor, 0603, Thin Film	4-02082
R305	10.0K	Resistor, 0603, Thin Film	4-02253	R506	2.00K	Resistor, 0603, Thin Film	4-02186
R306	806	Resistor, Thin Film, MELF	4-01108	R507	49.9	Resistor, 0603, Thin Film	4-02032
R307	806	Resistor, Thin Film, MELF	4-01108	R508	49.9	Resistor, 0603, Thin Film	4-02032
R308	49.9	Resistor, 0603, Thin Film	4-02032	R509	49.9	Resistor, 0603, Thin Film	4-02032
R309	49.9	Resistor, 0603, Thin Film	4-02032	R510	49.9	Resistor, 0603, Thin Film	4-02032
R310	10.0K	Resistor, 0603, Thin Film	4-02253	R511	49.9	Resistor, 0603, Thin Film	4-02032
R311	10.0K	Resistor, 0603, Thin Film	4-02253	R512	100	Resistor, 0603, Thin Film	4-02061
	10.0K	Resistor, 0603, Thin Film			4.99K	, ,	
R312		, ,	4-02253	R513		Resistor, 0603, Thin Film	4-02224
R313	10.0K	Resistor, 0603, Thin Film	4-02253	R514	49.9	Resistor, 0603, Thin Film	4-02032
R314	10	Resistor, 0603, Thin Film	4-01965	R516	100	Resistor, 0603, Thin Film	4-02061
R315	10	Resistor, 0603, Thin Film	4-01965	R517	4.99K	Resistor, 0603, Thin Film	4-02224
R316	10	Resistor, 0603, Thin Film	4-01965	R518	715	Resistor, 0603, Thin Film	4-02143
R317	10	Resistor, 0603, Thin Film	4-01965	R520	7.5K	Resistor, 0603, Thick Film	4-01890
R318	100		4-02061	R521	49.9		4-02032
		Resistor, 0603, Thin Film				Resistor, 0603, Thin Film	
R319	100	Resistor, 0603, Thin Film	4-02061	R522	49.9	Resistor, 0603, Thin Film	4-02032
R320	100	Resistor, 0603, Thin Film	4-02061	R523	19.6K	Resistor, 0603, Thin Film	4-02281
R321	100	Resistor, 0603, Thin Film	4-02061	R524	49.9	Resistor, 0603, Thin Film	4-02032
R322	24.9	Resistor, 0603, Thin Film	4-02003	R525	10.0K	Resistor, 0603, Thin Film	4-02253
R323	24.9	Resistor, 0603, Thin Film	4-02003	R526	30.1K	Resistor, 0603, Thin Film	4-02299
							4-02032
R324	24.9	Resistor, 0603, Thin Film	4-02003	R527	49.9	Resistor, 0603, Thin Film	
R325	24.9	Resistor, 0603, Thin Film	4-02003	R529	7.5K	Resistor, 0603, Thick Film	4-01890
R326	100	Resistor, 0603, Thick Film	4-01845	R530	19.6K	Resistor, 0603, Thin Film	4-02281
R327	100	Resistor, 0603, Thick Film	4-01845	R532	49.9	Resistor, 0603, Thin Film	4-02032
R328	200	Resistor, 0603, Thick Film	4-01852	R533	10.0K	Resistor, 0603, Thin Film	4-02253
R329	1.00K	Resistor, 0603, Thin Film	4-02157	R534	30.1K	Resistor, 0603, Thin Film	4-02299
R330	200			R535	49.9		4-02032
		Resistor, 0603, Thick Film	4-01852			Resistor, 0603, Thin Film	
R331	1.00K	Resistor, 0603, Thin Film	4-02157	R536	20.0K	Resistor, 0603, Thin Film	4-02282
R332	49.9	Resistor, 0603, Thin Film	4-02032	R537	10.0K	Resistor, 0603, Thin Film	4-02253
R333	49.9	Resistor, 0603, Thin Film	4-02032	R538	165	Resistor, 0603, Thin Film	4-02082
R336	249	Resistor, 0603, Thin Film	4-02099	R539	100	Resistor, 0603, Thin Film	4-02061
R337	249	Resistor, 0603, Thin Film	4-02099	R540	4.99K	Resistor, 0603, Thin Film	4-02224
R338	1.50K	Resistor, 0603, Thin Film	4-02174	R541	100	Resistor, 0603, Thin Film	4-02061
R339	1.50K	Resistor, 0603, Thin Film	4-02174	R542	49.9	Resistor, 0603, Thin Film	4-02032
R340	24.9	Resistor, 0603, Thin Film	4-02003	R543	4.99K	Resistor, 0603, Thin Film	4-02224
R341	24.9	Resistor, 0603, Thin Film	4-02003	R544	49.9	Resistor, 0603, Thin Film	4-02032
R342	24.9	Resistor, 0603, Thin Film	4-02003	R545	715	Resistor, 0603, Thin Film	4-02143
R343	24.9	Resistor, 0603, Thin Film	4-02003	R546	165	Resistor, 0603, Thin Film	4-02082
R344	499	Resistor, 0603, Thin Film	4-02128	R547	61.9	Resistor, 0603, Thin Film	4-02041
	499						4-02041
R345		Resistor, 0603, Thin Film	4-02128	R548	61.9	Resistor, 0603, Thin Film	
R346	499	Resistor, 0603, Thin Film	4-02128	R549	4.99K	Resistor, 0603, Thin Film	4-02224
R347	499	Resistor, 0603, Thin Film	4-02128	R600	4.7	Resistor, 0603, Thick Film	4-01813
R348	200	Resistor, 0603, Thick Film	4-01852	R601	1.00K	Resistor, 0603, Thin Film	4-02157
R349	200	Resistor, 0603, Thick Film	4-01852	R602	2.00K	Resistor, 0603, Thin Film	4-02186
R350		Resistor, 0603, Thick Film	4-01852	R603		Resistor, 0603, Thick Film	4-01852
R351	200	Resistor, 0603, Thick Film	4-01852	R604	1.00K	Resistor, 0603, Thin Film	4-02157
R352	100	Resistor, 0603, Thin Film	4-02061	R605	1.00K	Resistor, 0603, Thin Film	4-02157
R353	100	Resistor, 0603, Thin Film	4-02061	R606	45.3	Resistor, Thin Film, MELF	4-00988
R354	100	Resistor, 0603, Thin Film	4-02061	R607	24.9	Resistor, 0603, Thin Film	4-02003
R355	100	Resistor, 0603, Thin Film	4-02061	R608	499	Resistor, 0603, Thin Film	4-02128
R360	49.9	Resistor, 0603, Thin Film	4-02032	R609	1.00K	Resistor, 0603, Thin Film	4-02157
R361	49.9	Resistor, 0603, Thin Film	4-02032	R610	7.5K	Resistor, 0603, Thick Film	4-01890
R362	49.9	Resistor, 0603, Thin Film	4-02032	R611	10	Resistor, 0603, Thin Film	4-01965
R363	49.9	Resistor, 0603, Thin Film	4-02032	R612	10	Resistor, 0603, Thin Film	4-01965
R370	75	Resistor, 0603, Thick Film	4-01842	R613	24.9	Resistor, 0603, Thin Film	4-02003
R371	75	Resistor, 0603, Thick Film	4-01842	R614	2.00K	Resistor, 0603, Thin Film	4-02186
R372	100	Resistor, 0603, Thin Film	4-02061	R616	10.0K	Resistor, 0603, Thin Film	4-02253
						Resistor, 0603, Thin Film	
R373	100	Resistor, 0603, Thin Film	4-02061	R617	24.9		4-02003
R380	10.0K	Resistor, 0603, Thin Film	4-02253	R618	2.00K	Resistor, 0603, Thin Film	4-02186
R381	10.0K	Resistor, 0603, Thin Film	4-02253	R619	1.00K	Resistor, 0603, Thin Film	4-02157
R382	10.0K	Resistor, 0603, Thin Film	4-02253	R620	49.9	Resistor, 0603, Thin Film	4-02032
R383	10.0K	Resistor, 0603, Thin Film	4-02253	R621	49.9	Resistor, 0603, Thin Film	4-02032
R384	75	Resistor, 0603, Thick Film	4-01842	R622	24.9	Resistor, 0603, Thin Film	4-02003
R385	1.00K	Resistor, 0603, Thin Film	4-02157	R623	4.7	Resistor, 0603, Thick Film	4-01813
R386	75	Resistor, 0603, Thick Film	4-01842	R624	200	Resistor, 0603, Thick Film	4-01852
R387	1.00K	Resistor, 0603, Thin Film	4-02157	R625	1.00K	Resistor, 0603, Thin Film	4-02157
R390	200	Resistor, 0603, Thick Film	4-01852	R626	45.3	Resistor, Thin Film, MELF	4-00988
R391	200	Resistor, 0603, Thick Film	4-01852	R627	124	Resistor, 0603, Thin Film	4-02070
R401	4.7K	Resistor, 0603, Thick Film	4-01885	R628	49.9	Resistor, 0603, Thin Film	4-02032
R401	4.7K	Resistor, 0603, Thick Film	4-01885	R629	49.9	Resistor, 0603, Thin Film	4-02032
R403	100	Resistor, 0603, Thin Film	4-02061	R630	499	Resistor, 0603, Thin Film	4-02128

R631	1 00K	Resistor, 0603, Thin Film	4-02157	R739	1.00K	Resistor, 0603, Thin Film	4-02157
R632	1.00K	Resistor, 0603, Thin Film	4-02157	R740	49.9K	Resistor, 0603, Thin Film	4-02320
R633	499	Resistor, 0603, Thin Film	4-02128	R741	200	Resistor, 0603, Thick Film	4-01852
R634	16.5K	Resistor, 0603, Thin Film	4-02274	R800	12.1K	Resistor, 0603, Thin Film	4-02261
R635	10.0K	Resistor, 0603, Thin Film	4-02253	R801	100	Resistor, 0603, Thin Film	4-02061
R636	200	Resistor, 0603, Thick Film	4-01852	R802	100	Resistor, 0603, Thin Film	4-02061
R637	1.00K	Resistor, 0603, Thin Film	4-02157	R803	100K	Resistor, 0603, Thin Film	4-02349
R638	1.00K	Resistor, 0603, Thin Film	4-02157	R804	100K	Resistor, 0603, Thin Film	4-02349
R639	24.9	Resistor, 0603, Thin Film	4-02003	R807	1.00K	Resistor, 0603, Thin Film	4-02157
R640	7.5K	Resistor, 0603, Thick Film	4-01890	R808	10.0K	Resistor, 0603, Thin Film	4-02253
R641	499	Resistor, 0603, Thin Film	4-02128	R809	10.0K	Resistor, 0603, Thin Film	4-02253
R642	1.00K	Resistor, 0603, Thin Film	4-02157	R810	100	Resistor, 0603, Thin Film	4-02061
R643	10	Resistor, 0603, Thin Film	4-01965	R811	100	Resistor, 0603, Thin Film	4-02061
R644	10	Resistor, 0603, Thin Film	4-01965	R813	2.00K	Resistor, 0603, Thin Film	4-02186
					2.00K		
R645	2.00K	Resistor, 0603, Thin Film	4-02186	R814		Resistor, 0603, Thin Film	4-02186
R646	10K	Resistor, 0603, Thick Film	4-01893	R815	100	Resistor, 0603, Thin Film	4-02061
R647	10.0K	Resistor, 0603, Thin Film	4-02253	R816	1.00M	Resistor, 0603, Thin Film	4-02445
R648	24.9	Resistor, 0603, Thin Film	4-02003	R817	2.00K	Resistor, 0603, Thin Film	4-02186
R649	2.00K	Resistor, 0603, Thin Film	4-02186	R818	2.00K	Resistor, 0603, Thin Film	4-02186
R650	1.00K	Resistor, 0603, Thin Film	4-02157	R840	1.00K	Resistor, 0603, Thin Film	4-02157
R651	100K	Resistor, 0603, Thin Film	4-02349	R841	100	Resistor, 0603, Thin Film	4-02061
R652	49.9	Resistor, 0603, Thin Film	4-02032	R900	10.0K	Resistor, 0603, Thin Film	4-02253
R653	49.9	Resistor, 0603, Thin Film	4-02032	R901	100K	Resistor, 0603, Thin Film	4-02349
R654	24.9	Resistor, 0603, Thin Film	4-02003	R902	1.00K	Resistor, 0603, Thin Film	4-02157
R655	200		4-01852	R903	22.6K		4-02287
		Resistor, 0603, Thick Film				Resistor, 0603, Thin Film	
R656	49.9	Resistor, 0603, Thin Film	4-02032	R904	1.50K	Resistor, 0603, Thin Film	4-02174
R657	49.9	Resistor, 0603, Thin Film	4-02032	R905	1.00K	Resistor, 0603, Thin Film	4-02157
R658	124	Resistor, 0603, Thin Film	4-02070	R906	200	Resistor, 0603, Thin Film	4-02090
R659	499	Resistor, 0603, Thin Film	4-02128	R907	1.00K	Resistor, 0603, Thin Film	4-02157
R660	2.00K	Resistor, 0603, Thin Film	4-02186	RN101	10KX4D	Resistor network	4-00912
R661	24.9	Resistor, 0603, Thin Film	4-02003	RN102	4x47 OHM	Resistor, Misc.	4-02505
R662	150	Resistor, 0603, Thin Film	4-02078		4x47 OHM	Resistor, Misc.	4-02505
R663	150	Resistor, 0603, Thin Film	4-02078	RN104	180 x 4D	Resistor network	4-02534
R664	1.00K	Resistor, 0603, Thin Film	4-02157	RN105	180 x 4D	Resistor network	4-02534
R665	100						
		Resistor, 0603, Thin Film	4-02061		180 x 4D	Resistor network	4-02534
R666	100	Resistor, 0603, Thin Film	4-02061	RN201	4x47 OHM	Resistor, Misc.	4-02505
R670	249	Resistor, 0603, Thin Film	4-02099	RN400	4x100 ohm	Resistor, Misc.	4-02503
R671	6.2K	Resistor, 0603, Thick Film	4-01888		4x47 OHM	Resistor, Misc.	4-02505
R672	200	Resistor, 0603, Thick Film	4-01852	RN500	4x47 OHM	Resistor, Misc.	4-02505
R700	249	Resistor, 0603, Thin Film	4-02099	RN501	10KX4D	Resistor network	4-00912
R701	100K	Resistor, 0603, Thin Film	4-02349	RN600	4x47 OHM	Resistor, Misc.	4-02505
R702	1.00M	Resistor, Thin Film, MELF	4-01405	RN800	4x47 OHM	Resistor, Misc.	4-02505
R703	49.9	Resistor, Misc.	4-02558	RN801	10KX4D	Resistor network	4-00912
R704	1.00M	Resistor, Thin Film, MELF	4-01405	RN802	10KX4D	Resistor network	4-00912
R705	49.9						
		Resistor, 0603, Thin Film	4-02032		4x47 OHM	Resistor, Misc.	4-02505
R706	49.9	Resistor, 0603, Thin Film	4-02032	SW900	SW-SMT	Switch, Momentary	2-00075
R707	499	Resistor, Thin Film, MELF	4-01088	T100	TC4-1T	Transformer	6-00767
R708	2.00M	Resistor, Thin Film, MELF	4-01660	T101	TC4-1T	Transformer	6-00767
R709	402	Resistor, Thin Film, MELF	4-01079	T102	TC4-1T	Transformer	6-00767
R710	24.9	Resistor, 0603, Thin Film	4-02003	T103	TC1-1T SMT	Transformer	6-00671
R711	100	Resistor, 0603, Thin Film	4-02061	U100	7812 - THCK	Voltage Regulator	3-01618
R712	249	Resistor, 0603, Thin Film					
			4-02099		LM321MF/NOPB	Integrated Circuit	3-02010
R713	100K	Resistor, 0603, Thin Film	4-02349	U102	OPA2141AID	Integrated Circuit	3-02376
R714	49.9	Resistor, Misc.	4-02558	U103	74LVC1G3157DBVR	Integrated Circuit	3-02015
R715	1.00M	Resistor, Thin Film, MELF	4-01405	U104	OPA2141AID	Integrated Circuit	3-02376
						-	
R716	49.9	Resistor, 0603, Thin Film	4-02032	U105	MXR	Integrated Circuit	3-02377
R717	49.9	Resistor, 0603, Thin Film	4-02032	U106	ADA4895	Integrated Circuit	3-02379
R718	499	Resistor, Thin Film, MELF	4-01088	U107	65LVDS1DBV	Integrated Circuit	3-01769
R719						Integrated Circuit	3-00741
	1 0014	Posistor Thin Film MARIE	4 01405	11100			
	1.00M	Resistor, Thin Film, MELF	4-01405	U108	74HC04	0	
R719	1.00M 402	Resistor, Thin Film, MELF Resistor, Thin Film, MELF	4-01405 4-01079	U108 U109	74HC04 MAX6250BCSA	Integrated Circuit	3-01469
R720	402	Resistor, Thin Film, MELF	4-01079	U109	MAX6250BCSA	Integrated Circuit	3-01469
R720 R721	402 24.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film	4-01079 4-02003	U109 U110	MAX6250BCSA AD8037	Integrated Circuit Integrated Circuit	3-01469 3-00897
R720 R721 R722	402 24.9 2.00M	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF	4-01079 4-02003 4-01660	U109 U110 U111	MAX6250BCSA AD8037 74HC74	Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742
R720 R721 R722 R723	402 24.9 2.00M 100	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061	U109 U110 U111 U112	MAX6250BCSA AD8037 74HC74 74HC04	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741
R720 R721 R722	402 24.9 2.00M	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF	4-01079 4-02003 4-01660	U109 U110 U111	MAX6250BCSA AD8037 74HC74	Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742
R720 R721 R722 R723 R724	402 24.9 2.00M 100 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc.	4-01079 4-02003 4-01660 4-02061 4-02558	U109 U110 U111 U112 U113	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010
R720 R721 R722 R723 R724 R725	402 24.9 2.00M 100 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032	U109 U110 U111 U112 U113 U114	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741
R720 R721 R722 R723 R724 R725 R726	402 24.9 2.00M 100 49.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02058 4-02032 4-02032	U109 U110 U111 U112 U113 U114 U115	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04 LP5900SD-3.3	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784
R720 R721 R722 R723 R724 R725	402 24.9 2.00M 100 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032	U109 U110 U111 U112 U113 U114	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741
R720 R721 R722 R723 R724 R725 R726 R727	402 24.9 2.00M 100 49.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02058 4-02032 4-02032	U109 U110 U111 U112 U113 U114 U115	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04 LP5900SD-3.3	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01749
R720 R721 R722 R723 R724 R725 R726 R727 R728	402 24.9 2.00M 100 49.9 49.9 49.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, 0603, Thin Film Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-02032 4-01088 4-02349	U109 U110 U111 U112 U113 U114 U115 U116 U117	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01784 3-01749 3-01755
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729	402 24.9 2.00M 100 49.9 49.9 49.9 100K 100K	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film Resistor, 0603, Thin Film Resistor, 0603, Thin Film Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-02032 4-01088 4-02349 4-02349	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01749 3-01755 3-02016
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730	402 24.9 2.00M 100 49.9 49.9 49.9 100K 100K 100K 402	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, 0603, Thin Film Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-02032 4-01088 4-02349	U109 U110 U111 U112 U113 U114 U115 U116 U117	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01784 3-01749 3-01755
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729	402 24.9 2.00M 100 49.9 49.9 49.9 100K 100K	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film Resistor, 0603, Thin Film Resistor, 0603, Thin Film Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-02032 4-01088 4-02349 4-02349	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01749 3-01755 3-02016
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730 R731	402 24.9 2.00M 100 49.9 49.9 49.9 49.9 100K 100K 100K 402 24.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02358 4-02032 4-02032 4-02032 4-01088 4-02349 4-02349 4-02349 4-02349 4-02003	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120	MAX6250BCSA AD8037 74HC74 74HC04 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR VCX0 100MHz MC100EP14DT	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit VCXO Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01755 3-01755 3-02016 6-01122 3-01193
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730 R730 R731 R732	402 24.9 2.00M 100 49.9 49.9 49.9 499 100K 100K 402 24.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-02032 4-01088 4-02349 4-02349 4-02349 4-02349 4-02003 4-02058	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120 U200	MAX6250BCSA AD8037 74HC74 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR VCX0 100MHz MC100EP14DT LM321MF/NOPB	Integrated Circuit Integrated Circuit VCXO Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01749 3-01755 3-02016 6-01122 3-01193 3-02010
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730 R731 R732 R733	402 24.9 2.00M 100 49.9 49.9 49.9 100K 100K 402 24.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc.	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-02032 4-020349 4-02349 4-02349 4-02003 4-02003 4-02058 4-02032	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120 U200 U201	MAX6250BCSA AD8037 74HC74 24HC04 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR VCX0 100MHz VCX0 100MHz MC100EP14DT LM321MF/NOPB LM321MF/NOPB	Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01784 3-01755 3-02016 6-01122 3-01193 3-02010 3-02010
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730 R730 R731 R732	402 24.9 2.00M 100 49.9 49.9 49.9 499 100K 100K 402 24.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-02032 4-01088 4-02349 4-02349 4-02349 4-02349 4-02003 4-02058	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120 U200	MAX6250BCSA AD8037 74HC74 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR VCX0 100MHz MC100EP14DT LM321MF/NOPB	Integrated Circuit Integrated Circuit VCXO Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01749 3-01755 3-02016 6-01122 3-01193 3-02010
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730 R731 R731 R732 R733 R734	402 24.9 2.00M 100 49.9 49.9 49.9 100K 100K 100K 402 24.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Din Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-01088 4-02349 4-02349 4-02349 4-02349 4-02034 4-02003 4-020558 4-02032 4-02032	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120 U200 U201 U202	MAX6250BCSA AD8037 74HC74 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV23711DBVR VCX0 100MHz WC100EP14DT LM321MF/NOPB LM321MF/NOPB TPS2030	Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-00741 3-01784 3-01749 3-01755 3-02016 6-01122 3-01193 3-02010 3-02010 3-02380
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730 R731 R731 R731 R733 R734 R735	402 24.9 2.00M 100 49.9 49.9 49.9 49.9 100K 100K 402 24.9 49.9 49.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film Resistor, 0603, Thin Film	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-01088 4-02349 4-02349 4-02349 4-02349 4-02033 4-02032 4-02032 4-02032 4-02032 4-02032 4-02032 4-02032	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120 U200 U201 U202 U203	MAX6250BCSA AD8037 74HC74 74HC74 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR VCX0 100MHz MC100EP14DT LM321MF/NOPB LM321MF/NOPB TPS2030 THS4631DGN	Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-01784 3-01784 3-01785 3-02016 6-01122 3-01193 3-02010 3-02010 3-02010 3-02380 3-01780
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730 R731 R732 R733 R734 R735 R736	402 24.9 2.00M 100 49.9 49.9 49.9 49.9 100K 100K 402 24.9 49.9 49.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, Thin Film, MELF	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-01088 4-02349 4-02349 4-02034 4-02003 4-02003 4-02558 4-02032 4-02003 4-02005 4-0	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120 U200 U201 U201 U202 U203 U204	MAX6250BCSA AD8037 74HC74 74HC74 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR VCX0 100MHz WCX0 100MHz MC100EP14DT LM321MF/NOPB LM321MF/NOPB TPS2030 THS4631DGN LM7171AIM	Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-01784 3-01784 3-01755 3-02016 6-01122 3-01193 3-02010 3-02010 3-02380 3-01780 3-00819
R720 R721 R722 R723 R724 R725 R726 R727 R728 R728 R730 R731 R732 R733 R734 R735 R736 R736 R737	402 24.9 2.00M 100 49.9 49.9 49.9 49.9 100K 100K 100K 402 24.9 49.9 49.9 49.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, Thin Film, MELF	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-01088 4-02349 4-02349 4-02349 4-02349 4-02033 4-02032 4-02032 4-02032 4-02032 4-02032 4-02032 4-02032	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120 U200 U201 U202 U203	MAX6250BCSA AD8037 74HC74 74HC74 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR VCX0 100MHz MC100EP14DT LM321MF/NOPB LM321MF/NOPB TPS2030 THS4631DGN	Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-01784 3-01784 3-01785 3-02016 6-01122 3-01193 3-02010 3-02010 3-02010 3-02380 3-01780
R720 R721 R722 R723 R724 R725 R726 R727 R728 R729 R730 R731 R732 R733 R734 R735 R736	402 24.9 2.00M 100 49.9 49.9 49.9 49.9 100K 100K 402 24.9 49.9 49.9 49.9 49.9	Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, 0603, Thin Film Resistor, Misc. Resistor, 0603, Thin Film Resistor, Thin Film, MELF Resistor, Thin Film, MELF	4-01079 4-02003 4-01660 4-02061 4-02558 4-02032 4-02032 4-01088 4-02349 4-02349 4-02034 4-02003 4-02003 4-02558 4-02032 4-02003 4-02005 4-0	U109 U110 U111 U112 U113 U114 U115 U116 U117 U118 U119 U120 U200 U201 U201 U202 U203 U204	MAX6250BCSA AD8037 74HC74 74HC74 LM321MF/NOPB 74HC04 LP5900SD-3.3 74LVC2G00DCTR ADF4002BRUZ TLV2371IDBVR VCX0 100MHz WCX0 100MHz MC100EP14DT LM321MF/NOPB LM321MF/NOPB TPS2030 THS4631DGN LM7171AIM	Integrated Circuit Integrated Circuit	3-01469 3-00897 3-00742 3-00741 3-02010 3-01784 3-01784 3-01755 3-02016 6-01122 3-01193 3-02010 3-02010 3-02380 3-01780 3-00819

U207	74AUC1G74DCUR	Integrated Circuit	3-01774	U628	LMV321M5	Integrated Circuit	3-01412
		-				-	
U208	74AUC1G74DCUR	Integrated Circuit	3-01774	U629	AD8130ARM	Integrated Circuit	3-02000
U209	74AUC1G74DCUR	Integrated Circuit	3-01774	U630	74LVC3G34DCTR	Integrated Circuit	3-01852
U210	74AUC1G74DCUR	Integrated Circuit	3-01774	U631	74LVC3G34DCTR	Integrated Circuit	3-01852
	74LVC1G3157DBVR	Integrated Circuit	3-02015	U632	65LVDS1DBV	Integrated Circuit	3-01769
		-				-	
U212		Integrated Circuit	3-01770	U633	74AUC1G08DCKR	Integrated Circuit	3-01772
U213	65LVDS1DBV	Integrated Circuit	3-01769	U700	AD8130ARM	Integrated Circuit	3-02000
U214	65LVDS2DBV	Integrated Circuit	3-01770	U701	TLV3501AIDBVT	Integrated Circuit	3-01782
U215	65LVDS1DBV	Integrated Circuit	3-01769	U702	74LVC1G86DBVR	Integrated Circuit	
		-				-	3-01854
U216	65LVDS2DBV	Integrated Circuit	3-01770	U703	74LVC1G3157DBVR	Integrated Circuit	3-02015
U300	LM321MF/NOPB	Integrated Circuit	3-02010	U704	65LVDS1DBV	Integrated Circuit	3-01769
U301	LM321MF/NOPB	Integrated Circuit	3-02010	U705	65LVDS2DBV	Integrated Circuit	3-01770
	,	-					
U302	THS4631DGN	Integrated Circuit	3-01780	U706	AD8130ARM	Integrated Circuit	3-02000
U303	THS4631DGN	Integrated Circuit	3-01780	U707	TLV3501AIDBVT	Integrated Circuit	3-01782
U304	LM7171AIM	Integrated Circuit	3-00819	U708	74LVC1G86DBVR	Integrated Circuit	3-01854
U305	LM7171AIM	Integrated Circuit	3-00819	U709	74LVC1G3157DBVR	Integrated Circuit	3-02015
		-				U	
U306	74AUC1G74DCUR	Integrated Circuit	3-01774	U710	65LVDS1DBV	Integrated Circuit	3-01769
U307	74AUC1G74DCUR	Integrated Circuit	3-01774	U711	65LVDS2DBV	Integrated Circuit	3-01770
U308	74AUC1G74DCUR	Integrated Circuit	3-01774	U712	LM321MF/NOPB	Integrated Circuit	3-02010
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U309	74AUC1G74DCUR	Integrated Circuit	3-01774	U713	AD8130ARM	Integrated Circuit	3-02000
U310	74AUC1G74DCUR	Integrated Circuit	3-01774	U714	AD8130ARM	Integrated Circuit	3-02000
U311	74AUC1G74DCUR	Integrated Circuit	3-01774	U800	DS1816R-20	Integrated Circuit	3-02084
	74AUC1G74DCUR	Integrated Circuit	3-01774	U801	MCF52235CAL60	Integrated Circuit	3-01676
		0					
U313		Integrated Circuit	3-01774	U803	HS-212S-5	Relay	3-00196
U314	65LVDS2DBV	Integrated Circuit	3-01770	U804	74LVC138APWT	Integrated Circuit	3-01779
U315	65LVDS1DBV	Integrated Circuit	3-01769	U805	74LVC138APWT	Integrated Circuit	3-01779
U316	65LVDS2DBV	Integrated Circuit		U806	M25PE80-VMN6TP	Integrated Circuit	3-02313
		-	3-01770			-	
U317	65LVDS2DBV	Integrated Circuit	3-01770	U807	ADM3202ARUZ	Integrated Circuit	3-01757
U318	65LVDS1DBV	Integrated Circuit	3-01769	U808	74LVC2G08DCT	Integrated Circuit	3-01656
U319	65LVDS2DBV	Integrated Circuit	3-01770	U809	74LVC1G3157DBVR	Integrated Circuit	3-02015
		-					
U400	XC3S250E-4TQ144	Integrated Circuit	3-01783	U810	74LVC1G3157DBVR	Integrated Circuit	3-02015
U401	74LVC1G3157DBVR	Integrated Circuit	3-02015	U811	74LVC1G125DBV	Integrated Circuit	3-01886
U402	74LVC1G125DBV	Integrated Circuit	3-01886	U812	74LVC1G74DP	Integrated Circuit	3-01973
U403	16b_ADC	Integrated Circuit	3-02378	U813	74LVC1G74DP	Integrated Circuit	3-01973
		-				-	
U404	65LVDS2DBV	Integrated Circuit	3-01770	U814	65LVDS2DBV	Integrated Circuit	3-01770
U405	65LVDS2DBV	Integrated Circuit	3-01770	U815	74LVC1G04	Integrated Circuit	3-02070
U406	74LVC1G04	Integrated Circuit	3-02070	U816	74HC595	Integrated Circuit	3-00787
U407		-		U817	OP284FS	-	
	SN74LVC1G08DBVR	Integrated Circuit	3-01203			Integrated Circuit	3-00659
U500	DAC5672AIPFB	Integrated Circuit	3-02008	U818	LTC2620CGN	Integrated Circuit	3-01185
U501	AD8131ARMZ	Integrated Circuit	3-02001	U819	AD5760	Integrated Circuit	3-02381
U502	AD8131ARMZ	Integrated Circuit	3-02001	U900	LM393	Integrated Circuit	3-00728
		-				-	
U503	65LVDS2DBV	Integrated Circuit	3-01770		LTC6655	Integrated Circuit	3-02382
U504	AD8131ARMZ	Integrated Circuit	3-02001	U902	LP3878SD-ADJ	Integrated Circuit	3-01764
U505	ADA4860-1YRJZ	Integrated Circuit	3-02003	U903	LP3878SD-ADJ	Integrated Circuit	3-01764
						Crystal Oscillator	6-01171
11506		Integrated Circuit	3-02008	V101	20MHz 55C Xtal		
U506	DAC5672AIPFB	Integrated Circuit	3-02008	Y101	20MHz 55C Xtal		
U507	AD8131ARMZ	Integrated Circuit	3-02001	Z	FS740 BNC Block	Fabricated component	7-02464
		-					
U507 U508	AD8131ARMZ OPA2141AID	Integrated Circuit Integrated Circuit	3-02001 3-02376	Z Z	FS740 BNC Block FS740 BNC BLOCK	Fabricated component Fabricated component	7-02464 7-02468
U507 U508 U509	AD8131ARMZ OPA2141AID LM321MF/NOPB	Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010	Z Z Z	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh	Fabricated component Fabricated component Fabricated component	7-02464 7-02468 7-02472
U507 U508 U509 U510	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001	Z Z	FS740 BNC Block FS740 BNC BLOCK	Fabricated component Fabricated component	7-02464 7-02468
U507 U508 U509	AD8131ARMZ OPA2141AID LM321MF/NOPB	Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010	Z Z Z	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh	Fabricated component Fabricated component Fabricated component	7-02464 7-02468 7-02472
U507 U508 U509 U510 U511	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001	Z Z Z Z	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472
U507 U508 U509 U510 U511 U512	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02017 3-02003	Z Z Z Z	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472
U507 U508 U509 U510 U511 U512 U513	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ T55A623157DGS ADA4860-1YRJZ AD8131ARMZ	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02017 3-02003 3-02001	Z Z Z Z	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472
U507 U508 U509 U510 U511 U512 U513 U600	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRIZ AD8131ARMZ LT1396CMS8	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02017 3-02003 3-02001 3-01759	Z Z Z PO	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U510 U511 U512 U513 U600 U601	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02017 3-02003 3-02001 3-01759 3-01852	Z Z Z PO	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U510 U511 U512 U513 U600	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRIZ AD8131ARMZ LT1396CMS8	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02017 3-02003 3-02001 3-01759	Z Z Z PO	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U510 U511 U512 U513 U600 U601 U602	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02017 3-02003 3-02001 3-01759 3-01852	Z Z Z PO	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U510 U511 U512 U513 U600 U601 U602 U603	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02001 3-02003 3-02001 3-01759 3-01852 3-01852 3-01774 3-01769	Po (As	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblie	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U510 U511 U512 U513 U600 U601 U602 U603 U604	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ T55A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02001 3-02003 3-02001 3-01759 3-01852 3-01852 3-01774 3-01769 3-01770	Z Z Z PO	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N	Fabricated component Fabricated component Fabricated component Label	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U510 U511 U512 U513 U600 U601 U602 U603	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02001 3-02003 3-02001 3-01759 3-01852 3-01852 3-01774 3-01769	Z Z Z PO (As Ref	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblies Value	Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U510 U511 U512 U513 U600 U601 U602 U603 U604	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ T55A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02001 3-02003 3-02001 3-01759 3-01852 3-01852 3-01774 3-01769 3-01770	Z Z Z PO (As Ref C1	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblie Value 820UF	Fabricated component Fabricated component Fabricated component Label CIV S 337 & 338 Description Electrolytic, 50V, T/H	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 74AUC1G74DCUR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01770 3-01770 3-01770 3-01770	Z Z Z PO (AS Ref C1 C10	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblies Value 820UF .1U	Fabricated component Fabricated component Fabricated component Label Fabricated component Label Fabricated component Label Fabricated component Bell Fabricated component Fabricated component Fabrica	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD84860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770	Z Z Z PO (As Ref C1	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblie Value 820UF	Fabricated component Fabricated component Fabricated component Label CIV S 337 & 338 Description Electrolytic, 50V, T/H	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516
U507 U508 U509 U510 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02001 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01774 3-01770 3-01770	Z Z Z PO (AS Ref C1 C10	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblies Value 820UF .1U	Fabricated component Fabricated component Fabricated component Label Fabricated component Label Fabricated component Label Fabricated component Bell Fabricated component Fabricated component Fabrica	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD84860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770	Z Z Z PO (AS Ref C1 C10 C11 C12	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblie Value 820UF .1U 330U HIGH RIPPL 10U/T35	Fabricated component Fabricated component Fabricated component Label Fabricated component Label Fabricated component Label Fabricated component Soly Soly Soly Soly Soly Soly Soly Soly	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319
U507 U508 U509 U510 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U609 U610	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-01770 3-01770 3-01769 3-01852	Z Z Z PO (AS Ref C1 C10 C11 C12 C13	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblies Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P	Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00143
U507 U508 U509 U510 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 74LVC3G34DCTR AD8130ARM	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01759 3-01759 3-01774 3-01776 3-01770 3-01770 3-01770 3-01770 3-01770 3-01770 3-01775 3-01769 3-01852 3-02000	Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblies Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U	Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Ceramic, 1kV Capacitor, 1206, X7R	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U609 U610 U611 U612	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS1DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01774 3-01770 3-017769 3-01769 3-01852 3-02000 3-01769	Z Z Z PO (AS Ref C1 C10 C11 C12 C13	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblies Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P	Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00143
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U608 U609 U610 U611 U612 U613	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS1DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01770 3-01770 3-01770 3-01770 3-01770 3-01779 3-01779 3-01779 3-01769 3-01852 3-02000 3-01769 3-01769 3-01769	Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblies Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U	Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Ceramic, 1kV Capacitor, 1206, X7R	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U609 U610 U611 U612	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS1DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01774 3-01770 3-017769 3-01769 3-01852 3-02000 3-01769	Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Semblie Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U 330U HIGH RIPPL 10U/T35	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Clearmic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U609 U610 U611 U612 U613 U614	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02001 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-01770 3-01769 3-01852 3-02000 3-01852 3-02000 3-01769 3-01770 3-01770	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblie Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U 330U HIGH RIPPL 10U/T35 .001U	Fabricated component Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U608 U609 U610 U611 U612 U613 U614 U615	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD84860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G86DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-01776 3-01769 3-01769 3-01769 3-01769 3-01769 3-01769 3-01770 3-01775 3-01775	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Scemblie Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U 330U HIGH RIPPL 10U/T35 .001U 820UF	Fabricated component Fabricated component Fabricated component Fabricated component Label COLY S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, 120	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U510 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS1DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G8BDCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-01770 3-01769 3-01852 3-02000 3-01769 3-01755 3-01775 3-01775 3-01772 3-02376	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Ssemblie Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U 330U HIGH RIPPL 10U/T35 .001U	Fabricated component Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U608 U609 U610 U611 U612 U613 U614 U615	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD84860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G86DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-01776 3-01769 3-01769 3-01769 3-01769 3-01769 3-01769 3-01770 3-01775 3-01775	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Scemblies Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U 330U HIGH RIPPL 10U/T35 .001U 820UF 10U/T35	Fabricated component Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film Electrolytic, 50V, T/H Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00516 5-00319 5-00516 5-00319 5-00516 5-00319 5-00516
U507 U508 U509 U510 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 74AUC1G34DCTR AD8130ARM 65LVDS1DBV 74AUC1G86DCKR 74AUC1G08DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01770 3-01770 3-01770 3-01770 3-01770 3-01770 3-017769 3-01769 3-01769 3-01769 3-01769 3-01775 3-01775 3-01775 3-01775	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Scemblies Value 820UF .1U 330U HIGH RIPPL 10U/T35 .001U 820UF .10U/T35	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 337 & 337 Electrolytic, 50V, T/H Capacitor, 206, X7R Capacitor, 206, X7R Capacitor, 206, X7R Capacitor, 206, X7R Capacitor, 200, X	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00143 5-00299 5-00516 5-00319 5-00516 5-00319 5-00442 5-00442 5-00442 5-00443 5-00143 5-00143
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U608 U609 U610 U611 U612 U613 U614 U615 U616 U617 U618	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G86DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-017769 3-017769 3-017769 3-017769 3-017769 3-01775 3-01775 3-017772 3-02376	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Scemblie 2004 .10 3300 HIGH RIPPL 100/T35 .0010 82005 .10009 .10 3300 HIGH RIPPL 100/T35 .0010 82005 .0009 .100/T35 .010	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 3337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film Electrolytic, 50V, T/H Capacitor, Ceramic, 1kV Cap, Tantalum, SMT Capacitor, 1206, X7R	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00143 5-00299 5-00516 5-00319 5-00442 5-00844 5-00844 5-00143 5-00844
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U615 U616 U617 U618 U619	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD84860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC1G74DCUR 65LVDS1DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G80DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-017769 3-01770 3-01769 3-01769 3-01769 3-01769 3-01775 3-01775 3-01775 3-01775 3-01775 3-01775 3-01772 3-01772	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20 C21	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Semblie 200F .10 3300 HIGH RIPPL 100/T35 .0010 8200F 100/T35 .010 3300 HIGH RIPPL	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 3337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film Electrolytic, 50V, T/H Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, 1206, X7R Capacitor, 1206, X7R Capacitor, 1206, X7R Capacitor, 1206, X7R	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00143 5-00299 5-00516 5-00319 5-00516 5-00319 5-00442 5-00442 5-00442 5-00443 5-00143 5-00143
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U617 U618 U619 U620	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 74LVC3G34DCTR AD8130ARM 65LVDS2DBV 74AUC1G86DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-01770 3-017769 3-01852 3-02000 3-01769 3-01852 3-02000 3-01775 3-01775 3-01775 3-01775 3-01775 3-01772 3-01772 3-01772 3-01772 3-01772	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20	FS740 BNC Block FS740 BNC BLOCK FS740 Heater Sh SIM-PCB S/N Wer Supp Scemblie 2004 .10 3300 HIGH RIPPL 100/T35 .0010 82005 .10009 .10 3300 HIGH RIPPL 100/T35 .0010 82005 .0009 .100/T35 .010	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 3337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film Electrolytic, 50V, T/H Capacitor, Ceramic, 1kV Cap, Tantalum, SMT Capacitor, 1206, X7R	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00143 5-00299 5-00516 5-00319 5-00442 5-00844 5-00844 5-00143 5-00844
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U615 U616 U617 U618 U619	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD84860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC1G74DCUR 65LVDS1DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G80DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-017769 3-01770 3-01769 3-01769 3-01769 3-01769 3-01775 3-01775 3-01775 3-01775 3-01775 3-01775 3-01772 3-01772	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C2 C20 C21 C22	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Scemblie 200F .10 3300 HIGH RIPPL 100/T35 .0010 8200F 100/P 100/T35 .010 3300 HIGH RIPPL 100/T35 .010 3300 HIGH RIPPL 100/T35	Fabricated component Fabricated component Fabricated component Fabricated component Label Cly S 337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Cap, Tantalum, SMT Electrolytic, 50V, T/H Capacitor, Ceramic, 1kV Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00143 5-00442 5-00844 5-00299 5-00516 5-00319 5-0042 5-00844 5-00143 5-0042 5-00844 5-00143
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U614 U615 U616 U617 U618 U619 U620 U620 U621	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRIZ AD84860-1YRIZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74LVC3G34DCTR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC1G74DCUR 65LVDS1DBV 65LVDS1DBV 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-01770 3-01769 3-01852 3-02000 3-01769 3-01775 3-01772 3-02376 3-01775 3-01772 3-01772 3-01772 3-01772 3-01772 3-01772 3-01772	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20 C20 C21 C22 C23	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Scemblie Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U 330U HIGH RIPPL 10U/T35 .01U 820UF 1000P 10U/T35 .01U 330U HIGH RIPPL 10U/T35 .01U	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 337 & 338 Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U617 U618 U619 U619 U621 U622	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74AUC1G74DCUR 65LVDS2DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01770 3-01770 3-01770 3-01770 3-01770 3-01770 3-01769 3-01852 3-02000 3-01769 3-01775 3-01759 3-0	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20 C21 C22 C23 C3	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Scemblie 200F .10 3300 HIGH RIPPL 100/T35 .0010 8200F .0010 8200F 100/T35 .010 3300 HIGH RIPPL 100/T35 .010 3300 HIGH RIPPL	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 337 & 337 Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U617 U618 U619 U620 U621 U622 U623	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01770 3-01770 3-01770 3-01770 3-01770 3-01770 3-017769 3-01769 3-01769 3-01775 3-01775 3-01775 3-01775 3-01772 3-01772 3-01772 3-01772 3-01772 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20 C20 C21 C22 C23	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Scemblie Value 820UF .1U 330U HIGH RIPPL 10U/T35 1000P .1U 330U HIGH RIPPL 10U/T35 .01U 820UF 1000P 10U/T35 .01U 330U HIGH RIPPL 10U/T35 .01U	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 337 & 338 Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U617 U618 U617 U618 U619 U620 U621 U623 U624	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G74DCUR 65LVDS1DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01770 3-01770 3-01770 3-01770 3-01770 3-01776 3-017769 3-01770 3-017769 3-01775 3-01776 3-01775 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01777 3-01776 3-01777 3-01776 3-01777 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01777 3-01776 3-01777 3-01776 3-01777 3-01777 3-01776 3-01777 3-01777 3-01777 3-01777 3-01776 3-01777 3-01776 3-01777 3-01775 3-01775 3-01777 3-01775 3-01775 3-01775 3-01776 3-01775 3-01775 3-01776 3	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20 C21 C22 C23 C3	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Scemblie 200F .10 3300 HIGH RIPPL 100/T35 .0010 8200F .0010 8200F 100/T35 .010 3300 HIGH RIPPL 100/T35 .010 3300 HIGH RIPPL	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 337 & 337 Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Capacitor, 1206, X7R Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U617 U618 U619 U620 U621 U622 U623	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01770 3-01770 3-01770 3-01770 3-01770 3-01770 3-017769 3-01769 3-01769 3-01775 3-01775 3-01775 3-01775 3-01772 3-01772 3-01772 3-01772 3-01772 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20 C21 C22 C20 C21 C22 C23 C3 C4 C5	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Semblie 200F .10 3300 HIGH RIPPL 100/T35 .0010 3300 HIGH RIPPL 100/T35 .010 3300 HIGH RIPPL 100/T35 .010 3300 HIGH RIPPL 100/T35 .000P	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 3337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film Electrolytic, 50V, T/H Capacitor, Ceramic, 1kV Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00442 5-00844 5-00143 5-00299 5-00516 5-00319 5-00298 5-00516 5-00319 5-00143 5-00319 5-00143
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U617 U618 U616 U617 U618 U619 U620 U621 U622 U623 U624 U624 U626	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS1DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 74LVC3G34DCTR AD8130ARM 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G86DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G80DCKR 74AUC1G74DCUR 65LVDS1DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01769 3-01770 3-01770 3-01770 3-01770 3-01776 3-01770 3-01769 3-01775 3-01775 3-01775 3-01775 3-01775 3-01775 3-01772 3-01775 3-01772 3-01772 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01779 3-01769 3-01779 3-01779 3-01779 3-01779 3-01779	Z Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20 C21 C22 C23 C3 C4 C5 C6	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Semblie 200F .10 3300 HIGH RIPPL 100/T35 .0010 8200F 1000P 100/T35 .0010 3300 HIGH RIPPL 100/T35 1000P 3300 HIGH RIPPL 100/T35 1000P 3300 HIGH RIPPL 100/T35	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 3337 & 3337 Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film Electrolytic, 50V, T/H Capacitor, Ceramic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV Cap, Tantalum, SMT	7-02464 7-02468 7-02472 9-01570
U507 U508 U509 U511 U512 U513 U600 U601 U602 U603 U604 U605 U606 U608 U609 U610 U611 U612 U613 U614 U615 U616 U617 U618 U617 U618 U619 U620 U621 U623 U624	AD8131ARMZ OPA2141AID LM321MF/NOPB AD8131ARMZ TS5A623157DGS ADA4860-1YRJZ AD8131ARMZ LT1396CMS8 74LVC3G34DCTR 74AUC1G74DCUR 65LVDS1DBV 65LVDS2DBV 65LVDS2DBV 74AUC1G74DCUR 65LVDS1DBV 65LVDS1DBV 65LVDS1DBV 65LVDS2DBV 74AUC1G86DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G08DCKR 74AUC1G74DCUR 65LVDS1DBV	Integrated Circuit Integrated Circuit	3-02001 3-02376 3-02010 3-02001 3-02003 3-02001 3-01759 3-01852 3-01774 3-01770 3-01770 3-01770 3-01770 3-01770 3-01776 3-017769 3-01770 3-017769 3-01775 3-01776 3-01775 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01777 3-01776 3-01777 3-01776 3-01777 3-01776 3-01776 3-01776 3-01776 3-01776 3-01776 3-01777 3-01776 3-01777 3-01776 3-01777 3-01777 3-01776 3-01777 3-01777 3-01777 3-01777 3-01776 3-01777 3-01776 3-01777 3-01775 3-01775 3-01777 3-01775 3-01775 3-01775 3-01776 3-01775 3-01775 3-01776 3	Z Z Z Z PO (AS Ref C1 C10 C11 C12 C13 C14 C15 C16 C17 C18 C19 C2 C20 C21 C22 C20 C21 C22 C23 C3 C4 C5	F5740 BNC Block F5740 BNC BLOCK F5740 Heater Sh SIM-PCB S/N Wer Supp Semblie 200F .10 3300 HIGH RIPPL 100/T35 .0010 3300 HIGH RIPPL 100/T35 .010 3300 HIGH RIPPL 100/T35 .010 3300 HIGH RIPPL 100/T35 .000P	Fabricated component Fabricated component Fabricated component Fabricated component Label CDV S 3337 & 338 Description Electrolytic, 50V, T/H Capacitor, 1206, X7R Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Electrolytic Cap, Tantalum, SMT SMD PPS Film Electrolytic, 50V, T/H Capacitor, Ceramic, 1kV Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Electrolytic Cap, Tantalum, SMT Capacitor, Ceramic, 1kV Capacitor, Ceramic, 1kV	7-02464 7-02468 7-02472 9-01570 SRS P/N 5-00844 5-00299 5-00516 5-00319 5-00442 5-00844 5-00143 5-00299 5-00516 5-00319 5-00298 5-00516 5-00319 5-00143 5-00319 5-00143

C8	10U/T35	Cap, Tantalum, SMT	5-00319
C9	1000P	Capacitor, Ceramic, 1kV	5-00143
D1	RED	LED, T1 Package	3-00011
D10	ES2D	Diode, SMT	3-02090
D11	ES2D	Diode, SMT	3-02090
D12	MBRS230LT3G	Diode, SMT	3-02091
D13	ES2D	Diode, SMT	3-02090
D14	ES2D	Diode, SMT	3-02090
D15	MBRS230LT3G	Diode, SMT	3-02091
D15	ES2D		
		Diode, SMT	3-02090
D2	ES2D	Diode, SMT	3-02090
D3	MBRS230LT3G	Diode, SMT	3-02091
D4	ES2D	Diode, SMT	3-02090
D5	ES2D	Diode, SMT	3-02090
D6	MBRS230LT3G	Diode, SMT	3-02091
D7	ES2D	Diode, SMT	3-02090
D8	ES2D	Diode, SMT	3-02090
D9	MBRS230LT3G	Diode, SMT	3-02091
J1	4 PIN, WHITE	Connector	1-00260
J2	HEADER10	Connector	1-00554
J3	2 PIN, WHITE	Connector	1-00473
L1	10 UH / SMT	Misc. Components	6-01016
L2	10 UH / SMT	Misc. Components	6-01016
L3	10 UH / SMT	Misc. Components	6-01016
L4	10 UH / SMT	Misc. Components	6-01016
L5	10 UH / SMT	Misc. Components	6-01016
L6	10 UH / SMT	Misc. Components	6-01016
L7	10 UH / SMT	Misc. Components	6-01016
PCB1	SG385 P/S PCB	Fabricated component	7-02205
Q1	PZT3904	Integrated Circuit	3-01664
Q2	IRF530/IRF532	Integrated Circuit	3-00283
		-	
Q3	IRF530/IRF532	Integrated Circuit	3-00283
R1	7.50K	Resistor, Thin Film, MELF	4-01201
R10	49.9	Resistor, Thin Film, MELF	4-00992
R11	0.15 OHM /2W	Resistor, Misc.	4-02530
R2	121	Resistor, Thin Film, MELF	4-01029
R3	100K	Resistor, Thin Film, MELF	4-01309
R4	2.00K	Resistor, Thin Film, MELF	4-01146
R5	1.33K	Resistor, Thin Film, MELF	4-01129
R6	49.9	Resistor, Thin Film, MELF	4-00992
R7	1.00K	Resistor, Thin Film, MELF	4-01117
R8	49.9	Resistor, Thin Film, MELF	4-00992
R9			
	7.50K	Resistor, Thin Film, MELF	4-01201
RN1	100Kx4D 5%	Resistor network	4-01704
RN2	100Kx4D 5%	Resistor network	4-01704
T1	DG645/SG385	Transformer	6-00765
U1	LM358	Integrated Circuit	3-00773
U2	LM45CIM3	Integrated Circuit	3-00775
U3	LM1085IT-ADJ/NO	Voltage Regulator	3-02111
U4	LM2990T-15	Integrated Circuit	3-01787
U5	UA78L12ACPK	Integrated Circuit	3-02092
U6	LM1085IT-5.0/NO	Voltage Regulator	3-02112
U7	3525A	Integrated Circuit	3-00919
U8	LM2990T-5	Integrated Circuit	3-01789
U9	LM1085IT-3.3/NO	Voltage Regulator	3-02093
Z		Hardware	
	4-40 KEP		0-00043
Z	36154	Hardware	0-00084
Z	10-32 KEP	Hardware	0-00160
Z	6-32X1/2RP	Hardware	0-00167
Z	4-40X1/4PP	Hardware	0-00187
Z	4-40X3/8PF	Hardware	0-00208
Z	6-32X1/4PP	Hardware	0-00222
Z	1-32, #4 SHOULD	Hardware	0-00231
Z	TO-220	Hardware	0-00243
Z	10-32X1/2"PP	Hardware	0-00493
Z	4-40X5/16"PF	Hardware	0-00589
Z	2-520184-2	Hardware	0-00634
Z	4"GREEN W/YELL	Wire	0-00034
Z	KDE1205PHV2	Fans, & Hardware	0-01181
Z	3" BLACK	Wire	0-01191
Z	3" RED	Wire	0-01192
Z	10" WHITE	Wire	0-01231
Z	10" BLACK	Wire	0-01238
Z	FN9222R-3-06	Power Entry Hardware	0-01333
Z	AFM03	Fans, & Hardware	0-01335
Z	SILICONE TUBING	Hardware	0-01345
Z	5 PIN, 18AWG/OR	Connector	1-00033
Z	4 PIN, 18AWG/OR	Connector	1-00259

Z	2 PIN, 24AWG/WH	Connector	1-00472
Z	13 PIN, ORANGE	Connector	1-00601
Z	120W - 24V	Power Supply	6-01017
Z	SG385 P/S ENCLO	Fabricated component	7-02198
Z	SG385 P/S COVER	Fabricated component	7-02199
Z	SG385 INSULATOR	Fabricated component	7-02200
Z	SG385 SPACER BL	Fabricated component	7-02207

Chassis (Assembly 749)

Ref	Value	Description	SRS P/N
Z	RIGHT FOOT	Hardware	0-00179
Z	LEFT FOOT	Hardware	0-00180
Z	6-32X3/8PP	Hardware	0-00185
Z	4-40X1/4PP	Hardware	0-00187
Z	REAR FOOT	Hardware	0-00204
Z	4-40X3/8PF	Hardware	0-00208
Z	4-40X3/16PP	Hardware	0-00241
Z	10-32X3/8TRUSSP	Hardware	0-00248
Z	6-32X7/16 PP	Hardware	0-00315
Z	6-32X1/2FP BLK	Hardware	0-00492
Z	6-32X1/4 PF UC	Hardware	0-00907
Z	8 Cond, Ribbon, DIL	Connector	1-01429
Z	IDSD-08-D-02.00	Connector	1-01430
Z	DG535-36	Fabricated component	7-00122
Z	FS740 Front Cha	Fabricated component	7-02454
Z	FS740 Rear Chas	Fabricated component	7-02455
Z	FS740 Top Cover	Fabricated component	7-02456
Z	FS740 BTM Cover	Fabricated component	7-02457
Z	FS740 REAR LEXA	Fabricated component	7-02486
Z	FS740 Options C	Fabricated component	7-02489
Z	FS740 LEXAN	Fabricated component	7-02491
Z	4.3"TFT W/ TOUCH	LCD Display	8-00115

Option Backplane (Assembly 743)

Ref	Value	Description	SRS P/N
C1	1000P	Capacitor, 0603, NPO	5-00740
JP1	TSW-125-08-G-S-RA	Connector	1-01427
JP2	TSW-125-08-G-S-RA	Connector	1-01427
JP3	TSW-125-08-G-S-RA	Connector	1-01427
JP4	TSW-125-08-G-S-RA	Connector	1-01427
PCB0	FS740 PCB	Fabricated component	7-02483
R1	49.9	Resistor, 0603, Thin Film	4-02032
R2	49.9	Resistor, 0603, Thin Film	4-02032
R3	49.9	Resistor, 0603, Thin Film	4-02032
R4	49.9	Resistor, 0603, Thin Film	4-02032
R5	49.9	Resistor, 0603, Thin Film	4-02032
R6	49.9	Resistor, 0603, Thin Film	4-02032
R7	49.9	Resistor, 0603, Thin Film	4-02032
Z	SIM-PCB S/N	Label	9-01570

Option 10MHz (Assembly 744)

Ref	Value	Description	SRS P/N
C1	100000P	Capacitor, 0603, X7R	5-00764
C10	100000P	Capacitor, 0603, X7R	5-00764
C11	100000P	Capacitor, 0603, X7R	5-00764
C12	750P	Capacitor, 0603, NPO	5-00737
C13	100000P	Capacitor, 0603, X7R	5-00764
C14	100000P	Capacitor, 0603, X7R	5-00764
C15	750P	Capacitor, 0603, NPO	5-00737
C16	100000P	Capacitor, 0603, X7R	5-00764
C17	100000P	Capacitor, 0603, X7R	5-00764
C18	750P	Capacitor, 0603, NPO	5-00737
C19	750P	Capacitor, 0603, NPO	5-00737

C2	100000P	Capacitor, 0603, X7R	5-00764	C10	100000P	Capacitor, 0603, X7R	5-00764
C3	100000P	Capacitor, 0603, X7R	5-00764	C11	100000P	Capacitor, 0603, X7R	5-00764
C4	100000P	Capacitor, 0603, X7R	5-00764	C14	100000P	Capacitor, 0603, X7R	5-00764
C5	750P	Capacitor, 0603, NPO	5-00737	C15	100000P	Capacitor, 0603, X7R	5-00764
		1 7 7				1 7 7	
C6	100000P	Capacitor, 0603, X7R	5-00764	C16	100000P	Capacitor, 0603, X7R	5-00764
C7	100000P	Capacitor, 0603, X7R	5-00764	C19	100000P	Capacitor, 0603, X7R	5-00764
C8	100000P	Capacitor, 0603, X7R	5-00764	C2	100000P	Capacitor, 0603, X7R	5-00764
C9	750P	Capacitor, 0603, NPO	5-00737	C20	100000P	Capacitor, 0603, X7R	5-00764
J1	73100-0195	Connector	1-01158	C23	100000P	Capacitor, 0603, X7R	5-00764
J2	73100-0195	Connector	1-01158	C24	100000P	Capacitor, 0603, X7R	5-00764
J3	73100-0195	Connector	1-01158	C27	100000P	Capacitor, 0603, X7R	5-00764
J4	73100-0195	Connector	1-01158	C28	100000P	Capacitor, 0603, X7R	5-00764
J5	73100-0195	Connector	1-01158	C29	100000P	Capacitor, 0603, X7R	5-00764
JP1	SLW-125-01-G-S	Connector	1-01428	C3	100000P	Capacitor, 0603, X7R	5-00764
L1	2506031517Y0	Ferrite bead, SMT	6-00759	C30	100000P	Capacitor, 0603, X7R	5-00764
L10	2506031517Y0	Ferrite bead, SMT	6-00759	C4	100000P	Capacitor, 0603, X7R	5-00764
L10 L11	0.33uH		6-01011	C5	100000P		5-00764
		Fixed inductor				Capacitor, 0603, X7R	
L12	2506031517Y0	Ferrite bead, SMT	6-00759	C6	100000P	Capacitor, 0603, X7R	5-00764
L13	2506031517Y0	Ferrite bead, SMT	6-00759	C7	100000P	Capacitor, 0603, X7R	5-00764
L14	0.33uH	Fixed inductor	6-01011	C8	100000P	Capacitor, 0603, X7R	5-00764
L15	2506031517Y0	Ferrite bead, SMT	6-00759	C9	100000P	Capacitor, 0603, X7R	5-00764
L16	2506031517Y0	Ferrite bead, SMT	6-00759	J1	73100-0195	Connector	1-01158
				J2			
L17	0.33uH	Fixed inductor	6-01011		73100-0195	Connector	1-01158
L18	2506031517Y0	Ferrite bead, SMT	6-00759	J3	73100-0195	Connector	1-01158
L19	0.33uH	Fixed inductor	6-01011	J4	73100-0195	Connector	1-01158
L2	2506031517Y0	Ferrite bead, SMT	6-00759	J5	73100-0195	Connector	1-01158
L3	0.33uH	Fixed inductor	6-01011	JP1	SLW-125-01-G-S	Connector	1-01428
L4	2506031517Y0	Ferrite bead, SMT	6-00759	L1	2506031517Y0	Ferrite bead, SMT	6-00759
L5	2506031517Y0	Ferrite bead, SMT	6-00759	L11	2506031517Y0	Ferrite bead, SMT	6-00759
L6	2506031517Y0	Ferrite bead, SMT	6-00759	L13	2506031517Y0	Ferrite bead, SMT	6-00759
L7	2506031517Y0	Ferrite bead, SMT	6-00759	L14	2506031517Y0	Ferrite bead, SMT	6-00759
L8	0.33uH	Fixed inductor	6-01011	L2	2506031517Y0	Ferrite bead, SMT	6-00759
L9	2506031517Y0	Ferrite bead, SMT	6-00759	L3	2506031517Y0	Ferrite bead, SMT	6-00759
						,	
PCB0	FS740 PCB Opt A	Fabricated component	7-02466	L4	2506031517Y0	Ferrite bead, SMT	6-00759
R1	10	Resistor, 0603, Thin Film	4-01965	L6	2506031517Y0	Ferrite bead, SMT	6-00759
R10	49.9	Resistor, Misc.	4-02558	L7	2506031517Y0	Ferrite bead, SMT	6-00759
R11	432	Resistor, 0603, Thin Film	4-02122	L9	2506031517Y0	Ferrite bead, SMT	6-00759
R12	432	Resistor, 0603, Thin Film	4-02122	PCB0	FS740 PCB Opt.B	Fabricated component	7-02467
R13	10	Resistor, 0603, Thin Film	4-01965	R1	10KX4D	Resistor network	4-00912
R14	49.9	Resistor, Misc.	4-02558	R10	49.9	Resistor, Misc.	4-02558
R15	432	Resistor, 0603, Thin Film	4-02122	R11	402	Resistor, 0603, Thin Film	4-02119
R16	432	Resistor, 0603, Thin Film	4-02122	R12	499	Resistor, 0603, Thin Film	4-02128
R17	10	Resistor, 0603, Thin Film	4-01965	R13	499	Resistor, 0603, Thin Film	4-02128
R18	49.9	Resistor, Misc.	4-02558	R14	49.9	Resistor, Misc.	4-02558
R19	432	Resistor, 0603, Thin Film	4-02122	R15	499	Resistor, 0603, Thin Film	4-02128
R2	24.9	Resistor, 0603, Thin Film	4-02003	R16	499	Resistor, 0603, Thin Film	4-02128
R20	432	Resistor, 0603, Thin Film	4-02122	R17	20.0K	Resistor, 0603, Thin Film	4-02282
R21	10	Resistor, 0603, Thin Film	4-01965	R18	10.0K	Resistor, 0603, Thin Film	4-02253
R22	49.9	Resistor, Misc.	4-02558	R19	49.9	Resistor, Misc.	4-02558
R23	432		4-02122	R2	49.9		4-02032
		Resistor, 0603, Thin Film				Resistor, 0603, Thin Film	
R24	24.9	Resistor, 0603, Thin Film	4-02003	R20	499	Resistor, 0603, Thin Film	4-02128
R25	432	Resistor, 0603, Thin Film	4-02122	R21	499	Resistor, 0603, Thin Film	4-02128
R3	10	Resistor, 0603, Thin Film	4-01965	R22	49.9	Resistor, Misc.	4-02558
R4	49.9	Resistor, Misc.	4-02558	R23	499	Resistor, 0603, Thin Film	4-02128
R5	432	Resistor, 0603, Thin Film	4-02122	R24	499	Resistor, 0603, Thin Film	4-02128
	432						
R6		Resistor, 0603, Thin Film	4-02122	R25	49.9	Resistor, Misc.	4-02558
R7	280	Resistor, 0603, Thin Film	4-02104	R26	499	Resistor, 0603, Thin Film	4-02128
R8	432	Resistor, 0603, Thin Film	4-02122	R27	499	Resistor, 0603, Thin Film	4-02128
R9	10	Resistor, 0603, Thin Film	4-01965	R28	49.9	Resistor, 0603, Thin Film	4-02032
U1	AD8000	Integrated Circuit	3-02401	R3	499	Resistor, 0603, Thin Film	4-02128
U2	AD8000	Integrated Circuit	3-02401	R30	49.9	Resistor, 0603, Thin Film	4-02032
		-					
U3	74LVC1G125DBV	Integrated Circuit	3-01886	R31	1.00K	Resistor, 0603, Thin Film	4-02157
U4	AD8000	Integrated Circuit	3-02401	R32	1.00K	Resistor, 0603, Thin Film	4-02157
U5	AD8000	Integrated Circuit	3-02401	R33	1.00K	Resistor, 0603, Thin Film	4-02157
U6	AD8000	Integrated Circuit	3-02401	R34	1.00K	Resistor, 0603, Thin Film	4-02157
U7	AD8000	Integrated Circuit	3-02401	R35	1.00K	Resistor, 0603, Thin Film	4-02157
	1/2" CUSTOM	Hardware			402	Resistor, 0603, Thin Film	
Z			0-01259	R4		, ,	4-02119
Z	FS740 BNC Block	Fabricated component	7-02463	R5	49.9	Resistor, 0603, Thin Film	4-02032
Z	SIM-PCB S/N	Label	9-01570	R6	499	Resistor, 0603, Thin Film	4-02128
				R7	499	Resistor, 0603, Thin Film	4-02128
	,			R8	49.9	Resistor, 0603, Thin Film	4-02032
		1				, 00000,	
		ο/Διιχ		PO	199	Resistor 0602 Thin Film	
	otion Sine	e/Aux		R9	499	Resistor, 0603, Thin Film	4-02128
Op	otion Sine	-		U1	AD8130ARM	Integrated Circuit	4-02128 3-02000
Op	otion Sine	-					4-02128
Op		-		U1	AD8130ARM	Integrated Circuit	4-02128 3-02000
Op	otion Sine	-		U1 U10 U11	AD8130ARM 74LVC1G125DBV OPA2695IDR	Integrated Circuit Integrated Circuit Integrated Circuit	4-02128 3-02000 3-01886 3-02089
Op (As	otion Sine ssembly	747)		U1 U10 U11 U2	AD8130ARM 74LVC1G125DBV OPA2695IDR TS5A623157DGS	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	4-02128 3-02000 3-01886 3-02089 3-02017
Op (As _{Ref}	otion Sine ssembly	747) Description	SRS P/N	U1 U10 U11 U2 U3	AD8130ARM 74LVC1G125DBV OPA2695IDR TS5A623157DGS OPA2695IDR	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	4-02128 3-02000 3-01886 3-02089 3-02017 3-02089
Op (As	otion Sine ssembly	747)	SRS P/N 5-00764	U1 U10 U11 U2	AD8130ARM 74LVC1G125DBV OPA2695IDR TS5A623157DGS	Integrated Circuit Integrated Circuit Integrated Circuit Integrated Circuit	4-02128 3-02000 3-01886 3-02089 3-02017

U5	74LVC1G04	Integrated Circuit	3-02070
U6	74LVC2G08DCT	Integrated Circuit	3-01656
U7	74LVC1G74DP	Integrated Circuit	3-01973
U8	LM321MF/NOPB	Integrated Circuit	3-02010
U9	OPA2695IDR	Integrated Circuit	3-02089
Z	1/2" CUSTOM	Hardware	0-01259
Z	FS740 BNC Block	Fabricated component	7-02463
Z	SIM-PCB S/N	Label	9-01570

Option Pulse (Assembly 748)

Ref	Value	Description	SRS P/N
C1	100000P	Capacitor, 0603, X7R	5-00764
C10	100000P	Capacitor, 0603, X7R	5-00764
C11	100000P	Capacitor, 0603, X7R	5-00764
C12	100000P	Capacitor, 0603, X7R	5-00764
C13	100000P	Capacitor, 0603, X7R	5-00764
C14	100000P	Capacitor, 0603, X7R	5-00764
C15	100000P	Capacitor, 0603, X7R	5-00764
C2	100000P	Capacitor, 0603, X7R	5-00764
C3	100000P	Capacitor, 0603, X7R	5-00764
C4	100000P	Capacitor, 0603, X7R	5-00764
C5	100000P	Capacitor, 0603, X7R	5-00764
C6	100P	Capacitor, 0603, NPO	5-00716
C7	100000P	Capacitor, 0603, X7R	5-00764
C8	100000P	Capacitor, 0603, X7R	5-00764
C9	100000P	Capacitor, 0603, X7R	5-00764
J1	73100-0195	Connector	1-01158
J2	73100-0195	Connector	1-01158
J3	73100-0195	Connector	1-01158
J4	73100-0195	Connector	1-01158
J5	73100-0195	Connector	1-01158
JP1	SLW-125-01-G-S	Connector	1-01428
L1	2506031517Y0	Ferrite bead, SMT	6-00759
L2	2506031517Y0	Ferrite bead, SMT	6-00759
L3	2506031517Y0	Ferrite bead, SMT	6-00759
L4	2506031517Y0	Ferrite bead, SMT	6-00759
L5	2506031517Y0	Ferrite bead, SMT	6-00759
L6	2506031517Y0	Ferrite bead, SMT	6-00759
L7	2506031517Y0	Ferrite bead, SMT	6-00759
L8	2506031517Y0	Ferrite bead, SMT	6-00759
PCB0	FS740 PCB OPT. C	Fabricated component	7-02465
Q1	MMBT3904LT1	Integrated Circuit	3-00601
R1	4.7	Resistor, 0603, Thick Film	4-01813
R10	4.7	Resistor, 0603, Thick Film	4-01813

R11	45.3	Resistor, Thin Film, MELF	4-00988
R12	150	Resistor, 0603, Thin Film	4-02078
R13	150	Resistor, 0603, Thin Film	4-02078
R2	1.00K	Resistor, 0603, Thin Film	4-02157
R3	45.3	Resistor, Thin Film, MELF	4-00988
R4	4.7	Resistor, 0603, Thick Film	4-01813
R5	45.3	Resistor, Thin Film, MELF	4-00988
R6	4.7	Resistor, 0603, Thick Film	4-01813
R7	45.3	Resistor, Thin Film, MELF	4-00988
R8	4.7	Resistor, 0603, Thick Film	4-01813
R9	45.3	Resistor, Thin Film, MELF	4-00988
U1	74LVC3G34DCTR	Integrated Circuit	3-01852
U2	74LVC3G34DCTR	Integrated Circuit	3-01852
U3	65LVDS2DBV	Integrated Circuit	3-01770
U4	74LVC3G34DCTR	Integrated Circuit	3-01852
U5	74LVC1G125DBV	Integrated Circuit	3-01886
U6	74LVC1G04	Integrated Circuit	3-02070
U7	74LVC3G34DCTR	Integrated Circuit	3-01852
U8	74LVC3G34DCTR	Integrated Circuit	3-01852
U9	74LVC3G34DCTR	Integrated Circuit	3-01852
Z	1/2" CUSTOM	Hardware	0-01259
Z	FS740 BNC Block	Fabricated component	7-02463
Z	SIM-PCB S/N	Label	9-01570

Option Timebase Adapter (Assembly 605)

Ref	Value	Description	SRS P/N
J1	SSW-107-01-S-S	Connector	1-01078
J3	09-52-3101	Connector	1-01058
PC1	CG635 TIMEBASE	Fabricated component	7-01586
R1	3.01K	Resistor, Metal Film	4-00176
R2	2.00K	Resistor, Metal Film	4-00158
R3	3.01K	Resistor, Metal Film	4-00176
R4	12.1K	Resistor, Metal Film	4-00148
U1	LM358	Integrated Circuit	3-00508
Z	6-32 KEP	Hardware	0-00048
Z	4-40X1/4PP	Hardware	0-00187
Z	8-32X1/4PF	Hardware	0-00416
Z	3403	Hardware	0-01090
Z	26-48-1101	Connector	1-01057
Z	SC10-24V - CG	Oscillator	6-00079
Z	CG635, OPT	Fabricated component	7-01614

Appendix B: Schematic Diagrams

- Schematic 1: Front Panel Display 1 Schematic 2: Front Panel Display 2 Schematic 3: Front Panel Display 3 Schematic 4: Front Panel Keys and Lamps Schematic 5: Motherboard 1, 10MHz / 100 MHz / OCXO / Rubidium Timebases Schematic 6: Motherboard 2, GPS Timing Receiver and Time Tagging Schematic 7: Motherboard 3, Front and Rear Panel Time Tagging Schematic 8: Motherboard 4, FPGA Schematic 9: Motherboard 5, High Speed DACs Schematic 10: Motherboard 6, Agile Pulse Generator Schematic 11: Motherboard 7, Trigger Inputs and Waveform Outputs Schematic 12: Motherboard 8, CPU, LAN, RS232, and System DACs Schematic 13: Motherboard 9, Power Supplies and Voltage Reference Schematic 14: Power Supply Schematic 15: Option 10MHz Distribution Schematic 16: Option Sine/Aux Distribution Schematic 17: Option Pulse Distribution
- Schematic 18: Option Backplane
- Schematic 19: Timebase Option Adapter

